

CD Digital Signal Processor with Built-in Digital Servo + Shock-Proof Memory Controller + Digital High & Bass Boost

Description

The CXD3027R is a digital signal processor LSI for CD players. This LSI incorporates a digital servo, high & bass boost, shock-proof memory controller, 1-bit DAC and analog low-pass filter.

Features

- All digital signal processing during playback is performed with a single chip
- Highly integrated mounting possible due to a built-in RAM

Digital Signal Processor (DSP) Block

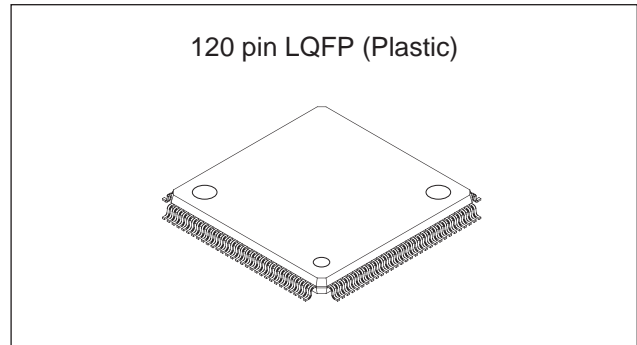
- Supports CAV (Constant Angular Velocity) playback
 - Frame jitter free
 - 0.5x to 4x speed continuous playback possible
 - Allows relative rotational velocity readout
- Wide capture range playback mode
 - Spindle rotational velocity following method
 - Supports 1x to 4x speed playback
- Supports variable pitch playback
- The bit clock, which strobes the EFM signal, is generated by the digital PLL.
- EFM data demodulation
- Enhanced EFM frame sync signal protection
- Refined super strategy-based powerful error correction
 - C1: double correction, C2: quadruple correction
 - Supported during 4x speed playback
- Noise reduction during track jumps
- Auto zero-cross mute
- Subcode demodulation and subcode-Q data error detection
- Digital spindle servo
- 16-bit traverse counter
- Asymmetry correction circuit
- CPU interface on serial bus
- Error correction monitor signal, etc. output from a new CPU interface
- Servo auto sequencer
- Fine search performs track jumps with high accuracy
- Digital audio interface outputs
- Digital level meter, peak meter
- Bilingual compatible
- VCO control mode
- CD TEXT data demodulation
- Digital Out can be generated from the audio serial input. (also supported after shock-proof and digital bass boost processing, subcode-Q addition function)

Digital Servo (DSSP) Block

- Microcomputer software-based flexible servo control
- Offset cancel function for servo error signal
- Auto gain control function for servo loop
- E:F balance, focus bias adjustment functions
- Surf jump function supporting micro two-axis
- Tracking filter: 6 stages
Focus filter: 5 stages

Shock-Proof Memory Controller Block

- Supports an external 4M-bit/16M-bit DRAM
- Time axis-based data linking
- ADPCM compression method (uncompressed/4 bits/6 bits/8 bits)



Digital Filter, DAC and Analog Low-pass Filter Blocks

- Digital dynamic bass boost and high boost
 - Bass Boost: 4th-order IIR 24dB/Oct
+10dB/+14dB/+18dB/+22dB
 - High Boost: Second-order IIR 12dB/Oct
+4dB/+6dB/+8dB/+10dB
- Independent turnover frequency selection possible
 - Bass Boost: 125Hz/160Hz/200Hz
 - High Boost: 5kHz/7kHz
- Digital dynamics (compressor)
 - Volume increased by +5dB at low level
- 8x oversampling digital filter (attenuation: 61dB, ripple within band: ±0.0075dB)
- Digital signal output possible after boost
- Serial data format selectable from (output) 20 bits/18 bits/16 bits (rearward truncation, MSB first)
- Digital attenuation: -∞, -60 to +6dB, 2048 steps (linear)
- Soft mute
- Digital de-emphasis
- High-cut filter

Applications

CD players

Structure

Silicon gate CMOS IC

Absolute Maximum Ratings

• Supply voltage	V_{DD}, AV_{DD}	-0.3 to +4.6	V
• Input voltage	V_I	-0.3 to +4.6	V
		$(V_{SS} - 0.3V \text{ to } V_{DD} + 0.3V)$	
• Output voltage	V_O	-0.3 to +4.6	V
• Storage temperature	T_{stg}	-40 to +125	°C
• Supply voltage difference	$AV_{SS} - V_{SS}$	-0.3 to +0.3	V
	$AV_{DD} - V_{DD}$	-0.3 to +0.3V ($AV_{DD} < 2.2V$)	
	$AV_{DD} - V_{DD}$	-0.3 to +1.4V ($AV_{DD} = 2.2 \text{ to } 3.6V$)	

Recommended Operating Conditions

• Supply voltage	$V_{DD}, AV_{DD0}, 3$	2.2 to 3.6	V
	$AV_{DD1}, 2, DV_{DD}$	V_{DD} to 3.6	V
• Operating temperature	T_{opr}	-20 to +75	°C

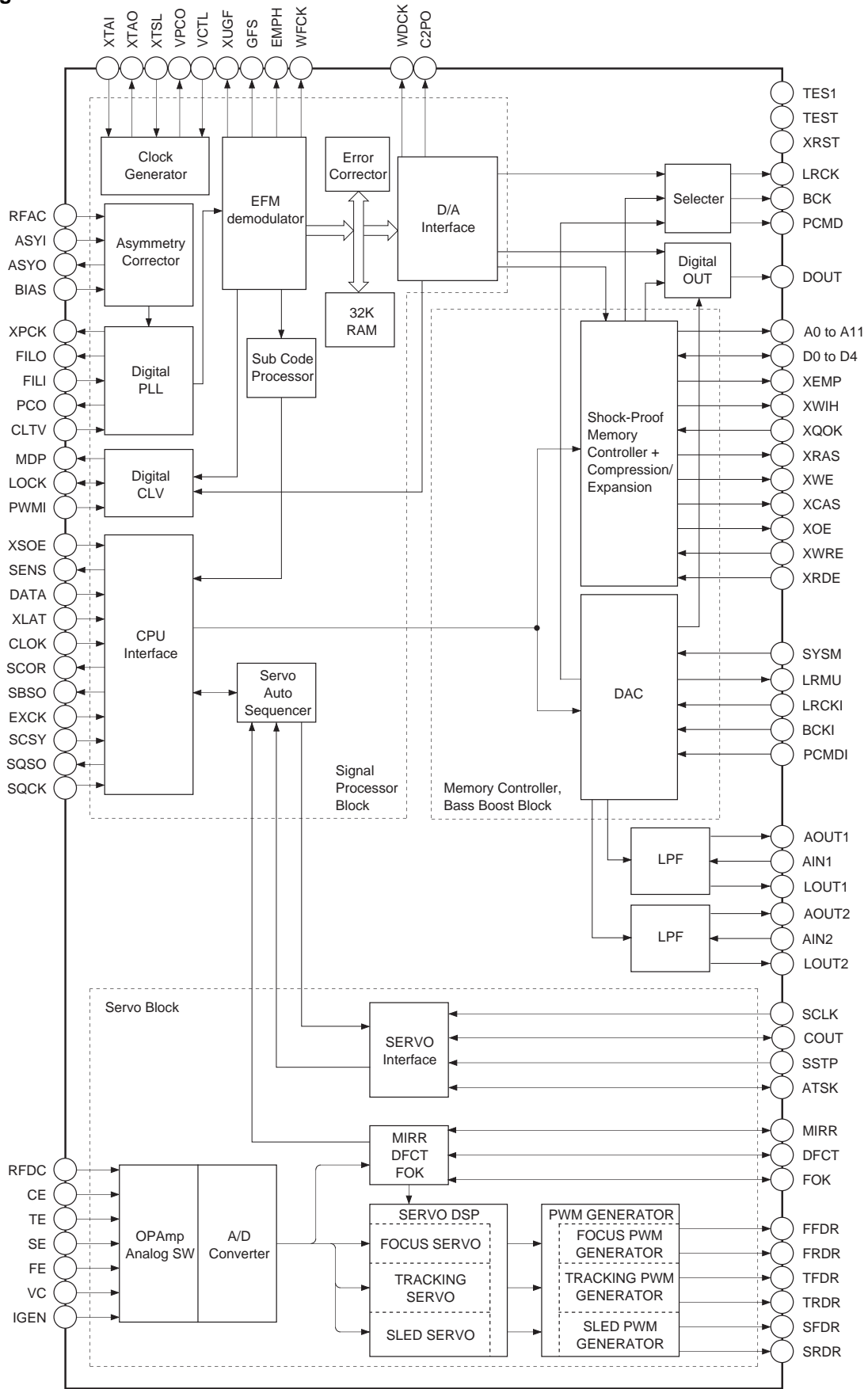
I/O Pin Capacitance

• Input capacitance	C_I	12 (max.)	pF
• Output capacitance	C_O	12 (max.)	pF

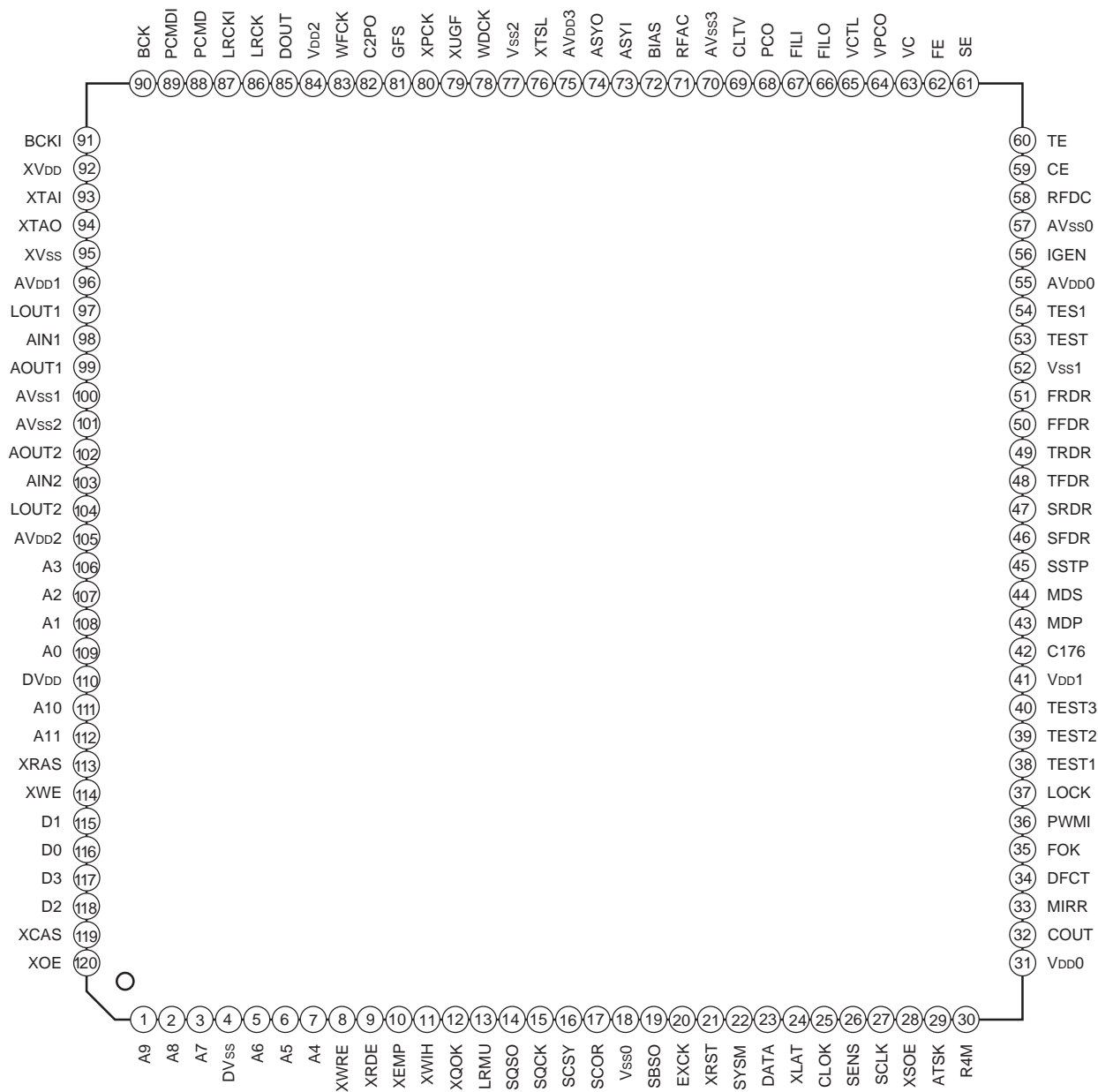
Note Measurement conditions $V_{DD} = V_I = 0V$
 $f_M = 1MHz$

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Block Diagram



Pin Configuration



Pin Description

Pin No.	Symbol	I/O		Description
1	A9	O	1, 0	4M-bit/16M-bit DRAM address bus 9.
2	A8	O	1, 0	4M-bit/16M-bit DRAM address bus 8.
3	A7	O	1, 0	4M-bit/16M-bit DRAM address bus 7.
4	DVss	—	—	DRAM interface GND
5	A6	O	1, 0	4M-bit/16M-bit DRAM address bus 6.
6	A5	O	1, 0	4M-bit/16M-bit DRAM address bus 5.
7	A4	O	1, 0	4M-bit/16M-bit DRAM address bus 4.
8	XWRE	I		DRAM write enable signal.
9	XRDE	I		DRAM readout enable signal.
10	XEMP	O	1, 0	DRAM readout prohibited signal.
11	XWIH	O	1, 0	DRAM write prohibited signal.
12	XQOK	I		Subcode-Q OK input.
13	LRMU	O	1, 0	Lch, Rch "0" detection flag (AND output)
14	SQSO	O	1, 0	Subcode-Q 80-bit, PCM peak and level data output. CD TEXT data output, DRAM data output.
15	SQCK	I		SQSO readout clock input.
16	SCSY	I		GRSCOR resynchronization input. High during track jump.
17	SCOR	O	1, 0	Outputs a high signal when either subcode sync S0 or S1 is detected.
18	Vss0	—	—	Digital GND.
19	SBSO	O	1, 0	Subcode P to W serial output.
20	EXCK	I		SBSO readout clock input.
21	XRST	I		System reset. Reset when low.
22	SYSM	I		Mute input. Muted when high.
23	DATA	I		Serial data input from CPU.
24	XLAT	I		Latch input from CPU. Serial data is latched at the falling edge.
25	CLOCK	I		Serial data transfer clock input from CPU. SQSO or SENS readout clock is input by switching with the command.
26	SENS	O	1, 0	SENS output to CPU. SQSO data is output by switching with the command.
27	SCLK	I		SENS serial data readout clock input.
28	XSOE	I		CPU serial data output enable signal.
29	ATSK	I/O	1, 0	Anti-shock I/O.
30	R4M	O		Microcomputer clock output. C4M is output by switching with the command.
31	VDD0	—	—	Digital power supply.

Pin No.	Symbol	I/O		Description
32	COUT	I/O	1, 0	Track count signal I/O.
33	MIRR	I/O	1, 0	Mirror signal I/O.
34	DFCT	I/O	1, 0	Defect signal I/O.
35	FOK	I/O	1, 0	Focus OK signal I/O.
36	PWMI	I		Spindle motor external control input.
37	LOCK	I/O	1, 0	GFS is sampled at 460Hz; when GFS is high, this pin outputs a high signal. If GFS is low eight consecutive samples, this pin outputs low. Or input when LKIN = 1.
38	TEST1	O		Test pin.
39	TEST2	O		Test pin.
40	TEST3	O		Test pin.
41	V _{DD1}	—	—	Digital power supply.
42	C176	O		176.4kHz output.
43	MDP	O	1, Z, 0	Spindle motor servo control output.
44	MDS	O		Spindle motor servo control output.
45	SSTP	I		Disc innermost track detection signal input.
46	SFDR	O	1, 0	Sled drive output.
47	SRDR	O	1, 0	Sled drive output.
48	TFDR	O	1, 0	Tracking drive output.
49	TRDR	O	1, 0	Tracking drive output.
50	FFDR	O	1, 0	Focus drive output.
51	FRDR	O	1, 0	Focus drive output.
52	V _{SS1}	—	—	Digital GND.
53	TEST	I		Test pin. Normally, GND.
54	TES1	I		Test pin. Normally, GND.
55	AV _{DD0}	—	—	Analog power supply.
56	IGEN	I		Operational amplifier constant current input.
57	AV _{SS0}	—	—	Analog GND.
58	RFDC	I		RF signal input.
59	CE	I		Center servo analog input or E input.
60	TE	I		Tracking error signal input or F input.
61	SE	I		Sled error signal input or B input.
62	FE	I		Focus error signal input or A output.
63	VC	I		Center voltage input.
64	VPCO	O	1, Z, 0	Wide-band EFM PLL charge pump output.
65	VCTL	I		Wide-band EFM PLL VCO2 control voltage input.

Pin No.	Symbol	I/O		Description
66	FILO	O	Analog	Master PLL filter output (slave = digital PLL).
67	FILI	I		Master PLL filter input.
68	PCO	O	1, Z, 0	Master PLL charge pump output.
69	CLTV	I		Multiplier VCO1 control voltage input.
70	AV _{SS3}	—	—	Analog GND.
71	RFAC	I		EFM signal input.
72	BIAS	I		Asymmetry circuit constant current input.
73	ASYI	I		Asymmetry comparator voltage input.
74	ASYO	O	1, 0	EFM full-swing output (low = V _{SS} , high = V _{DD}).
75	AV _{DD3}	—	—	Analog power supply.
76	XTSL	I		Crystal selection input. Low when the crystal is 16.9344MHz; high when the crystal is 33.8688MHz.
77	V _{SS2}	—	—	Digital GND.
78	WDCK	O	1, 0	Word clock output $f = 2F_s$. GRSCOR is output by switching with the command.
79	XUGF	O	1, 0	XUGF output. MNT0, RFCK or SOUT is output by switching with the command.
80	XPCK	O	1, 0	XPCK output. MNT1 or SOCK is output by switching with the command.
81	GFS	O	1, 0	GFS output. MNT2, XROF or XOLT is output by switching with the command.
82	C2PO	O	1, 0	C2PO output. MNT3 or GTOP is output by switching with the command.
83	WFCK	O	1, 0	WFCK output.
84	V _{DD2}	—	—	Digital power supply.
85	DOUT	O	1, 0	Digital Out output.
86	LRCK	O	1, 0	D/A interface. LR clock output $f = F_s$.
87	LRCKI	I		D/A interface. LR clock input.
88	PCMD	O	1, 0	D/A interface. Serial data output. (two's complement, MSB first)
89	PDMDI	I		D/A interface. Serial data input. (two's complement, MSB first)
90	BCK	O	1, 0	D/A interface. Bit clock output.
91	BCKI	I		D/A interface. Bit clock input.
92	XV _{DD}	—	—	Master clock power supply.
93	XTAI	I		Crystal oscillation circuit input. The master clock is externally input from this pin.
94	XTAO	O		Crystal oscillation circuit output.

Pin No.	Symbol	I/O		Description
95	XVss	—	—	Master clock GND.
96	AVDD1	—	—	Analog power supply.
97	LOUT1	O		Lch LINE output.
98	AIN1	I		Lch operational amplifier input.
99	AOUT1	O		Lch analog output.
100	AVss1	—	—	Analog GND.
101	AVss2	—	—	Analog GND.
102	AOUT2	O		Rch analog output.
103	AIN2	I		Rch operational amplifier input.
104	LOUT2	O		Rch LINE output.
105	AVDD2	—	—	Analog power supply.
106	A3	O	1, 0	4M-bit/16M-bit DRAM address bus 3.
107	A2	O	1, 0	4M-bit/16M-bit DRAM address bus 2.
108	A1	O	1, 0	4M-bit/16M-bit DRAM address bus 1.
109	A0	O	1, 0	4M-bit/16M-bit DRAM address bus 0.
110	DVDD	—	—	DRAM interface power supply.
111	A10	O	1, 0	16M DRAM address bus 10.
112	A11	O	1, 0	16M DRAM address bus 11.
113	XRAS	O	1, 0	DRAM row address strobe signal.
114	XWE	O	1, 0	DRAM data input enable signal.
115	D1	I/O	1, 0	DRAM data bus 1.
116	D0	I/O	1, 0	DRAM data bus 0.
117	D3	I/O	1, 0	DRAM data bus 3.
118	D2	I/O	1, 0	DRAM data bus 2.
119	XCAS	O	1, 0	DRAM column address strobe signal.
120	XOE	O	1, 0	DRAM data output enable signal.

- Notes)**
- PCMD is a MSB first, two's complement output.
 - GTOP is used to monitor the frame sync protection status. (High: sync protection window released.)
 - XUGF is the frame sync obtained from the EFM signal, and is negative pulse. It is the signal before sync protection.
 - XPCK is the inverse of the EFM PLL clock. The PLL is designed so that the falling edge and the EFM signal transition point coincide.
 - The GFS signal goes high when the frame sync and the insertion protection timing match.
 - RFCK is derived from the crystal accuracy, and has a cycle of 136 μ s.
 - C2PO represents the data error status.
 - XROF is generated when the 32K RAM exceeds the ± 28 F jitter margin.
 - C4M is a 4.2336MHz output that changes in CAV-W mode and variable pitch mode.
 - FSTO is the 2/3 frequency-division output of the XTAI pin.
 - SOUT is the serial data output inside the servo block.
 - SOCK is the serial data readout clock output inside the servo block.
 - XOLT is the serial data latch output inside the servo block.

Monitor Pin Output Combinations

Command bit			Output data			
SRO1	MTSL1	MTSL0				
0	0	0	XUGF	XPCK	GFS	C2PO
0	0	1	MNT0	MNT1	MNT2	MNT3
0	1	0	RFCK	XPCK	XROF	GTOP
0	1	1	C4M	FSTO	GFS	C2PO
1	0	0	SOUT	SOCK	XOLT	C2PO

Electrical Characteristics

1. DC Characteristics

(V_{DD} = AV_{DD} = 3.3 ± 0.3V, V_{SS} = AV_{SS} = 0V, Topr = -20 to +75°C)

Item			Conditions	Min.	Typ.	Max.	Unit	Applicable pins
Input voltage (1)	High level input voltage	V _{IH} (1)		0.7V _{DD}			V	*1, *2,
	Low level input voltage	V _{IL} (1)				0.2V _{DD}	V	*3, *4, *12
Input voltage (2)	High level input voltage	V _{IH} (2)	Schmitt input	0.8V _{DD}			V	*5
	Low level input voltage	V _{IL} (2)				0.2V _{DD}	V	
Input voltage (3)	Input voltage	V _{IN} (3)	Analog input	V _{SS}		V _{DD}	V	*6, *7
Output voltage (1)	High level output voltage	V _{OH} (1)	I _{OH} = -4mA	V _{DD} - 0.4		V _{DD}	V	*2, *4, *8,
	Low level output voltage	V _{OL} (1)	I _{OL} = 4mA	0		0.4	V	*9, *11, *12
Output voltage (2)	High level output voltage	V _{OH} (2)	I _{OH} = -0.28mA	V _{DD} - 0.5		V _{DD}	V	*10
	Low level output voltage	V _{OL} (2)	I _{OL} = 0.36mA	0		0.4	V	
Input leak current (1)		I _{LI} (1)	V _{IN} = 0 to V _{DD}	-10		10	μA	*3, *4, *5, *6
Input leak current (2)		I _{LI} (2)	V _{IN} = 0.25V _{DD} to 0.75V _{DD}	-40		40	μA	*7
Tri-state output leak current		I _{LO}	V _O = 0 to 3.6V	-5		5	μA	*9

Applicable pins

*1 TEST, TES1

*2 COUT, MIRR, DFCT, FOK, LOCK

*3 XQOK, SCSY, SYSM, DATA, PCMDI, XWRE, XSOE, XRDE, XTSL, SSTP

*4 ATSK, PWMI, SSTP

*5 SQCK, EXCK, XRST, CLOK, SCLK, BCKI, LRCKI, XLAT

*6 VCTL, FILI, CLTV, ASYI, IGEN, BIAS

*7 CE, TE, SE, FE, VC

*8 XEMP, XWIH, SQSO, SBSO, WFCK, XUGF, XPCK, GFS, C2PO, SCOR, WDCK, SFDR, SRDR, TFDR, TRDR, FFDR, FRDR, ASYO, DOUT, LRCK, PCMD, BCK, R4M, C176

*9 SENS, MDP, VPCO, PCO, MDS

*10 FILO

*11 A0, A11, XRAS, XWE, XCAS, XOE

*12 D0 to D3

2. AC Characteristics

(1) XTAI pin

(a) When using self-excited oscillation

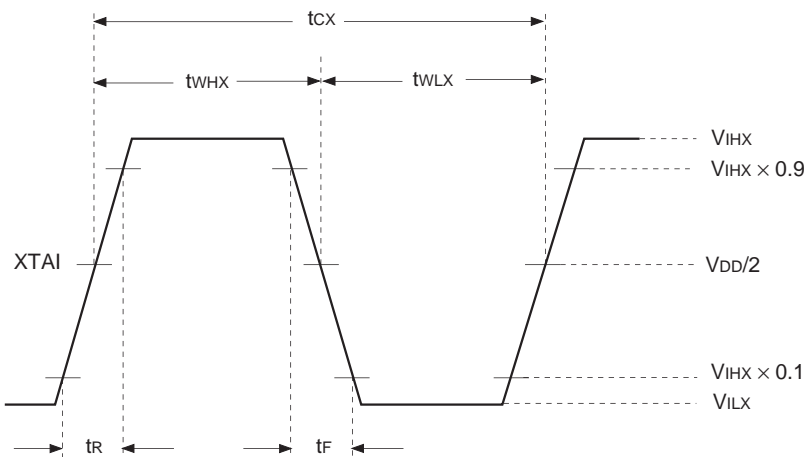
(Topr = -20 to +75°C, VDD = AVDD = 3.3 ± 0.3V)

Item	Symbol	Min.	Typ.	Max.	Unit
Oscillation frequency	f _{MAX}	7		34	MHz

(b) When inputting pulses to XTAI pin

(Topr = -20 to +75°C, VDD = AVDD = 3.3 ± 0.3V)

Item	Symbol	Min.	Typ.	Max.	Unit
High level pulse width	t _{WHX}	13		500	ns
Low level pulse width	t _{WLX}	13		500	ns
Pulse cycle	t _{CX}	26		1000	ns
Input high level	V _{IHX}	0.7V _{DD}			V
Input low level	V _{ILX}			0.2V _{DD}	V
Rise time, fall time	t _R , t _F			10	ns



(c) When inputting sine waves to XTAI pin via a capacitor

(Topr = -20 to +75°C, VDD = AVDD = 3.3 ± 0.3V)

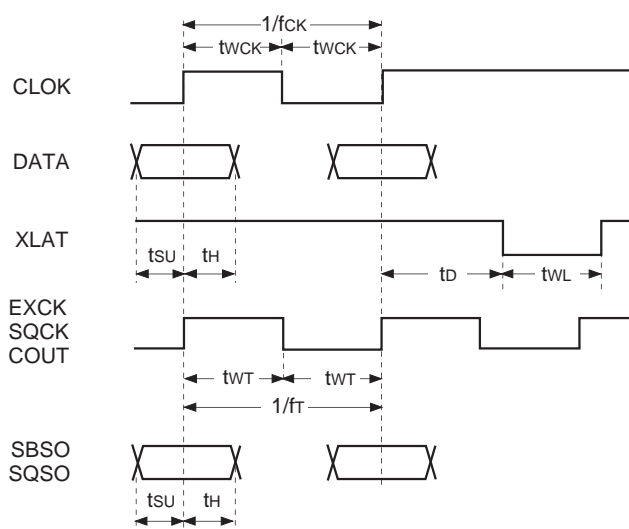
Item	Symbol	Min.	Typ.	Max.	Unit
Input amplitude	V _I	0.5V _{DD}		V _{DD} + 0.3	V _{p-p}

(2) CLOK, DATA, XLAT, SQCK and EXCK pins

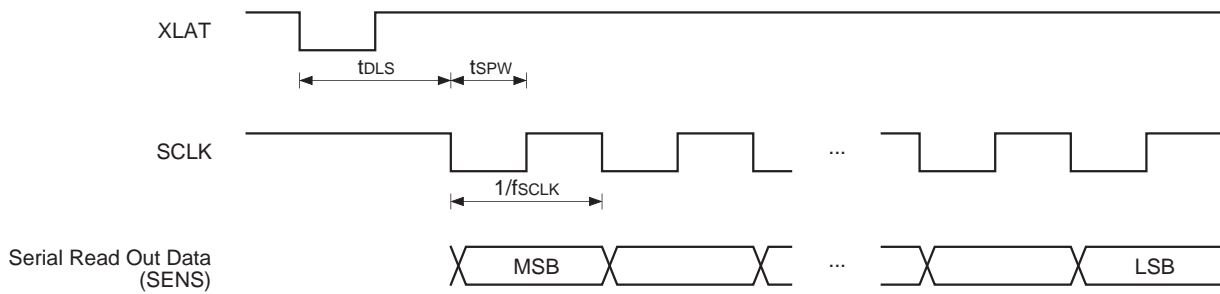
($V_{DD} = AV_{DD} = 3.3 \pm 0.3V$, $V_{SS} = AV_{SS} = 0V$, $T_{opr} = -20$ to $+75^{\circ}C$)

Item	Symbol	Min.	Typ.	Max.	Unit
Clock frequency	f _{ck}			0.65	MHz
Clock pulse width	t _{wck}	750			ns
Setup time	t _{su}	300			ns
Hold time	t _h	300			ns
Delay time	t _d	300			ns
Latch pulse width	t _{wl}	750			ns
EXCK SQCK frequency	f _τ			0.65	MHz
EXCK SQCK pulse width	t _{wτ}	750			ns
COUT frequency (during input)*	f _τ			65	kHz
COUT pulse width (during input)*	t _{wτ}	7.5			μs

* Only when \$44 and \$45 are executed.



(3) SCLK pin



Item	Symbol	Min.	Typ.	Max.	Unit
SCLK frequency	f_{SCLK}			16	MHz
SCLK pulse width	t_{SPW}	31.3			ns
Delay time	t_{DLS}	15			μ s

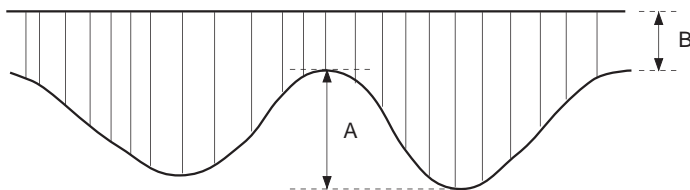
(4) COUT, MIRR and DFCT pins

Operating frequency ($V_{DD} = AV_{DD} = 3.3 \pm 0.3V$, $V_{SS} = AV_{SS} = 0V$, $T_{opr} = -20$ to $+75^{\circ}C$)

Signal	Symbol	Min.	Typ.	Max.	Unit	Conditions
COUT maximum operating frequency	f_{COUT}	40			kHz	*1
MIRR maximum operating frequency	f_{MIRR}	40			kHz	*2
DFCT maximum operating frequency	f_{DFCTH}	5			kHz	*3

*1 When using a high-speed traverse TZC.

*2



When the RF signal continuously satisfies the following conditions during the above traverse.

- $A = 0.11V_{DD}$ to $0.23V_{DD}$

- $\frac{B}{A + B} \leq 25\%$

*3 During complete RF signal omission.

When settings related to DFCT signal generation are Typ.

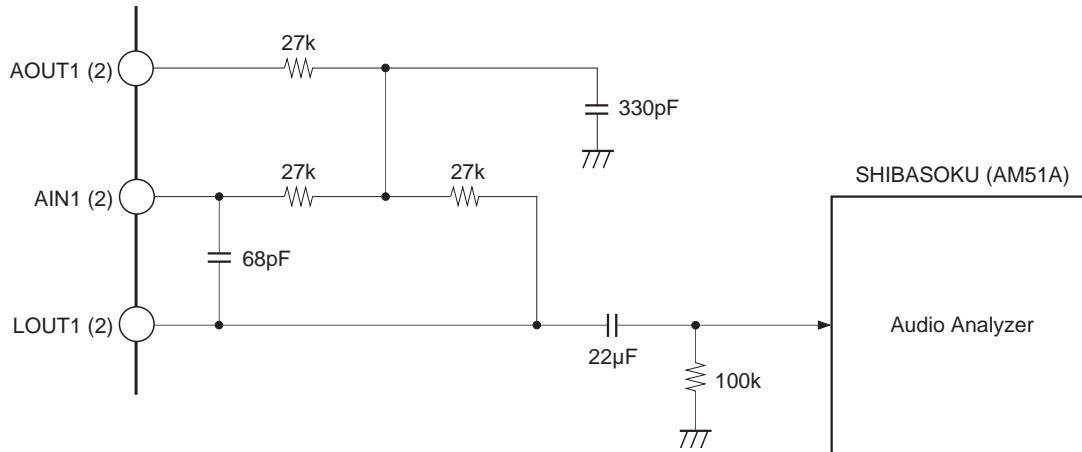
1-bit DAC and LPF Block Analog Characteristics

($V_{DD} = AV_{DD} = 3.3V$, $V_{SS} = AV_{SS} = 0V$, $T_a = 25^{\circ}C$)

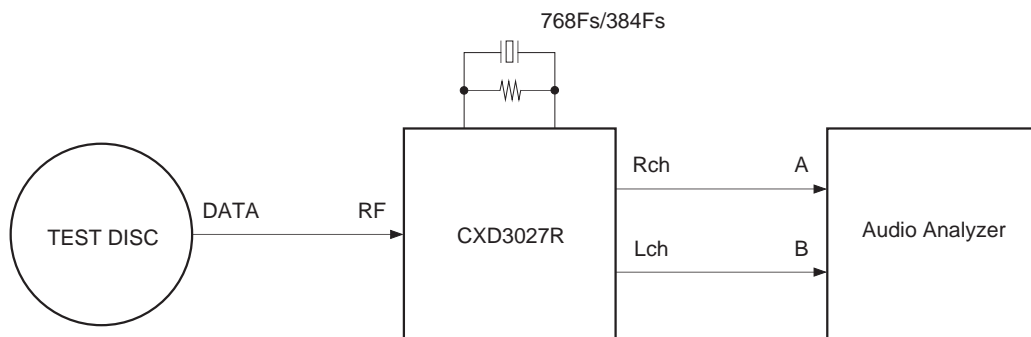
Item	Symbol	Conditions	Crystal	Min.	Typ.	Max.	Unit
Total harmonic distortion	THD	1kHz, 0dB data	384Fs		0.0120	0.0140	%
			768Fs		0.0120	0.0140	
Signal-to-noise ratio	S/N	1kHz, 0dB data, AMUT ON (Using A-weighting filter)	384Fs	96	100		dB
			768Fs	96	100		

Fs = 44.1kHz in all cases.

The total harmonic distortion and signal-to-noise ratio measurement circuits are shown below.



LPF external circuit diagram



Block diagram of analog characteristics measurement

($V_{DD} = AV_{DD} = 3.3V$, $V_{SS} = AV_{SS} = 0V$, $T_{opr} = -20$ to $+75^{\circ}C$)

Item	Symbol	Min.	Typ.	Max.	Unit	Applicable pins
Output voltage	V_{OUT}		0.64		V _{rms}	*1
Load resistance	R_L	20			kΩ	*1

* Measurement is conducted for the above circuit diagrams with the sine wave output of 1kHz and 0dB.

Applicable pins

*1 LOUT1, LOUT2

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Explanation of abbreviations	
AVRG: Average	
AGCNTL: Auto gain control	
FCS: Focus	
TRK: Tracking	
SLD: Sled	
DFCT: Defect	

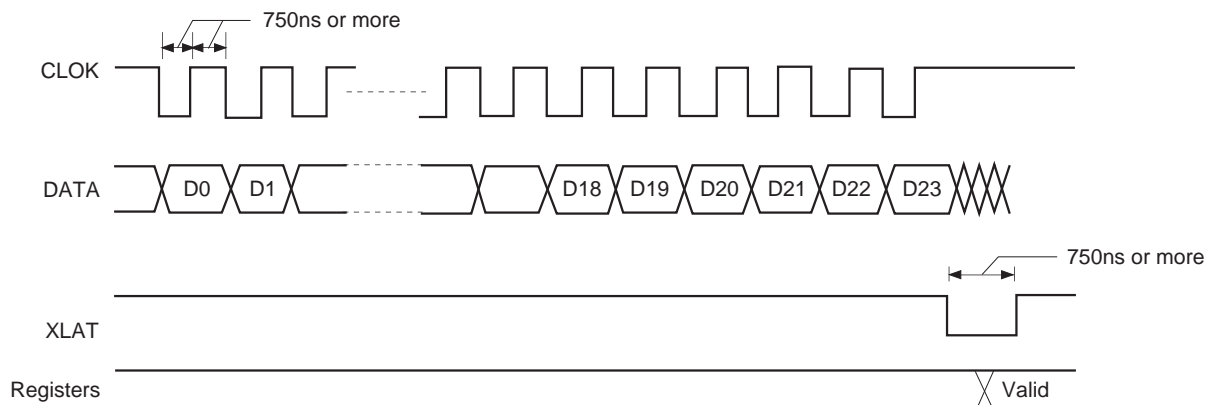
[1] CPU Interface

§1-1. CPU Interface Timing

• CPU interface

This interface uses DATA, CLOK and XLAT to set the modes.

The interface timing chart is shown below.



- The internal registers are initialized by a reset when XRST = 0.

§1-2. CPU Interface Command Table

Total bit length for each register

Register	Total bit length
0 to 2	8 bits
3	8 to 24 bits
4 to 6	16 bits
7	20 bits
8	32 bits
9	32 bits
A	28 bits
B	28 bits
C	28 bits
D	28 bits
E	20 bits

Command Table (\$2X to 3X)

Regis- ter	Command	Address		Data 1				Data 2				Data 3				Data 4				Data 5								
		D23 to D20		D19	D18	D17	D16	D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0					
2	TRACKING MODE	0 0 1 0		0	0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	TRACKING SERVO OFF			
				0	1	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	TRACKING SERVO ON	
				1	0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	FORWARD TRACK JUMP
				1	1	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	REVERSE TRACK JUMP
				—	—	0	0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	SLED SERVO OFF
				—	—	—	0	1	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	SLED SERVO ON
				—	—	—	—	1	0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	FORWARD SLED MOVE
				—	—	—	—	—	1	1	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	REVERSE SLED MOVE
3	SELECT	0 0 1 1		0	0	0	0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	SLED KICK LEVEL (±1 × basic value) (default)			
				0	0	0	1	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	SLED KICK LEVEL (±2 × basic value)	
				0	0	1	0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	SLED KICK LEVEL (±3 × basic value)
				0	0	1	1	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	SLED KICK LEVEL (±4 × basic value)
																								—: don't care				
																								—: don't care				
																								—: don't care				
																								—: don't care				

Command Table (\$340X)

Regis- ter	Command	Address 1			Address 2			Address 3			Address 4				Data 1				Data 2							
		D23 to D20	D19 to D16	D15 to D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0		
3	SELECT	0 0 1	0 1 0 0	0 0 0 0	0	0	0	0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K00) SLED INPUT GAIN	
		0 0 0			0	0	0	1	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K01) SLED LOW BOOST FILTER A-H	
		0 0 0			0	0	1	0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K02) SLED LOW BOOST FILTER A-L	
		0 0 0			0	0	1	1	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K03) SLED LOW BOOST FILTER B-H	
		0 1 0			0	1	0	0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K04) SLED LOW BOOST FILTER B-L	
		0 1 0			0	1	0	1	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K05) SLED OUTPUT GAIN	
		0 1 0			0	1	1	0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K06) FOCUS INPUT GAIN	
		0 1 1			0 0 0 0	0	1	1	1	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K07) SLED AUTO GAIN
		1 0 0	0 0 1 1	0 1 0 0	0 0 0 0	1	0	0	0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K08) FOCUS HIGH CUT FILTER A
		1 0 0				1	0	0	1	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K09) FOCUS HIGH CUT FILTER B
		1 0 0				1	0	1	0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K0A) FOCUS LOW BOOST FILTER A-H
		1 0 0				1	0	1	1	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K0B) FOCUS LOW BOOST FILTER A-L
		1 1 0				1	1	0	0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K0C) FOCUS LOW BOOST FILTER B-H
		1 1 0				1	1	0	1	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K0D) FOCUS LOW BOOST FILTER B-L
		1 1 1				1	1	1	0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K0E) FOCUS PHASE COMPENSATE FILTER A
		1 1 1				1	1	1	1	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K0F) FOCUS DEFECT HOLD GAIN

Command Table (\$343X)

Regis-ter	Command	Address 1		Address 4				Data 1				Data 2				
		D23 to D20	D19 to D16	D15 to D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	
3	SELECT	0 0 1 1	0 1 0 0	0 0 1 1	0 0 1 1	0 0 1 1	0 0 1 1	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K30) SLED INPUT GAIN (when TgUp2 is accessed with SFSK = 1)
								KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K31) ANTI SHOCK LOW PASS FILTER B
								KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K32) NOT USED
								KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K33) ANTI SHOCK HIGH PASS FILTER B-H
								KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K34) ANTI SHOCK HIGH PASS FILTER B-L
								KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K35) ANTI SHOCK FILTER COMPARETE GAIN
								KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K36) TRACKING GAIN UP2 HIGH CUT FILTER A
								KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K37) TRACKING GAIN UP2 HIGH CUT FILTER B
								KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K38) TRACKING GAIN UP2 LOW BOOST FILTER A-H
								KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K39) TRACKING GAIN UP2 LOW BOOST FILTER A-L
								KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K3A) TRACKING GAIN UP2 LOW BOOST FILTER B-H
								KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K3B) TRACKING GAIN UP2 LOW BOOST FILTER B-L
								KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K3C) TRACKING GAIN UP PHASE COMPENSATE FILTER A
								KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K3D) TRACKING GAIN UP PHASE COMPENSATE FILTER B
								KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K3E) TRACKING GAIN UP OUTPUT GAIN
								KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0	KRAM DATA (K3F) NOT USED

Command Table (\$4X to EX)

Regis- ter	Command	Address				Data 1				Data 2				Data 3				Data 4				
		D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	
4	Auto sequence	0	1	0	0	AS3	AS2	AS1	AS0	MT3	MT2	MT1	MT0	LSSL	0	0	0	0	—	—	—	—
5	Blind (A, E), Brake (B), Overflow (C, G)	0	1	0	1	TR3	TR2	TR1	TR0	0	0	0	0	0	0	0	0	0	—	—	—	—
6	Sled KICK, BRAKE (D), KICK (F)	0	1	1	0	SD3	SD2	SD1	SD0	KF3	KF2	KF1	KF0	0	0	0	0	—	—	—	—	
7	Auto sequence (N) track jump count setting	0	1	1	1	32768	16384	8192	4096	32768	16384	8192	4096	256	128	64	32	16	8	4	2	1
8	MODE specification	1	0	0	0	CD- ROM	DOUT Mute	DOUT Mute-F	WSEL	VCO SEL1	ASHS SUB	SOCT0	VCO SEL2	KSL3	KSL2	KSL1	KSL0	VCO1 CS1	VCO1 CS0	0	0	VCO2 CS
9	Function specification	1	0	0	1	1	DSPB	ASEQ	1	BitIGL MAIN	BitIGL SUB	FLFC	0	0	0	SYCOF	0	0	0	0	0	1

—: don't care

Command Table (\$4X to EX) cont.

Regis-ter	Command	Address				Data 1				Data 2				Data 3				Data 4												
		D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0									
	Audio CTRL			Mute	ATT	0	0	PCT2	SOC2	0	0	0	0	0	0	0	0	0	1	0	0									
	Signal select					0	1	RSL1	0	0	0	0	DTSL1	MCSL1	MCSL0	0	0	0	0	SDSL2	SDSL1	SDSL0								
	Bass boost					0	1	0	1	0	0	1	ZMUTA	AD9	AD8	AD7	AD6	AD5	AD4											
						0	1	0	1	0	0	1	PWDN	ZDPL	XWOC	HiCut	BST	CL	0	0	OBIT1	OBITO								
						0	1	0	1	0	0	0	BBON1	BBON0	HBON1	HBON0	BBSL1	BBSL0	HBBSL1	HBBSL0	BBST	BBST								
						0	1	0	1	0	0	0	COMP	ON	0	0	0	0	0	0	0	0	1	0						
A	Shock-proof memory setting					0	1	1	0	0	0	0	SL	SL	GTOP	NOLIM	SPSL	REFSEL	REFON	0	MSL2	MSL1	MSL0							
	Shock-proof memory control					1	0	0	0	0	0	0	XQOK	XWRE	XRDE	XSOE0	XSOE2	0	0	SDTO	OUT									
	DOUJ subcode-Q setting					1	0	0	1	0	0	0	SubQA3	SubQA2	SubQA1	SubQA0	0	0	0	0	SubQD7	SubQD6	SubQD5	SubQD4						
DRAM I/F						1	0	0	1	0	0	0	1	1	1	0	1	DRWR	DRADR	0	DRD15	DRD14	DRD13	DRD12						
						1	0	1	0	0	0	0	1	1	1	0	0	DADR19	DADR18	DADR17	DADR16	DADR15	DADR14	DADR13	DADR12					
Compression setting						1	0	1	0	0	0	0	ADPON	BITSL1	BITSL0	0	0	0	0	0	0	0	0	0	0					
	EFM playability enhancement setting					1	0	1	1	0	0	0	ARDTEN	1	1	1	1	0	0	0	0	0	0	1	0					
Sleep setting						1	1	0	0	0	0	0	AVW	0	0	0	0	0	0	0	0	0	0	0	0					
	Sync expansion specification					1	1	0	1	0	0	0	ADCPS	SLEEP	SLEEP	SLEEP	SLEEP	SLEEP	SLEEP	SLEEP	SLEEP	SLEEP	SLEEP	SLEEP	SLEEP					
Variable pitch setting						1	1	1	0	0	0	0	VARI	ON	USE	0	0	0	0	0	0	0	0	0	0					
	Spindle servo setting					1	1	1	1	0	0	0	SYG3	EA	SYG2	EA	SYG1	EA	SYG0	EA	MDP	OUTSL1	OUTSL0	MDP	LPWR2	0	MDP	UP	0	MDP

Command Table (\$4X to EX) cont.

Regis- ter	Command	Address				Data 1				Data 2				Data 3				Data 4			
		D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
B	Traverse monitor counter setting	1	0	1	1	32768	16384	8192	4096	2048	1024	512	256	128	64	32	16	8	4	2	1
C	Spindle servo coefficient setting	1	1	0	0	Gain MDP1	Gain MDPO	Gain MDS1	Gain MDS0	Gain DCLV1	Gain DCLV0	PCC1	PCC0	SFP3	SFP2	SFP1	SFP0	SRP3	SRP2	SRP1	SRP0
D	CLV CTRL	1	1	0	1	0	TB	TP	CLVS Gain	VP7	VP6	VP5	VP4	VP3	VP2	VP1	VP0	VP CTL1	VP CTL0	0	0
E	SPD mode	1	1	1	0	CM3	CM2	CM1	CM0	EPWM	SPD	ICAP	SFSL	VC2C	HIFC	LPWR	VPON	Gain CAV1	Gain CAV0	0	INV VPCCO

Command Table (\$4X to EX) cont.

Regis-ter	Command	Address	Data 1	Data 2	Data 3	Data 4	Data 5				Data 6				Data 7				
							D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3
8	MODE specification	1 0 0 0					ERC4	SCOR SEL	SCSY	SOCT1	TXON	OUTL0	OUTL1	OUTL2	0	0	0	0	
9	Function specification	1 0 0 1					0	0	0	0	0	0	0	0	DIV4	0	0	0	
A	AUDIO CTRL		0 0 * *				0	0	0	0	0	0	0	0	—	—	—	—	
	Signal select		0 1 0 0				EN XSOE	CKOUT SL2	CKOUT SL1	SLD BBIN									
	Bass boost				0 0 0 0			AD3	AD2	AD1	AD0								
					0 1 * *			0	1	0	0								
					1 0 * *			BBST Vup1	BBST Vup0	BBST Uth	BBST Lth								
	DOUT subcode-Q setting				1 1 * *			0	0	0	0	PDM INV							
					0 1 1 0			0	0	0	0	0	0	0	0	0	0	0	0
	DRAM I/F				* * * *	0 0 0 0		SubQD3	SubQD2	SubQD1	SubQD0								
					1 0 0 1	1 1 1 0		DRD11	DRD10	DRD9	DRD8	DRD7	DRD6	DRD5	DRD4	DRD3	DRD2	DRD1	DRD0
						1 1 1 1		DADR11	DADR10	DADR9	DADR8	DADR7	DADR6	DADR5	DADR4	DADR3	DADR2	DADR1	DADR0
EFM playability enhancement setting				1 0 1 1			1	0	0	0	0	0	0	0	1	0	0	0	
	Spindle servo setting			1 1 1 1			MDP CTL3	MDP CTL2	MDP CTL1	MDP CTL0									
B	Traverse monitor counter setting	1 0 1 1					0	0	MTSL1	MTSL0	ASYE	MD2	0	0					
C	Spindle servo coefficient setting	1 1 0 0					EDC7	EDC6	EDC5	EDC4	EDC3	EDC2	EDC1	EDC0	—	—	—	—	
D	CLV CTRL	1 1 0 0					0	0	0	0	0	0	0	—	—	—	—	—	

—: don't care

Command Preset Table (\$4X to EX) cont.

Regis- ter	Command	Address				Data 1				Data 2				Data 3				Data 4				
		D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	
B	Traverse monitor counter setting	1	0	1	1	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0
C	Spindle servo coefficient setting	1	1	0	0	0	0	0	0	0	0	0	0	1	1	0	0	0	0	1	0	1
D	CLV CTRL	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
E	SPD mode	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Command Preset Table (\$4X to EX) cont.

Regis- ter	Command	Address	Data 1	Data 2	Data 3	Data 4	Data 5				Data 6				Data 7													
							D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0						
8	MODE specification	1 0 0 0					0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
9	Function specification	1 0 0 1					0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
A	AUDIO CTRL		0 0 * *				0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Signal select		0 1 0 0				0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	Bass boost			0 0 0 0				0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
				0 1 * *				0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
				1 0 * *				0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
B	DOUT subcode-Q setting		0 1 1 0				0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	DRAM I/F		1 0 0 1	1 1 1 0			0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
				1 1 1 1				0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
	EFM playability enhancement setting		1 0 1 1				1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
B	Traverse monitor counter setting	1 0 1 1					0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
C	Spindle servo coefficient setting	1 1 0 0					0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	
D	CLV CTRL	1 1 0 0					0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	

— : don't care

<Coefficient ROM Preset Values Table (1)>

ADDRESS	DATA	CONTENTS
K00	E0	SLED INPUT GAIN
K01	81	SLED LOW BOOST FILTER A-H
K02	23	SLED LOW BOOST FILTER A-L
K03	7F	SLED LOW BOOST FILTER B-H
K04	6A	SLED LOW BOOST FILTER B-L
K05	10	SLED OUTPUT GAIN
K06	14	FOCUS INPUT GAIN
K07	30	SLED AUTO GAIN
K08	7F	FOCUS HIGH CUT FILTER A
K09	46	FOCUS HIGH CUT FILTER B
K0A	81	FOCUS LOW BOOST FILTER A-H
K0B	1C	FOCUS LOW BOOST FILTER A-L
K0C	7F	FOCUS LOW BOOST FILTER B-H
K0D	58	FOCUS LOW BOOST FILTER B-L
K0E	82	FOCUS PHASE COMPENSATE FILTER A
K0F	7F	FOCUS DEFECT HOLD GAIN
K10	4E	FOCUS PHASE COMPENSATE FILTER B
K11	32	FOCUS OUTPUT GAIN
K12	20	ANTI SHOCK INPUT GAIN
K13	30	FOCUS AUTO GAIN
K14	80	HPTZC / Auto Gain HIGH PASS FILTER A
K15	77	HPTZC / Auto Gain HIGH PASS FILTER B
K16	80	ANTI SHOCK HIGH PASS FILTER A
K17	77	HPTZC / Auto Gain LOW PASS FILTER B
K18	00	Fix*
K19	F1	TRACKING INPUT GAIN
K1A	7F	TRACKING HIGH CUT FILTER A
K1B	3B	TRACKING HIGH CUT FILTER B
K1C	81	TRACKING LOW BOOST FILTER A-H
K1D	44	TRACKING LOW BOOST FILTER A-L
K1E	7F	TRACKING LOW BOOST FILTER B-H
K1F	5E	TRACKING LOW BOOST FILTER B-L
K20	82	TRACKING PHASE COMPENSATE FILTER A
K21	44	TRACKING PHASE COMPENSATE FILTER B
K22	18	TRACKING OUTPUT GAIN
K23	30	TRACKING AUTO GAIN
K24	7F	FOCUS GAIN DOWN HIGH CUT FILTER A
K25	46	FOCUS GAIN DOWN HIGH CUT FILTER B
K26	81	FOCUS GAIN DOWN LOW BOOST FILTER A-H
K27	3A	FOCUS GAIN DOWN LOW BOOST FILTER A-L
K28	7F	FOCUS GAIN DOWN LOW BOOST FILTER B-H
K29	66	FOCUS GAIN DOWN LOW BOOST FILTER B-L
K2A	82	FOCUS GAIN DOWN PHASE COMPENSATE FILTER A
K2B	44	FOCUS GAIN DOWN DEFECT HOLD GAIN
K2C	4E	FOCUS GAIN DOWN PHASE COMPENSATE FILTER B
K2D	1B	FOCUS GAIN DOWN OUTPUT GAIN
K2E	00	NOT USED
K2F	00	NOT USED

* Fix indicates that normal preset values should be used.

<Coefficient ROM Preset Values Table (2)>

ADDRESS	DATA	CONTENTS
K30	80	SLED INPUT GAIN (Only when TRK gain up2 is accessed with SFSK = 1.)
K31	66	ANTI SHOCK LOW PASS FILTER B
K32	00	NOT USED
K33	7F	ANTI SHOCK HIGH PASS FILTER B-H
K34	6E	ANTI SHOCK HIGH PASS FILTER B-L
K35	20	ANTI SHOCK FILTER COMPARATE GAIN
K36	7F	TRACKING GAIN UP2 HIGH CUT FILTER A
K37	3B	TRACKING GAIN UP2 HIGH CUT FILTER B
K38	80	TRACKING GAIN UP2 LOW BOOST FILTER A-H
K39	44	TRACKING GAIN UP2 LOW BOOST FILTER A-L
K3A	7F	TRACKING GAIN UP2 LOW BOOST FILTER B-H
K3B	77	TRACKING GAIN UP2 LOW BOOST FILTER B-L
K3C	86	TRACKING GAIN UP PHASE COMPENSATE FILTER A
K3D	0D	TRACKING GAIN UP PHASE COMPENSATE FILTER B
K3E	57	TRACKING GAIN UP OUTPUT GAIN
K3F	00	NOT USED
K40	04	TRACKING HOLD FILTER INPUT GAIN
K41	7F	TRACKING HOLD FILTER A-H
K42	7F	TRACKING HOLD FILTER A-L
K43	79	TRACKING HOLD FILTER B-H
K44	17	TRACKING HOLD FILTER B-L
K45	6D	TRACKING HOLD FILTER OUTPUT GAIN
K46	00	TRACKING HOLD FILTER INPUT GAIN (Only when TRK gain up2 is accessed with THSK = 1.)
K47	00	NOT USED
K48	02	FOCUS HOLD FILTER INPUT GAIN
K49	7F	FOCUS HOLD FILTER A-H
K4A	7F	FOCUS HOLD FILTER A-L
K4B	79	FOCUS HOLD FILTER B-H
K4C	17	FOCUS HOLD FILTER B-L
K4D	54	FOCUS HOLD FILTER OUTPUT GAIN
K4E	00	NOT USED
K4F	00	NOT USED

§1-4. Description of SENS Signals

SENS output

Microcomputer serial register (latching not required)	ASEQ = 0	ASEQ = 1	Output data length
\$0X	Z	FZC	—
\$1X	Z	AS	—
\$2X	Z	TZC	—
\$30 to 37	Z	SSTP	—
\$38	Z	AGOK*	—
\$38	Z	XAVEBSY*	—
\$3904	Z	TE Avrg Reg.	9 bits
\$3908	Z	FE Avrg Reg.	9 bits
\$390C	Z	VC Avrg Reg.	9 bits
\$391C	Z	TRVSC Reg.	9 bits
\$391D	Z	FB Reg.	9 bits
\$391F	Z	RFDC Avrg Reg.	8 bits
\$3A	Z	FBIAS Count STOP	—
\$3B to 3F	Z	SSTP	—
\$4X	Z	XBUSY	—
\$5X	Z	FOK	—
\$6X	Z	0	—
\$A0 to \$A8 \$AA to \$AF	GFS	GFS	—
\$BX	COMP	COMP	—
\$CX	COUT	COUT	—
\$EX	$\overline{\text{OV64}}$	$\overline{\text{OV64}}$	—
\$7X, 8X, 9X, DX, FX	Z	0	—

* \$38 outputs AGOK during AGT and AGF command settings, and XAVEBSY during AVRGM measurement. SSTP is output in all other cases.

Description of SENS Signals

SENS output	
Z	The SENS pin is high impedance.
XBUSY	Low while the auto sequencer is in operation, high when operation terminates.
FOK	Outputs the same signal as the FOK pin. High for "focus OK".
GFS	High when the regenerated frame sync is obtained with the correct timing.
COMP	Counts the number of tracks set with Reg.B. High when Reg.B is latched, low when COUT is counted for the initial Reg.B number.
COUT	Counts the number of tracks set with Reg.B. High when Reg.B is latched, toggles each time COUT is counted for the Reg.B number. While \$44 and \$45 are being executed, toggles with each COUT 8-count instead of the Reg.B number.
$\overline{\text{OV64}}$	Low when the EFM signal is lengthened by 64 channel clock pulses or more after passing through the sync detection filter.

§1-5. Description of Commands

The meaning of the data for each address on the XLAT pin side is explained below.

\$4X commands

Register name	Data 1				Data 2				Data 3			
4	Command				MAX timer value				Timer range			
	AS3	AS2	AS1	AS0	MT3	MT2	MT1	MT0	LSSL	0	0	0

Command	AS3	AS2	AS1	AS0
Cancel	0	0	0	0
Fine Search	0	1	0	RXF
Focus-On	0	1	1	1
1 Track Jump	1	0	0	RXF
10 Track Jump	1	0	1	RXF
2N Track Jump	1	1	0	RXF
M Track Move	1	1	1	RXF

RXF = 0 Forward

RXF = 1 Reverse

- When the Focus-on command (\$47) is canceled, \$02 is sent and the auto sequence is interrupted.
- When the Track jump commands (\$44, \$45 and \$48 to \$4D) are canceled, \$25 is sent and the auto sequence is interrupted.

MAX timer value				Timer range			
MT3	MT2	MT1	MT0	LSSL	0	0	0
23.2ms	11.6ms	5.8ms	2.9ms	0	0	0	0
1.49s	0.74s	0.37s	0.18s	1	0	0	0

- To disable the MAX timer, set the MAX timer value to 0.

\$5X commands

Timer	TR3	TR2	TR1	TR0
Blind (A, E), Overflow (C, G)	0.18ms	0.09ms	0.045ms	0.022ms
Brake (B)	0.36ms	0.18ms	0.09ms	0.045ms

\$6X commands

Register name	Data 1				Data 2			
6	KICK (D)				KICK (F)			
	SD3	SD2	SD1	SD0	KF3	KF2	KF1	KF0

Timer	SD3	SD2	SD1	SD0
When executing KICK (D) \$44 or \$45	23.2ms	11.6ms	5.8ms	2.9ms
When executing KICK (D) \$4C or \$4D	11.6ms	5.8ms	2.9ms	1.45ms

Timer	KF3	KF2	KF1	KF0
KICK (F)	0.72ms	0.36ms	0.18ms	0.09ms

\$7X commands

Auto sequence track jump count setting

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
Auto sequence track jump count setting	2 ¹⁵	2 ¹⁴	2 ¹³	2 ¹²	2 ¹¹	2 ¹⁰	2 ⁹	2 ⁸	2 ⁷	2 ⁶	2 ⁵	2 ⁴	2 ³	2 ²	2 ¹	2 ⁰

This command is used to set N when a 2N-track jump is executed, to set M when an M-track move is executed and to set the jump count when fine search is executed for auto sequencer.

- The maximum track count is 65,535, but note that with a 2N-track jump the maximum track jump count depends on the mechanical limitations of the optical system.
- When the track jump count is from 0 to 15, the COUT signal is counted for 2N-track jumps and M-track moves; when the count is 16 or over, the MIRR signal is counted. For fine search, the COUT signal is counted.

\$8X commands

Command	Data 1				Data 2			
	D3	D2	D1	D0	D3	D2	D1	D0
MODE specification	CD-ROM	DOUT Mute	DOUT Mute-F	WSEL	VCO SEL1	ASHS	SOCT0	VCO SEL2

Command bit	C2PO timing	Processing
CDROM = 1	1-3	CDROM mode; average value interpolation and pre-value hold are not performed.
CDROM = 0	1-3	Audio mode; average value interpolation and pre-value hold are performed.

Command bit	Processing
DOUT Mute = 1	When Digital Out is on (MD2 pin = 1), DOUT output is muted.
DOUT Mute = 0	When Digital Out is on, DOUT output is not muted.

Command bit	Processing
DOUT Mute F = 1	When Digital Out is on (MD2 pin = 1), DA output is muted.
DOUT Mute F = 0	DA output mute is not affected when Digital Out is either on or off.

MD2	Other mute conditions*	DOUT Mute	DOUT Mute F	DOUT output	DA output for 48-bit slot
0	0	0	0	OFF	0dB
0	0	0	1		
0	0	1	0		
0	0	1	1		
0	1	0	0		-∞dB
0	1	0	1		
0	1	1	0		
0	1	1	1		
1	0	0	0	0dB	0dB
1	0	0	1		-∞dB
1	0	1	0	-∞dB	0dB
1	0	1	1		
1	1	0	0		
1	1	0	1		
1	1	1	0		
1	1	1	1		

* See "Mute conditions" (1), (2) and (4) to (6) under \$AX commands for other mute conditions.

* When DTSL1 = 1, the Digital Out from the bass boost or shock-proof is selected. See the description of Digital Out.

Command bit	Sync protection window width	Application
WSEL = 1	±26 channel clock	Anti-rolling is enhanced.
WSEL = 0	±6 channel clock	Sync window protection is enhanced.

* In normal-speed playback, channel clock = 4.3218MHz.

Command bit	Function
ASHS = 0	The command transfer rate from the auto sequencer to the DSSP block is set to normal speed.
ASHS = 1	The command transfer rate from the auto sequencer to the DSSP block is set to half speed.

* See "§4-8. CD-DSP Block Playback Speed" for settings.

Command bit		Processing
SOCT0	SOCT1	
0	—	Subcode-Q is output from the SQSO pin.
1	0	Various signals are output from the SQSO pin. Input the readout clock to SQCK. (See Timing Chart 2-4.)
1	1	The error rate is output from the SQSO pin. Input the readout clock to SQCK. (See Timing Chart 2-6.)

* \$8X command TXOUT = 0 and \$A8X command SDTOOUT = 0 must be set.

—: don't care

Command	Data 2				Data 3			
	D3	D2	D1	D0	D3	D2	D1	D0
MODE specification	VCO SEL1	ASHS	SOCT0	VCO SEL2	KSL3	KSL2	KSL1	KSL0

See above.

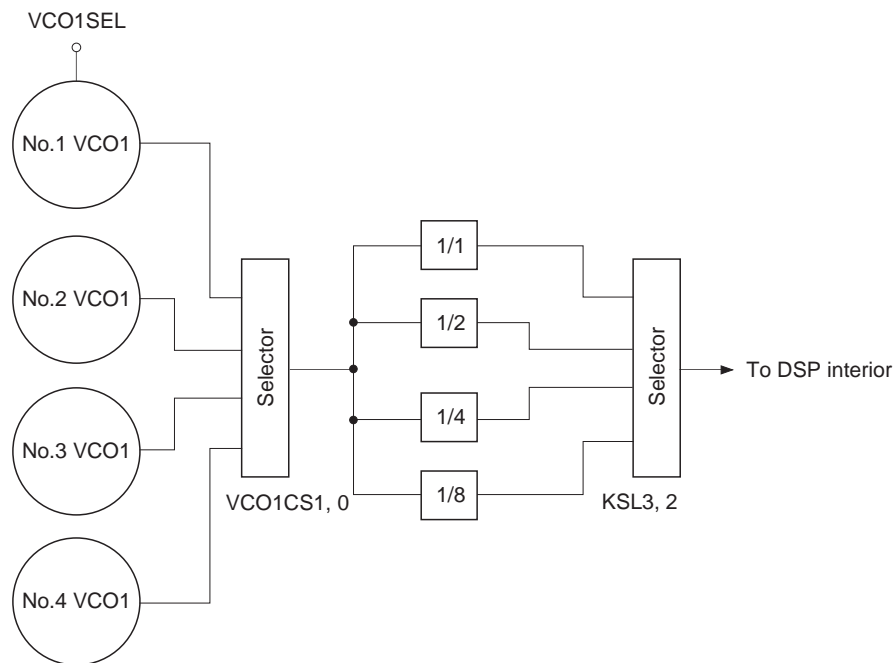
Command bit	Processing
VCOSSEL1 = 0	Multiplier PLL VCO1 is set to normal speed.
VCOSSEL1 = 1	Multiplier PLL VCO1 is set to approximately twice the normal speed.

Command bit		Processing
KSL3	KSL2	
0	0	Output of multiplier PLL VCO1 selected by VCO CS0 is 1/1 frequency-divided.
0	1	Output of multiplier PLL VCO1 selected by VCO CS0 is 1/2 frequency-divided.
1	0	Output of multiplier PLL VCO1 selected by VCO CS0 is 1/4 frequency-divided.
1	1	Output of multiplier PLL VCO1 selected by VCO CS0 is 1/8 frequency-divided.

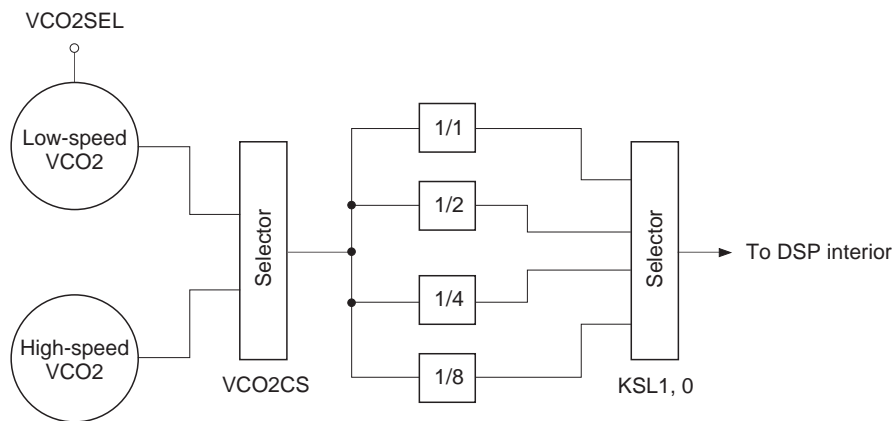
Command bit	Processing
VCOSEL2 = 0	Wide-band PLL VCO2 is set to normal speed.
VCOSEL2 = 1	Wide-band PLL VCO2 is set to approximately twice the normal speed.

Command bit		Processing
KSL1	KSL0	
0	0	Output of wide-band PLL VCO2 is 1/1 frequency-divided.
0	1	Output of wide-band PLL VCO2 is 1/2 frequency-divided.
1	0	Output of wide-band PLL VCO2 is 1/4 frequency-divided.
1	1	Output of wide-band PLL VCO2 is 1/8 frequency-divided.

* Block Diagram of VCO Internal Path



VCO1 internal path



VCO2 internal path

\$8X commands cont.

Command	Data 4				Data 5				Data 6			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
MODE specification	VCO1 CS1	VCO1 CS0	0	VCO2 CS	ERC4	SCOR SEL	SCSY	SOCT1	TXON	TXOUT	OUTL1	OUTL0

See page 43.

Command bit		Processing
VCO1CS1	VCO1CS0	
0	0	Selects the No. 1 VCO1.
0	1	Selects the No. 2 VCO1.
1	0	Selects the No. 3 VCO1.
1	1	Selects the No. 4 VCO1.

* The CXD3027R has four multiplier PLL VCO1s, and this command selects one of these VCO1s. The four VCOs are No. 4, No. 3, No. 2 and No. 1 in order of the maximum frequency.

Command bit	Processing
VCO2 CS = 0	Selects the low-speed wide-band PLL VCO2.
VCO2 CS = 1	Selects the high-speed wide-band PLL VCO2.

* The CXD3027R has two wide-band PLL VCO2s, and this command selects one of these VCO2s.

* The block diagrams for VCO1 and VCO2 including VCOSEL1, VCOSEL2, KSL0 to KSL3, VCO1CS0, VCO1CS1, and VCO2CS are shown on the previous page.

Command bit	Processing
ERC4 = 0	C2 error double correction is performed when DSPB = 1.
ERC4 = 1	C2 error quadruple correction is performed even when DSPB = 1.

Command bit	Processing
SCOR SEL = 0	WDCK signal is output.
SCOR SEL = 1	GRSCOR (protected SCOR) is output.

* Used when outputting GRSCOR from the WDCK pin.

Command bit	Processing
SCSY = 0	No processing.
SCSY = 1	GRSCOR (protected SCOR) synchronization is applied again.

* Used to resynchronize GRSCOR.

The rising edge signal of this command bit is used internally, so when resynchronizing GRSCOR, first return the setting to 0 and then set to 1.

GRSCOR is the crystal accuracy SCOR signal obtained by removing the motor wow component.

This signal is synchronized with PCMDATA.

The resynchronization conditions are when GTOP = high or when the GRSRST pin = high.

(Same as when SCSY = 1 is sent by the \$8X command.)

Command bit	Processing
TXON = 0	When CD TEXT data is not demodulated, set TXON to 0.
TXON = 1	When CD TEXT data is demodulated, set TXON to 1.

* See "§4-15. CD TEXT Data Demodulation".

Command bit	Processing
TXOUT = 0	Various signals except for CD TEXT are output from the SQSO pin.
TXOUT = 1	CD TEXT data is output from the SQSO pin.

* See "§4-15. CD TEXT Data Demodulation".

Command bit	Processing
OUTL1 = 0	C4M and WDCK are output.
OUTL1 = 1	C4M and WDCK outputs are set low.

Command bit	Processing
OUTL0 = 0	XPCK, PCMD, BCK, LRCK and EMPH are output.
OUTL0 = 1	XPCK, PCMD, BCK, LRCK and EMPH outputs are set low.

Command	Data 7			
	D3	D2	D1	D0
MODE specification	0	0	OUTL2	0

Command bit	Processing
OUTL2 = 0	WFCK is output.
OUTL2 = 1	WFCK is set low.

\$9X commands

Command	Data 1				Data 2			
	D3	D2	D1	D0	D3	D2	D1	D0
Function specification	1	DSPB ON-OFF	A.SEQ ON-OFF	1	BiliGL MAIN	BiliGL SUB	FLFC	0

Command bit	Processing
DSPB = 0	Normal-speed playback, C2 error quadruple correction.
DSPB = 1	Double-speed playback, C2 error double correction. (quadruple correction when ERC4 = 1)

Normally FLFC = 0.

In CAV-W mode, set FLFC to 1 independently of the playback speed.

Command bit	BiliGL MAIN = 0	BiliGL MAIN = 1
BiliGL SUB = 0	STEREO	MAIN
BiliGL SUB = 1	SUB	Mute

Definition of bilingual capable MAIN, SUB and STEREO

The left channel input is output to the left and right channels for MAIN.

The right channel input is output to the left and right channels for SUB.

The left and right channel inputs are output to the left and right channels, respectively, for STEREO.

Command	Data 3				Data 4				Data 5			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
Function specification	0	0	0	0	1	0	0	1	0	0	0	0

Command	Data 6				Data 7			
	D3	D2	D1	D0	D3	D2	D1	D0
Function specification	0	0	0	0	DIV4	0	0	0

This switches the digital PLL master clock.

Either the conventional mode or the 2/3 mode (2/3 of the conventional clock) can be selected.

Command bit	Processing
DIV4 = 0	Digital PLL master clock; conventional mode. (preset)
DIV4 = 1	Digital PLL master clock; 2/3 mode.

Note) Do not set DIV4 to 1 when DSPB = 0.

\$AX commands

Command	Data 1				Data 2			
	D3	D2	D1	D0	D3	D2	D1	D0
Audio CTRL	0	0	Mute	ATT	PCT1	PCT2	0	SOC2

Command bit	Meaning
Mute = 0	Mute off if other mute conditions are not set.
Mute = 1	Mute on. Peak register reset.

Command bit	Meaning
ATT = 0	Attenuation off.
ATT = 1	-12dB

Mute conditions

- (1) When register A mute = 1.
 - (2) When register 8 DOUT Mute F = 1 and Digital Out is on (\$B command MD2 = 1).
 - (3) When GFS stays low for over 35ms (during normal-speed).
 - (4) When register 9 BiliGL MAIN = Sub = 1.
 - (5) When register A PCT1 = 1 and PCT2 = 0.
- (1) to (3) perform zero-cross muting with a 1ms time limit.

Command bit		Meaning	PCM Gain	ECC error correction ability
PCT1	PCT2			
0	0	Normal mode	× 0dB	C1: double; C2: quadruple
0	1	Level meter mode	× 0dB	C1: double; C2: quadruple
1	0	Peak meter mode	Mute	C1: double; C2: double
1	1	Normal mode	× 0dB	C1: double; C2: double

Description of level meter mode (see Timing Chart 1-4.)

- When the LSI is set to this mode, it performs digital level meter functions.
- When the 96-bit clock is input to SQCK, 96 bits of data are output to SQSO.
The initial 80 bits are subcode-Q data (see "[2] Subcode Interface"). The last 16 bits are LSB first, which are 15-bit PCM data (absolute values) and an L/R flag.
The final bit (L/R flag) is high when the 15-bit PCM data is from the left channel and low when the data is from the right channel.
- The PCM data is reset and the L/R flag is inverted after one readout.
Then the measurement for the maximum value continues until the next readout.

Description of peak meter mode (see Timing Chart 1-5.)

- When the LSI is set to this mode, the maximum PCM data value is detected regardless of if it comes from the left or right channel.
The 96-bit clock must be input to SQCK to read out this data.
- When the 96-bit clock is input, 96 bits of data are output to SQSO and the value is set in the LSI internal register again.
In other words, the PCM maximum value register is not reset by the readout.
- To reset the PCM maximum value register to 0, set PCT1 = PCT2 = 0 or set the \$AX command Mute.
- The subcode-Q absolute time is automatically controlled in this mode.
In other words, after the maximum value is generated, the absolute time for CRC to become OK is retained in the memory. Normal operation is conducted for the relative time.
- The final bit (L/R flag) of the 96-bit data is normally 0.
- The pre-value hold and average value interpolation data are fixed to level ($-\infty$) for this mode.

Command bit	Processing
SOC2 = 0	The SENS signal is output from the SENS pin as usual.
SOC2 = 1	The SQSO pin signal is output from the SENS pin.

SENS output switching

- This command is used to output the SQSO pin signal from the SENS pin.
When SOC2 = 0, SENS output is performed as usual.
When SOC2 = 1, the SQSO pin signal is output from the SENS pin.
At this time, the readout clock is input to the SCLK pin.

Note) Perform the SOC2 switching when SQCK = SCLK = high.

Command	Data 3				Data 4				Data 5				Data 6			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
Audio CTRL	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0

\$A4 commands (preset: \$A4C800)

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
A4 (Signal select)	0	1	0	0	RSL1	RSL0	0	0	DTSL1	DTSL0	MCSL1	MCSL0	0	SDSL 2	SDSL 1	SDSL 0

Data 5				Data 6				Data 7			
D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
EN XSOE	CKOUT SL2	CKOUT SL1	SLD BBIN								

RSL1, 0: These bits set the external buffer RAM.

RSL1	RSL0	Processing
0	0	The external buffer RAM is set to 4M bits.
* 1	1	The external buffer RAM is set to 16M bits.

*: preset

DTSL1, DTSL0: See the second half of the description of \$A4 commands.

MCSL1: This bit sets the DAC block master clock.

When 0, the DAC block master clock is set to 16.9344MHz (384fs). (default)

When 1, the DAC block master clock is set to 33.8688MHz (768fs).

MCSL0: This bit sets the shock-proof memory controller block master clock.

When 0, the shock-proof memory controller block master clock is set to 16.9344MHz (384fs). (default)

When 1, the shock-proof memory controller block master clock is set to 33.8688MHz (768fs).

ENXSOE: This bit switches the command input method.

When 0, the command transfer clock and the SENS serial data readout clock are input from the respective pins. (default)

When 1, the command transfer clock and the SENS serial data readout clock are input from the CLOK pin.

The clock input is switched with the XSOE pin. At this time, connect the SCLK pin to high.

ENXSOE	XSOE pin	CLOK pin	SCLK pin
0	L	Command transfer clock input	SENS serial data readout clock input
0	H	Command transfer clock input	SENS serial data readout clock input
1	L	SENS serial data readout clock input	Connect to high.
1	H	Command transfer clock input	Connect to high.

In addition, when ENXSOE is set to 1 and the SQSO pin signal output is read from the SENS pin, the command input method is as follows.

At this time, connect the SCLK and SQCK pins to high.

See the command descriptions for \$A command SOC2 and \$8 commands TXOUT, SOCT0 and SOCT1.

ENXS OE	XSOE pin	\$A SOC2	\$A8 SDT0 OUT	\$8 TXOUT	\$8 SOCT0	\$8 SOCT1	CLOK pin	SENS pin
1	H	*	*	*	*	*	Command transfer clock input	High or low output
1	L	0	*	*	*	*	SENS serial data readout clock input	SENS output*1
1	L	1	0	0	0	*	Subcode-Q readout clock input	Subcode-Q output
1	L	1	0	0	1	0	Various signal readout clock input	Various signal output*2
1	L	1	0	0	1	1	Error rate readout clock input	Error rate output*3
1	L	1	0	1	*	*	CD TEXT data readout clock input	CD TEXT data output
1	L	1	1	*	*	*	Readout clock input of shock-proof memory controller serial data	Shock-proof memory controller serial data output

*: don't care

*1 See "§1-4. Description of SENS Signals" for the SENS output.

*2 The output signals are PER7 to PER0, FOK, GFS, LOCK, EMPH, ALOCK and VF9 to VF0.
For details, see Timing Chart 2-4.

*3 For the error rate timing, see Timing Chart 2-6.

CKOUTSL2, CKOUTSL1:

These bits select the clock output from the R4M pin.

When the crystal is 16.9344 MHz and XTSL = high, the output frequency is halved.

CKOUTSL2	CKOUTSL1	Processing
0	0	4.2336MHz output
0	1	8.4672MHz output
1	0	4.2336MHz output
1	1	Changes in CAV-W mode and variable pitch mode.

*: preset

DTSL1, DTSL0: These bits select the data output from the DOUT pin.

In external mode, the data input through the LRCKI, BCKI and PCMDI pins is used.

DOUT output in the following tables is valid when \$34A commands DOUT EN and DOUT EN2 are both 1. In this case, see "\$34A commands".

When \$34A commands DOUT EN and DOUT EN2 are both 0, see "§4-5-2. Digital Out from DA Interface Input".

At this time, the data from the CD DSP is output from the DOUT pin with a subcode is added.

SDSL2, SDSL1: These bits select the data input to the DAC block and the data output from the PCMD pin.

SLDBBIN: This bit selects the data input to the DAC block and the data output from the PCMD and DOUT pins.

When SLDBBIN = 0, the internally connected data is selected. (default)

DTSL1	DTSL0	SDSL2	SDSL1	SDSL0	Input to DAC block	DOUT output	PCMD output	
0	0	0	0	0	DSP mode	DSP & DAC mode	DSP mode	
0	0	0	1	*1			DSP & DAC mode	
0	0	1	0	0	Shock-proof memory controller mode	Shock-proof memory controller & DAC mode	Shock-proof memory controller mode	
0	0	1	1	*1			Shock-proof memory controller & DAC mode	
0	1	0	0	0	DSP mode	DSP mode	DSP mode	
0	1	0	1	*1			DSP & DAC mode	
0	1	1	0	0	Shock-proof memory controller mode	Shock-proof memory controller mode	Shock-proof memory controller mode	
0	1	1	1	*1			Shock-proof memory controller & DAC mode	
*	1	0	0	0	DSP mode	DSP mode	DSP mode	
	1	0	0	1			*1	DSP & DAC mode
	1	0	1	0	0		Shock-proof memory controller mode	Shock-proof memory controller mode
	1	0	1	1	*1			Shock-proof memory controller & DAC mode
	1	1	0	0	0		DSP mode	DSP mode
	1	1	0	1	*1			DSP & DAC mode
	1	1	1	0	0		Shock-proof memory controller mode	Shock-proof memory controller mode
	1	1	1	1	*1			Shock-proof memory controller & DAC mode

*: preset

*1: The relationship between LRCK, BCK and PCMD changes according to the setting value.

When SDSL0 = 0, the LRCK, BCK and PCMD phase difference is constant but the LRCK frequency changes when SDSL0 is switched.

When SDSL0 = 1, the LRCK frequency is constant but the phase difference between LRCK, BCK and PCMD changes before and after SDSL1 is switched. When not switching the output data selection, set SDSL1 and SDSL0 to the same value.

When SLDBBIN = 1, the data input from the LRCKI, BCKI and PCMDI pins is selected.

DTSL1	DTSL0	SDSL2	SDSL1	SDSL0	Input to DAC block	DOUT output	PCMD output
0	0	0	0	0	External mode	External & DAC mode	DSP mode
0	0	0	1	*1			External & DAC mode
0	0	1	0	0			Shock-proof memory controller mode
0	0	1	1	*1			External & DAC mode
0	1	0	0	0		DSP mode	DSP mode
0	1	0	1	*1		External & DAC mode	
0	1	1	0	0		Shock-proof memory controller mode	Shock-proof memory controller mode
0	1	1	1	*1		External & DAC mode	
1	0	0	0	0		DSP mode	DSP mode
1	0	0	1	*1			External & DAC mode
1	0	1	0	0			Shock-proof memory controller mode
1	0	1	1	*1			External & DAC mode
1	1	0	0	0		External mode	DSP mode
1	1	0	1	*1			External & DAC mode
1	1	1	0	0			Shock-proof memory controller mode
1	1	1	1	*1			External & DAC mode

*1: The relationship between LRCK, BCK and PCMD changes according to the setting value.

When SDSL0 = 0, the LRCK, BCK and PCMD phase difference is constant but the LRCK frequency changes when SDSL0 is switched.

When SDSL0 = 1, the LRCK frequency is constant but the phase difference between LRCK, BCK and PCMD changes before and after SDSL1 is switched. When not switching the output data selection, set SDSL1 and SDSL0 to the same value.

\$A5 commands (when Data 2 D3 = 0, D2 = 0) (preset: \$A50400)

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
A5 (Bass boost)	0	1	0	1	0	0	1	ZMUTA	SMUT	AD10	AD9	AD8	AD7	AD6	AD5	AD4

Data 5			
D3	D2	D1	D0
AD3	AD2	AD1	AD0

- ZMUTA:** This bit sets the zero detection analog mute on/off.
 When 0, zero detection analog mute is on. (default)
 When 1, zero detection analog mute is off.
 When zero data is detected for both the left and right channels, the LPF block output is set to center output.
- SMUT:** This bit sets the soft mute on/off.
 When 0, soft mute is off. (default)
 When 1, soft mute is on.
- AD10 to AD0:** These bits set the attenuation data. The attenuation data consists of 11 bits, and is set as follows.

Attenuation data	Audio output
7FF (hex)	+6.02dB
7FE (hex)	+6.016dB
:	:
402 (hex)	+0.017dB
401 (hex)	+0.0085dB
* 400 (hex)	0dB
3FF (hex)	-0.0085dB
3FE (hex)	-0.017dB
:	:
001 (hex)	-60.206dB
000 (hex)	-∞

*: preset

The audio output from 001 (h) to 7FF (h) is obtained using the following equation:

$$\text{Audio data output} = 20 \log \frac{20 \log \text{Attenuation data}}{1024} \text{ [dB]}$$

\$A5 commands (when Data 2 D3 = 0, D2 = 1) (preset: \$A540A4)

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
A5 (Bass boost)	0	1	0	1	0	1	PWDN	ZDPL	WOC	DAC EMPH	HiCut FILTER	BST CL	1	0	OBIT1	OBIT0

Data 5			
D3	D2	D1	D0
0	1	0	0

- PWDN:** This bit sets the DAC block operation mode.
 When 0, the DAC block clock is stopped. This makes it possible to reduce power consumption. (default)
 When 1, the DAC block operates normally.
- ZDPL:** This bit sets the zero detection flag polarity.
 When 0, the LRMU pin is set low during mute. (default)
 When 1, the LRMU pin is set high during mute.
- WOC:** When WOC = 1, the DAC sync window opens. This is used to synchronize the DAC.
- DAC EMPH:** This bit sets the digital de-emphasis on/off.
 When 0, digital de-emphasis is off. (default)
 When 1, digital de-emphasis is on.
- HiCutFILTER:** This bit sets the high-cut filter on/off.
 When 0, the high-cut filter is off. (default)
 When 1, the high-cut filter is on.
- BSTCL:** This bit sets the bass boost level clear on/off.
 1: On; the set bass boost level is cleared to 0dB.
 0: Off; normal operation (default)
- OBIT1, OBIT0:** These bits set the word length of the serial data output from the PCMD pin.
 The serial data word length can be selected only when the data output from the PCMD pin is set to DAC output.

OBIT1	OBIT0	Serial data word length
0	0	20bit
0	1	18bit
1	0	16bit

*

*: preset

\$A5 commands (when Data 2 D3 = 1, D2 = 0) (preset: \$A58000)

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
A5 (Bass boost)	0	1	0	1	1	0	BBON1	BBON0	HBON1	HBON0	BBSL1	BBSL0	HBSL1	HBSL0	BBST Vdwn1	BBST Vdwn0

Data 5			
D3	D2	D1	D0
BBST Vup1	BBST Vup0	BBST Uth	BBST Lth

BBON1, BBON0: These bits set the bass boost on/off and the turnover frequency.

	BBON1	BBON0	Processing
*	0	0	Bass boost is off.
	0	1	Bass boost is on and the turnover frequency is set to 125Hz.
	1	0	Bass boost is on and the turnover frequency is set to 160Hz.
	1	1	Bass boost is on and the turnover frequency is set to 200Hz.

*: preset

HBON1, HBON0: These bits set the high boost on/off and the turnover frequency.

	HBON1	HBON0	Processing
*	0	0	High boost is off.
	1	0	High boost is on and the turnover frequency is set to 5kHz.
	1	1	High boost is on and the turnover frequency is set to 7kHz.

*: preset

BBSL1, BBSL0: These bits set the boost level for bass boost.

	BBSL1	BBSL0	Processing
*	0	0	The boost level for bass boost is set to 10dB.
	0	1	The boost level for bass boost is set to 14dB.
	1	0	The boost level for bass boost is set to 18dB.
	1	1	The boost level for bass boost is set to 22dB.

*: preset

HBSL1, HBSL0: These bits set the boost level for high boost.

	HBSL1	HBSL0	Processing
*	0	0	The boost level for high boost is set to 4dB.
	0	1	The boost level for high boost is set to 6dB.
	1	0	The boost level for high boost is set to 8dB.
	1	1	The boost level for high boost is set to 10dB.

*: preset

BBST Vdwn1, BBST Vdwn0: These bits set the boost attack time (Vol Down) for bass and high boost.

	BBST Vdwn1	BBST Vdwn0	Processing
*	0	0	The boost attack time for bass and high boost is set to standard.
	0	1	The boost attack time for bass and high boost is set to fast.
	1	1	The boost attack time for bass and high boost is set to slow.

*: preset

BBST Vup1, BBST Vup0: These bits set the boost release time (Vol Up) for bass and high boost.

	BBST Vup1	BBST Vup0	Processing
*	0	0	The boost release time for bass and high boost is set to standard.
	0	1	The boost release time for bass and high boost is set to fast.
	1	1	The boost release time for bass and high boost is set to slow.

*: preset

BBST Uth: This bit sets the bass and high boost Uth.
 When 0, Uth is set to -1.9dB. (default)
 When 1, Uth is set to -0.9dB.

BBST Lth: This bit sets the bass and high boost Lth.
 When 0, Lth is set to -12dB. (default)
 When 1, Lth is set to -4.4dB.

* When the volume rises above Uth, the boost level is reduced. The speed at which the boost level is reduced is the attack time.

When the volume falls below Lth, the boost level is increased up to the setting value. The speed at which the boost level is increased is the release time.

\$A5 commands (when Data 2 D3 = 1, D2 = 1) (preset: \$A5C000)

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
A5 (Bass boost)	0	1	0	1	1	1	COMP ON	0	0	0	0	0	0	0	1	0

Data 5			
D3	D2	D1	D0
0	0	0	PDM INV

COMP ON: This bit sets the compressor on/off.
 When 0, the compressor is off. (default)
 When 1, the compressor is on.

PDM INV: This bit sets the DAC block PDM signal polarity. (The HP circuit polarity is also set at the same time.)
 When 0, the polarity is set to non-inverted. (default)
 When 1, the polarity is set to inverted.

\$A7 commands (preset: \$A7200)

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
A7 (Shock-proof memory setting)	0	1	1	1	SL XQOK	SL XWRE	GTOP CHECK	NOLIM WDCK	SPSL COM	READ2	REF SEL	REF ON	0	MSL2	MSL1	MSL0

- SL XQOK: This bit sets the XQOK control mode.
When 0, XQOK should be controlled for the period from when SCOR goes high until GRSCOR goes high. (default)
When 1, XQOK should be controlled for the period while GRSCOR is high.
- SL XWRE: This bit sets the XWRE control mode.
When 0, XWRE should be controlled for the period from when SCOR goes high until GRSCOR goes high. (default)
When 1, XWRE should be controlled for the period while GRSCOR is high.
- GTOP CHECK: This bit controls GRSCOR generation when GTOP is high.
When 0, the GRSCOR generation circuit is not resynchronized even when GTOP is high.
When 1, the GRSCOR generation circuit is resynchronized when GTOP goes high. (default)
- NOLIM WDCK: Always set to 1.
- SPSL COM: This bit sets whether to control XQOK, XWRE and XRDE with pins or serial data.
When 0, XQOK, XWRE and XRDE should be controlled with pins. (default)
When 1, XQOK, XWRE and XRDE should be controlled with serial data (\$A8).
- READ2: This bit sets the audio data readout speed from the shock-proof memory controller block.
When 0, Data is read out at normal speed. (default)
When 1, Data is read out at double speed.
- REF SEL: This bit sets the DRAM refresh rate.
When 0, refresh is performed 2048 times/46.44ms. (default)
When 1, refresh is performed 2048 times/23.22ms.
- REF ON: This bit sets the DRAM refresh function on/off.
When 0, the refresh function is off. (default)
When 1, the refresh function is on.
- MSL2 to MSL0: These bits set the DRAM area that can be accessed from the microcomputer.

	MSL2	MSL1	MSL0	DRAM area that can be accessed from the microcomputer
*	0	0	0	The entire DRAM area can be used as audio data.
	0	0	1	32K bits
	0	1	0	64K bits
	0	1	1	128K bits
	1	0	0	256K bits
	1	0	1	512K bits
	1	1	0	1M bits
	1	1	1	2M bits

*: preset

\$A8 commands (preset: \$A8F8)

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
A8 (Shock-proof memory control)	1	0	0	0	XQOK	XWRE	XRDE	XSOEO	XSOEO 2	0	0	SDTO OUT				

XQOK, XWRE, XRDE:

When \$A7 command SPSL COM = 1, XQOK, XWRE and XRDE are controlled with serial data.

XSOEO:

This bit controls the serial data from the shock-proof block.

Shock-proof block data is loaded to the serial readout register by detecting the falling edge of XSOEO.

XSOEO2:

This bit is used when the microcomputer reads data from the DRAM.

The shock-proof memory controller block loads the data from the DRAM to the serial readout register by detecting the fall of XSOEO2.

SDTO OUT:

This bit is used to output serial data from the shock-proof block to the SQSO pin.

When 0, various signals are output from the SQSO pin. For details on these signals, see \$8X commands SOCT1, SOCT0 and TXOUT. (default)

When 1, the shock-proof block serial data is output from the SQSO pin.

\$A9 commands (preset: \$A90000)

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
A9 (DOUT subcode-Q setting)	1	0	0	1	SubQA3	SubQA2	SubQA1	SubQA0	0	0	0	0	SubQD7	SubQD6	SubQD5	SubQD4

Data 5				Data 6				Data 7			
D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
SubQD3	SubQD2	SubQD1	SubQD0								

SubQA3 to SubQA0, SubQD7 to SubQD0:

These bits set the Ubit inside the DOUT generation circuit in the DAC block. Note that these bits have no effect on the DOUT generation circuit in the CD DSP block.

SubQA3	SubQA2	SubQA1	SubQA0	SubQD7	SubQD6	SubQD5	SubQD4	SubQD3	SubQD2	SubQD1	SubQD0	Setting contents
0	0	0	0	Q1	Q2	Q3	Q4	Q5	Q6	Q7	Q8	Control, address
0	0	0	1	Q9	Q10	Q11	Q12	Q13	Q14	Q15	Q16	Movement number
0	0	1	0	Q17	Q18	Q19	Q20	Q21	Q22	Q23	Q24	INDEX number
0	0	1	1	Q25	Q26	Q27	Q28	Q29	Q30	Q31	Q32	Elapsed time within a movement (minutes)
0	1	0	0	Q33	Q34	Q35	Q36	Q37	Q38	Q39	Q40	Elapsed time within a movement (seconds)
0	1	0	1	Q41	Q42	Q43	Q44	Q45	Q46	Q47	Q48	Elapsed time within a movement (frames)
0	1	1	0	Q49	Q50	Q51	Q52	Q53	Q54	Q55	Q56	(Set to 0.)
0	1	1	1	Q57	Q58	Q59	Q60	Q61	Q62	Q63	Q64	Absolute time (minutes)
1	0	0	0	Q65	Q66	Q67	Q68	Q69	Q70	Q71	Q72	Absolute time (seconds)
1	0	0	1	Q73	Q74	Q75	Q76	Q77	Q78	Q79	Q80	Absolute time (frames)
1	0	1	0	DON	DCL	DUP1	DUP0	DLD	0	0	0	(Control command)

- DON:** This bit sets the Ubit output on/off inside the DOUT generation circuit in the DAC block.
When 0, Ubit is not output. (default)
When 1, Ubit is output.
- DCL:** This bit clears the elapsed time within a movement to 0.
The elapsed time is cleared to 0 at the falling edge of DCL (DCL = 1 → 0). (default: DCL = 1)
- DUP1:** This bit sets the absolute time counter operate/stop.
When 0, the absolute time counter is stopped. (default)
When 1, the absolute time counter operates.
- DUP0:** This bit sets the elapsed time within a movement counter operate/stop.
When 0, the elapsed time within a movement counter is stopped. (default)
When 1, the elapsed time within a movement counter operates.
- DLD:** This bit is used when setting the INDEX number, elapsed time within a movement, and absolute time.
When 0, the settings cannot be changed. (default)
When 1, the settings can be changed. Note that 0 is output for the INDEX number, elapsed time within a movement, and absolute time while DLD = 1.
The control, address and movement number settings can be changed regardless of the DLD setting.

\$A9 commands (preset: \$A9E00000)

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
A9E (DRAM I/F)	1	0	0	1	1	1	1	0	1	DRWR	DRADR	0	DRD15	DRD14	DRD13	DRD12

Data 5				Data 6				Data 7			
D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
DRD11	DRD10	DRD9	DRD8	DRD7	DRD6	DRD5	DRD4	DRD3	DRD2	DRD1	DRD0

DRWR: This bit sets write/read for access from the microcomputer to the DRAM.

When 0, the read from DRAM mode is set. (default)

When 1, the write to DRAM mode is set.

DRADR: This bit sets the address control method for access from the microcomputer to the DRAM.

When 0, relative address control is set. (default)

When 1, absolute address control is set.

DRD15 to DRD0: These bits set the data to be written to the DRAM for access from the microcomputer to the DRAM.

\$A9 commands (preset: \$A9F00000)

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
A9F (DRAM I/F)	1	0	0	1	1	1	1	1	DADR19	DADR18	DADR17	DADR16	DADR15	DADR14	DADR13	DADR12

Data 5				Data 6				Data 7			
D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
DADR11	DADR10	DADR9	DADR8	DADR7	DADR6	DADR5	DADR4	DADR3	DADR2	DADR1	DADR0

DADR19 to DADR0:

These bits set the DRAM address for access from the microcomputer to the DRAM.

\$AA commands (preset: \$AA004)

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
AA (Compression setting)	1	0	1	0	ADPON	BITSL1	BITSL0	0	0	0	0	0	0	GRSEL	0	0

ADPON: This bit sets audio data compressed/uncompressed.
 When 0, the audio data uses uncompressed mode. (default)
 When 1, the audio mode is compressed mode.

BITSL1, BITSL0: These bits set the audio data compression mode.

	BITSL1	BITSL0	Compression mode
*	0	0	4 bits
	0	1	6 bits
	1	0	8 bits

*: preset

GRSEL: This bit selects the GRSCOR signal output. Note that GRSCOR is output from the WDCK pin when \$8 command SCOR SEL = 1.
 When 0, the GRSCOR signal generated by the CD DSP block is output.
 When 1, the GRSCOR signal is output at the timing used inside the shock-proof memory controller block. (default)

\$AB commands (preset: \$AB000000)

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
AB (EFM playability enhancement setting)	1	0	1	1	ARDTEN	1	1	1	1	0	1	0	0	0	1	0

Data 5				Data 6				Data 7			
D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
1	0	0	0	0	0	0	0	1	0	0	0

ARDTEN: This is the EFM playability enhancement setting.
 When 0, the EFM playability enhancement function is off.
 When 1, the EFM playability enhancement function is on.
 * Set this command in the condition when a disc is not being played back.

\$AC commands (preset: \$AC0C0)

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
AC (Sync expansion specification)	1	1	0	0	AVW	0	SFP5	SFP4	SFP3	SFP2	SFP1	SFP0	0	0	0	0

- AVW: This bit sets the sync protection window width automatic expansion function.
 When 0, the sync protection window width automatic expansion function is off.
 When 1, the sync protection window width automatic expansion function is on.
 This setting is not affected by the sync forward protection times setting SFP5 to 0.
 * The sync protection window width (± 6 channel clocks when WSEL = 0, ± 26 channel clocks when WSEL = 1) is widened 32 channel clocks at a time each time a sync mark is inserted during the interval from the 16th forward protection until GFS goes high. When the maximum window width is reached (when the window width exceeds 588 channel clocks), GTOP goes high.
- SFP5 to SFP0: These bits set the frame sync forward protection times. The setting range is from 1 to 3F (h).
 For details on frame sync protection, see "§4-2. Frame Sync Protection".
 * Part of this command bit register is also used by \$C SFP3 to SFP0. Of \$AC SFP3 to SFP0 or \$C SFP3 to SFP0, the command bit setting made last is valid. When using an existing status, set the value with \$C SFP5 to SFP0. When using the \$AC commands, set \$AC SFP3 to SFP0 to the value set by \$C SFP3 to SFP0.

\$AD commands (preset: \$AD00)

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
AD (Sleep setting)	1	1	0	1	ADCPS	DSP SLEEP	DSSP SLEEP	ASYM SLEEP	ESP SLEEP	LPF SLEEP	DSUB SLEEP	0				

- ADCPS:** This bit sets the operating mode of the DSSP block A/D converter.
When 0, the operating mode of the DSSP block A/D converter is set to normal. (default)
When 1, the operating mode of the DSSP block A/D converter is set to power saving.
- DSP SLEEP:** This bit sets the operating mode of the DSP block.
When 0, the DSP block operates normally. (default)
When 1, the DSP block clock is stopped. This makes it possible to reduce power consumption.
- DSSP SLEEP:** This bit sets the operating mode of the DSSP block.
When 0, the DSSP block operates normally. (default)
When 1, the DSSP block clock is stopped. In addition, the A/D converter and operational amplifier in the DSSP block are set to standby mode. This makes it possible to reduce power consumption.
- ASYM SLEEP:** This bit sets the operating mode of the asymmetry correction circuit and VCO1/VCO2.
When 0, the asymmetry correction circuit and VCO1/VCO2 operate normally. (default)
When 1, the operational amplifier in the asymmetry correction circuit is set to standby mode. In addition, the multiplier PLL VCO1 and wide-band PLL VCO2 oscillation are stopped. This makes it possible to reduce power consumption.
- ESP SLEEP:** This bit sets the operating mode of the shock-proof memory controller block.
When 0, the shock-proof memory controller block operates normally. (default)
When 1, the shock-proof memory controller block clock is stopped. This makes it possible to reduce power consumption.
- LPF SLEEP:** This bit sets the operating mode of the analog low-pass filter block.
When 0, the analog low-pass filter block operates normally.
When 1, the analog low-pass filter block is set to standby mode. (default) This makes it possible to reduce power consumption.
- DSUB SLEEP:** This bit sets the operating mode of the Ubit generation block inside the DOUT generation circuit in the DAC block. This setting has no effect on the DOUT generation circuit in the CD DSP block.
When 0, the Ubit generation block operates normally. (default)
When 1, The clock for the Ubit generation block inside the DOUT generation circuit in the DAC block is stopped. This makes it possible to reduce power consumption. Also, in this case Ubit is set to 0.

* The DAC block clock can be stopped by setting \$A5 command PWDN (when Data 2 D3 = 0, D2 = 1).

\$AE commands (preset: \$AE0)

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
AE (Variable pitch setting)	1	1	1	0	VARI ON	VARI USE	0	0								

Command bit	Processing
VARION = 0	Variable pitch mode is off. (The internal clock uses the crystal reference.)
VARION = 1	Variable pitch mode is on. (The internal clock uses the VCO2 reference.)

Command bit	Processing
VARIUSE = 0	Set VARIUSE = 0 when not using variable pitch mode.
VARIUSE = 1	Set VARIUSE = 1 when using variable pitch mode.

* See "\$DX commands" for the variable pitch range and example of use.

\$AF commands (preset: \$AF8000)

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
AF (Spindle servo setting)	1	1	1	1	SYG3EA	SYG2EA	SYG1EA	SYG0EA	MDP OUTSL1	MDP OUTSL0	LPWR2	0	MDS CTL	MDP UP	0	MDP CTL4

Data 5			
D3	D2	D1	D0
MDP CTL3	MDP CTL2	MDP CTL1	MDP CTL0

SYG3EA to SYG0EA:

These bits set the spindle drive output gain. However, this is valid only in CLV-N mode.

SYG3EA	SYG2EA	SYG1EA	SYG0EA	GAIN
0	0	0	0	0 (−∞dB)
0	0	0	1	0.125 (−18.1dB)
0	0	1	0	0.250 (−12.0dB)
0	0	1	1	0.375 (−8.5dB)
0	1	0	0	0.500 (−6.0dB)
0	1	0	1	0.625 (−4.1dB)
0	1	1	0	0.750 (−2.5dB)
0	1	1	1	0.875 (−1.2dB)
* 1	0	0	0	1.000 (0.0dB)
1	0	0	1	1.125 (+1.0dB)
1	0	1	0	1.250 (+1.9dB)
1	0	1	1	1.375 (+2.8dB)
1	1	0	0	1.500 (+3.5dB)
1	1	0	1	1.625 (+4.2dB)
1	1	1	0	1.750 (+4.9dB)
1	1	1	1	1.875 (+5.5dB)

*: preset

MDP OUTSL1, MDP OUTSL0:

These bits set the spindle drive output method.

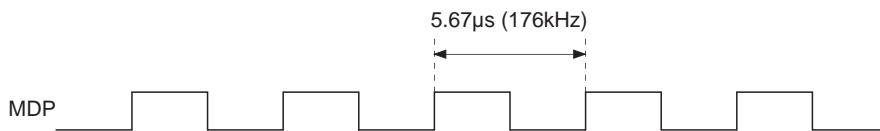
MDP OUTSL1	MDP OUTSL0	Spindle drive output
* 0	0	Ternary output from the MDP pin
1	0	Binary output from the MDS and MDP pins
0	1	Command-based MDP and MDS output control

*: preset

- LPWR2: The low output (brake pulse) of the MDP pin can be masked.
When 0, binary output is high or low output, and ternary output is high, low or high impedance output. (default)
When 1, high or high impedance is output. This makes it possible to mask the brake pulse.
- MDS CTL: This bit sets the PWM output polarity according to the setting from the microcomputer. (valid when MDPOUTSL1 = 0 and MDPOUTSL0 = 1)
When 0, the MDS pin output is set low.
When 1, the MDS pin output is set high.
- MDP UP: This bit switches the MDP pin according to the setting from the microcomputer. (valid when MDPOUTSL1 = 0 and MDPOUTSL0 = 1)
When 0, the MDP pin output is set to PWM output.
When 1, the MDP pin output is set high.
- MDP CTL4 to MDP CTL0: These bits set the PWM output value according to the setting from the microcomputer. (valid when MDPOUTSL1 = 0 and MDPOUTSL0 = 1)
The carrier frequency is 176.4kHz. (88.2kHz when set to quasi-double speed)
At the minimum value (MDP CTL4 to MDP CTL0 = 0), the MDP pin output is set low.
At the maximum value (MDP CTL4 to MDP CTL0 = 1F (h)), the MDP pin output is set high for 31/32 intervals.
Note that when \$AF command MDP UP = 1, the MDP pin output is set high regardless of the MDP CTL4 to MDP CTL0 setting value.

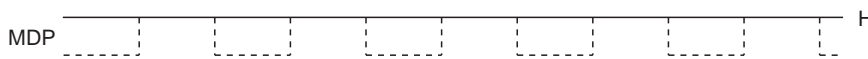
Command-based MDP and MDS output control (MDPOUTSL1 = 0, MDPOUTSL0 = 1)

(1) Timing Chart 1 LPWR2 = 0, MDPUP = 0, MDPCTL4 to 0 = 10 (hex)



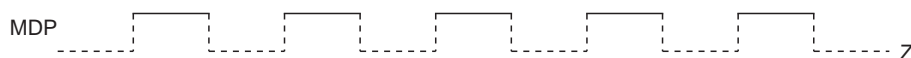
The MDP waveform ratio is set by MDP CTL4 to MDP CTL0.
When MDP CTL4 to MDP CTL0 = 10 (h), 10 (h)/20 (h) intervals are high.

(2) Timing Chart 2 LPWR2 = 0, MDPUP = 1, MDPCTL4 to 0 = 10 (hex)



When MDPUP = 1, MDP is fixed high regardless of MDP CTL4 to MDP CTL0.

(3) Timing Chart 3 LPWR2 = 1, MDPUP = 0, MDPCTL4 to 0 = 10 (hex)



When LPWR2 = 1, the low output of MDP binary output becomes high impedance.

\$BX commands

This command sets the traverse monitor count.

Command	Data 1				Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
Traverse monitor count setting	2 ¹⁵	2 ¹⁴	2 ¹³	2 ¹²	2 ¹¹	2 ¹⁰	2 ⁹	2 ⁸	2 ⁷	2 ⁶	2 ⁵	2 ⁴	2 ³	2 ²	2 ¹	2 ⁰

- When the set number of tracks are counted during fine search, the sled control for the traverse cycle control goes off.
- The traverse monitor count is set to monitor the traverse status using the SENS outputs COMP and COUT.

The monitor output is set as follows.

Command	Data 5				Data 6			
	D3	D2	D1	D0	D3	D2	D1	D0
Traverse monitor count setting	0	0	MTSL1	MTSL0	ASYE	MD2	0	0

Command bit		Output data			
MTSL1	MTSL0				
0	0	XUGF	XPCK	GFS	C2PO
0	1	MINT0	MNT1	MNT2	MNT3
1	0	RFCK	XPCK	XROF	GTOP
1	1	C4M	FSTO	GFS	C2PO

* However, the \$39 command SRO1 must be set to 0.

Command bit	Processing
ASYE = 1	Asymmetry is on.
ASYE = 0	Asymmetry is off.

Command bit	Processing
MD2 = 0	Digital Out on/off control. Off when 0.
MD2 = 1	Digital Out on/off control. On when 1.

\$CX commands

Command	Data 1				Data 2			
	D3	D2	D1	D0	D3	D2	D1	D0
Spindle servo coefficient setting	Gain MDP1	Gain MDP0	Gain MDS1	Gain MDS0	Gain DCLV1	Gain DCLV0	PCC1	PCC0
CLV CTRL (\$DX)				Gain CLVS				

- CLVS mode gain setting: GCLVS

Gain MDS1	Gain MDS0	Gain CLVS	GCLVS
0	0	0	-12dB
0	0	1	-6dB
0	1	0	-6dB
0	1	1	0dB
1	0	0	0dB
1	0	1	+6dB

- CLVP mode gain setting: GMDP: GMDS

Gain MDP1	Gain MDP0	GMDP
0	0	-6dB
0	1	0dB
1	0	+6dB

Gain MDS1	Gain MDS0	GMDS
0	0	-6dB
0	1	0dB
1	0	+6dB

- DCLV overall gain setting: GDCLV

Gain DCLV1	Gain DCLV0	GDCLV
0	0	0dB
0	1	+6dB
1	0	+12dB

Command bit		Processing
PCC1	PCC0	
0	0	The VPCO signal is output.
0	1	The VPCO pin output is high impedance.
1	0	The VPCO pin output is low.
1	1	The VPCO pin output is high.

- This command controls the VPCO pin signal.

The VPCO output can be controlled with this setting.

Command	Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0
Spindle servo coefficient setting	SFP3	SFP2	SFP1	SFP0	SRP3	SRP2	SRP1	SRP0

Command bit	Processing
SFP3 to 0	Sets the number of frame sync forward protection times. The setting range is from 1 to F (h).

Command bit	Processing
SRP3 to 0	Sets the number of frame sync backward protection times. The setting range is from 1 to F (h).

* See "§4-2. Frame Sync Protection" regarding frame sync protection.

- The CXD3027R can serially output the 40 bits (10 BCD codes) of error rate data selected by EDC7 to EDC0 from the SQSO pin and monitor this data using a microcomputer.
In order to output error rate data, set \$C commands for C1 and C2 individually, and set \$8 commands SOCT0 and SOCT1 to 1. Then, the data can be read out from the SQSO pin by sending 40 SQCK pulses.

Command	Data 5				Data 6			
	D3	D2	D1	D0	D3	D2	D1	D0
Spindle servo coefficient setting	EDC7	EDC6	EDC5	EDC4	EDC3	EDC2	EDC1	EDC0

Error rate monitor commands

Command bit	Processing
EDC7 = 0 EDC6	The [No C1 errors, pointer reset] count is output when 1.
EDC5	The [One C1 error corrected, pointer reset] count is output when 1.
EDC4	The [No C1 errors, pointer set] count is output when 1.
EDC3	The [One C1 error corrected, pointer set] count is output when 1.
EDC2	The [Two C1 errors corrected, pointer set] count is output when 1.
EDC1	The [C1 correction impossible, pointer set] count is output when 1.
EDC0	7350-frame count cycle mode*1 when 0. 73500-frame count cycle mode*2 when 1.
EDC7 = 1 EDC6	The [No C2 errors, pointer reset] count is output when 1.
EDC5	The [One C2 error corrected, pointer reset] count is output when 1.
EDC4	The [Two C2 errors corrected, pointer reset] count is output when 1.
EDC3	The [Three C2 errors corrected, pointer reset] count is output when 1.
EDC2	The [Four C2 errors corrected, pointer reset] count is output when 1.
EDC1	The [C2 correction impossible, pointer copy] count is output when 1.
EDC0	The [C2 correction impossible, pointer set] count is output when 1.

*1 The values selected by C1 (EDC1 to EDC6) and C2 (EDC0 to EDC6) are added to C1 and C2, respectively, and output every 7350 frames.

*2 The values selected by C1 (EDC1 to EDC6) and C2 (EDC0 to EDC6) are added to C1 and C2, respectively, and output every 73500 frames.

\$DX commands

Command	Data 1			
	D3	D2	D1	D0
CLV CTRL	0	TB	TP	Gain CLVS

See "\$CX commands".

Command bit	Description
TB = 0	Bottom hold at a cycle of RFCK/32 in CLVS mode.
TB = 1	Bottom hold at a cycle of RFCK/16 in CLVS mode.
TP = 0	Peak hold at a cycle of RFCK/4 in CLVS mode.
TP = 1	Peak hold at a cycle of RFCK/2 in CLVS mode.

Command	Data 2				Data 3				Data 4			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
CLV CTRL	VP7	VP6	VP5	VP4	VP3	VP2	VP1	VP0	VP CTL1	VP CTL0	0	0

The settings in CAV-W mode are as follows.

Command bit	Processing
VP0 to 7	Sets the spindle rotational velocity.

Command bit		Processing
VPCTL1	VPCTL0	
0	0	The setting of VP0 to VP7 is multiplied by 1.
0	1	The setting of VP0 to VP7 is multiplied by 2.
1	0	The setting of VP0 to VP7 is multiplied by 3.
1	1	The setting of VP0 to VP7 is multiplied by 4.

* The above setting should be 0, 0 except for the CAV-W operating mode.

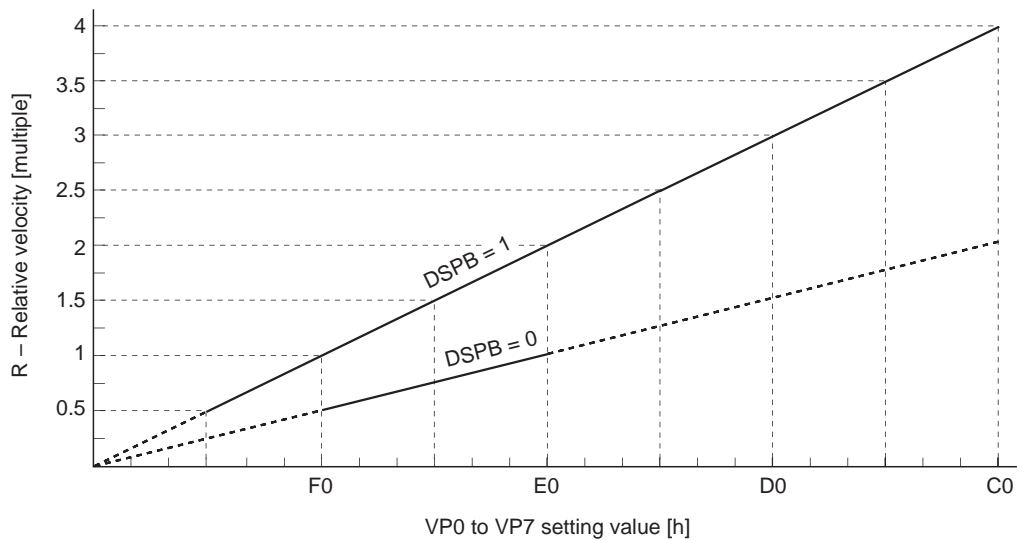
The rotational velocity R of the spindle can be expressed with the following equation.

$$R = \frac{256 - n}{32} \times 1$$

R: Relative velocity at normal speed = 1
 n: VP0 to VP7 setting value
 1: Multiple set by VPCTL0, 1

Command bit	Description
VP0 to 7 = F0 (H)	Playback at half (normal) speed to
:	
VP0 to 7 = E0 (H)	Playback at normal (double) speed to
:	
VP0 to 7 = C0 (H)	Playback at (quadruple) speed

- Notes)** 1. Values when crystal is 16.9344MHz and XTSL is low or when crystal is 33.8688MHz and XTSL is high.
 2. Values in parentheses are for when DSPB is 1.



The settings in variable pitch mode are as follows.

Command bit	Processing
VPCTL1 to VPCTL0, VP7 to VP0	Sets the pitch for variable pitch mode.

The pitch setting can be expressed with the following equation.

$$P = \frac{-n}{10} \text{ [%]}$$

P: Pitch setting value

n: VPCTL1 and VPCTL0, VP7 to VP0 setting value (two's complement, VPCTL1 = sign bit)

Command bit			Pitch setting value [%]	Command setting example
VPCTL1	VPCTL0	VP7 to 0		
1	0	00 (H)	+51.2	\$D60080
		:	to	:
		FF (H)	+25.7	\$D6FF80
1	1	00 (H)	+25.6	\$D600C0
		:	to	:
		FF (H)	+0.1	\$D6FFC0
0	0	00 (H)	0.0	\$D60000
		:	to	:
		FF (H)	-25.5	\$D6FF00
0	1	00 (H)	-25.6	\$D60040
		:	to	:
		E7 (H)	-48.7	\$D6E740

The pitch setting range is from -48.7 to +51.2%.

The plus pitch setting should not exceed the playback speed given in the Recommended Operating Conditions.

An example of variable pitch mode commands is shown below.

\$EX001 (Sets INV VPCO = 1.)

\$AE4 (Setting to enable variable pitch mode.)

\$AEC (Turns on variable pitch mode. The internal clock uses the VCO2 reference.)

\$D60A00 (Sets the pitch to -1.0%.)

\$D60000 (Sets the pitch to 0.0%.)

\$AE4 (Turns off variable pitch mode. The internal clock uses the crystal reference.)

\$EX commands

Command	Data 1				Data 2				Data 3			
	D3	D2	D1	D0	D3	D2	D1	D0	D3	D2	D1	D0
SPD mode	CM3	CM2	CM1	CM0	EPWM	SPDC	ICAP	SFSL	VC2C	HIFC	LPWR	VPON

Command bit				Mode	Description
CM3	CM2	CM1	CM0		
0	0	0	0	STOP	Spindle stop mode.*1
1	0	0	0	KICK	Spindle forward rotation mode.*1
1	0	1	0	BRAKE	Spindle reverse rotation mode. Valid only when LPWR = 0 in any mode.*1
1	1	1	0	CLVS	Rough servo mode. When the RF-PLL circuit isn't locked, this mode is used to pull the disc rotations within the RF-PLL capture range.
1	1	1	1	CLVP	PLL servo mode.
0	1	1	0	CLVA	Automatic CLVS/CLVP switching mode. Used for normal playback.

*1 See Timing Charts 1-6 to 1-29.

In the digital CLV servo, the sampling frequency of the internal digital filter is switched simultaneously with the switching of CLVP/CLVS.

Then, the CLVS mode cut-off frequency f_c is 70Hz when \$D command TB = 0 or 140Hz when \$D command TB = 1.

Spindle control can be set to the ternary output of only MDP or the binary outputs of MDP and MDS by \$AF commands MDPOUTSL1 and MDPOUTSL0.

Command bit									Mode	Description
EPWM	SPDC	ICAP	SFSL	VC2C	HIFC	LPWR	VPON	INV VPCO		
0	0	0	0	0	0	0	0	0	CLV-N	Crystal reference CLV servo.
0	0	0	0	0	0	0	0	1	CLV-N	VCO2 reference CLV servo.
0	0	0	0	1	1	0	0	0	CLV-W	Used for playback in CLV-W mode.*2
0	1	1	0	0	1	0	1	0	CAV-W	Spindle control with VP0 to VP7.
1	0	1	0	0	1	0	1	0	CAV-W	Spindle control with the external PWM.
0	0	0	0	0	1	0	1	1	VCO-C	VCO control*3

*2 Figs. 3-1 and 3-2 show the control flow with the microcomputer software in CLV-W mode.

*3 Fig. 3-3 shows the control flow with the microcomputer software in VCO-C mode.

Mode	LPWR	LPWR2	Command	Timing chart – Ternary output	Timing chart – Binary output
CLV-N	0	0	KICK	1-6 (a)	1-18 (a)
			BRAKE	1-6 (b)	1-18 (b)
			STOP	1-6 (c)	1-18 (c)
CLV-W	0	0	KICK	1-7 (a)	1-19 (a)
			BRAKE	1-7 (b)	1-19 (b)
			STOP	1-7 (c)	1-19 (c)
	1	0	KICK	1-8 (a)	1-20 (a)
			BRAKE	1-8 (b)	1-20 (b)
			STOP	1-8 (c)	1-20 (c)
CAV-W	0	0	KICK	1-9 (a)	1-21 (a)
			BRAKE	1-9 (b)	1-21 (b)
			STOP	1-9 (c)	1-21 (c)
	1	0	KICK	1-10 (a)	1-22 (a)
			BRAKE	1-10 (b)	1-22 (b)
			STOP	1-10 (c)	1-22 (c)

Mode	LPWR	LPWR2	Timing chart – Ternary output	Timing chart – Binary output
CLV-N	0	0	1-11	1-23
CLV-W	0	0	1-12	1-24
	1		1-13	1-25
CAV-W	0	0	1-14 (EPWM = 0)	1-26 (EPWM = 0)
	1		1-15 (EPWM = 0)	1-27 (EPWM = 0)
	0		1-16 (EPWM = 1)	1-28 (EPWM = 1)
	1		1-17 (EPWM = 1)	1-29 (EPWM = 1)

Mode	LPWR	LPWR2	Command	Timing chart – Ternary output	Timing chart – Binary output
CLV-W	0	1	KICK	1-8 (a)	1-30 (a)
			BRAKE	1-8 (b)	1-30 (b)
			STOP	1-8 (c)	1-30 (c)
	1	1	KICK	1-8 (a)	1-31 (a)
			BRAKE	1-8 (b)	1-31 (b)
			STOP	1-8 (c)	1-31 (c)
CAV-W	0	1	KICK	1-10 (a)	1-32 (a)
			BRAKE	1-10 (b)	1-32 (b)
			STOP	1-10 (c)	1-32 (c)
	1	1	KICK	1-10 (a)	1-33 (a)
			BRAKE	1-10 (b)	1-33 (b)
			STOP	1-10 (c)	1-33 (c)

Mode	LPWR	LPWR2	Timing chart – Ternary output	Timing chart – Binary output
CLV-W	0	1	1-13	1-34
	1		1-13	1-35
CAV-W	0	1	1-15 (EPWM = 0)	1-36 (EPWM = 0)
	1		1-15 (EPWM = 0)	1-37 (EPWM = 0)
	0		1-17 (EPWM = 1)	1-38 (EPWM = 1)
	1		1-17 (EPWM = 1)	1-39 (EPWM = 1)

Command	Data 4			
	D3	D2	D1	D0
SPD mode	Gain CAV1	Gain CAV0	0	INV VPCO

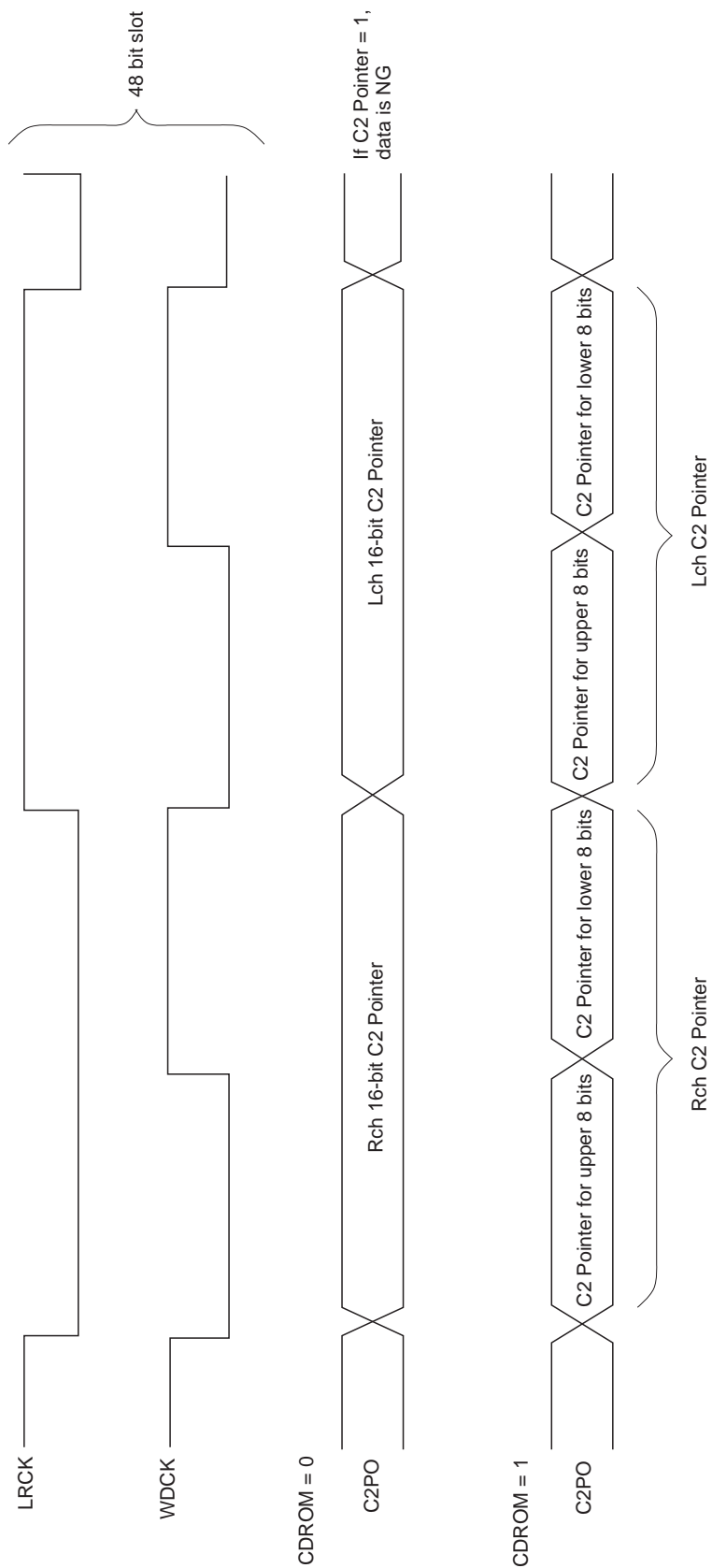
See page 75.

Gain CAV1	Gain CAV0	Gain
0	0	0dB
0	1	-6dB
1	0	-12dB
1	1	-18dB

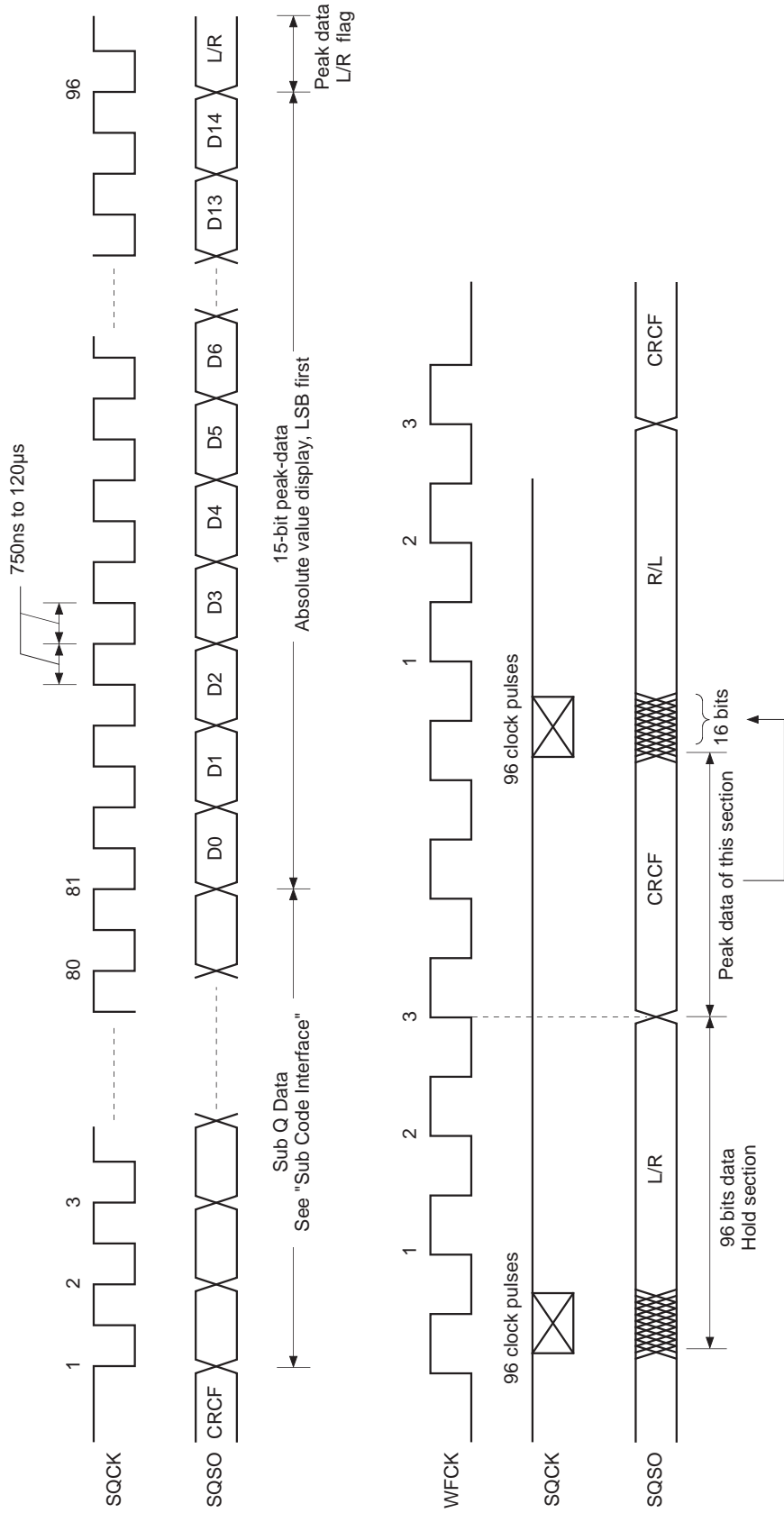
- This sets the gain when controlling the spindle with VP7 to VP0 in CAV-W mode.

Note) The Gain CAV1, 0 commands are invalid for spindle control with the external PWM.

Timing Chart 1-3

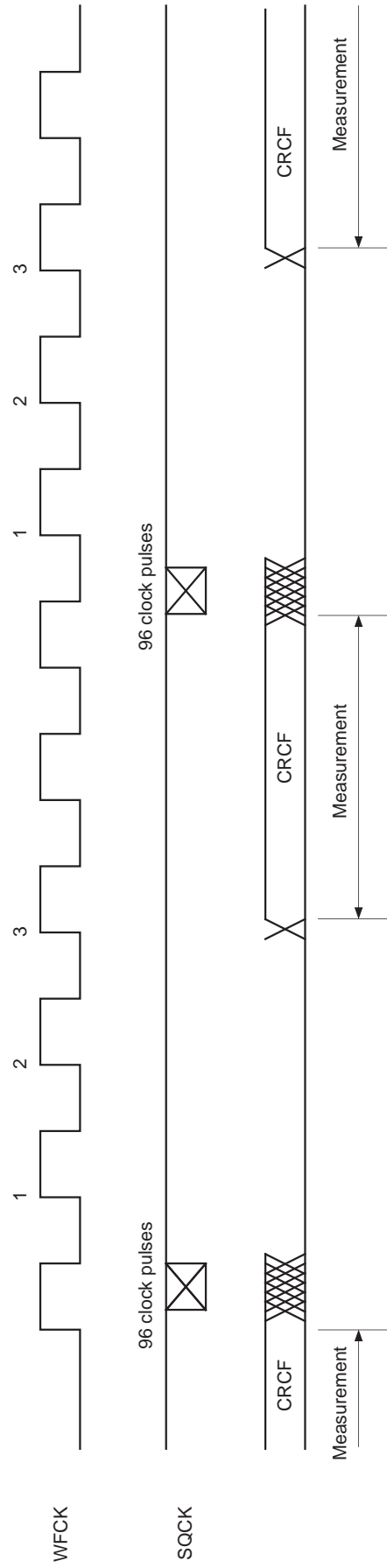


Timing Chart 1-4



Level Meter Timing

Timing Chart 1-5

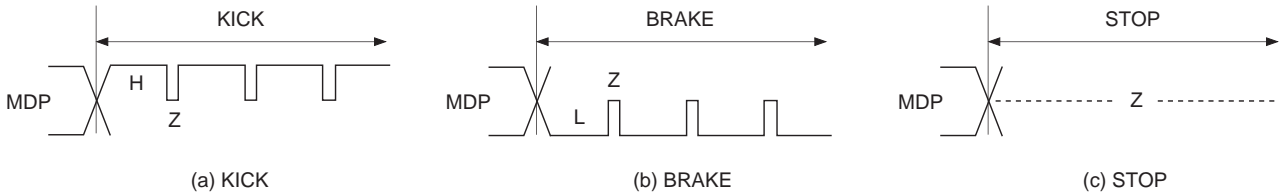


Peak Meter Timing

Ternary output from MDP pin (\$AF MDPOUTSL1 = 0, MDPOUTSL0 = 0)

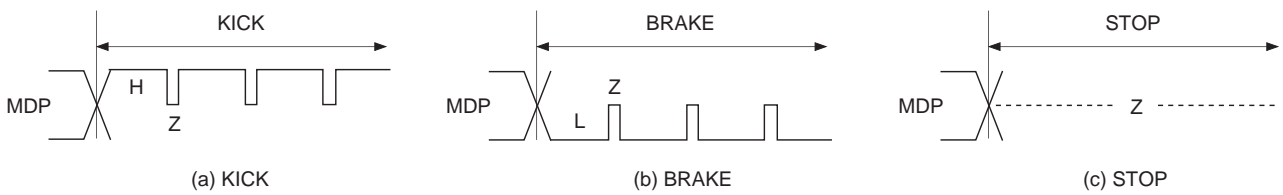
Timing Chart 1-6

CLV-N mode LPWR = 0, LPWR2 = 0



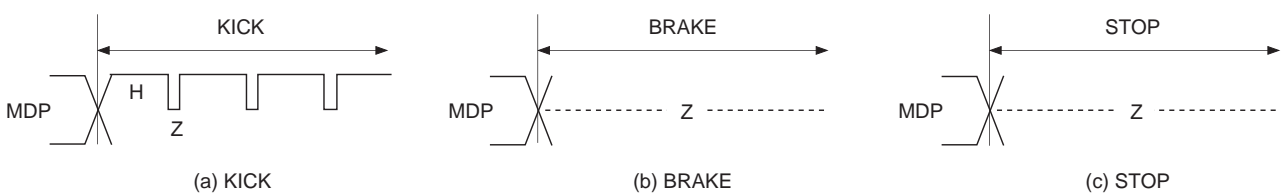
Timing Chart 1-7

CLV-W mode (when following the spindle rotational velocity) LPWR = 0, LPWR2 = 0



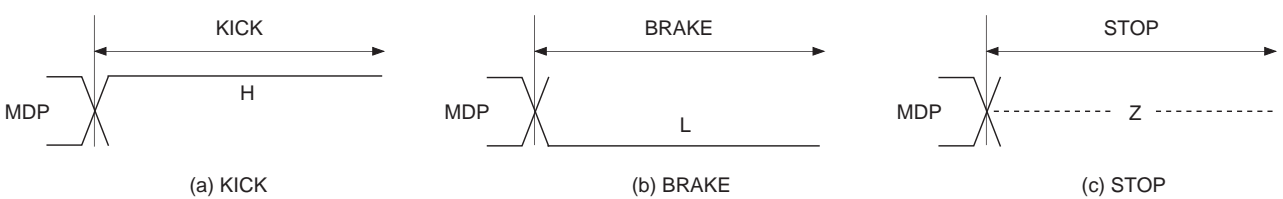
Timing Chart 1-8

CLV-W mode (when following the spindle rotational velocity) LPWR = 1, LPWR2 = 0



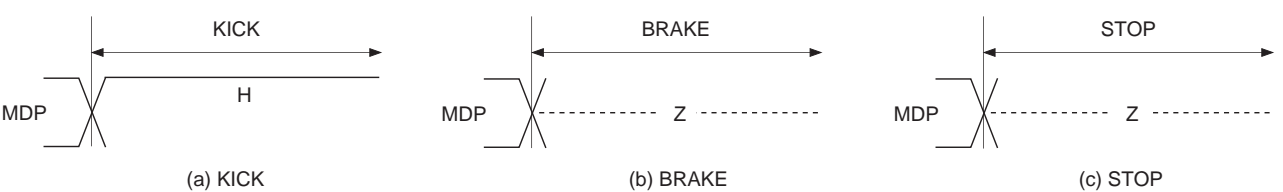
Timing Chart 1-9

CAV-W mode LPWR = 0, LPWR2 = 0



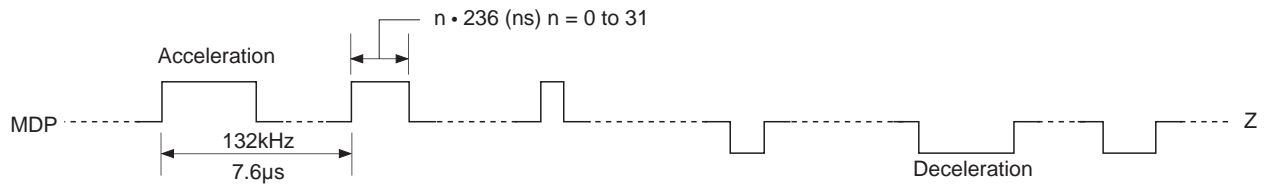
Timing Chart 1-10

CAV-W mode LPWR = 1, LPWR2 = 0



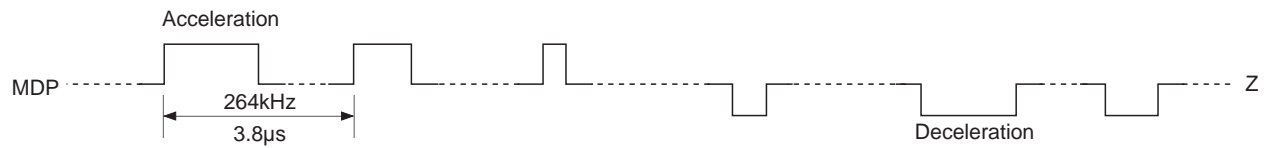
Timing Chart 1-11

CLV-N mode LPWR = 0, LPWR2 = 0



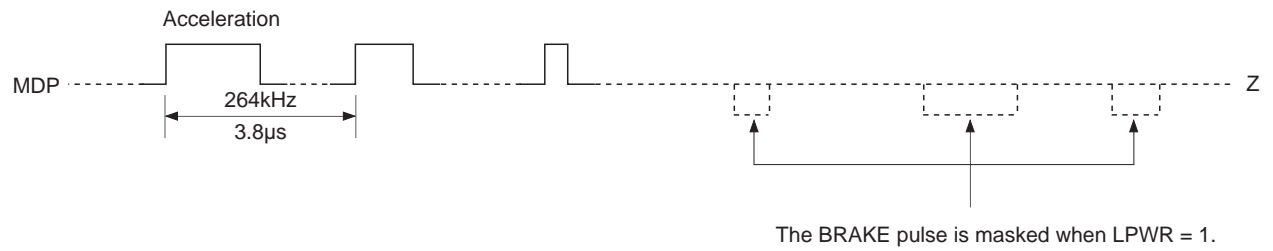
Timing Chart 1-12

CLV-W mode LPWR = 0, LPWR2 = 0



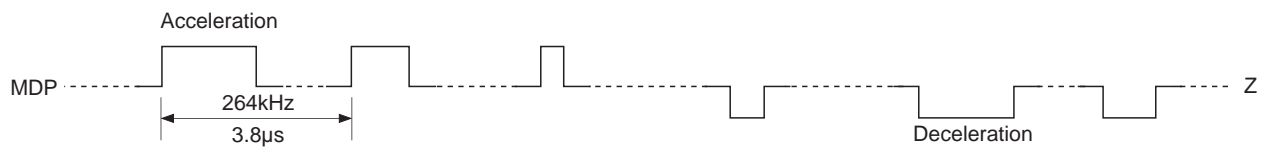
Timing Chart 1-13

CLV-W mode LPWR = 1, LPWR2 = 0



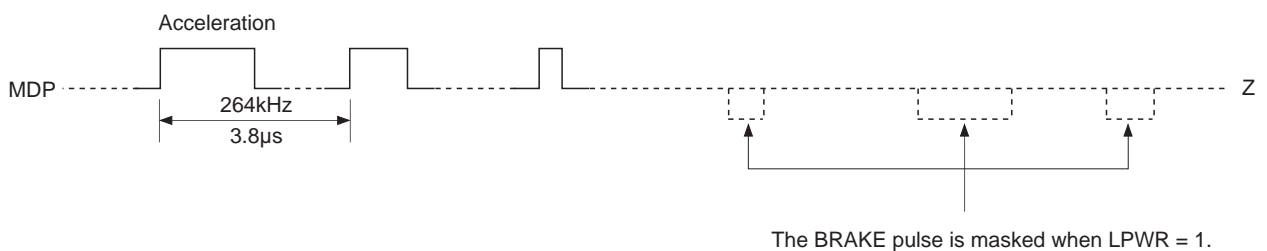
Timing Chart 1-14

CAV-W mode EPWM = LPWR = 0, LPWR2 = 0



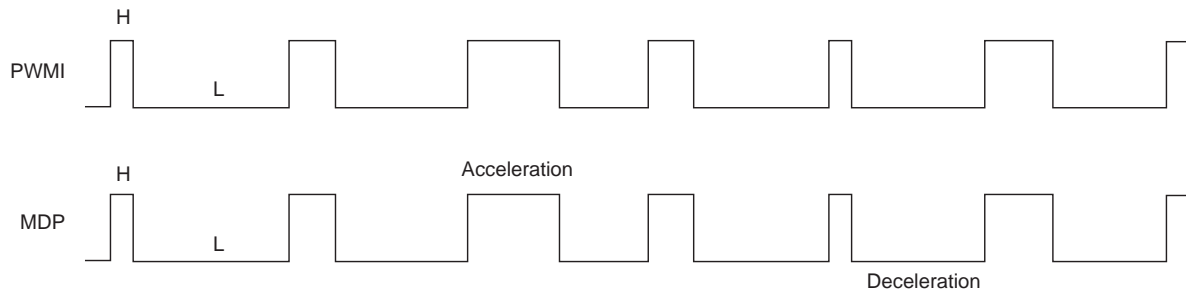
Timing Chart 1-15

CAV-W mode EPWM = 0, LPWR = 1, LPWR2 = 0



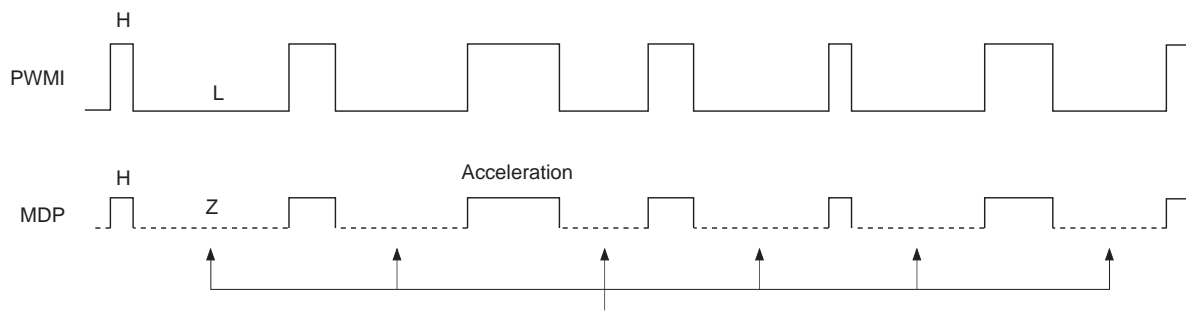
Timing Chart 1-16

CAV-W mode EPWM = 1, LPWR = 0, LPWR2 = 0



Timing Chart 1-17

CAV-W mode EPWM = LPWR = 1, LPWR2 = 0

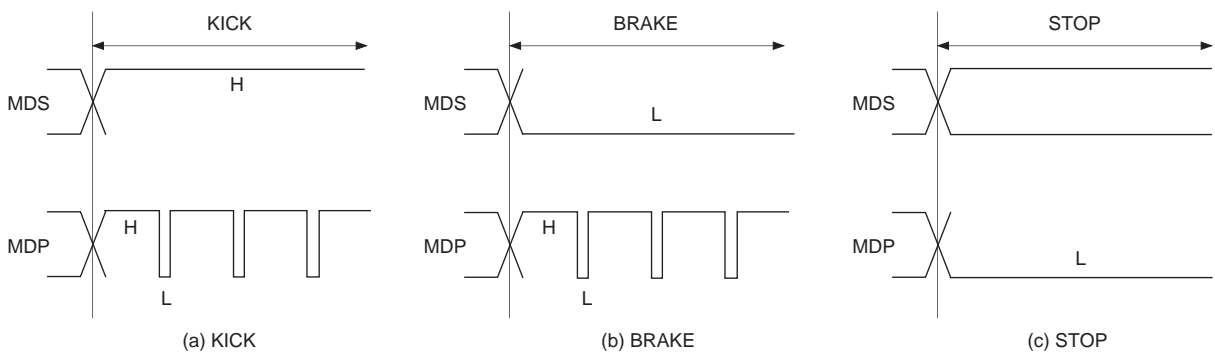


The BRAKE pulse is masked when LPWR = 1.

Binary output from MDP and MDS pins (\$AF MDPOUTSL1 = 1, MDPOUTSL0 = 0)

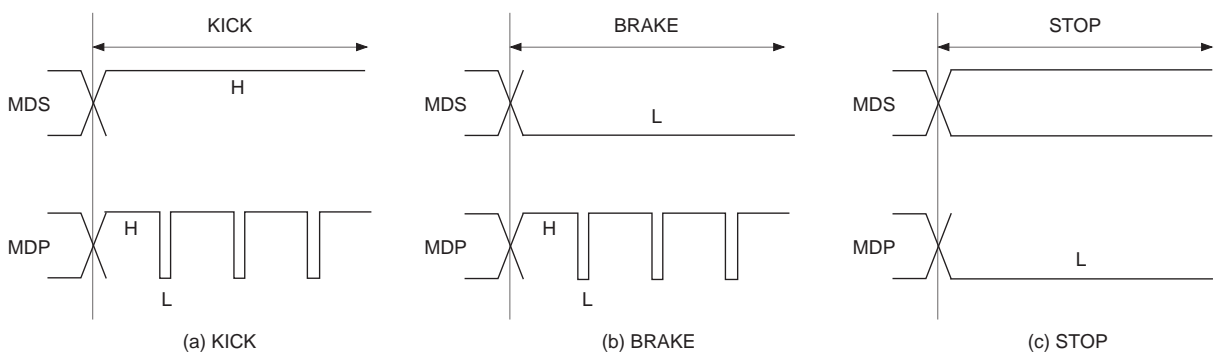
Timing Chart 1-18

CLV-N mode LPWR = 0, LPWR2 = 0



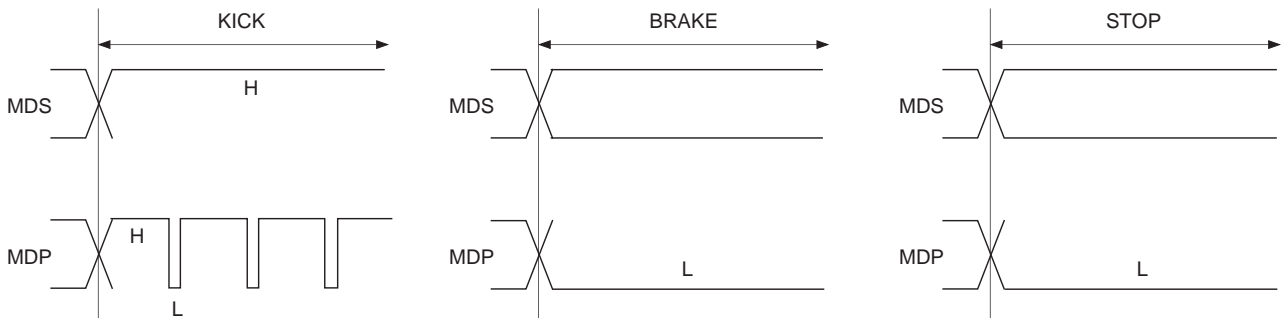
Timing Chart 1-19

CLV-W mode (when following the spindle rotational velocity) LPWR = 0, LPWR2 = 0



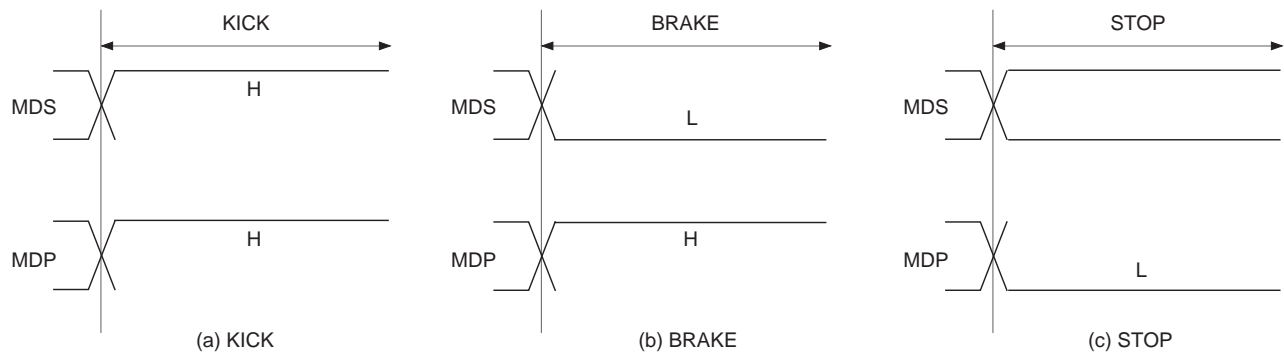
Timing Chart 1-20

CLV-W mode (when following the spindle rotational velocity) LPWR = 1, LPWR2 = 0



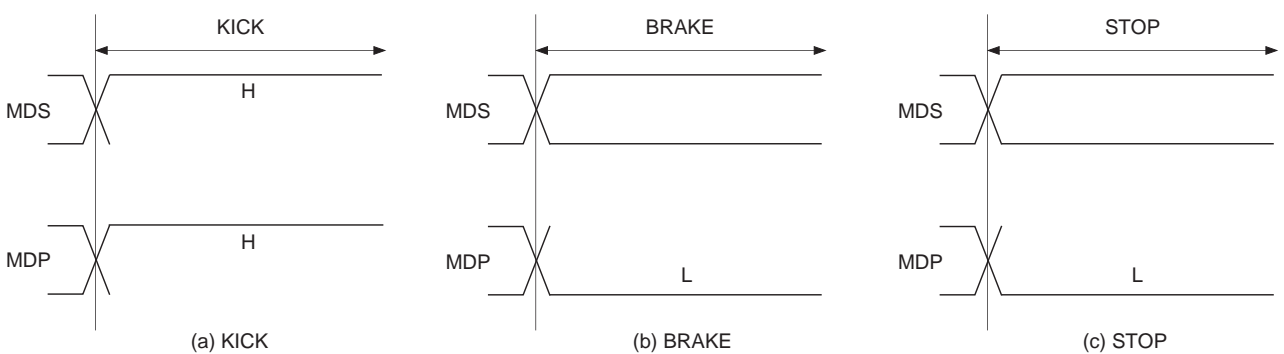
Timing Chart 1-21

CAV-W mode LPWR = 0, LPWR2 = 0



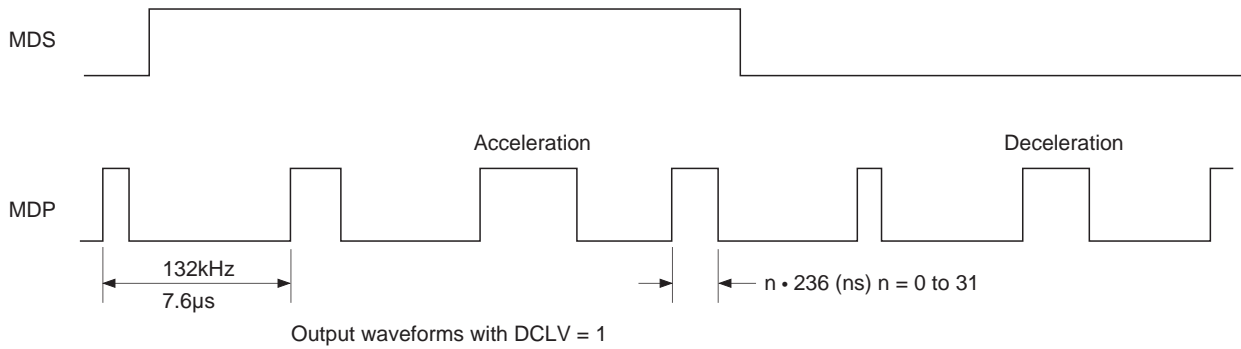
Timing Chart 1-22

CAV-W mode LPWR = 1, LPWR2 = 0



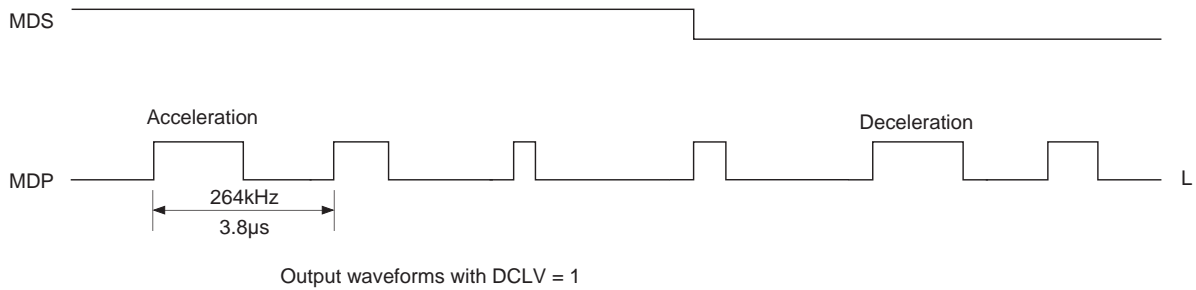
Timing Chart 1-23

CLV-N mode LPWR = 0, LPWR2 = 0



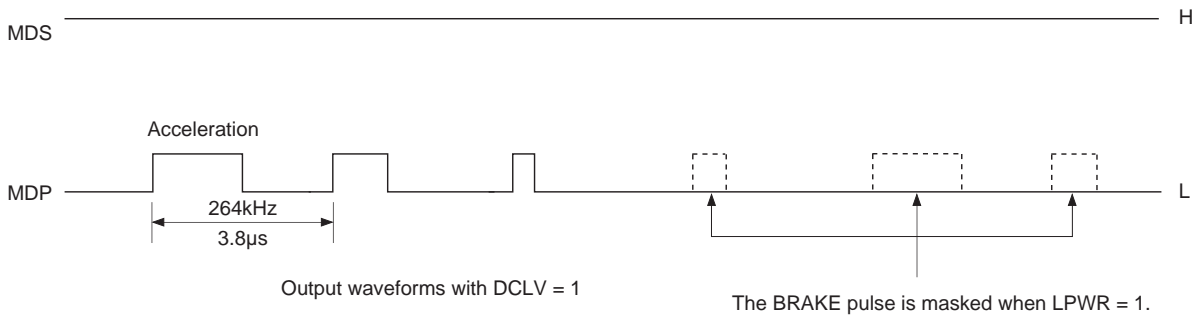
Timing Chart 1-24

CLV-W mode LPWR = 0, LPWR2 = 0



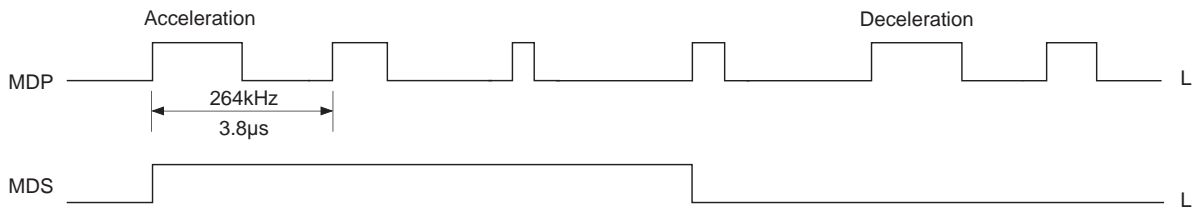
Timing Chart 1-25

CLV-W mode LPWR = 1, LPWR2 = 0



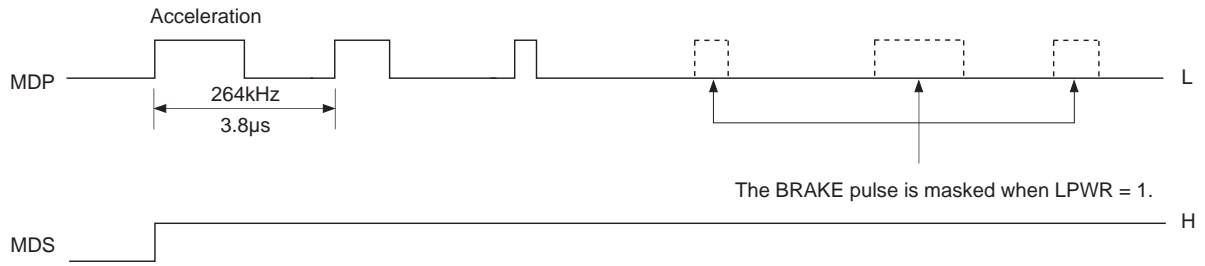
Timing Chart 1-26

CAV-W mode EPWM = 0, LPWR = 0, LPWR2 = 0



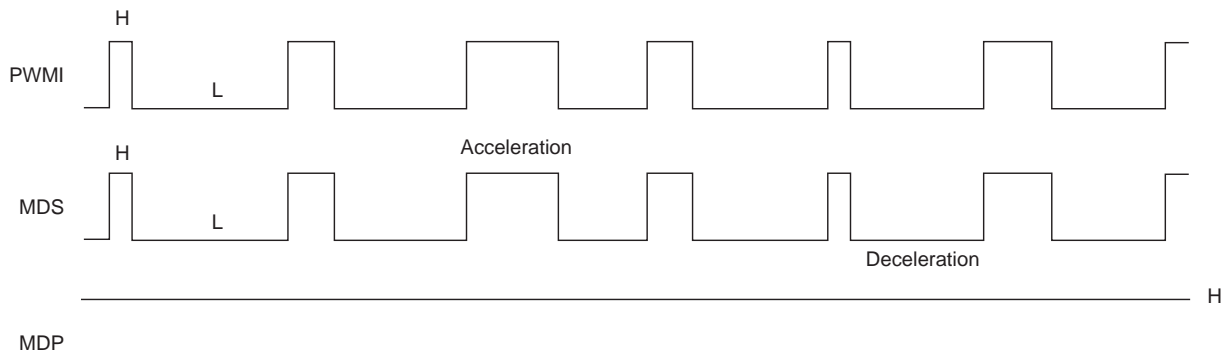
Timing Chart 1-27

CAV-W mode EPWM = 0, LPWR=1, LPWR2 = 0



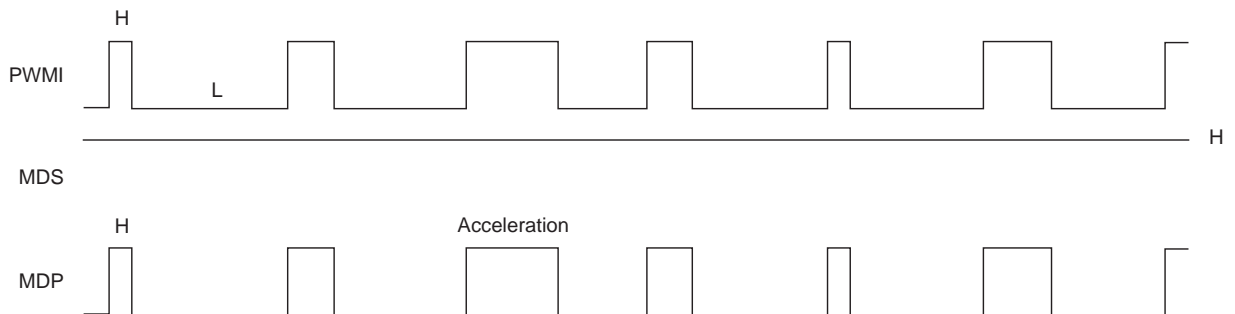
Timing Chart 1-28

CAV-W mode EPWM = 1, LPWR = 0, LPWR2 = 0



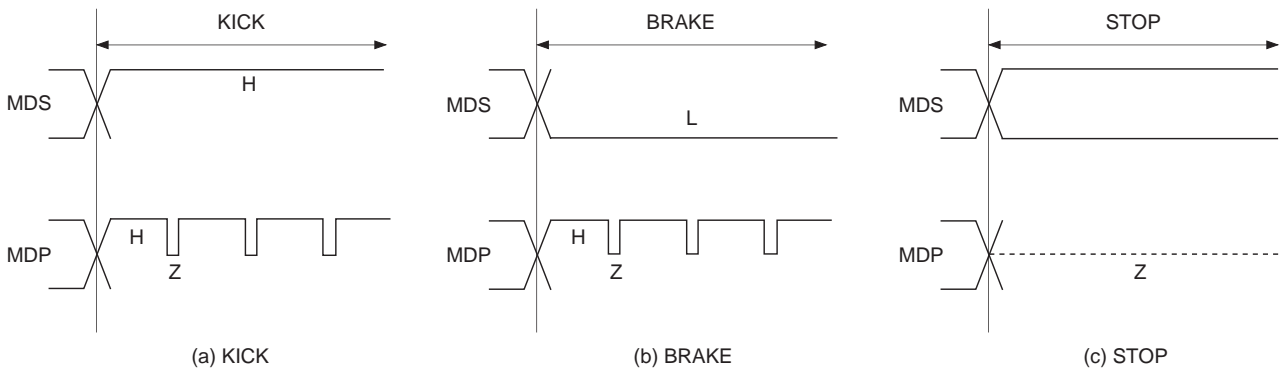
Timing Chart 1-29

CAV-W mode EPWM = 1, LPWR = 1, LPWR2 = 0



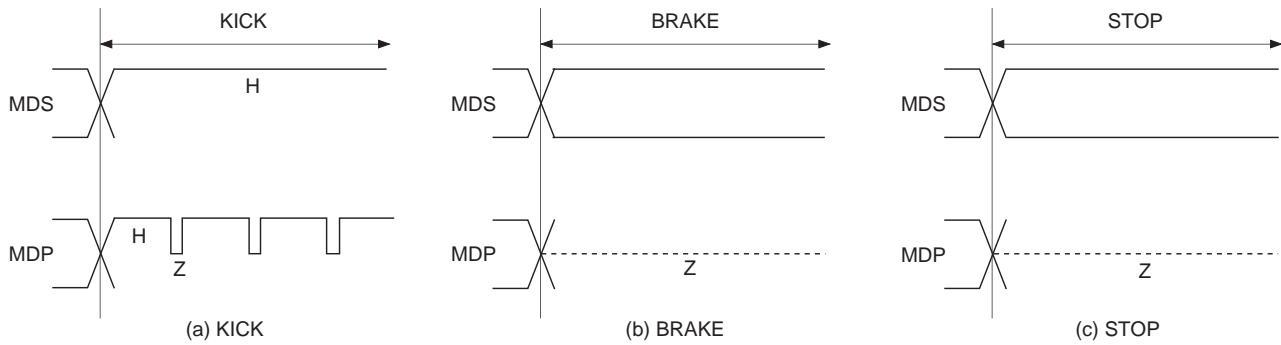
Timing Chart 1-30

CLV-W mode (when following the spindle rotational velocity) LPWR = 0, LPWR2 = 1



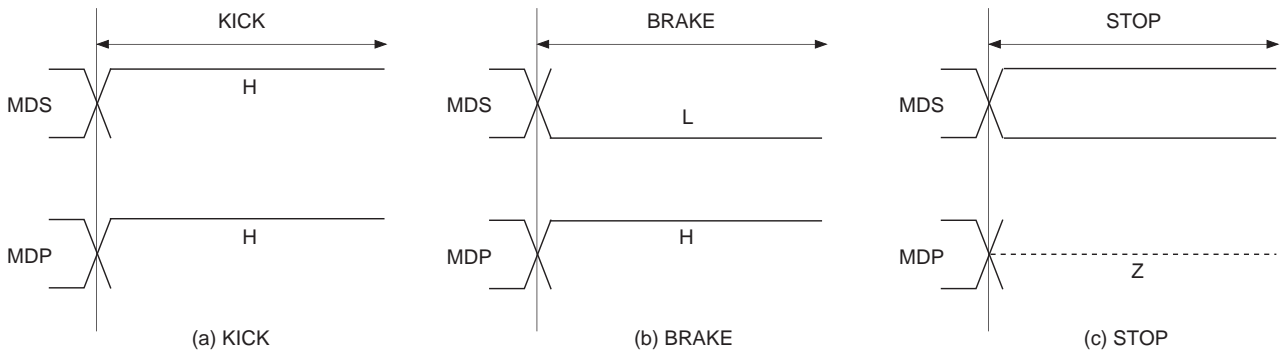
Timing Chart 1-31

CLV-W mode (when following the spindle rotational velocity) LPWR = 1, LPWR2 = 1



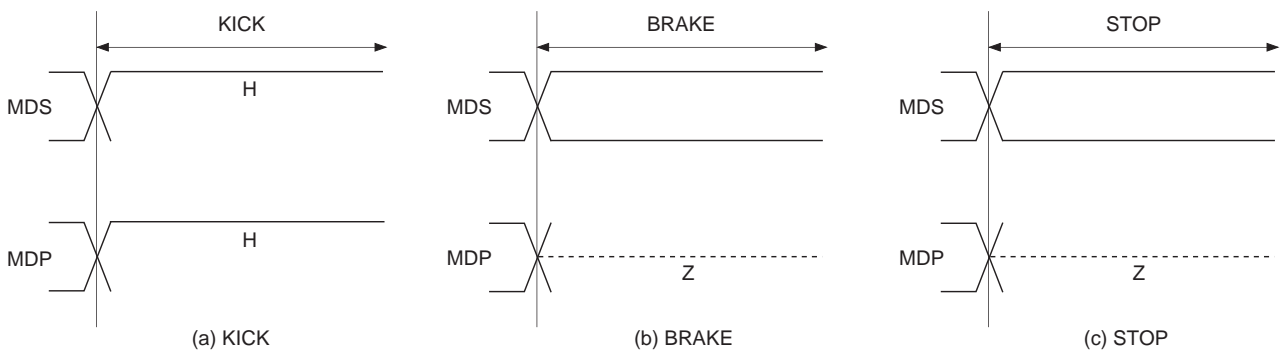
Timing Chart 1-32

CAV-W mode LPWR = 0, LPWR2 = 1



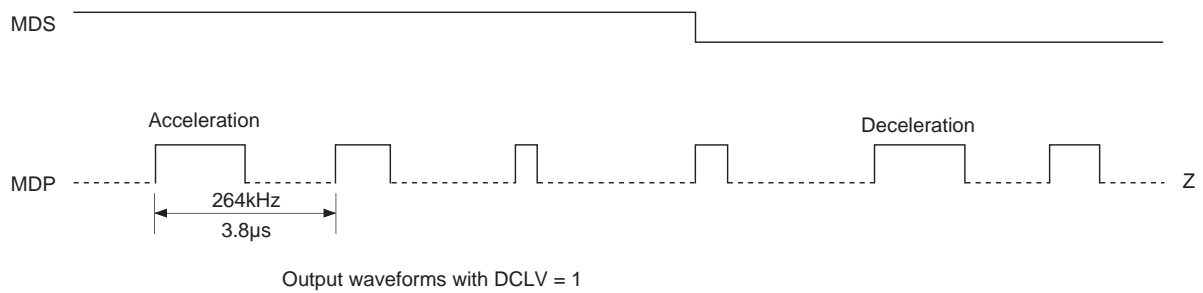
Timing Chart 1-33

CAV-W mode LPWR = 1, LPWR2 = 1



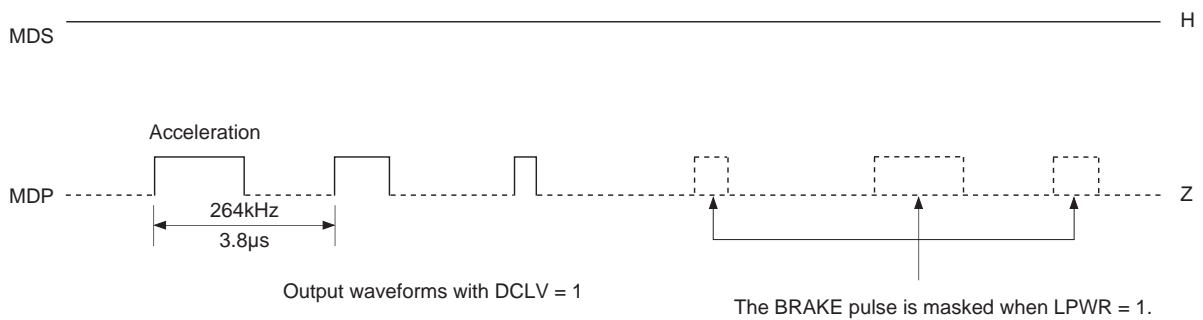
Timing Chart 1-34

CLV-W mode LPWR = 0, LPWR2 = 1



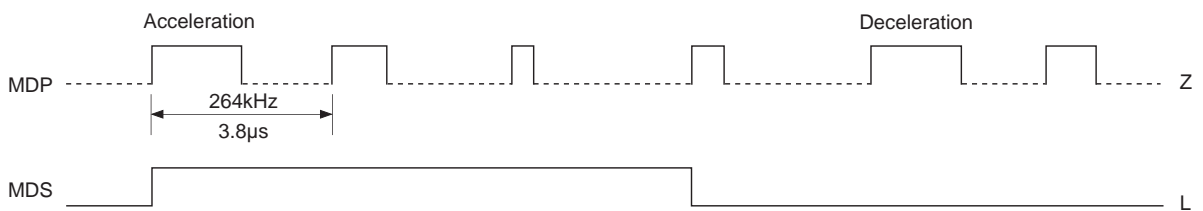
Timing Chart 1-35

CLV-W mode LPWR = 1, LPWR2 = 1



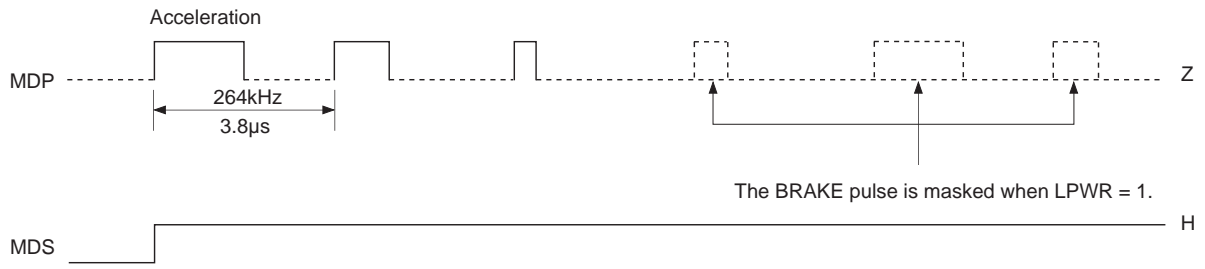
Timing Chart 1-36

CAV-W mode EPWM = 0, LPWR = 0, LPWR2 = 1



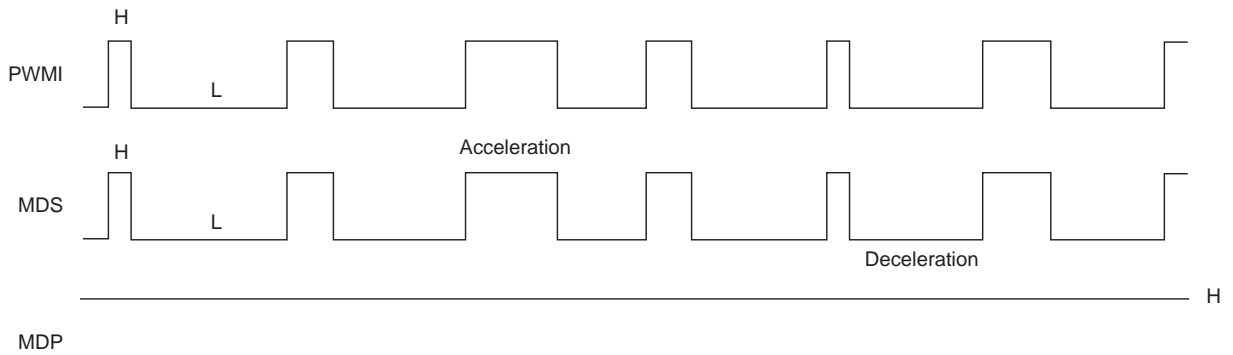
Timing Chart 1-37

CAV-W mode EPWM = 0, LPWR=1, LPWR2 = 1



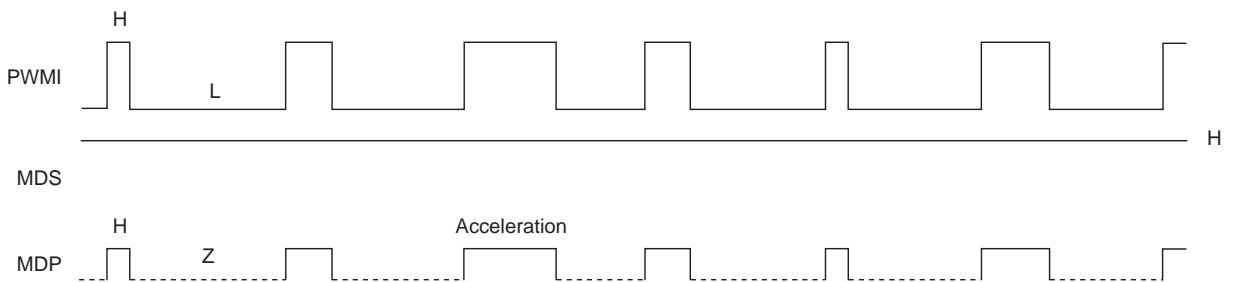
Timing Chart 1-38

CAV-W mode EPWM = 1, LPWR = 0, LPWR2 = 1



Timing Chart 1-39

CAV-W mode EPWM = 1, LPWR = 1, LPWR2 = 1



[2] Subcode Interface

There are two methods for reading out a subcode externally.

The 8-bit subcodes P to W can be read out from SBSO by inputting EXCK.

The subcode-Q can be read out after checking CRC of the 80 bits in the subcode frame.

The subcode-Q can be read out from the SQSO pin by inputting 80 clock pulses to the SQCK pin when SCOR comes correctly and CRCF is high.

§2-1. P to W Subcode Readout

Data can be read out by inputting EXCK immediately after WFCK falls. (See Timing Chart 2-1.)

§2-2. 80-bit Subcode-Q Readout

Fig. 2-2 shows the peripheral block of the 80-bit subcode-Q register.

- First, subcode-Q, regenerated at one bit per frame, is input to the 80-bit serial/parallel register and the CRC check circuit.

- 96-bit subcode-Q is input, and if the CRC is OK, it is output to SQSO with CRCF = 1. In addition, 80 bits are loaded into the parallel/serial register.

When SQSO goes high after SCOR is output, the CPU determines that new data (which passed the CRC check) has been loaded.

- When the 80-bit data is loaded, the order of the MSB and LSB is inverted within each byte. As a result, although the sequence of the bytes is the same, the bits within the bytes are now ordered LSB first.

- Once the 80-bit data load is confirmed, SQCK is input so that the data can be read.

The SQCK input is detected, and the retriggerable monostable multivibrator is reset while the input is low.

- The retriggerable monostable multivibrator has a time constant from 270 to 400 μ s. When the duration when SQCK is high is less than this time constant, the monostable multivibrator is kept reset; during this interval, the serial/parallel register is not loaded into the parallel/serial register.

- While the monostable multivibrator is being reset, data cannot be loaded in the peak detection parallel/serial register or the 80-bit parallel/serial register.

In other words, while reading out with a clock cycle shorter than this time constant, these registers will not be rewritten by CRCOK and others.

- The previously mentioned peak detection register can be connected to the shift-in of the 80-bit parallel/serial register.

For ring control 1, input and output are shorted during peak meter and level meter modes.

For ring control 2, input and output are shorted during peak meter mode.

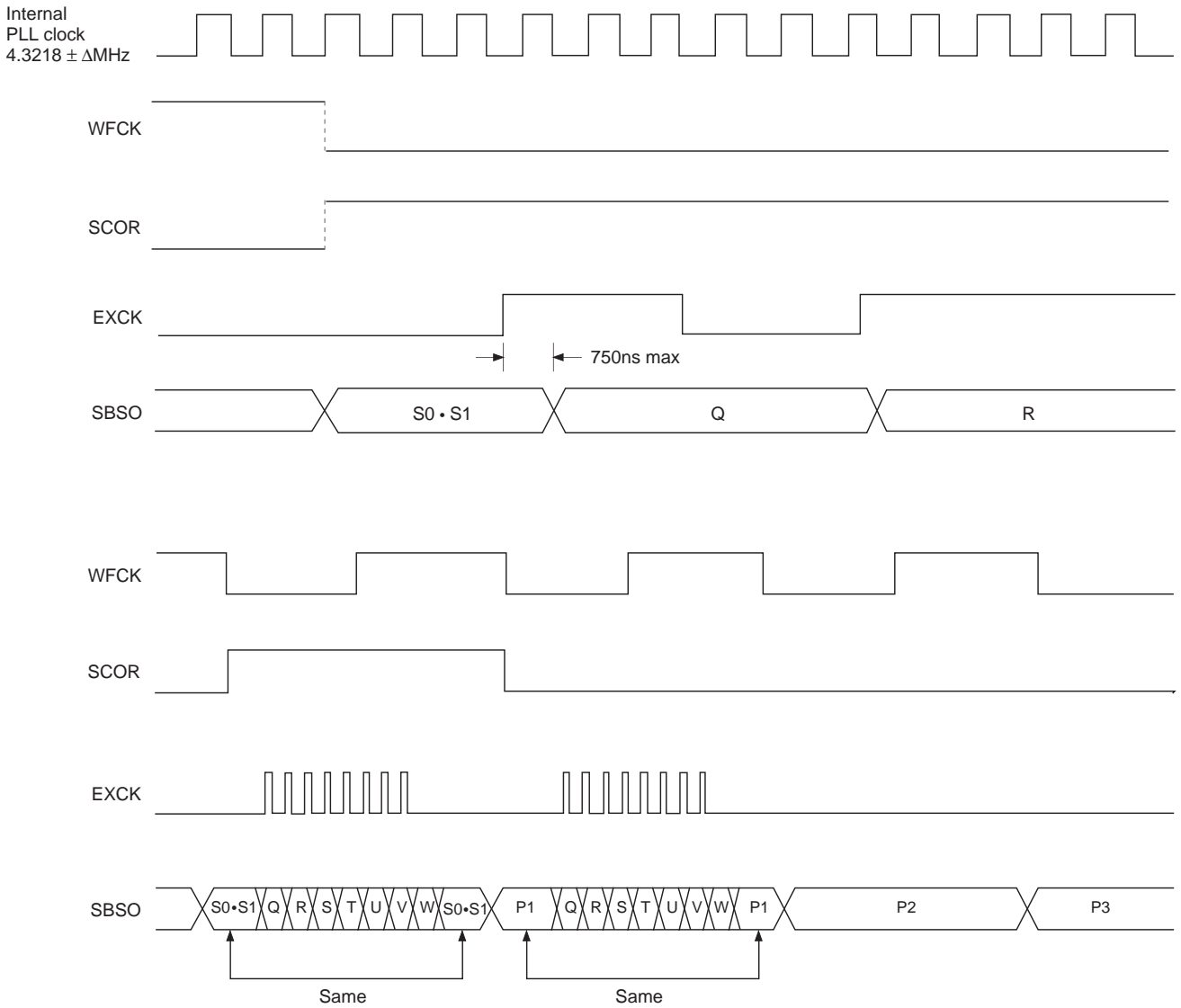
This is because the register is reset with each readout in level meter mode, and to prevent readout destruction in peak meter mode.

As a result, the 96-bit clock must be input in peak meter mode.

- The absolute time after peak is stored in the memory in peak meter mode as noted in "Description of peak meter mode" on page 49. See Timing Chart 2-3.

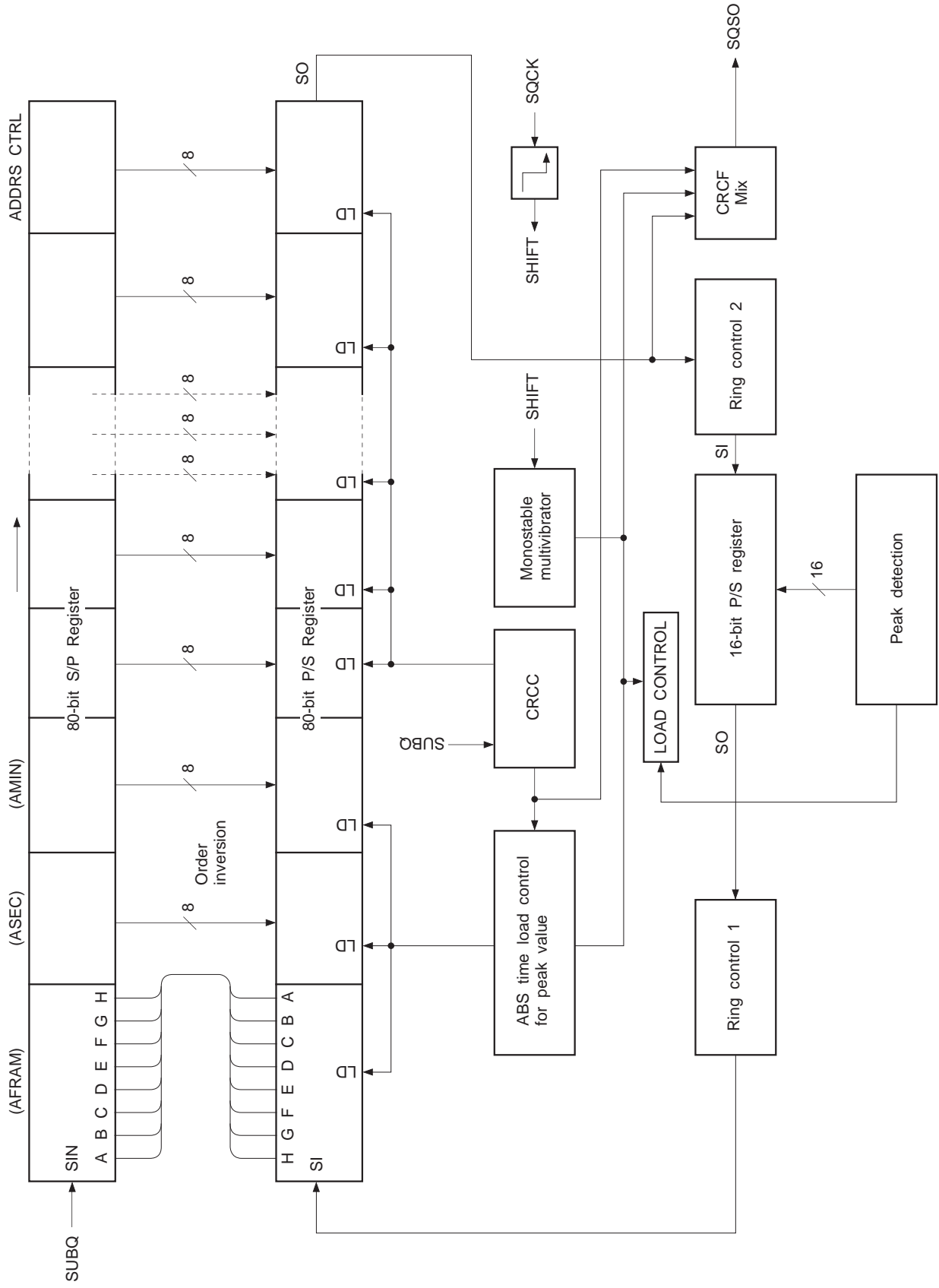
- The clock is input from the SQCK pin to perform these operations. The high and low intervals of the clock should be between 750ns and 120 μ s.

Timing Chart 2-1

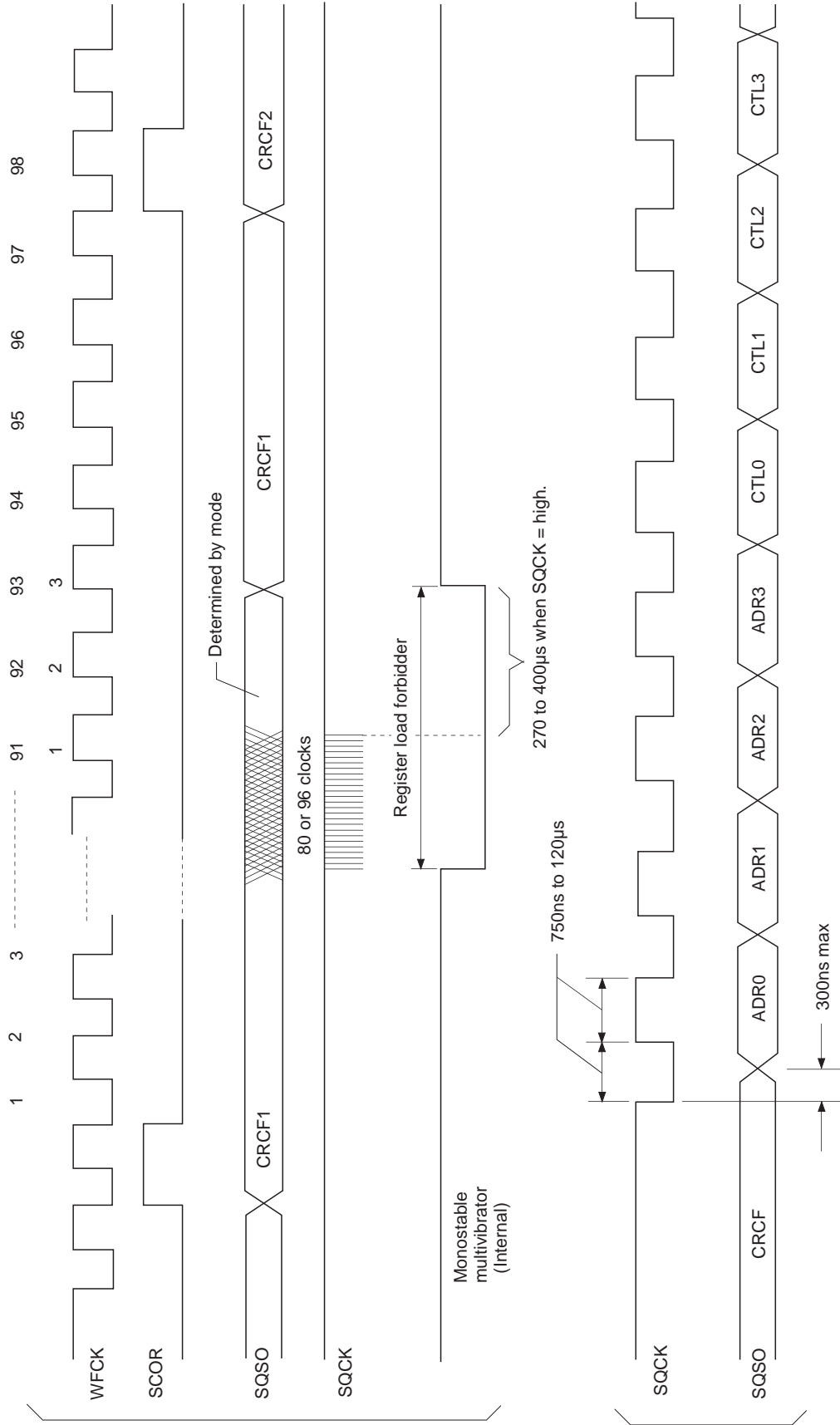


Subcode P.Q.R.S.T.U.V.W Read Timing

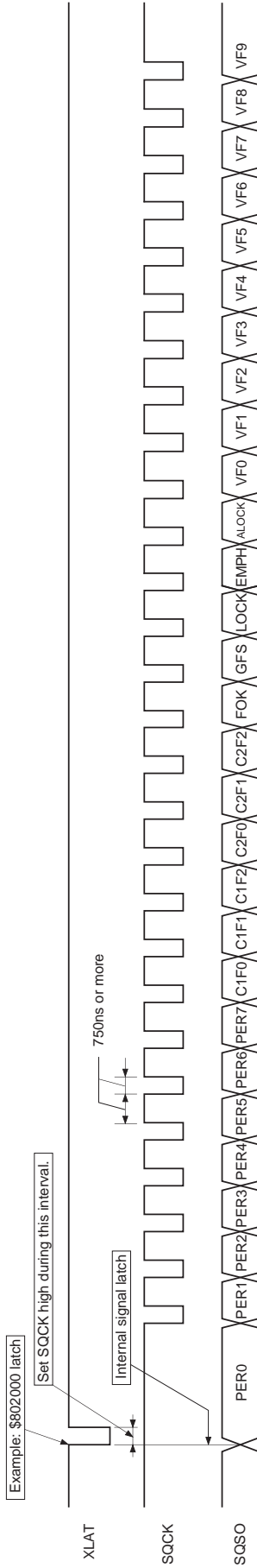
Block Diagram 2-2



Timing Chart 2-3



Timing Chart 2-4

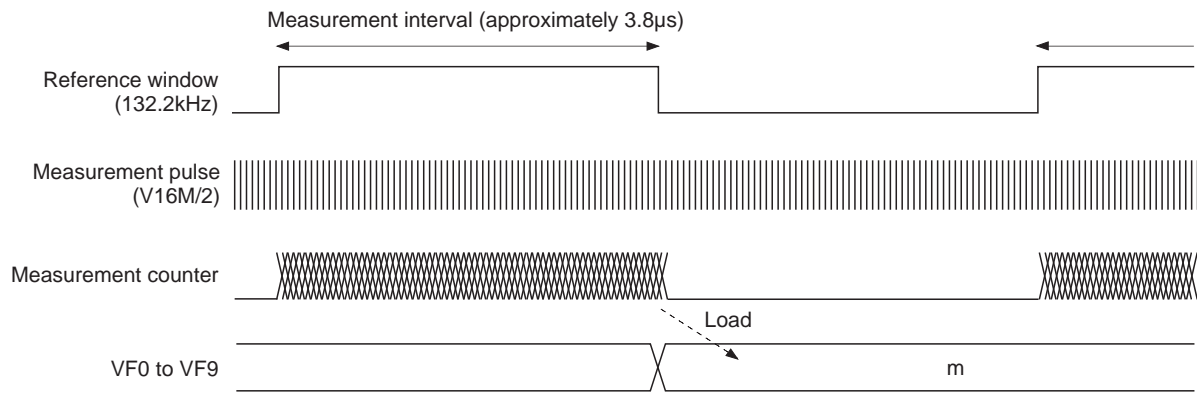


Signal	Description
PER0 to PER7	RF jitter amount (used to adjust the focus bias). 8-bit binary data in PER0 = LSB, PER7 = MSB.
FOK	Focus OK.
GFS	High when the frame sync and the insertion protection timing match.
LOCK	GFS is sampled at 460Hz; when GFS is high, this pin outputs a high signal. If GFS is low eight consecutive samples, this pin outputs low.
EMPH	High when the playback disc has emphasis.
ALOCK	GFS is sampled at 460Hz; when GFS is high eight consecutive samples, this pin outputs a high signal. If GFS is low eight consecutive samples, this pin outputs low.
VF0 to VF9	Used in CAV-W mode. The result obtained by measuring the rotational velocity of the disc. (See Timing Chart 2-5.) VF0 = LSB, VF9 = MSB.

C1F2	C1F1	C1F0	Description
0	0	0	No C1 errors; C1 pointer reset
0	0	1	One C1 error corrected; C1 pointer reset
0	1	0	—
0	1	1	—
1	0	0	No C1 errors; C1 pointer set
1	0	1	One C1 error corrected; C1 pointer set
1	1	0	Two C1 errors corrected; C1 pointer set
1	1	1	C1 correction impossible; C1 pointer set

C2F2	C2F1	C2F0	Description
0	0	0	No C2 errors; C2 pointer reset
0	0	1	One C2 error corrected; C2 pointer reset
0	1	0	Two C2 errors corrected; C2 pointer reset
0	1	1	Three C2 errors corrected; C2 pointer reset
1	0	0	Four C2 errors corrected; C2 pointer reset
1	0	1	—
1	1	0	C2 correction impossible; C1 pointer copy
1	1	1	C2 correction impossible; C2 pointer set

Timing Chart 2-5

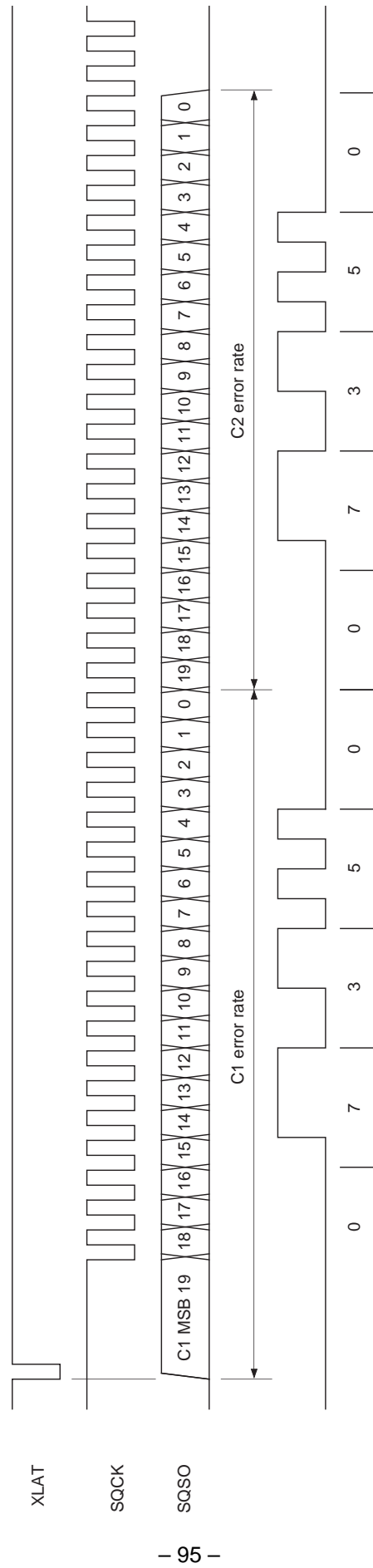


The relative velocity of the disc can be obtained with the following equation.

$$R = \frac{m + 1}{32} \text{ (R: Relative velocity, m: Measurement results)}$$

VF0 to VF9 is the result obtained by counting V16M/2 pulses while the reference signal (132.2kHz) generated from XTAL (XTAI, XTAO) (384Fs) is high. This value is 31 when the disc is rotating at normal speed and 63 when it is rotating at double speed (when DSPB is low).

Timing Chart 2-6



[3] Description of Modes

This LSI has three basic operating modes using a combination of spindle control and the PLL. The operations for each mode are described below.

§3-1. CLV-N Mode

This mode is compatible with the CXD2510Q, and operation is the same as for conventional control. The PLL capture range is $\pm 150\text{kHz}$.

§3-2. CLV-W Mode

This is the wide capture range mode. This mode allows the conventional PLL to follow the rotational velocity of the disc. This rotational following control uses the built-in VCO2. The spindle is the same CLV servo as for the conventional series. Operation using the built-in VCO2 is described below.

When starting to rotate the disc and/or speeding up to the lock range from the condition where the disc is stopped, CAV-W mode should be used. Specifically, first send $\$E665X$ to set CAV-W mode and kick the disc, then send $\$E60CX$ to set CLV-W mode if ALOCK is high, which can be read out serially from the SQSO pin. CLV-W mode can be used while ALOCK is high. The microcomputer monitors the serial data output, and must return the operation to the speed adjusting state (CAV-W mode) when ALOCK becomes low. The control flow according to the microcomputer software in CLV-W mode is shown in Fig. 3-2.

In CLV-W mode (normal), low power consumption is achieved by setting LPWR high. Control was formerly performed by applying acceleration and deceleration pulses to the spindle motor. However, when LPWR is set high, deceleration pulses are not output, thereby achieving low power consumption mode.

Note) The capture range for this mode is theoretically up to the signal processing limit.

§3-3. CAV-W Mode

This is CAV mode. In this mode, the external clock is fixed and it is possible to control the spindle to the desired rotational velocity. The rotational velocity is determined by the VP0 to VP7 setting values or the external PWM. When controlling the spindle with VP0 to VP7, setting CAV-W mode with the $\$E665X$ command and controlling VP0 to VP7 with the $\$DX$ commands allows the rotational velocity to be varied from low speed to quadruple speed. (See " $\$DX$ commands".) When controlling the spindle with the external PWM, the PWMI pin is binary input which becomes KICK during high intervals and BRAKE during low intervals.

The microcomputer can know the rotational velocity using the internal master clock frequency as the parameter. With XTAL (XTAI, XTAO) (384Fs) as the reference frequency, the result after measuring the high interval by the internal master clock is output in 10 bits (VP0 to VP9) from the new CPU interface. These measurement results are 31 when the disc is rotating at normal speed or 127 when it is rotating at quadruple speed. These values match those of the $256 - n$ for control with VP0 to VP7. (See Table 2-5 and Fig. 2-6.)

In CAV-W mode, the spindle is set to the desired rotational velocity and the operation speed for the entire system follows this rotational velocity. Therefore, the cycles for the Fs system clock, PCM data and all other output signals from this LSI change according to the rotational velocity of the disc.

Note) The capture range for this mode is theoretically up to the signal processing limit.

Note) Set FLFC to 1 for this mode

§3-4. VCO-C Mode

This is VCO control mode. In this mode, the oscillation frequency of the internal master clock (VCLK) can be controlled by setting \$D commands VP0 to VP7 and VPCTL0, 1. The VCLK oscillation frequency can be expressed by the following equation.

$$VCLK = \frac{1(256 - n)}{32}$$

n: VP0 to VP7 setting value
1: VPCTL0, 1 setting value

The VCO1 oscillation frequency is determined by VCLK. The VCO1 frequency can be expressed by the following equation.

- When DSPB = 0

$$VCO1 = VCLK \times \frac{49}{24}$$

- When DSPB = 1

$$VCO1 = VCLK \times \frac{49}{16}$$

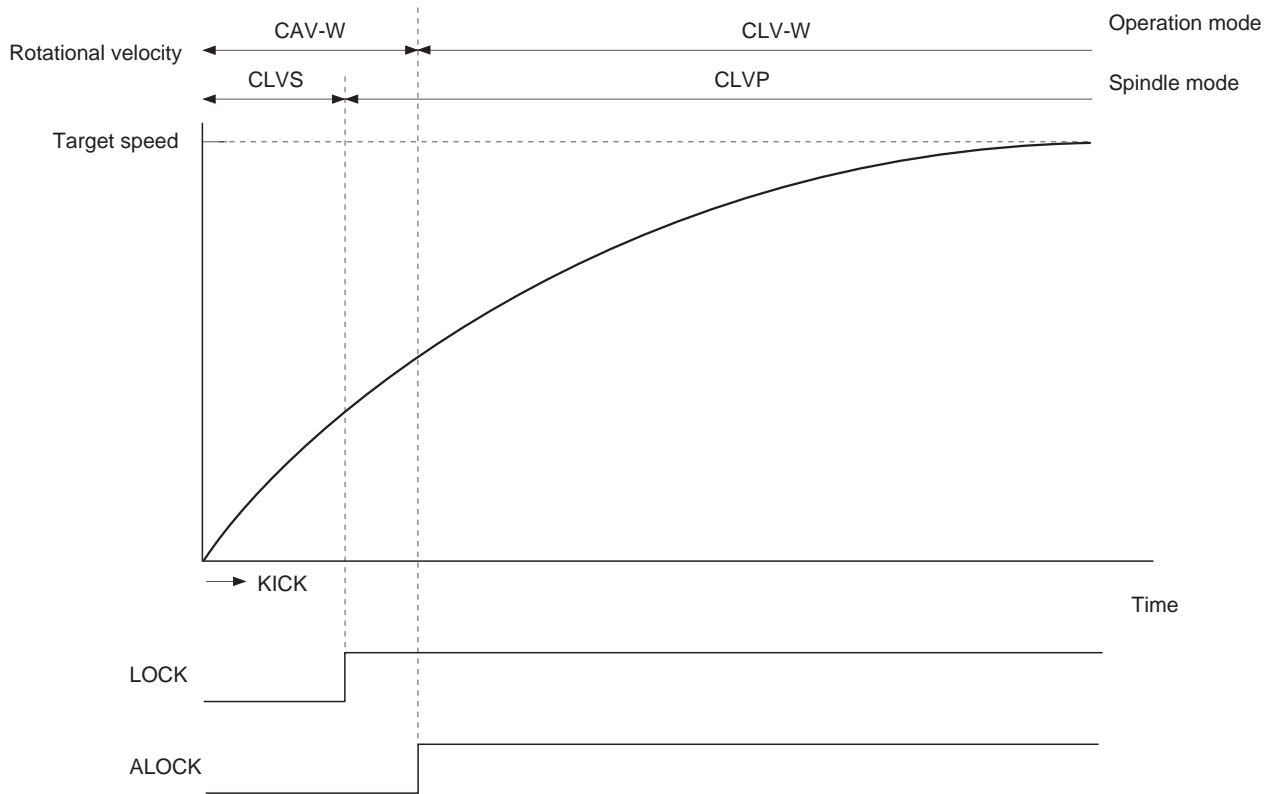


Fig. 3-1. Disc Stop to Regular Playback in CLV-W Mode

CLV-W Mode

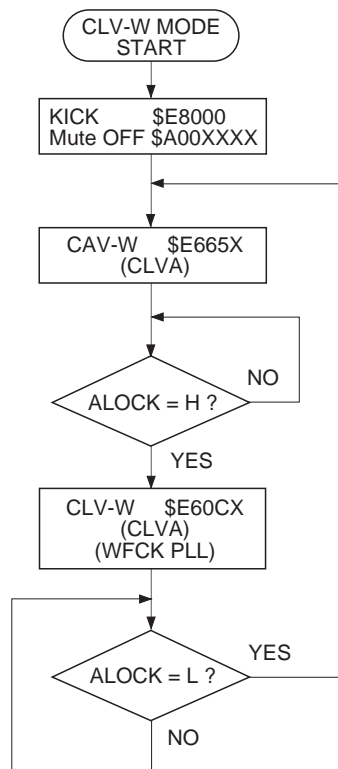


Fig. 3-2. CLV-W Mode Flow Chart

VCO-C Mode

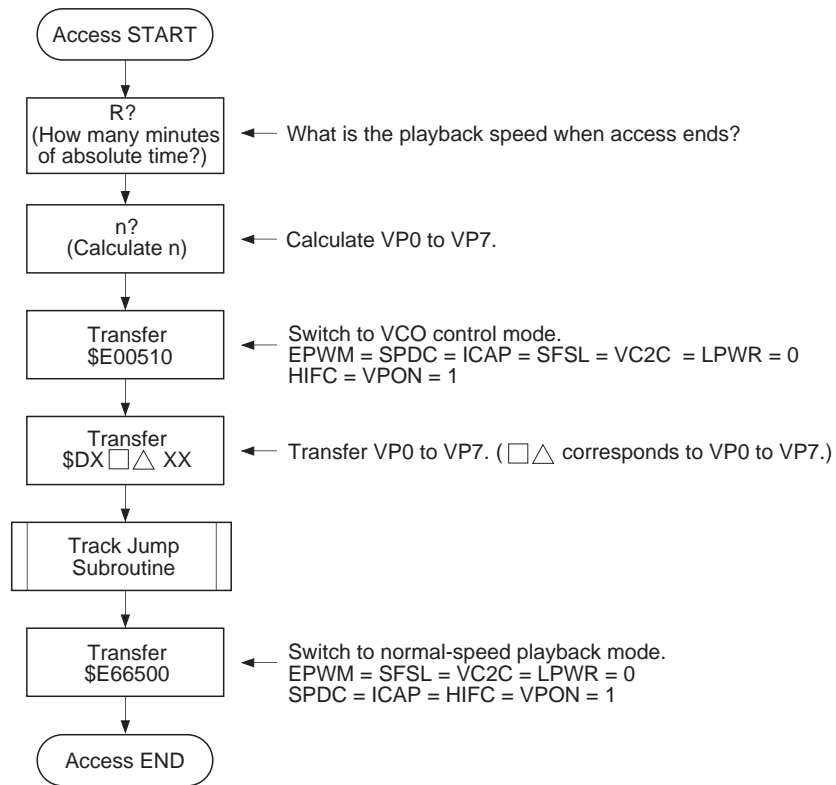


Fig. 3-3. Access Flow Chart Using VCO Control

[4] Description of other functions

§4-1. Channel Clock Recovery by Digital PLL Circuit

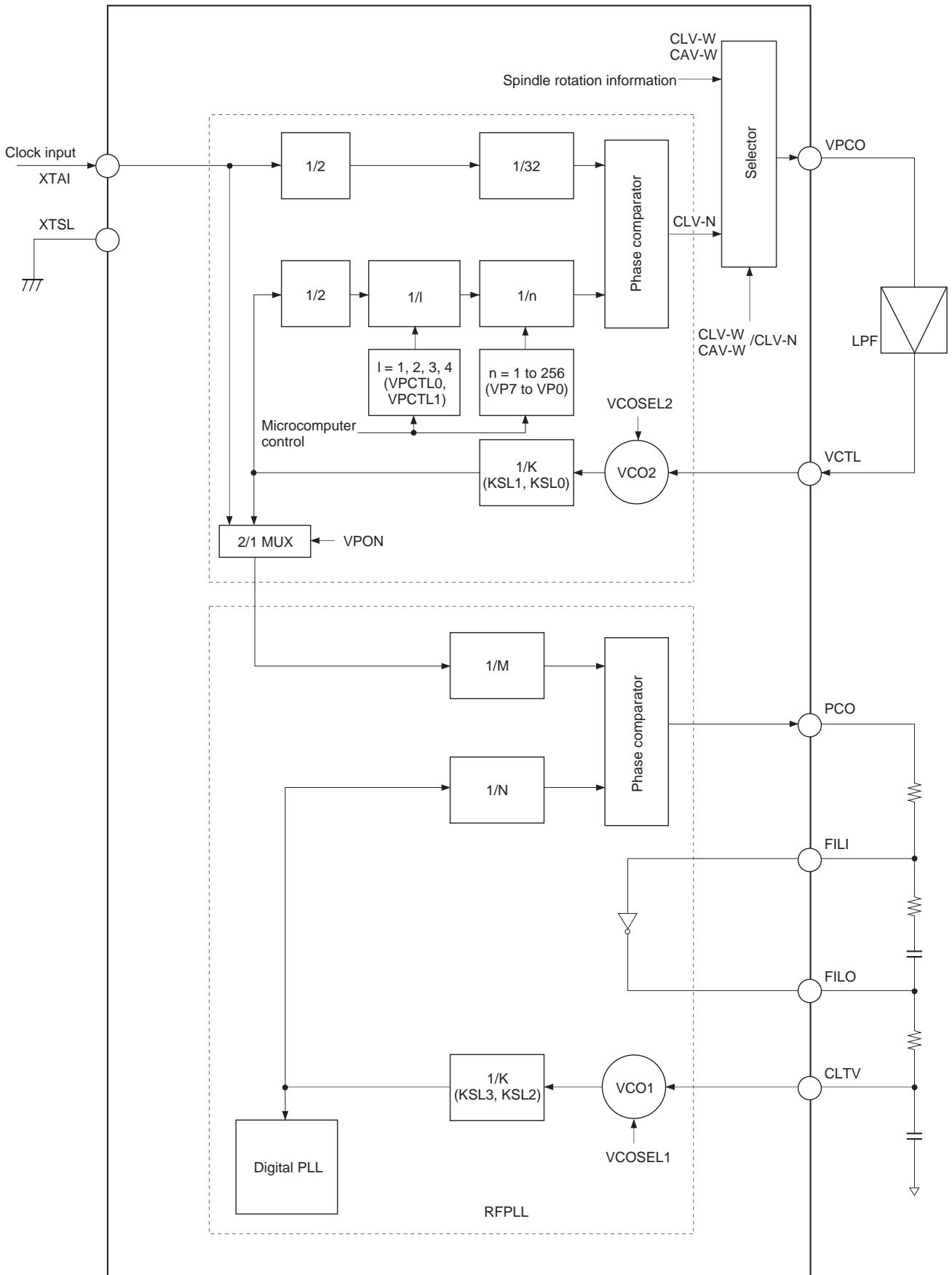
- The channel clock is necessary for demodulating the EFM signal regenerated by the optical system. Assuming T as the channel clock cycle, the EFM signal is modulated in an integer multiple of T from $3T$ to $11T$. In order to read the information in the EFM signal, this integer value must be read correctly. As a result, T , that is the channel clock, is necessary. In an actual player, a PLL is necessary to recover the channel clock because the fluctuation in the spindle rotation alters the width of the EFM signal pulses.

The block diagram of this PLL is shown in Fig. 4-1.

The CXD3027R has a built-in three-stage PLL.

- The first-stage PLL is a wide-band PLL. When using the internal VCO2, an external LPF is necessary. The output of this first-stage PLL is used as a reference for all clocks within the LSI.
- The second-stage PLL generates the high-frequency clock needed by the third-stage digital PLL.
- The third-stage PLL is a digital PLL that recovers the actual channel clock.
- The digital PLL in CLV-N mode has a secondary loop, and is controlled by the primary loop (phase) and the secondary loop (frequency). When $FLFC = 1$, the secondary loop can be turned off. High frequency components such as $3T$ and $4T$ may contain deviations. In such cases, turning the secondary loop off yields better playability. However, in this case the capture range becomes $\pm 50\text{kHz}$.
- A new digital PLL has been provided for CLV-W mode to follow the rotational velocity of the disc in addition to the conventional secondary loop.

Block Diagram 4-1



§4-2. Frame sync protection

- In normal-speed playback, a frame sync is recorded approximately every 136 μ s (7.35kHz). This signal is used as a reference to recognize the data within a frame. Conversely, if the frame sync cannot be recognized, the data is processed as error data because the data cannot be recognized. As a result, recognizing the frame sync properly is extremely important for improving playability.
- In the CXD3027R, window protection and forward protection/backward protection have been adopted for frame sync protection. These functions achieve very powerful frame sync protection. There are two window widths; one for cases where a rotational disturbance affects the player and the other for cases where there is no rotational disturbance (WSEL = 0/1). In addition, the forward protection counter is set to 13*, and the backward protection counter to 3*. Concretely, when the frame sync is being played back normally and then cannot be detected due to scratches, etc., a maximum of 13 frames are inserted. If the frame sync cannot be detected for 13 frames or more, the window opens to resynchronize the frame sync. In addition, immediately after the window opens and the resynchronization is executed, if a proper frame sync cannot be detected within 3 frames, the window opens immediately.

* Default values. These values can be set as desired by \$C commands SFP3 to SFP0 and SRP3 to SRP0.

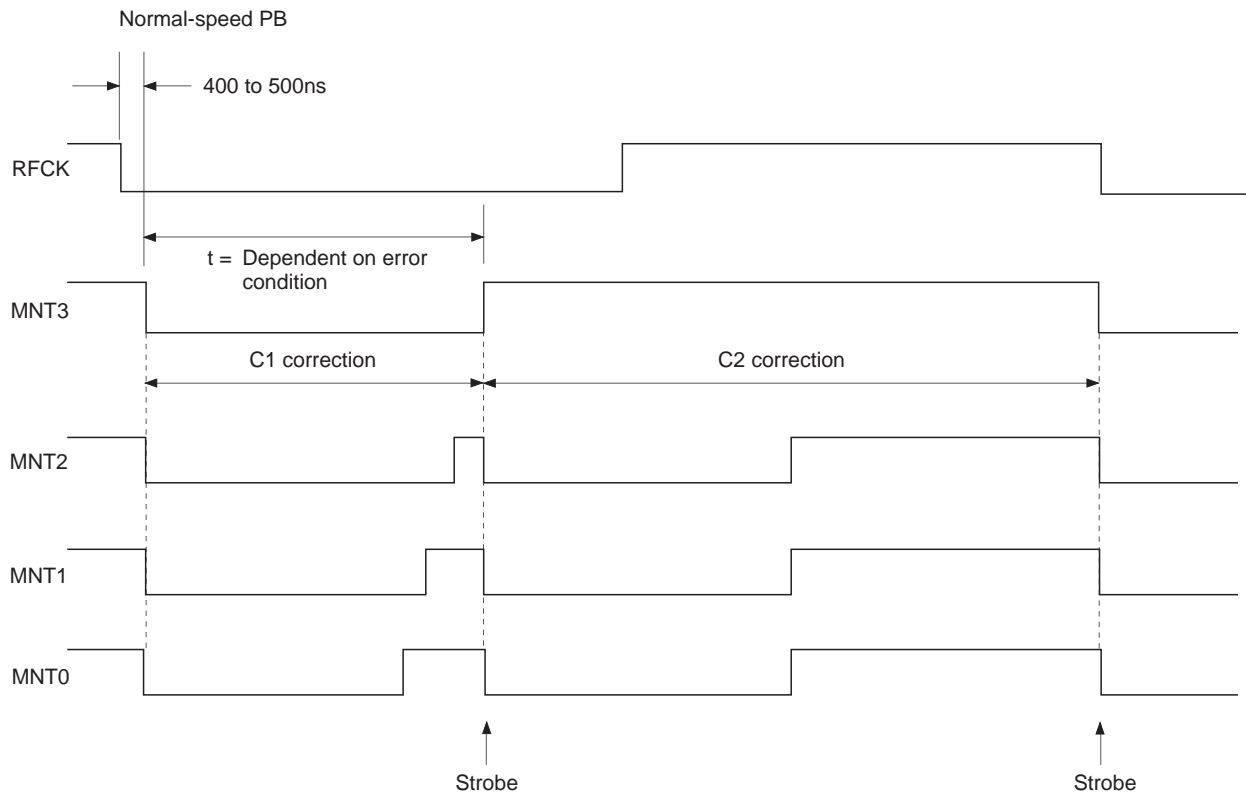
§4-3. Error Correction

- In the CD format, one 8-bit data contains two error correction codes, C1 and C2. For C1 correction, the code is created with 28-byte information and 4-byte C1 parity. For C2 correction, the code is created with 24-byte information and 4-byte parity. Both C1 and C2 are Reed-Solomon codes with a minimum distance of 5.
- The CXD3027R uses refined super strategy to achieve double correction for C1 and quadruple correction for C2.
- In addition, to prevent C2 miscorrection, a C1 pointer is attached to data after C1 correction according to the C1 error status, the playback status of the EFM signal and the operating status of the player.
- The correction status can be monitored externally. See Table 4-2.
- When the C2 pointer is high, the data in question was uncorrectable. Either the pre-value was held or an average value interpolation was made for the data.

MNT3	MNT2	MNT1	MNT0	Description	
0	0	0	0	No C1 errors;	C1 pointer reset
0	0	0	1	One C1 error corrected;	C1 pointer reset
0	0	1	0		—
0	0	1	1		—
0	1	0	0	No C1 errors;	C1 pointer set
0	1	0	1	One C1 error corrected;	C1 pointer set
0	1	1	0	Two C1 errors corrected;	C1 pointer set
0	1	1	1	C1 correction impossible;	C1 pointer set
1	0	0	0	No C2 errors;	C2 pointer reset
1	0	0	1	One C2 error corrected;	C2 pointer reset
1	0	1	0	Two C2 errors corrected;	C2 pointer reset
1	0	1	1	Three C2 errors corrected;	C2 pointer reset
1	1	0	0	Four C2 errors corrected;	C2 pointer reset
1	1	0	1		—
1	1	1	0	C2 correction impossible;	C1 pointer copy
1	1	1	1	C2 correction impossible;	C2 pointer set

Table 4-2.

Timing Chart 4-3



§4-4. DA Interface

- The DA interface supports the 48-bit slot interface.

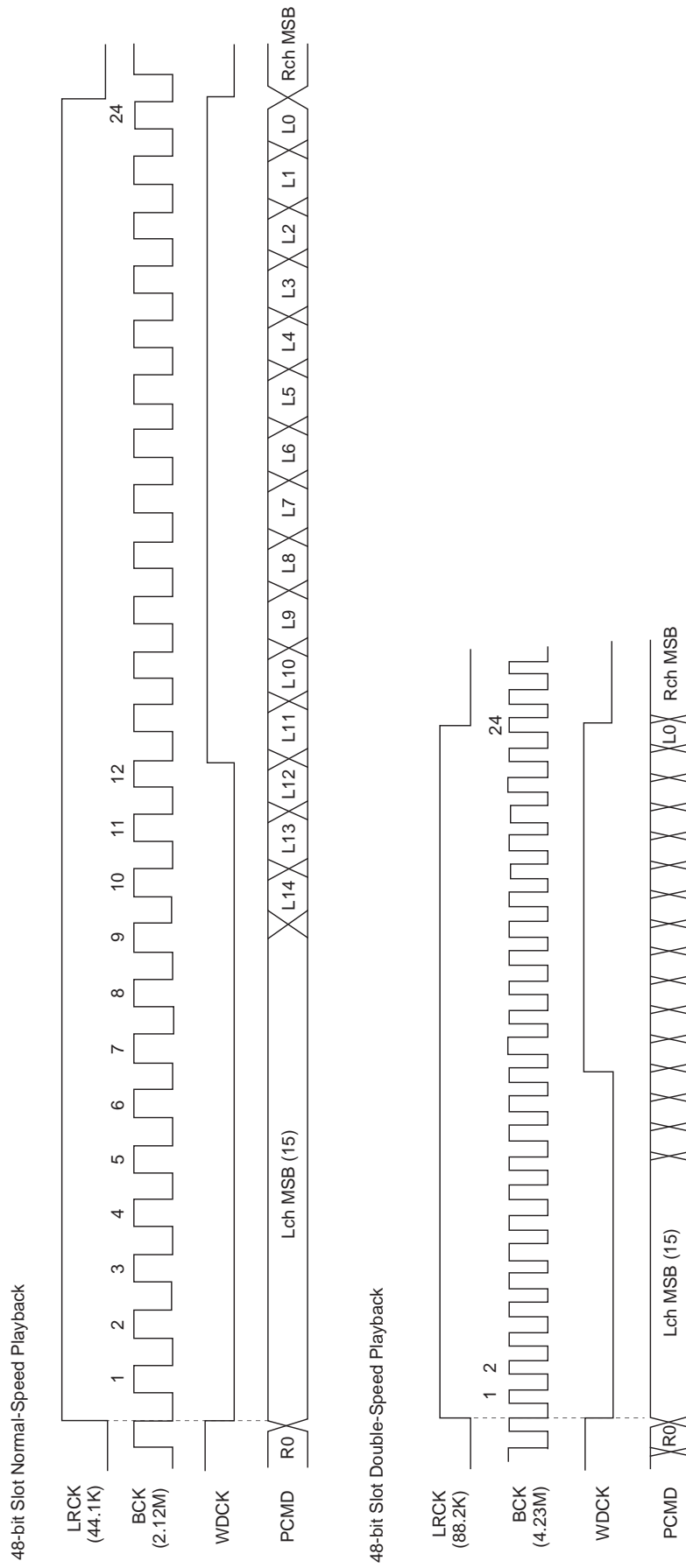
48-bit slot interface

This interface includes 48 cycles of the bit clock within one LRCK cycle, and is MSB first.

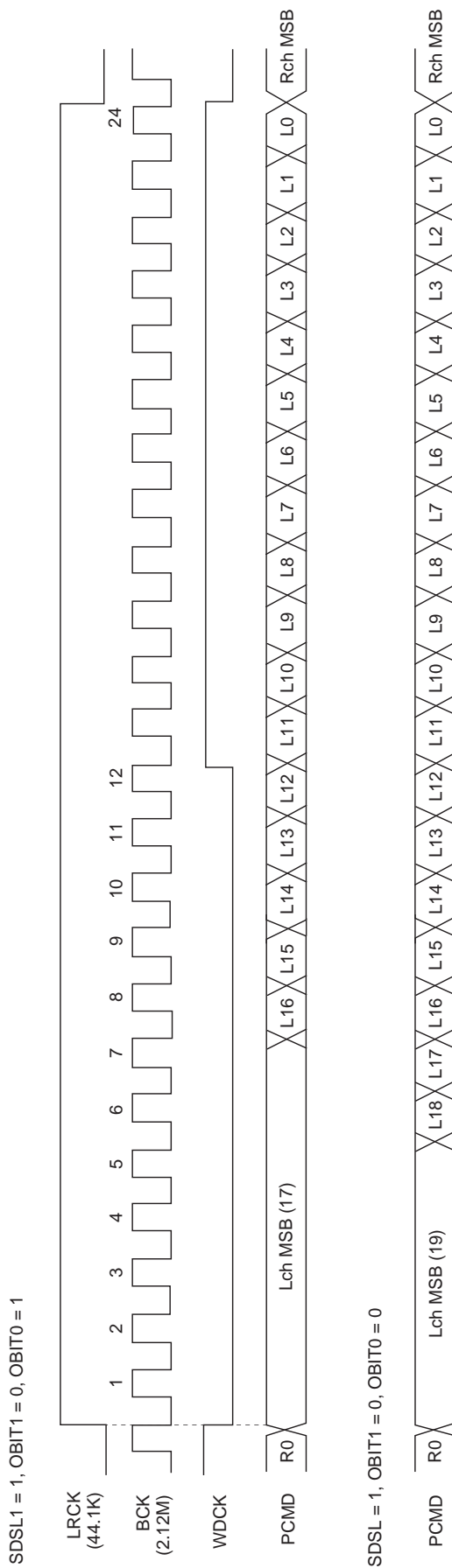
When LRCK is high, the data is for the left channel.

The output format from the bass boost block supports 18 bits and 20 bits in addition to 16 bits.

Timing Chart 4-4



Timing Chart 4-5 (DAC output selected)



§4-5. Digital Out

There are three Digital Out: the type 1 format for broadcasting stations, the type 2 form 1 format for home use, and the type 2 form 2 format for the manufacture of software.

The CXD3027R supports type 2 form 1.

This LSI supports two kinds of Digital Out generation methods; generation from the PCM data read out from the disc, and generation from the DA interface inputs (PCMDI, LRCKI, BCKI).

§4-5-1. Digital Out from PCM Data

The Digital Out is generated from the PCM data which is read out from the disc.

The clock accuracy of the channel status is automatically set to level II when the crystal clock is used and to level III in CAV-W mode or variable pitch mode. In addition, the subcode-Q data matched twice in succession with CRC check are input to the initial 4 bits (bits 0 to 3).

DOUT is output when the crystal is 34MHz and XTSL is high in CLV-N or CLV-W mode with DSPB = 1. Therefore, DOUT is set to off by setting the \$B command MD2 to 0.

Digital Out C bit

	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
0	From sub Q ← ID0 ID1 COPY Emph →				0	0	0	0	1	0	0	0	0	0	0	0
16	0	0	0	0	0	0	0	0	0	0	0	0	0	0/1	0	0
32	0															
48																
64																
176																

bits 0 to 3 Subcode-Q control bits that matched twice in succession with CRCOK
 bit 29 VPON or VARION: 1 X'tal: 0

Table 4-5-1.

§4-5-2. Digital Out from DA Interface Input

The Digital Out is generated from the DA interface input.

Validity Flag and User Data

The Validity Flag is fixed to 0.

The User Data is fixed to 0 or it can be output according to the format by setting 0 data.

For the Q data, first set the Q1 to Q80 data using the \$A90 to \$A99 commands, then the set data can be output according to the digital interface format using the \$A9A command. In addition, CRC operations are performed internally on the Q81 to Q96 data and then this data is output.

The data is output in the order shown in Table 4-5-2.

The setting flow is shown in Figs. 4-5 (a) and 4-5 (b). Fig. 4-5 (a) shows the case when changing all the data, and Fig. 4-5 (b) the case when changing the INDEX, movement time and absolute time.

	0	1	2	3	4	5	6	7	8	9	10	11
0	0	0	0	0	0	0	0	0	0	0	0	0
12	0	0	0	0	0	0	0	0	0	0	0	0
24	1	Q1	0	0	0	0	0	0	0	0	0	0
36	1	Q2	0	0	0	0	0	0	0	0	0	0
48	1	Q3	0	0	0	0	0	0	0	0	0	0
:	:	:	:	:	:	:	:	:	:	:	:	:
1164	1	Q96	0	0	0	0	0	0	0	0	0	0

Table 4-5-2.

Channel Status Data

For the Channel Status Data, bits 0, 6 and 7 are fixed to 0. The following items can be set by bits 1, 2, 3 and 8.

- a) Digital data/audio data
- b) Digital copy enabled/prohibited
- c) With/without emphasis
- d) Category code (2 types possible)

Digital Out C bit

	0	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15
0	0	A/D SEL	COPY En	EMPH D	0	0	0	0	CAT b8	0	0	0	0	0	0	0
16	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
32	0															
48																
64																
176																

Table 4-5-3.

Note) In this method, DOUT can be set to off by setting \$B command MD2 to 0 and \$34A command DOUT EN to 0.

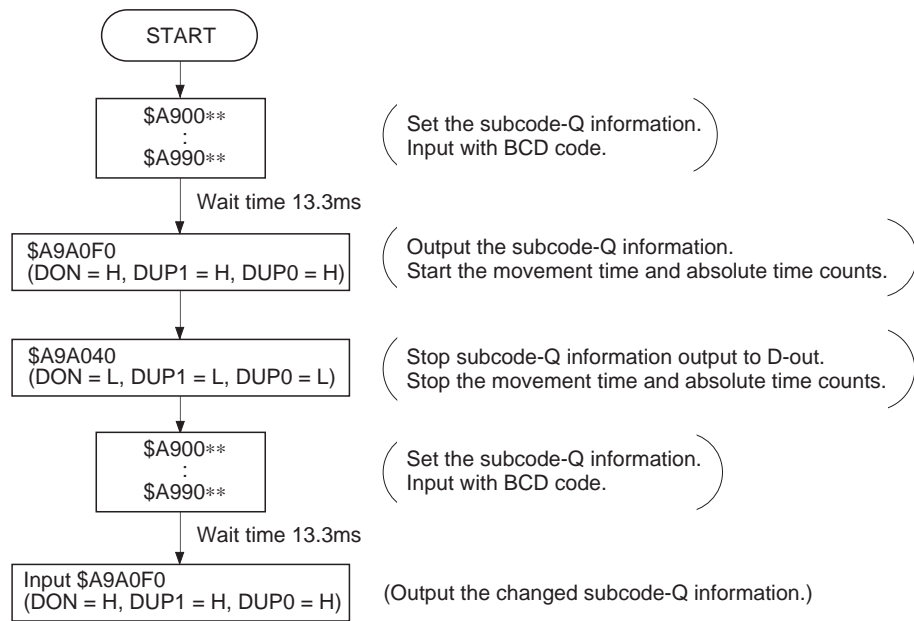


Fig. 4-5(a). Flow Chart for Settings Using Q Data

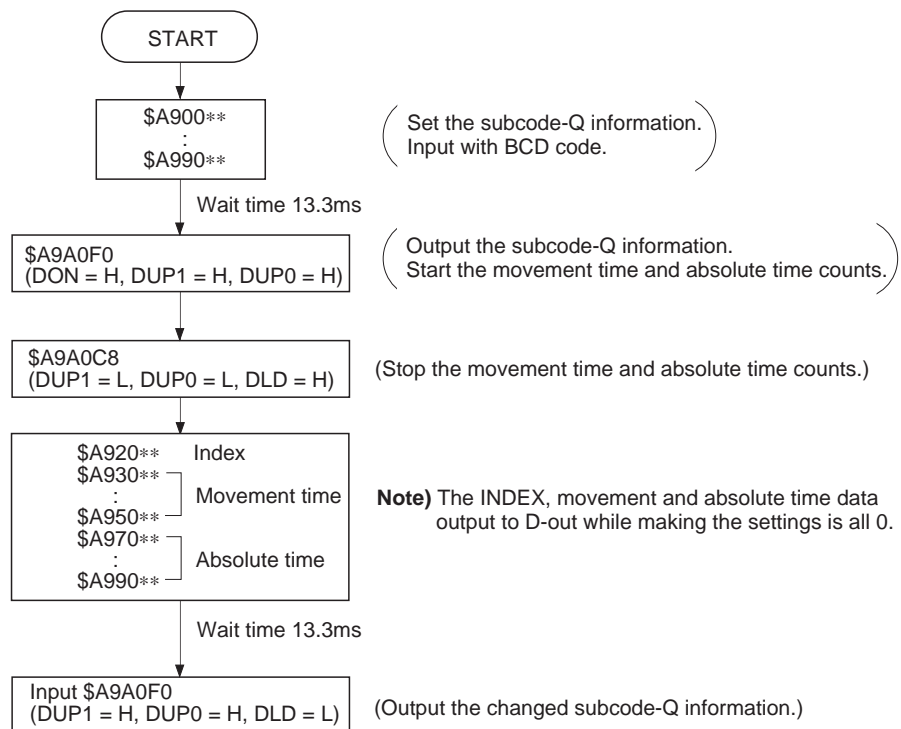


Fig. 4-5(b). Flow Chart for Settings Using Q Data

Digital Audio Data Input

The input signal of the digital audio data is input through the DAC input signal pins PCMDI, LRCKI and BCKI. The input format supports the 48-bit slot, MSB first.

Mute Function

By setting the command bit DOUT_DMUT to 1, all the audio data portions in the Digital Out output can be set to 0 without altering the Channel Status Data.

Input/Output Synchronization Circuit

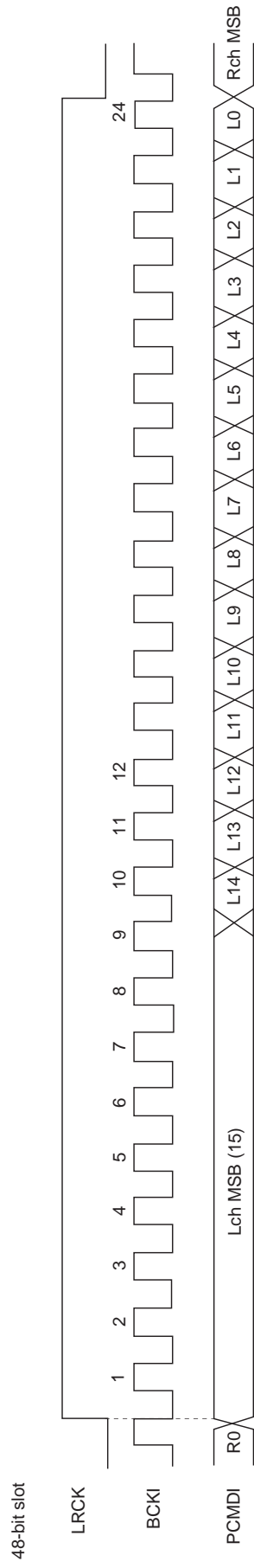
In normal operation, the DAC automatically synchronizes with the input LRCK. However, synchronization may not be achieved when the input data contains much jitter or during power-on, etc. In such cases, internal operation should be forcibly resynchronized by setting the \$34A command DOUT WOD to 1. Forced synchronization is also required when the operating frequency is changed such as switching between CLV and CAV, etc. Be sure to set DOUT WOD to 0 and then to 1 for forced resynchronization.

* Resynchronization clears the internal frame counter so that the count starts over from frame 0 after the resynchronization processing. In cases where automatic resynchronization processing is not desirable or the user wants to do it manually, set the \$34A command WINEN to 0 to disable the resynchronization circuit.

DOUT Circuit Clock System

For the DOUT block, the master clock is set using the clock control command MCSL (\$A) employed by the DAC block. Set MCSL to 1 for 768fs, and to 0 for 384fs.

DOUT Block Input Timing Chart



§4-6. Servo Auto Sequence

This function performs a series of controls, including auto focus and track jumps. When the auto sequence command is received from the CPU, auto focus, 1-track jump, 2N-track jump, fine search and M-track move are executed automatically.

The servo block operates according to the built-in program during the auto sequence execution (when XBUSY = low), so that commands from the CPU, that is \$0, 1, 2 and 3 commands, are not accepted. (\$4 to E commands are accepted.)

In addition, when using the auto sequence, turn the A.SEQ ON-OFF of register 9 on.

When CLOK goes from low to high while XBUSY is low, XBUSY does not become high for a maximum of 100µs after that point. This is to prevent the transfer of erroneous data to the servo when XBUSY changes from low to high by the monostable multivibrator, which is reset by CLOK being low (when XBUSY is low).

In addition, a MAX timer is built into this LSI as a countermeasure against abnormal operation due to external disturbances, etc. When the auto sequence command is sent from the CPU, this command assumes a \$4XY format, in which X specifies the command and Y sets the MAX timer value and timer range. If the executed auto sequence command does not terminate within the set timer value, the auto sequence is interrupted (like \$40). See "[1] \$4X commands" concerning the timer value and range. Also, the MAX timer is invalidated by inputting \$4X0.

Although this command is explained in the format of \$4X in the following command descriptions, the timer value and timer range are actually sent together from the CPU.

(a) Auto focus (\$47)

Focus search-up is performed, FOK and FZC are checked, and the focus servo is turned on.

If \$47 is received from the CPU, the focus servo is turned on according to Fig. 4-6. The auto focus starts with focus search-up, and note that the pickup should be lowered beforehand (focus search-down). In addition, blind E of register 5 is used to eliminate FZC chattering. Concretely, the focus servo is turned on at the falling edge of FZC after FZC has been continuously high for a longer time than E.

(b) Track jump

1, 10 and 2N-track jumps are performed respectively. Always use this when the focus, tracking, and sled servos are on. Note that tracking gain-up and braking-on (\$17) should be sent beforehand because they are not involved in this sequence.

- 1-track jump

When \$48 (\$49 for REV) is received from the CPU, a FWD (REV) 1-track jump is performed in accordance with Fig. 4-7. Set blind A and brake B with register 5.

- 10-track jump

When \$4A (\$4B for REV) is received from the CPU, a FWD (REV) 10-track jump is performed in accordance with Fig. 4-8. The principal difference from the 1-track jump is to kick the sled. In addition, after kicking the actuator, when 5 tracks have been counted through COUT, the brake is applied to the actuator. Then, when the actuator speed is found to have slowed up enough (determined by the COUT cycle becoming longer than the overflow C set with register 5), the tracking and sled servos are turned on.

- 2N-track jump

When \$4C (\$4D for REV) is received from the CPU, a FWD (REV) 2N-track jump is performed in accordance with Fig. 4-9. The track jump count N is set with register 7. Although N can be set to 2^{16} tracks, note that the setting is actually limited by the actuator. COUT is used for counting the number of jumps when N is less than 16, and MIRR is used when N is 16 or more.

Although the 2N-track jump basically follows the same sequence as the 10-track jump, the one difference is that after the tracking servo is turned on, the sled continues to move only for "D", set with register 6.

- Fine search

When \$44 (\$45 for REV) is received from the CPU, a FWD (REV) fine search (N-track jump) is performed in accordance with Fig. 4-10. The differences from a 2N-track jump are that a higher precision is achieved by controlling the traverse speed, and a longer distance jump can be performed by controlling the sled. The track jump count N is set with register 7. N can be set to 2^{16} tracks. After kicking the actuator and sled, the traverse speed is controlled based on the overflow G. Set kick D and F with register 6 and overflow G with register 5. Also, sled speed control during traverse can be turned off by causing COMP to fall. Set the number of tracks during which COMP falls with register B. After N tracks have been counted through COUT, the brake is applied to the actuator and sled. (This is performed by turning on the tracking servo for the actuator, and by kicking the sled in the opposite direction during the time for kick D set with register 6.) Then, the tracking and sled servos are turned on.

Set overflow G to the speed required to slow up just before the track jump terminates. (The speed should be such that it will come on-track when the tracking servo turns on at the termination of the track jump.) For example, set the target track count N – a for the traverse monitor counter which is set with register B, and COMP will be monitored. When the falling edge of this COMP is detected, overflow G can be set again.

- M-track move

When \$4E (\$4F for REV) is received from the CPU, a FWD (REV) M-track move is performed in accordance with Fig. 4-11. M can be set to 2^{16} tracks. Like the 2N-track jump, COUT is used for counting the number of moves when M is less than 16, and MIRR is used when M is 16 or more. The M-track move is executed by moving only the sled, and is therefore suited for moving across several thousand to several ten-thousand tracks. In addition, the track and sled servos are turned off after M tracks have been counted through COUT or MIRR unlike for the other jumps. Transfer \$25 from the microcomputer after the actuator has stabilized.

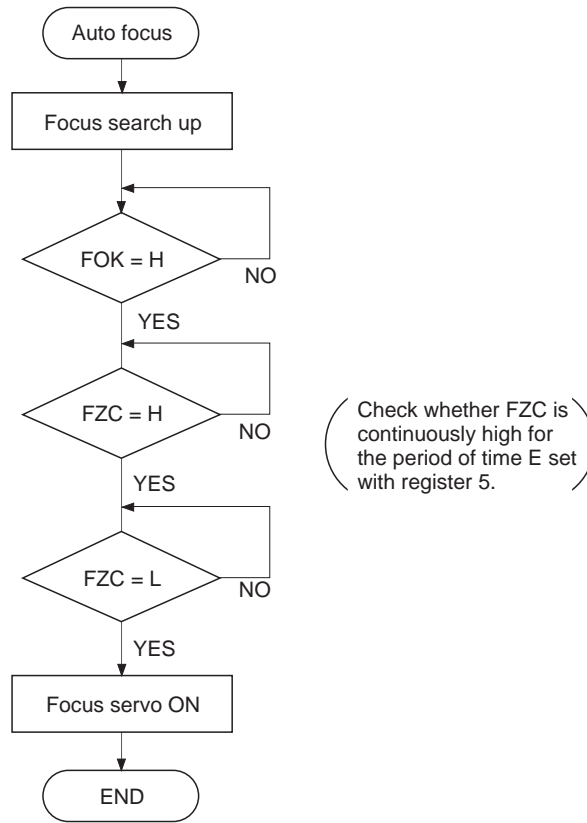


Fig. 4-6-(a). Auto Focus Flow Chart

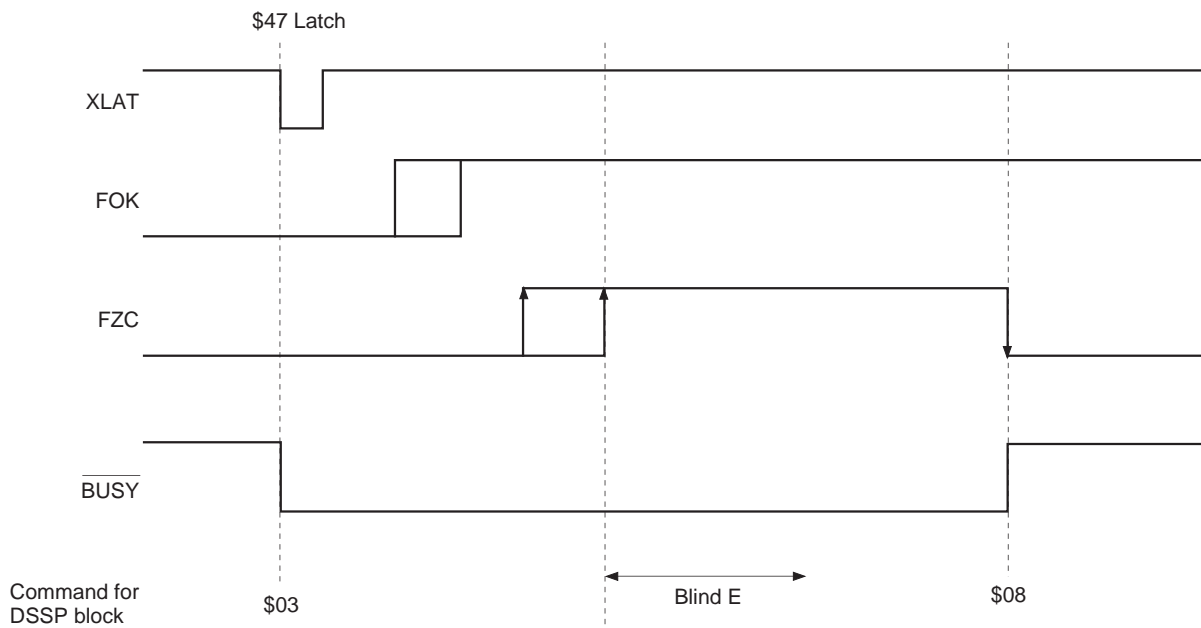


Fig. 4-6-(b). Auto Focus Timing Chart

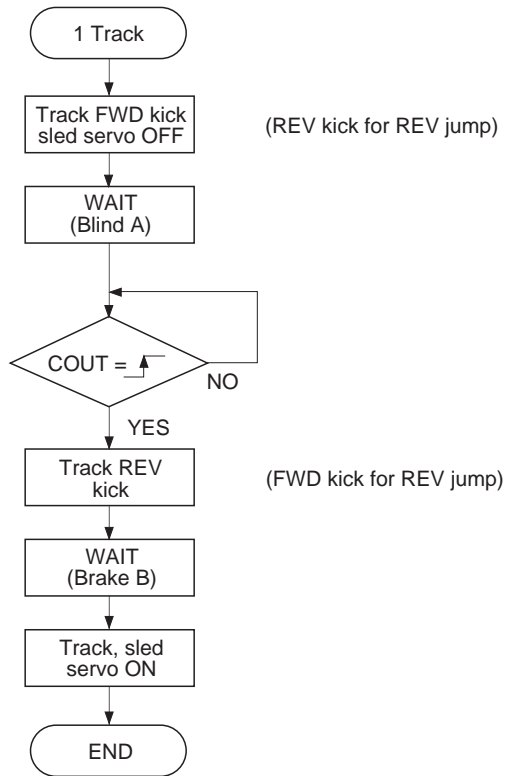


Fig. 4-7-(a). 1-Track Jump Flow Chart

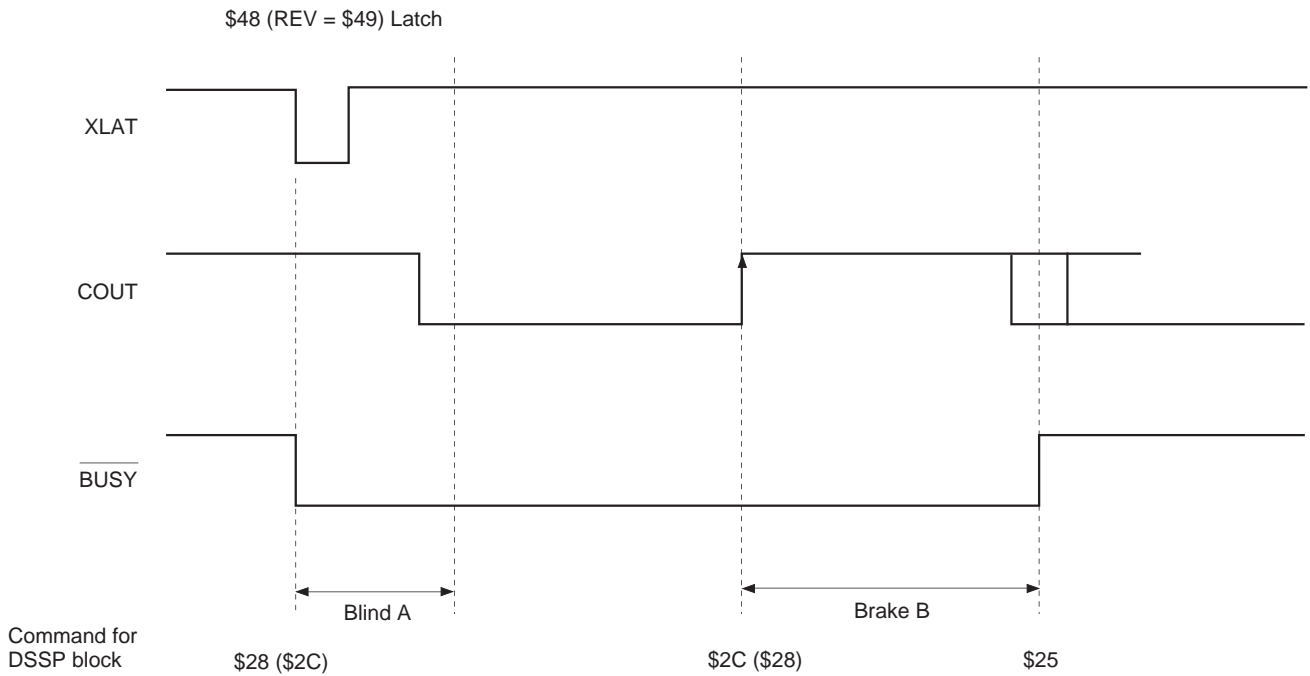


Fig. 4-7-(b). 1-Track Jump Timing Chart

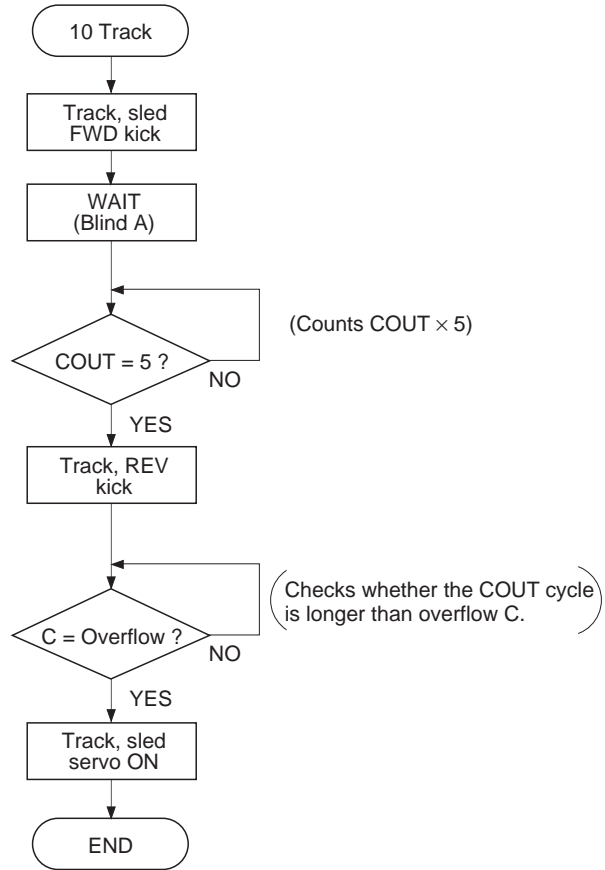


Fig. 4-8-(a). 10-Track Jump Flow Chart

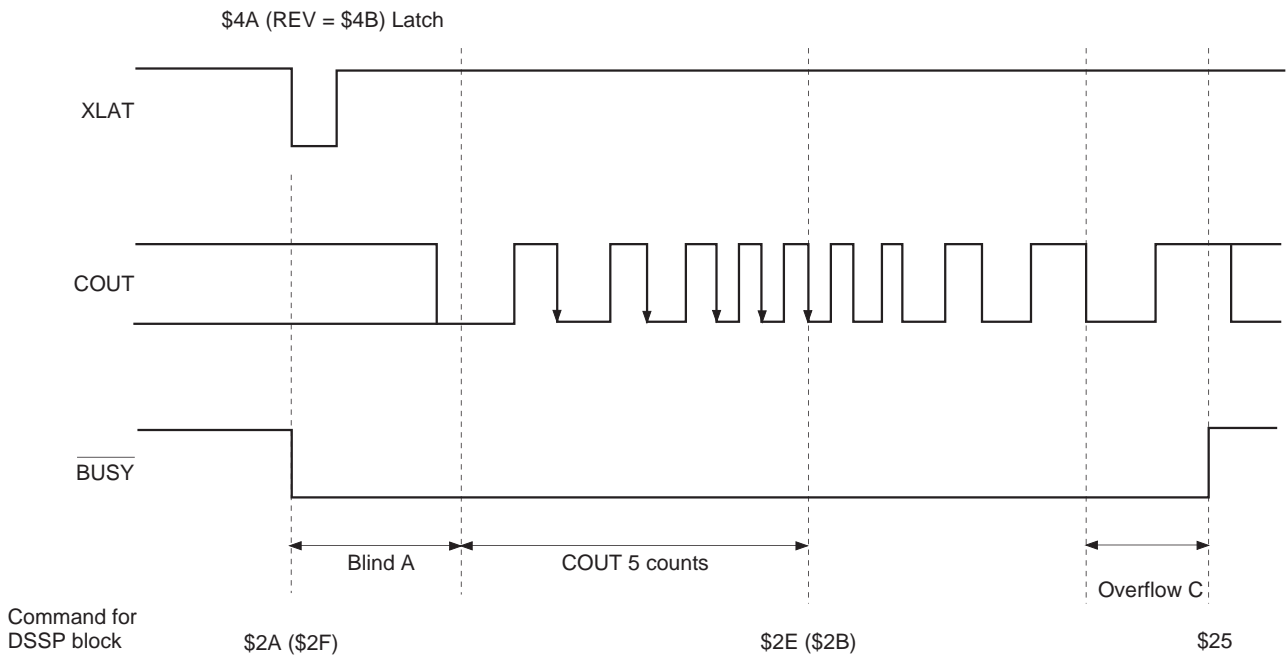


Fig. 4-8-(b). 10-Track Jump Timing Chart

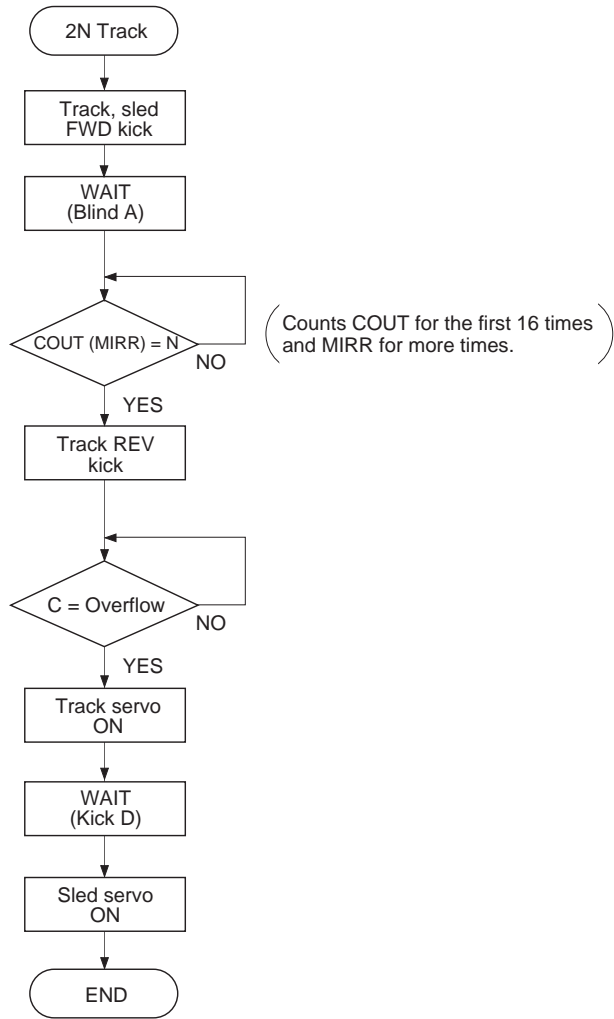


Fig. 4-9-(a). 2N-Track Jump Flow Chart

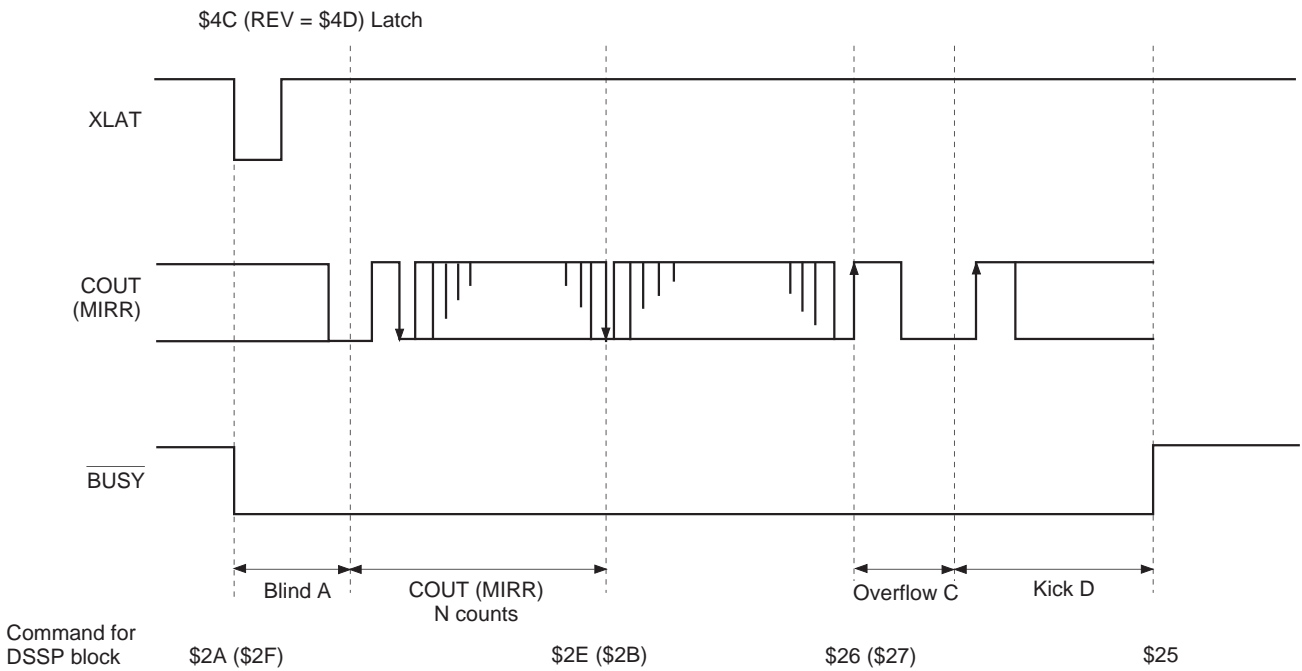


Fig. 4-9-(b). 2N-Track Jump Timing Chart

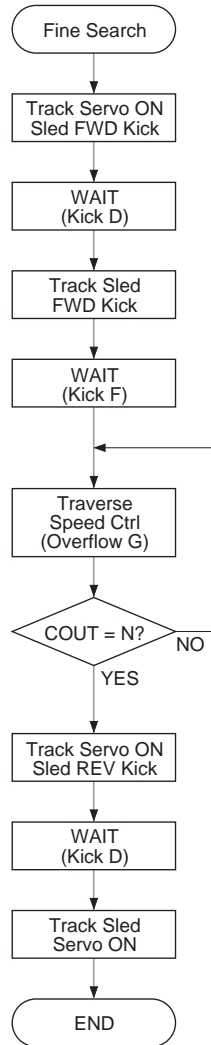


Fig. 4-10-(a). Fine Search Flow Chart

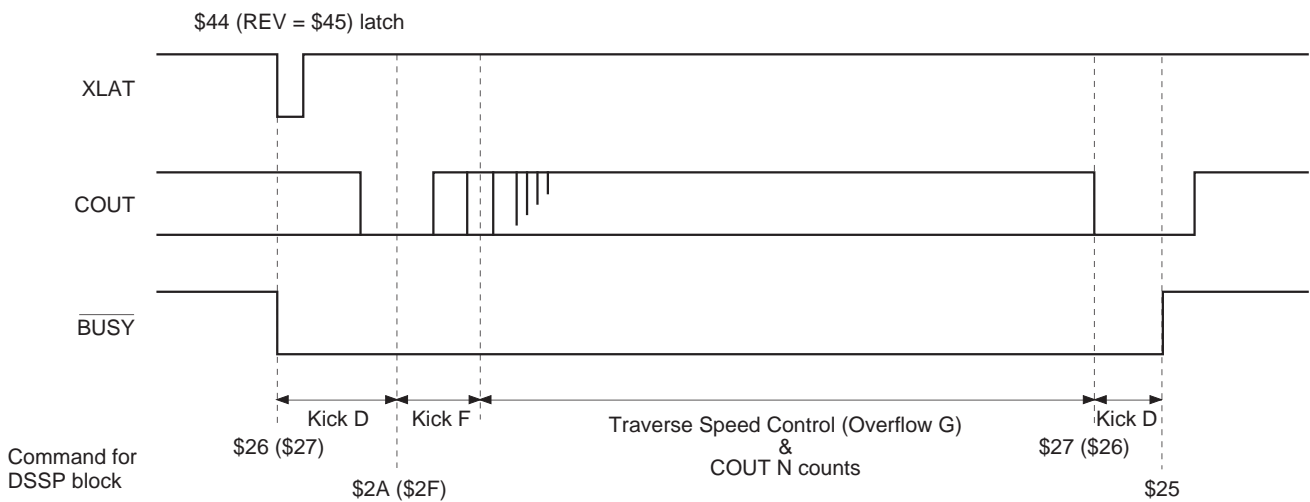


Fig. 4-10-(b). Fine Search Timing Chart

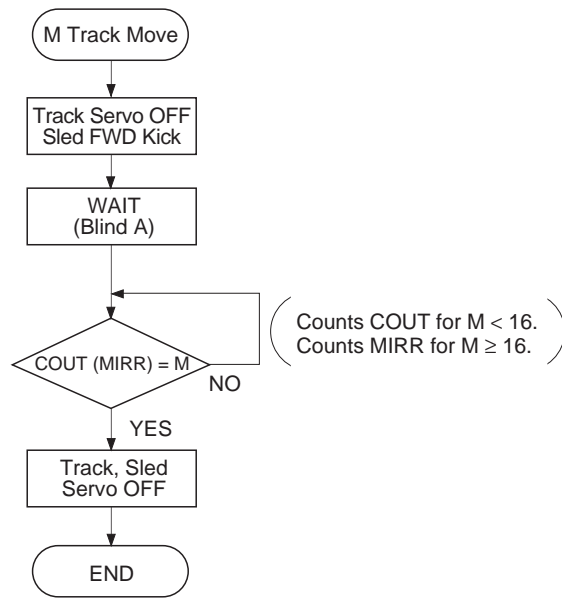


Fig. 4-11-(a). M-Track Move Flow Chart

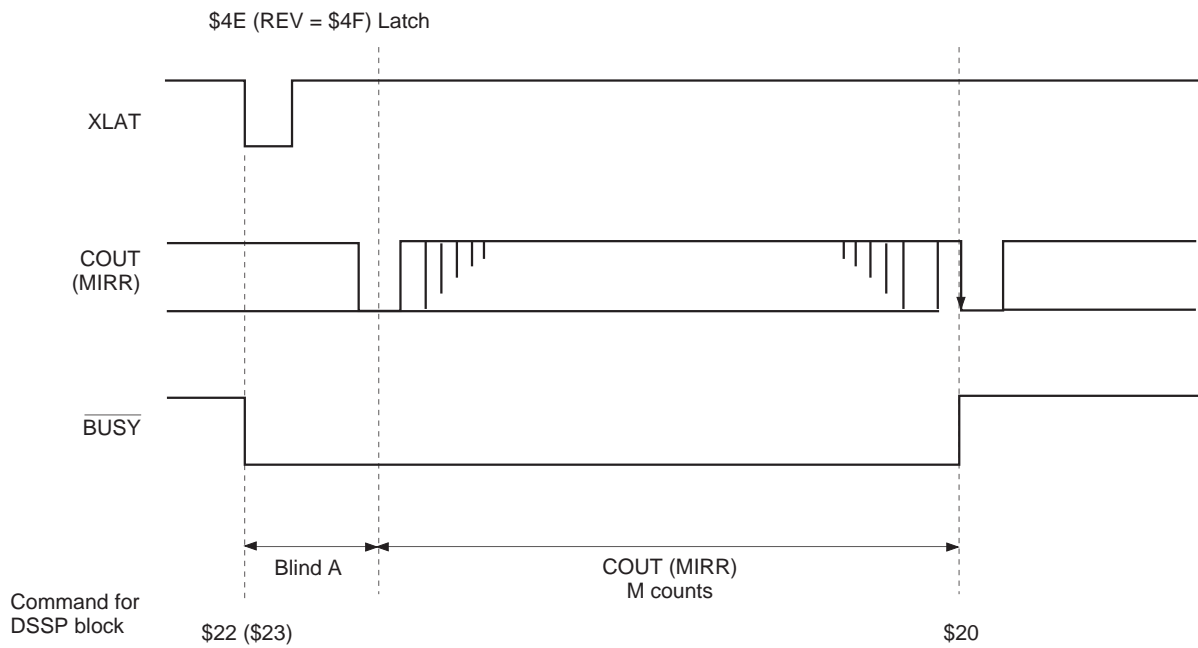
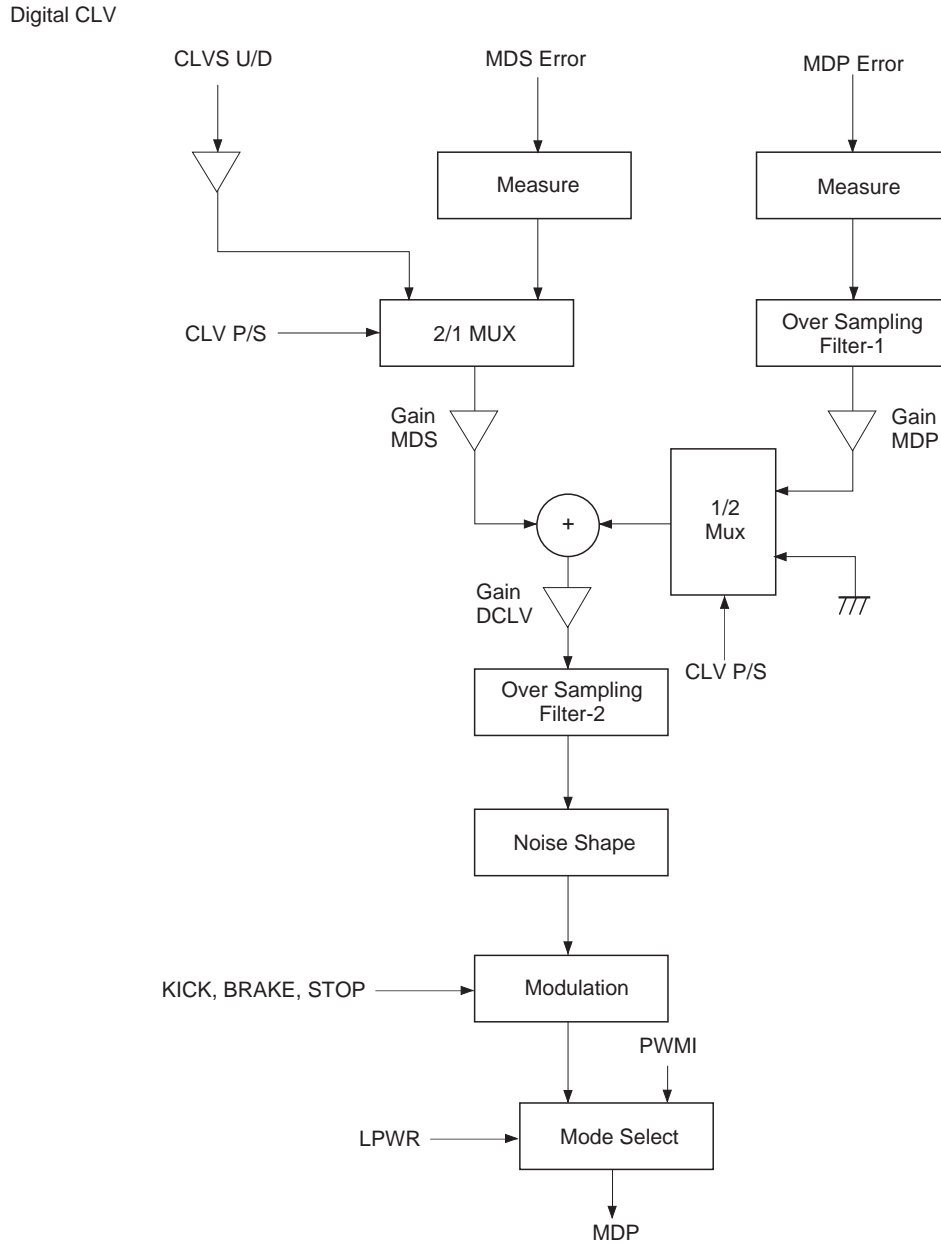


Fig. 4-11-(b). M-Track Move Timing Chart

§4-7. Digital CLV

Fig. 4-12 shows the block diagram. Digital CLV outputs MDS error and MDP error signals with PWM, with the sampling frequency increased up to 130kHz during normal-speed playback in CLVS, CLVP and other modes. In addition, the digital spindle servo gain is variable.



CLVS U/D: Up/down signal from CLVS servo
 MDS error: Frequency error for CLVP servo
 MDP error: Phase error for CLVP servo
 PWMI: Spindle drive signal from the microcomputer for CAV servo

Fig. 4-12. Block Diagram

§4-8. CD-DSP Block Playback Speed

In the CXD3027R, the following playback modes can be selected through different combinations of the XTAI, XTSL pins, double-speed command (DSPB), VCO1 selection command (VCOSEL1), VCO1 frequency division commands (KSL3, KSL2) and command transfer rate selector (ASHS) in CLV-N or CLV-W mode.

Mode	XTAI	XTSL	DSPB	VCOSEL1*1	ASHS	Playback speed	Error correction*2
1	768Fs	1	0	0/1	0	1×	C1: double; C2: quadruple
2	768Fs	1	1	0/1	0	2×	C1: double; C2: double
3	768Fs	0	0	1	1	2×	C1: double; C2: quadruple
4	768Fs	0	1	1	1	4×	C1: double; C2: double
5	384Fs	0	0	0/1	0	1×	C1: double; C2: quadruple
6	384Fs	0	1	0/1	0	2×	C1: double; C2: double
7	384Fs	1	1	0/1	0	1×	C1: double; C2: double

*1 Actually, the optimal value should be used together with KSL3 and KSL2.

*2 When \$8 command ERC4 = 1, C2 is quadruple correction even when DSPB = 1.

The playback speed can be varied by setting VP0 to VP7 in CAV-W mode. See "[3] Description of Modes" for details.

§4-9. Description of DAC Block and Shock-Proof Memory Controller Block Circuits

The CXD3027R inputs data from the CD-DSP block to the DAC block via the shock-proof memory controller block.

The data from the shock-proof memory controller block is output externally as bass-boosted data via the DBB circuit.

When not using the DAC block, the data from the shock-proof memory controller block can be output directly to the outside of the LSI.

Also, when not using the shock-proof memory controller, the data can be input directly from the CD-DSP block to the DAC block.

The DAC block output format supports 16, 18 or 20 bits.

§4-10. DAC Block Input Timing

Fig. 4-13 shows the input timing chart to the DAC block. The CXD3027R can transfer data from the CD-DSP block to the DAC block via an external route. This allows the data to be sent to the DAC block via an audio DSP, etc.

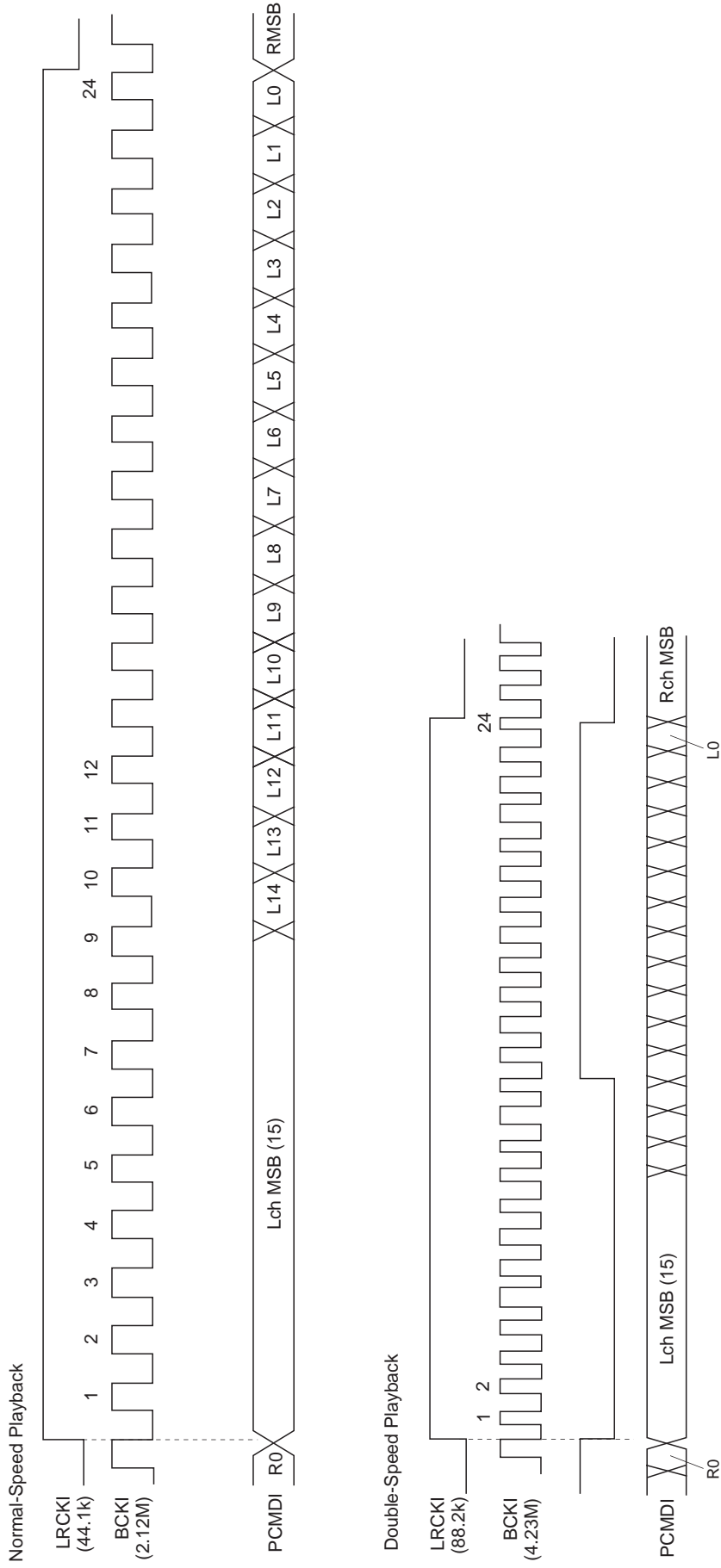


Fig. 4-13. Input Timing to the DAC Block

§4-11. Description of DAC Block Functions

Zero Data Detection

When the condition where the lower 4 bits of the input data are DC and the remaining upper bits are all 0 or all 1 has continued for about 300ms (16384/44.1kHz), zero data is detected. Zero data detection is performed independently for the left and right channels.

Mute flag output

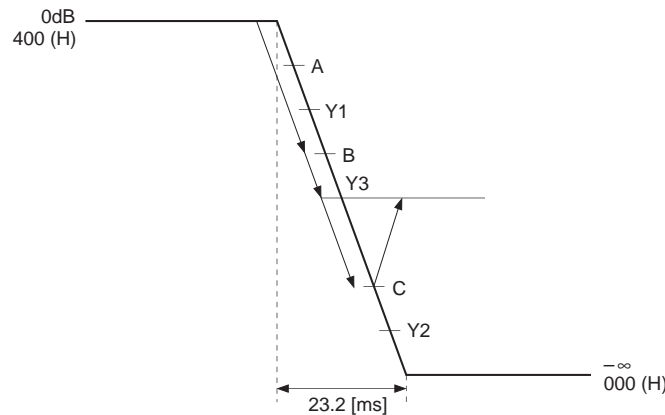
The LRMU pin goes active when any one of the following conditions is met.

The polarity can be selected by the \$A5X command ZDPL.

- When zero data is detected
- When a high signal is input to the SYSM pin and zero data is detected
- When the \$A5 command SMUT is set and zero data is detected

Attenuation Operation

Assuming the attenuation commands X1, X2 and X3, the corresponding audio outputs are Y1, Y2 and Y3 (Y1 > Y3 > Y2). First, the command X1 is sent and then the audio output approaches Y1. When the command X2 is sent before the audio output reaches Y1 (A in the figure), the audio output passes Y1 and approaches Y2. And, when the command X3 is sent before the audio output reaches Y2 (B or C in the figure), the audio output approaches Y3 from the value (B or C in the figure) at that point.

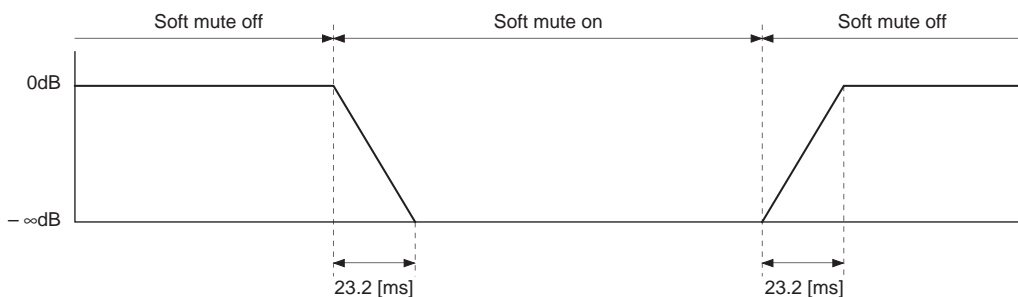


DAC Block Mute Operation

Soft mute

Soft mute results and the input data is attenuated to zero when any one of the following conditions is met.

- When attenuation data of 000 (h) is set
- When \$A5 command SMUT is set to 1
- When a high signal is input to the SYSM pin



Zero detection mute

Analog mute is applied to the respective channel when \$AX command ZMUTA is set to 0 and zero data is detected for the left or right channel. (See "Zero data detection".)

When \$AX command ZMUTA is set to 0, analog mute is applied even if the mute flag output condition is met.

LRCK Synchronization

Synchronization is performed at the first rising edge of the LRCK input when reset.

After that, synchronization is lost when the LRCK input frequency changes, etc., so resynchronization must be performed.

The LRCK input frequency changes when the master clock of the LSI is switched and the playback speed changes such as the following cases.

- When the XTSL pin switches between high and low
- When the \$9 command DSPB setting changes
- When the \$A4 command MCSL setting changes
- When operation switches between CLV mode and CAV mode

For resynchronization, set the \$A5 command XWOC to 1, wait for one LRCK cycle or more, and then set XWOC to 0.

* When setting XWOC to 1, be sure to set the \$9X command SYCOF to 0 beforehand.

SYCOF

When LRCK, PCMD and BCK are connected directly with LRCKI, PCMDI and BCKI, respectively, playback can be performed easily in CAV-W mode by setting the \$AX command SYCOF to 1.

Normally, the memory proof, etc., is used for playback in CAV-W mode.

In CAV-W mode, the LRCK output conforms not to the crystal but to the VCO. Therefore, synchronization is frequently lost.

Setting the \$AX command SYCOF to 1 ignores the LRCKI input asynchronization, facilitating playback. However, the playback is not perfect because pre-value hold or data skip occurs due to the wow and flutter in the LRCKI input, etc.

* Set SYCOF to 0 other than when performing playback in CAV-W mode with LRCK, PCMD and BCK connected directly to LRCKI, PCMDI and BCKI, respectively.

Digital High and Bass Boost

High and bass boost without external parts is possible using the built-in digital filter.

Perform the following operations when turning boost off or when lowering the current boost level.

1. Set \$AX command BSTCL to 1.
2. Wait 20ms or more, set the boost level or turn boost off, then set \$AX command BSTCL to 0.

High-Cut Filter

This filter lowers the high-frequency level by approximately 8dB.

The frequency response is shown in Fig. 4-14.

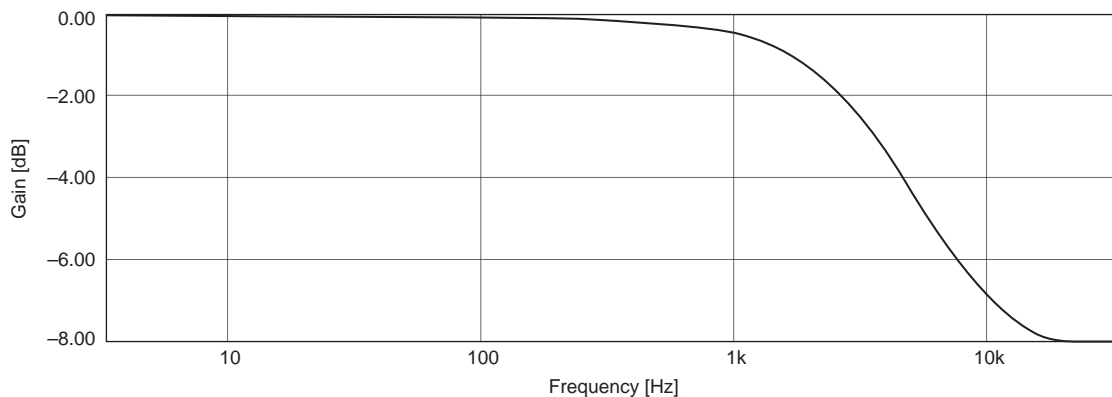


Fig. 4-14. High-Cut Filter Frequency Response

Compressor, Dynamic High and Bass Boost

1. Frequency Response and I/O Characteristics

Fig. 4-15 shows the frequency response for dynamic high boost and bass boost.

This figure shows the frequency response for a high boost turnover frequency of 5kHz and a bass boost turnover frequency of 160Hz. The boost level and turnover frequency can be set independently for high boost and bass boost. In addition, all frequencies are lowered by approximately 2dB in order to prevent clipping, so the medium frequencies are -2dB output. The high boost and bass boost levels indicate the relative values from this level.

Next, the compressor, high boost and bass boost I/O characteristics are shown in Fig. 4-17.

As shown in this figure, the compressor characteristics span all frequencies. In addition, the high boost and bass boost characteristics are for when the input signal is sufficiently higher or lower than the turnover frequency.

The boost levels can be set independently. Uth and Lth on the vertical axis are the gain control threshold values, and the desired output value can be taken from the area enclosed by the parallelograms near these levels. The Uth and Lth settings are described hereafter.

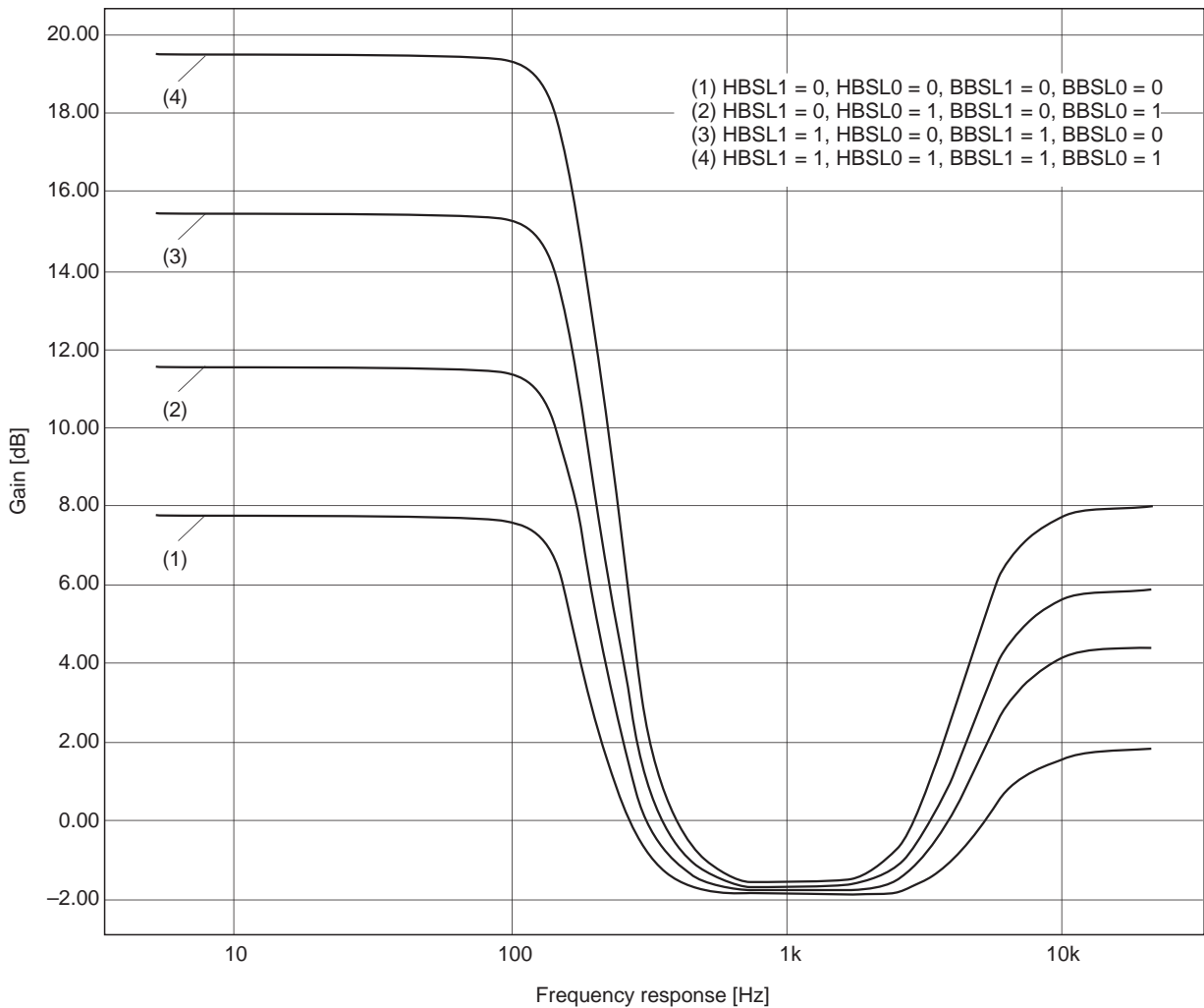


Fig. 4-15. Digital Bass Boost Frequency Response

2. Settings

When performing dynamic processing, the auditory volume and other characteristics change according to the boost levels and various other settings. The values that can be set by the serial commands and the resulting effects are described below.

2-1. Boost Level

The boost level can be set independently for the compressor, high boost and bass boost. Boost level here refers to the maximum boost level when a low level signal is input. The boost level changes over time when a high level signal is input in order to prevent clipping.

2-2. Gain Control Thresholds

The gain control thresholds are Uth and Lth. When the level exceeds Uth, the gain is reduced; when the level falls below Lth, the gain is increased. If both Uth and Lth are set to large values, the volume increases and the respective boost effects are emphasized. On the other hand, some sources may be clipped due to the balance with the boost level. These values can be set independently for the compressor and high/bass boost. The same values are shared for high and bass boost.

2-3. Attack Time, Release Time

The attack time represents the speed at which the gain is reduced after high level input, and the release time represents the speed at which the gain is increased when the input level suddenly becomes smaller. If these values are set to "fast", the boost effects increase. Like the gain control thresholds, these values can be set independently for the compressor and high/bass boost.

2-4. Envelope Detection Release Time

This sets the output signal envelope coefficient used for gain control. When set to "fast", the boost effects increase. This setting is shared by compressor and high/bass boost.

High boost	Bass boost	Attack time	Release time	Lch	Uch
*	+10dB	Standard	Standard	-12dB	-1.9dB
*	+14dB	Slow	Standard	-12dB	-1.9dB
*	+18dB	Slow	Standard	-12dB	-1.9dB
*	+22dB	Slow	Standard	-12dB	-1.9dB

Table 4-16. Recommended Dynamic Bass and High Boost Settings

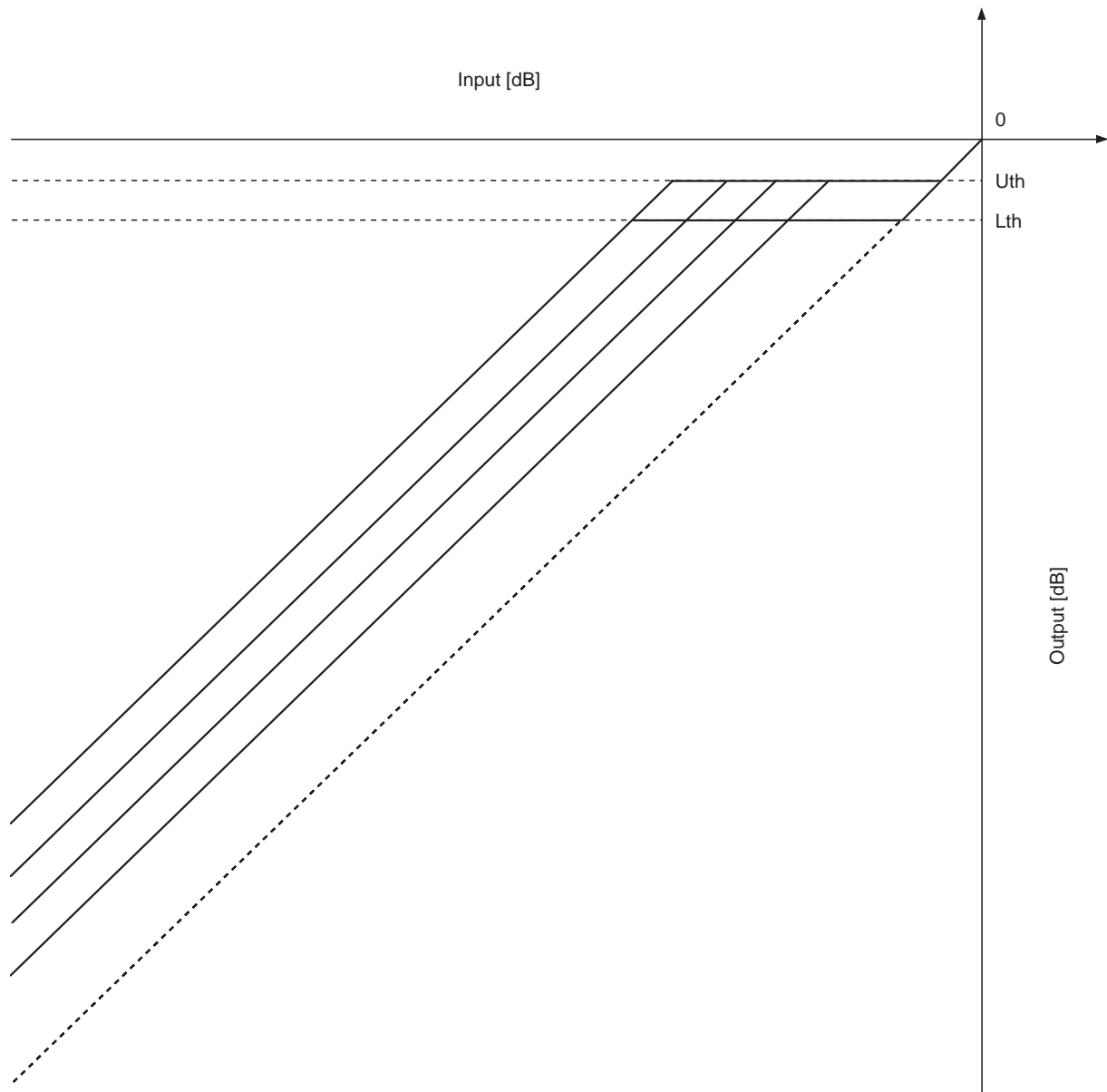


Fig. 4-17. Dynamic Processing I/O Characteristics

	Uth [dB]	Lth [dB]	Boost level [dB]
Compressor	-8.0	-23	6
High Boost	-1.9/-0.9	-12/-4.4	4/6/8/10
Bass Boost	-1.9/-0.9	-12/-4.4	10/14/18/22

§4-12. LPF Block

The CXD3027R contains an initial-stage secondary active LPF with numerous resistors and capacitors and an operational amplifier with reference voltage.

The resistors and capacitors are attached externally, allowing the cut-off frequency f_c to be determined flexibly. The reference voltage (V_c) is $(AV_{DD} - AV_{SS}) \times 0.45$.

The LPF block application circuit is shown in Fig. 4-18.

In this circuit, the cut-off frequency is $f_c \approx 40\text{kHz}$.

LPF Block Application Circuit

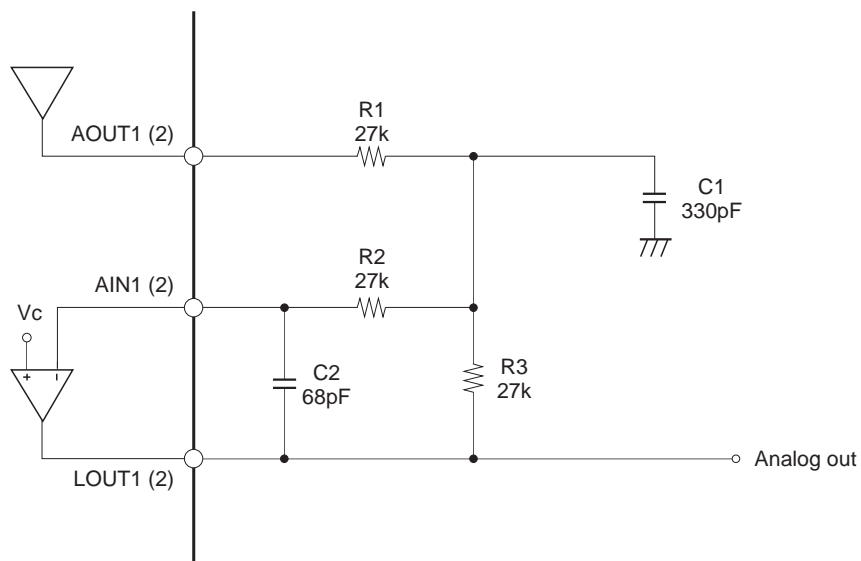


Fig. 4-18. LPF External Circuit

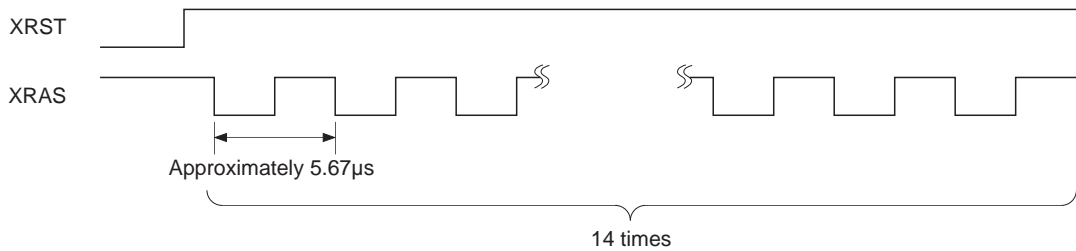
§4-13. Description of Shock-Proof Memory Controller Block Functions

§4-13-1. DRAM I/F

A 4M DRAM or 16M DRAM can be selected as the external buffer RAM. The 16M DRAM supports either row address 2^{12} and column address 2^{10} or row address 2^{11} and column address 2^{11} .

Refresh is performed by data access, and the refresh cycle is approximately 11.6ms when 4M DRAM is selected, or approximately 46.4ms ($2^{10} \times 2^{12}$) or 23.2ms ($2^{11} \times 2^{11}$) when 16M DRAM is selected.

In addition, XRAS-only-refresh is executed 14 times in order to initialize the RAM during power-on reset. Data access to the DRAM is not possible during this period.



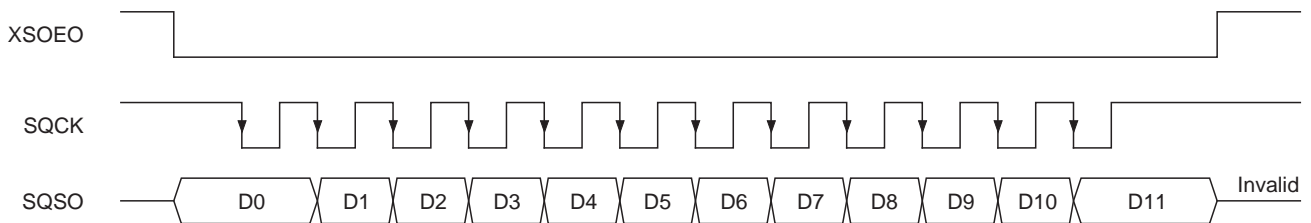
§4-13-2. Switching from Data Through Mode to Shock-Proof

The CXD3027R performs refresh by data access.

When switching from (1) shock-proof mode to (2) data through mode to (3) shock-proof mode, be sure to reset all of WA, VWA and RA before performing data access for (3).

§4-13-3. CPU Serial Data Output

Data is read out by setting the XSOEO command low and inputting SQCK. The data contents at the falling edge of the XSOEO command are output from the SQSO pin at the falling edge of SCK.



- D0: XWPHD Data write to DRAM prohibited signal (low for $\overline{XFUL} + \overline{ROF} + WRNG$)
- D1: QRCVD Indicates whether XQOK was registered as a defined address after it was sent. (High = registration OK)
- D2: XEMP Low when the DRAM is empty of valid data. (VWA = RA)
- D3: AM15 Address monitor; indicates the amount of valid data remaining.
- D4: AM16 Address monitor; indicates the amount of valid data remaining.
- D5: AM17 Address monitor; indicates the amount of valid data remaining.
- D6: AM18 Address monitor; indicates the amount of valid data remaining.
- D7: AM19 Address monitor; indicates the amount of valid data remaining.
- D8: AM20 Address monitor; indicates the amount of valid data remaining.
- D9: AM21 Address monitor; indicates the amount of valid data remaining.
- D10: XFUL Low when the DRAM is full and there is no write area.
- D11: ROF High when the DSP RAM has overflowed.

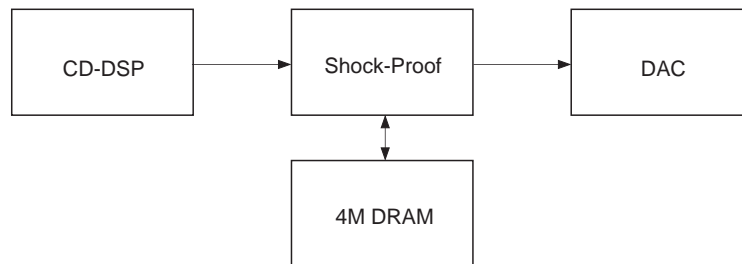
Note) When GRSCOR is low, QRCVD is high when data write to the DRAM is enabled, even if a negative pulse is input to XQOK.

§4-13-4. Data Linking

In order to restart write after PCM data write to the DRAM has been interrupted due to sound skipping or other factors, continuity must be maintained between the data written last and the subsequent data to be written. Conventional systems fix an aim at the data linking point, compare the preceding DRAM reference data with the data read from the disc, and then link the data when matching data is detected. However, when using music software where a fixed pattern is repeated, this system may link the data at an incorrect point. In addition, if pre-value hold or interpolation is performed at the point to be linked, data linking may not be possible at all. In order to eliminate these data linking errors, the CXD3027R generates a crystal accuracy SCOR (= GRSCOR) synchronized to the PCM data to allow data linking along the time axis, thus greatly increasing the data linking accuracy.

§4-13-5. Data Processing

The CXD3027R accumulates PCM data from the CD-DSP block in an external buffer and then inputs the data to the DAC block in sync with the internally generated Fs system clock. At this time, the PCM data is loaded and read out at the same rate during normal playback, so data does not accumulate in the buffer RAM. Therefore, the loading rate must be increased. This is accomplished by setting the CD-DSP block to double-speed mode and doubling the loading rate until the RAM is full. When the RAM becomes full, data regeneration from the disc stops temporarily and the RAM data is read out to create an empty area, at which point loading is restarted. These operations are then repeated to effectively use the entire area inside the RAM.



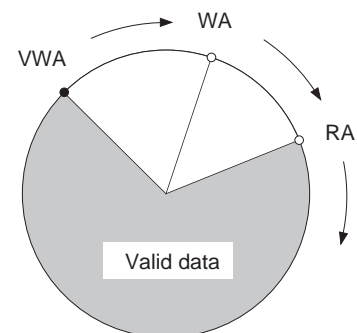
PCM Data Flow (Example for 4M × 1 mode)

§4-13-6. System Outline (when SLXQOK = 1 and SLXWRE = 1)

The addresses for accessing the buffer RAM data consist of a readout address (RA) and a write address (WA). The data to be written is not always correct, and the subcodes, etc. must be constantly checked to make sure the data is correct and there is no sound skipping. The CXD3027R checks subcode-Q using the CPU, and defines the data by inputting a negative pulse to the XQOK pin. This defined address (VWA) is loaded to the internal register and the data between VWA and RA is treated as valid data. WA advances at a speed twice that of RA, and RA is written by WA and read out sequentially in the order registered by VWA. When RA catches up to VWA, there is no more valid data and readout is prohibited (XEMP = low). In addition, when WA catches up to RA, the buffer is full and write is prohibited (XWIH = low). In this manner, write to the RAM is interrupted when the RAM becomes full and there is no write area or when sound skipping caused by scratches, external disturbances or other factors is detected. Data continuity must be ensured in order to restart write. Therefore, the CXD3027R returns to the last defined address, and the CPU accesses the defined address point it sent last (actually the data slightly before that point) and reads the subcode-Q after the rising edge of SCOR. If the subcode-Q matches the last defined address, XWRE is made to fall and write is restarted when GRSCOR comes high within 7ms.

Note 1) If XWRE is made to fall when GRSCOR is low, XWIH goes low and the write prohibited state results.

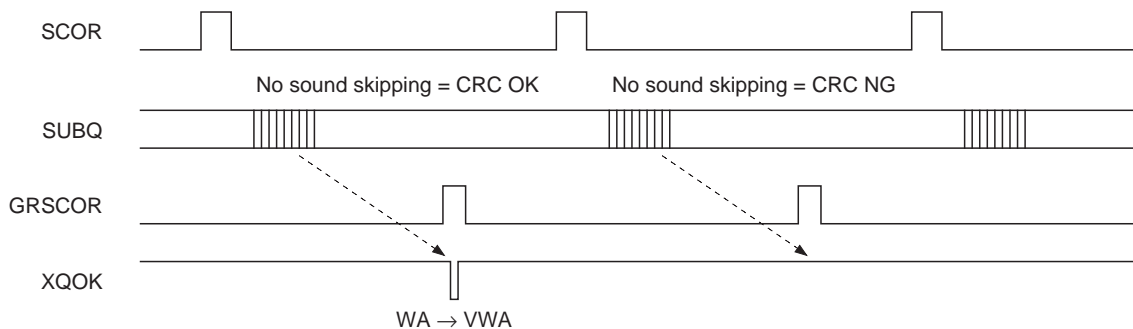
Note 2) When GRSCOR is low, VWA is not updated even if a negative pulse is input to XQOK. Therefore, set XQOK high while GRSCOR is low.



§4-13-7. Data write (when SLXQOK = 1 and SLXWRE = 1)

The PCM data input from the DSP is loaded according to the Fs system clock inputs (BCKI, WDCI and LRCI), and is written sequentially to the external DRAM according to WA when the XWRE pin input goes low and internal write is enabled (XWIH pin output = high).

The written data must be checked by some means or other. The CXD3027R assumes data checking with subcode-Q. In this case, the CPU reads subcode-Q triggered by the SCOR signal output from the DSP to determine whether sound skipping occurred. If sound skipping is not detected, the CPU inputs a negative pulse to the XQOK pin during the GRSCOR high interval which comes within 7ms, and the data written to WA thus far is registered to VWA as data without sound skipping.



Write prohibition is determined by the internal status or by an external command. When prohibited by the internal status, the XWIH pin goes low, and this status is established when any one of the following three conditions is met.

1. There is no empty area in the DRAM. XFUL = low
2. The DSP RAM has overflowed. ROF = high
3. XWRE was made to fall when GRSCOR is low. WRNG = high

When the XWIH pin goes low due to the above conditions, the CPU must set the XWRE pin high and then the XWIH pin high.

After the CPU sends XQOK, it must check whether XQOK was registered as a defined address. This is because if the above conditions arise at the same time XQOK is sent, XQOK becomes invalid and the addresses defined by the CPU and the CXD3027R may not match. Therefore, the XWIH pin output is used as the XQOK recognition signal (QRCVD) while XQOK is low. When QRCVD is high, this indicates that XQOK was correctly registered as a defined address (VWA was updated). When QRCVD is low, this indicates one of the following conditions.

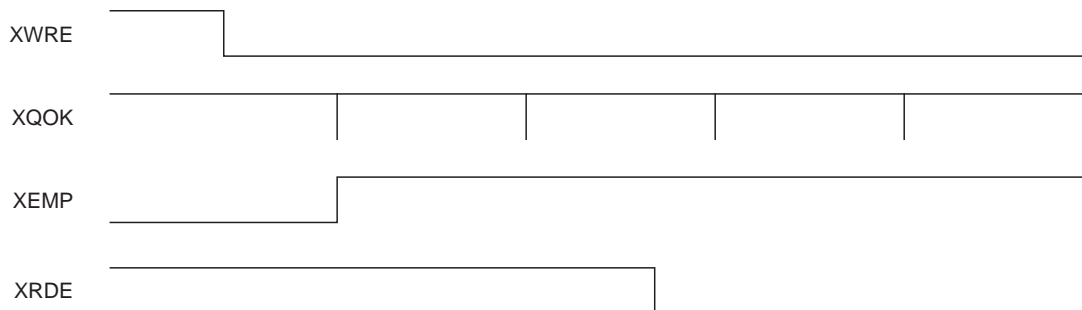
1. Write is prohibited due to the above three conditions.
2. XWRE is high.

Regarding condition 2, if XQOK is sent while the XWRE pin is high, WA, VWA and RA are all reset (when GRSCOR is high).

§4-13-8. Data Readout (when SLXQOK = 1 and SLXWRE = 1)

When data write starts, there is no valid data in the RAM so the XEMP pin is low. The XWRE pin goes from high to low, and if there is no sound skipping or other problems with the CRC check at the next SCOR, XQOK is sent during the GRSCOR high interval which comes within 7ms, and the defined address and valid data are registered. At this point, the XEMP pin goes high for the first time and readout is enabled. Data readout follows RA, and is performed in sync with the internally generated Fs system clocks. The readout data and the Fs system clocks are output from the DATA and the BCK and LRCK pins, respectively.

RA is the address for reading out the written data that has been validated by VWA, and the area from VWA to RA is the amount of valid data ($|VWA - RA|$). The upper 5 bits are output as AM21 to AM17. When RA catches up to VWA and there is no more valid data ($|VWA - RA| = 0$), the XEMP pin goes low and readout is prohibited. When this state occurs, the CPU must set the XRDE pin high to prohibit readout. To restart readout, valid data must be registered as described above. The XEMP pin is held low until valid data is registered.



Note) After the XWRE pin goes from high to low, readout is enabled when valid data is registered by the first XQOK. However, ensuring some difference between VWA and RA is recommended in consideration of CRC NG, etc.

§4-14. CPU to DRAM Access Function

The CXD3027R can establish a special area in the DRAM. This allows a microcomputer to read and write optional 16-bit data to a portion of the DRAM area.

This function can be used to store and optionally read out demodulated CD TEXT data, etc.

The range of this special area is set by \$A7, and can be selected in 8 steps from 32K to 2M bits.

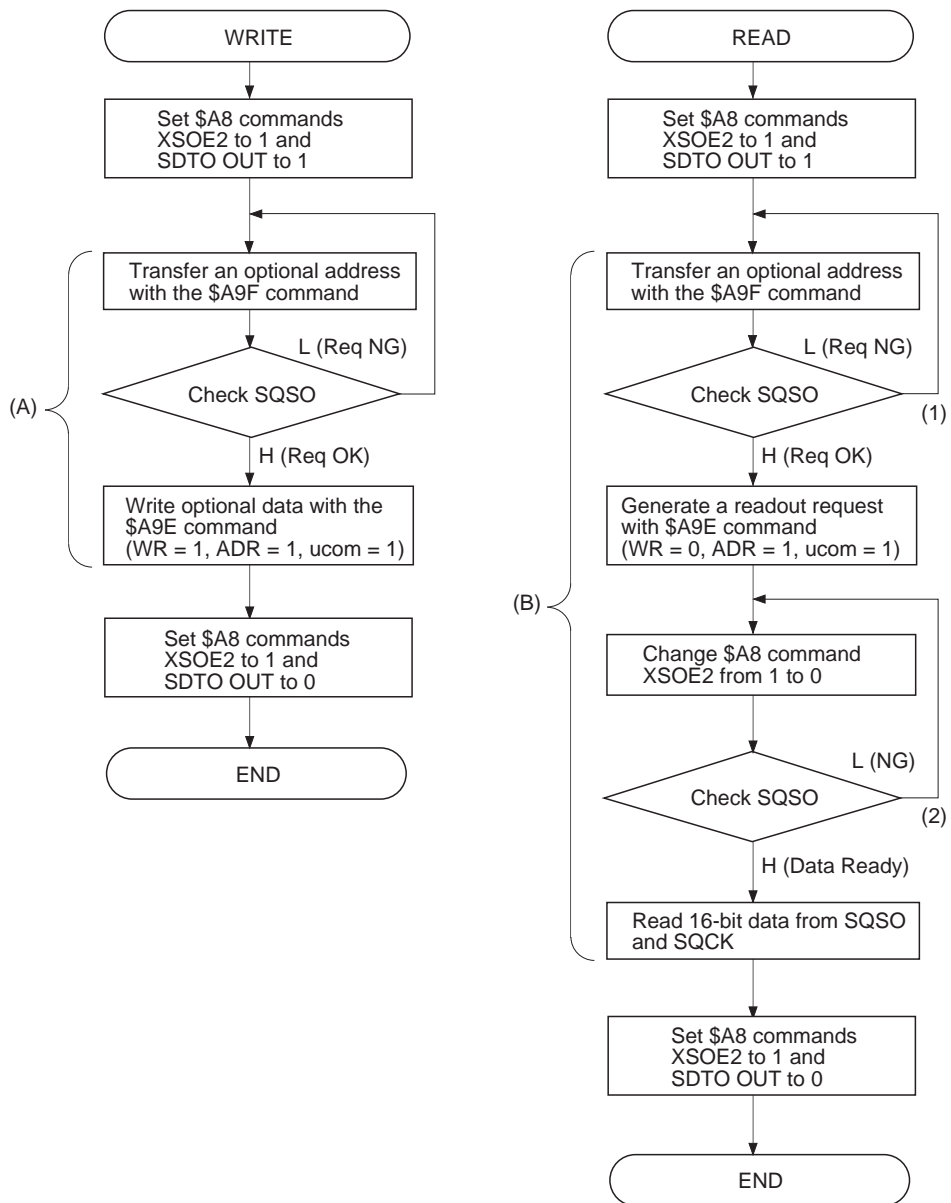
Table 4-19 shows the addresses which can be specified according to the used DRAM capacity and the special area setting value.

In addition, the address specification method can be selected from absolute and relative specification.

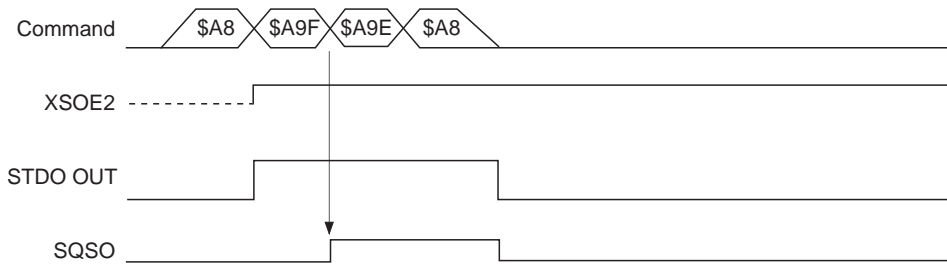
	RSL 1 0	MSL 2 1 0	DRDR19 to 0 specification range
4M setting	0 0	0 0 0	-----
		0 0 1	00000 to 007FF
		0 1 0	00000 to 00FFF
		0 1 1	00000 to 01FFF
		1 0 0	00000 to 03FFF
		1 0 1	00000 to 07FFF
		1 1 0	00000 to 0FFFF
		1 1 1	00000 to 1FFFF
16M setting	1 1	0 0 0	-----
		0 0 1	00000 to 007FF
		0 1 0	00000 to 00FFF
		0 1 1	00000 to 01FFF
		1 0 0	00000 to 03FFF
		1 0 1	00000 to 07FFF
		1 1 0	00000 to 0FFFF
		1 1 1	00000 to 1FFFF

Table 4-19

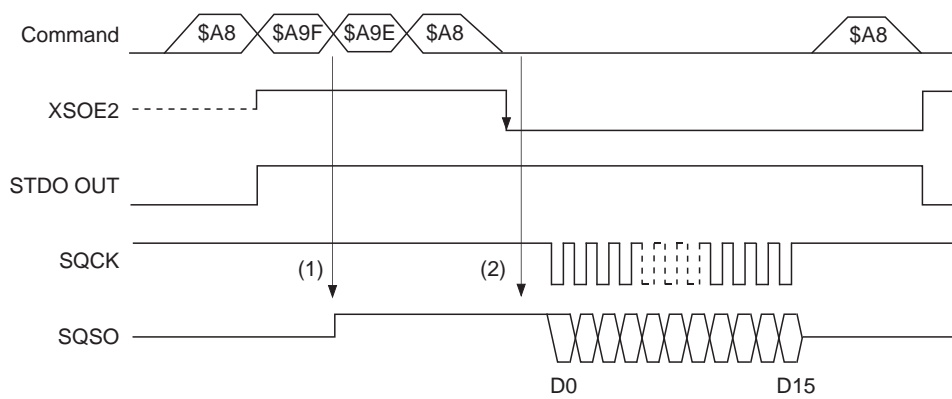
Write and Read by Absolute Address Specification



Write Communication Timing



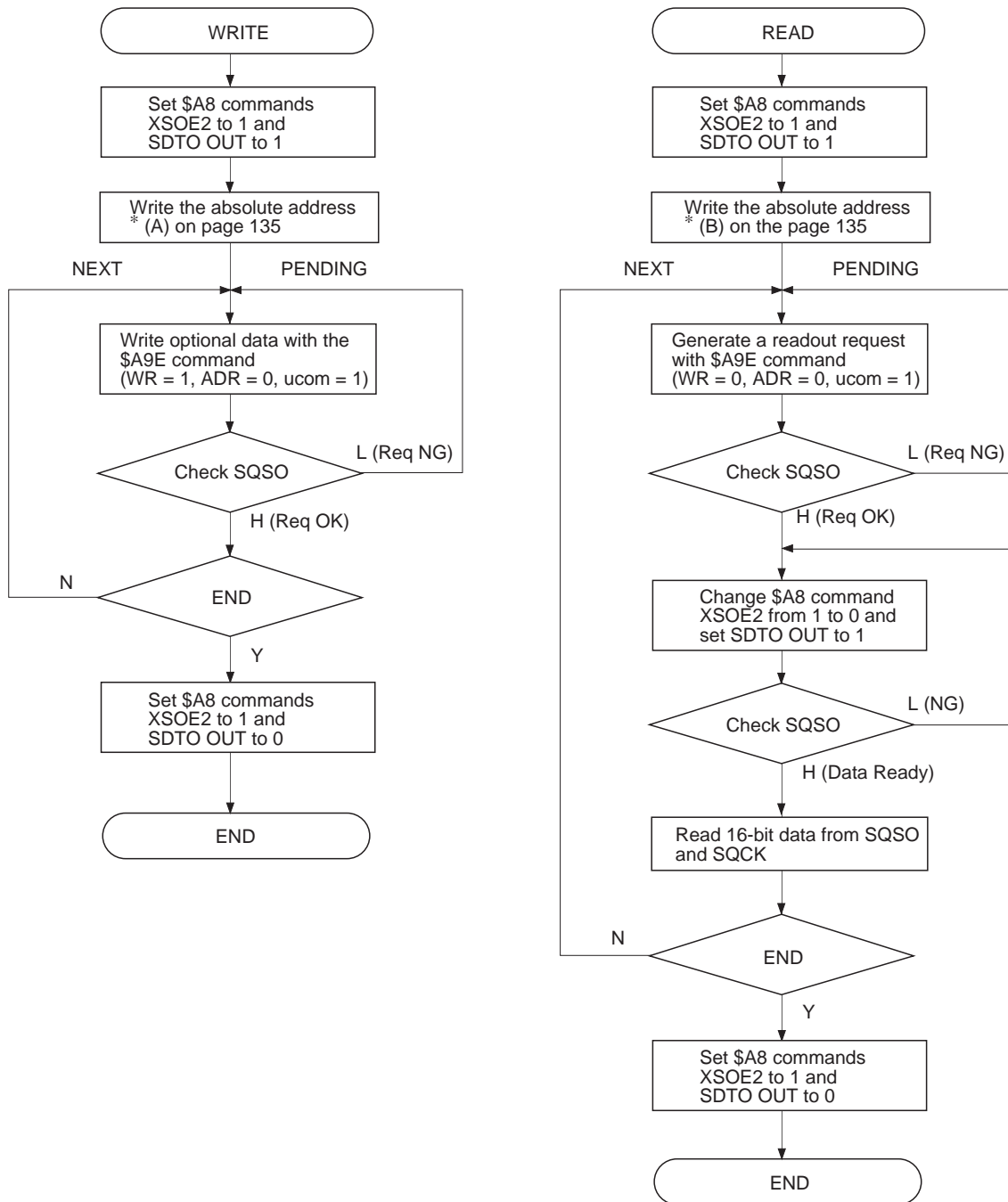
Readout Communication Timing



Readout Communication Operation

- (1) Set STDO OUT to 1 to switch the serial communication line for special memory.
- (2) Send the address command (\$A9F), then check whether the DRAM related processing has completed using the SQSO pin.
- (3) The data read out from the DRAM is loaded to the communication block inside the LSI by sending the read command (\$A9E) and causing XSOE2 to fall (\$A8). However, the DRAM related processing requires a check as to whether the data was loaded properly using the SQSO pin.
- (4) The readout data is output from the SQSO pin by inputting 16 clocks from the SQCK pin.

Write and Read by Relative Address Specification



§4-15. Asymmetry Correction

Fig. 4-20 shows the block diagram and circuit example.

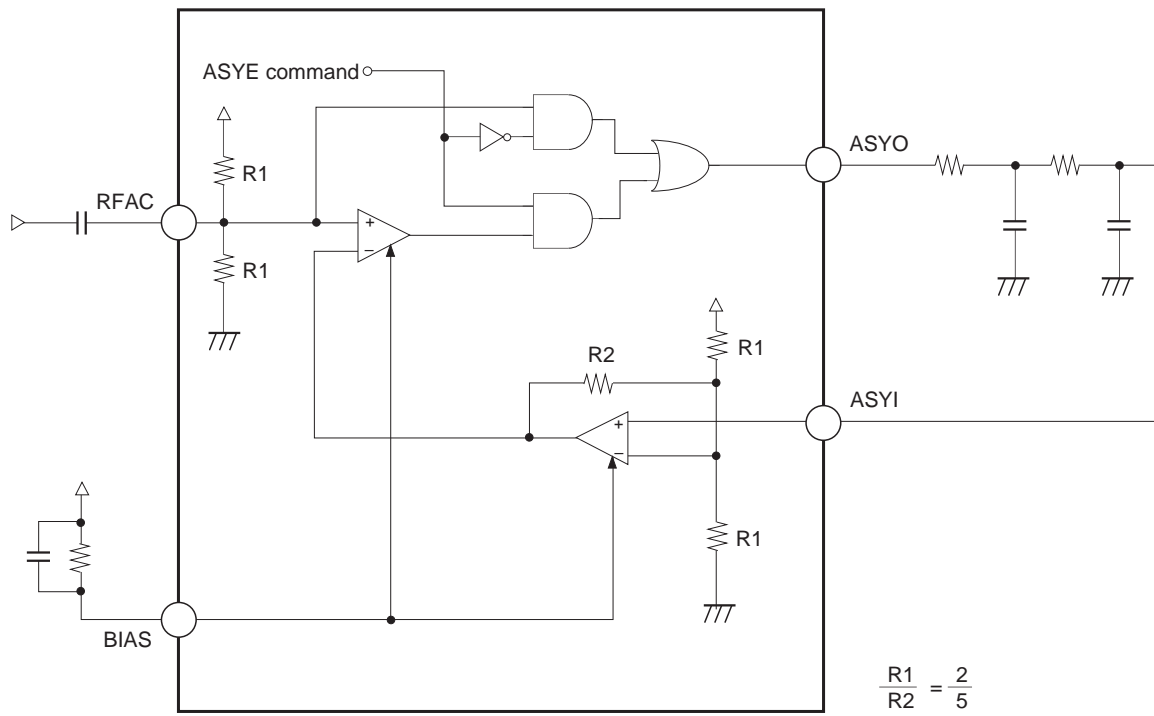


Fig. 4-20. Asymmetry Correction Application Circuit.

§4-16. CD TEXT Data Demodulation

- In order to demodulate the CD TEXT data, set the command \$8 Data 6 D3 TXON to 1. While TXON is 1, the CD TEXT demodulation circuit occupies the EXCK and SBSO pins, so connect EXCK to low and do not use the data output from SBSO. Also, 26.7ms (max.) are required to demodulate the CD TEXT data correctly after TXON is set to 1.
- The CD TEXT data is output by switching the SQSO pin with the command. The CD TEXT data output is enabled by setting the command \$8 Data 6 D2 TXOUT to 1. To read data, the readout clock should be input to SQCK.
- The readable data are the CRC counting results for each pack and the CD TEXT data (16 bytes) except for CRC data.
- When the CD TEXT data is read, the order of the MSB and LSB is inverted within each byte. As a result, although the sequence of the bytes is the same, the bits within the bytes are now ordered LSB first.
- Data which can be stored in the LSI is 1 packet (4 packs).

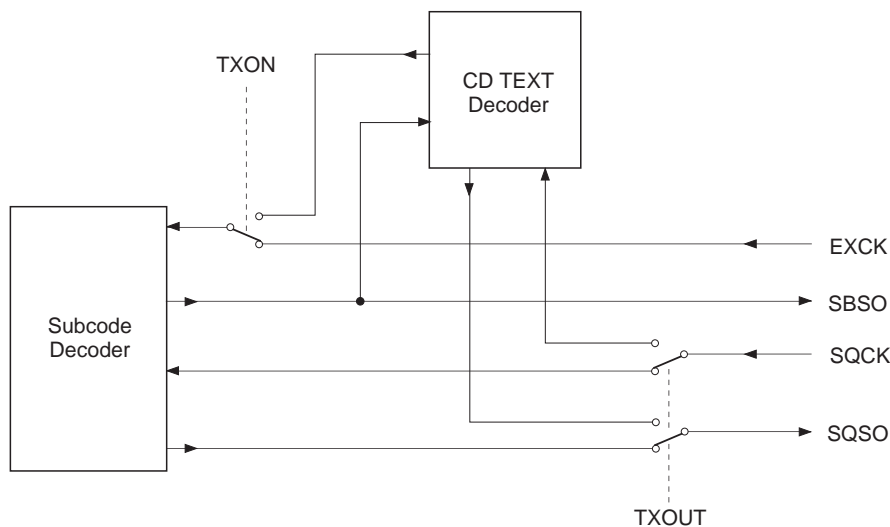


Fig. 4-21. Block Diagram of CD TEXT Demodulation Circuit

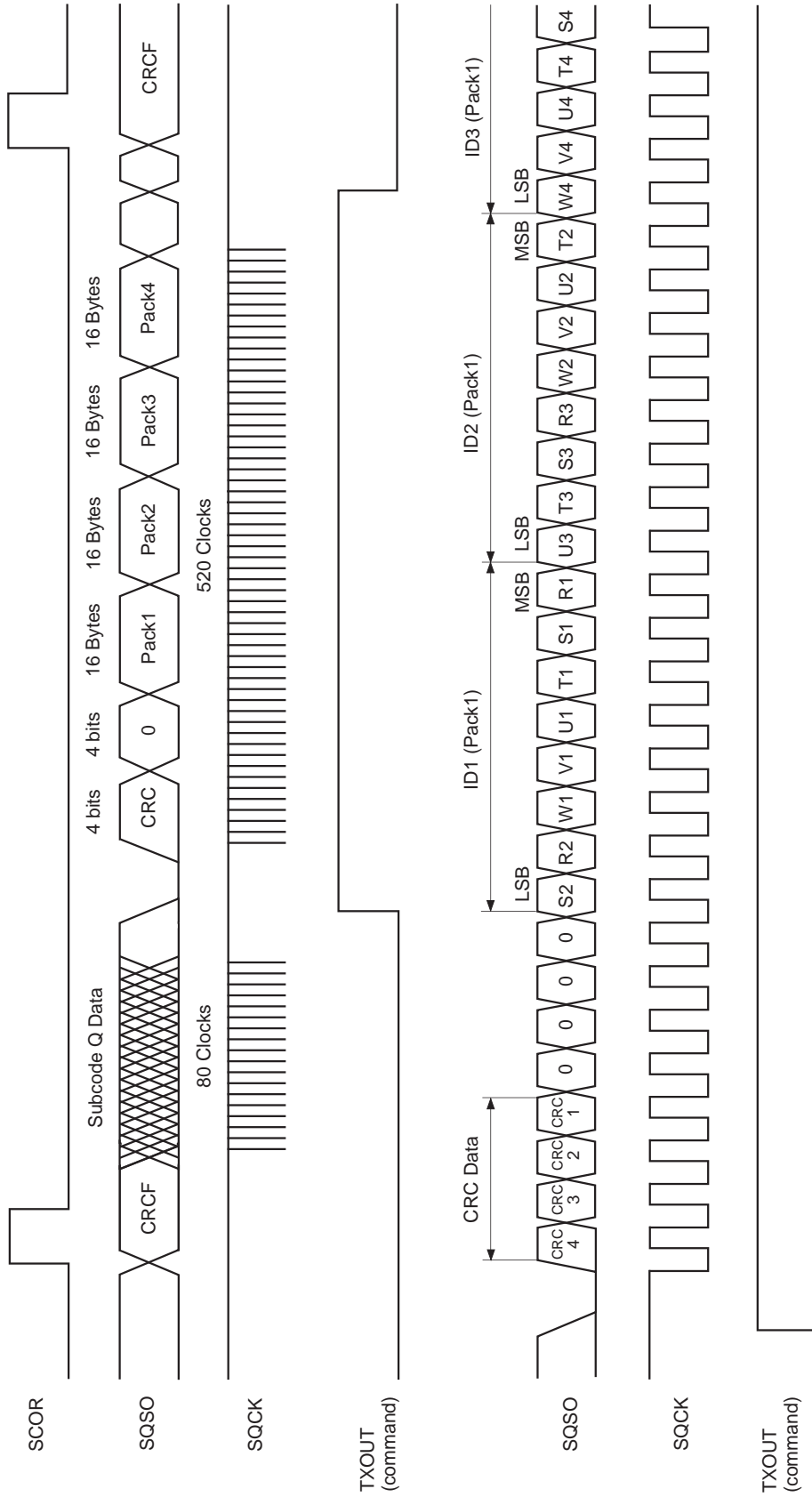


Fig. 4-22. CD TEXT Data Timing Chart

[5] Description of Servo Signal Processing System Functions and Commands

§5-1. General Description of Servo Signal Processing System (V_{DD} : Supply voltage)

Focus servo

Sampling rate:	88.2kHz (when MCK = 128Fs)
Input range:	$1/4V_{DD}$ to $3/4V_{DD}$
Output format:	7-bit PWM
Other:	Offset cancel Focus bias adjustment Focus search Gain-down Defect countermeasure Auto gain control

Tracking servo

Sampling rate:	88.2kHz (when MCK = 128Fs)
Input range:	$1/4V_{DD}$ to $3/4V_{DD}$
Output format:	7-bit PWM
Other:	Offset cancel E:F balance adjustment Track jump Gain-up Defect countermeasure Drive cancel Auto gain control Vibration countermeasure

Sled servo

Sampling rate:	345Hz (when MCK = 128Fs)
Input range:	$1/4V_{DD}$ to $3/4V_{DD}$
Output format:	7-bit PWM
Other:	Sled move

FOK, MIRR, DFCT signal generation

RF signal sampling rate:	1.4MHz (when MCK = 128Fs)
Input range:	$1/4V_{DD}$ to $3/4V_{DD}$
Other:	RF zero level automatic measurement

§5-2. Digital Servo Block Master Clock (MCK)

The clock with 2/3 frequency of the crystal is supplied to the digital servo block.

XT4D and XT2D are \$3F commands, and XT1D is a \$3E command. (Default is 0 for each command)

The digital servo block is designed with an MCK frequency of 5.6448MHz (128Fs) as typical.

Mode	XTAI	FSTO	XTSL	XT4D	XT2D	XT1D	Frequency division ratio	MCK
1	384Fs	256Fs	*	*	*	1	1	256Fs
2	384Fs	256Fs	*	*	1	0	1/2	128Fs
3	384Fs	256Fs	0	0	0	0	1/2	128Fs
4	768Fs	512Fs	*	*	*	1	1	512Fs
5	768Fs	512Fs	*	*	1	0	1/2	256Fs
6	768Fs	512Fs	*	1	0	0	1/4	128Fs
7	768Fs	512Fs	1	0	0	0	1/4	128Fs

Fs = 44.1kHz, *: don't care

Table 5-1.

§5-3. DC Offset Cancel [AVRG (Average) Measurement and Compensation] (See Fig. 5-3.)

The CXD3027R can measure the averages of RFDC, VC, FE and TE and compensate these signals using the measurement results to control the servo effectively. This AVRG measurement and compensation is necessary to initialize the CXD3027R, and is able to cancel the DC offset.

AVRG measurement takes the levels applied to the VC, FE, RFDC and TE pins as the digital average values of 256 samples, and then loads these values into each AVRG register.

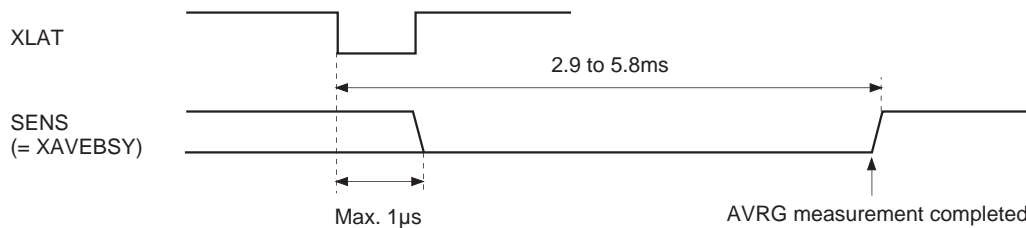
The AVRG measurement commands are D15 (VCLM), D13 (FLM), D11 (RFLM) and D4 (TLM) of \$38.

Measurement is on when the respective command is set to 1.

AVRG measurement requires approximately 2.9ms to 5.8ms (when MCK = 128Fs) after the command is received.

The completion of AVRG measurement operation can be monitored by the SENS pin. (See Timing Chart 5-2.)

Monitoring requires that the upper 8 bits of the command register are 38 (h).



Timing Chart 5-2.

<Measurement>

VC AVRG: The VC DC offset (VC AVRG) which is the center voltage for the system is measured and used to compensate the FE, TE and SE signals.

FE AVRG: The FE DC offset (FE AVRG) is measured and used to compensate the FE and FZC signals.

TE AVRG: The TE DC offset (TE AVRG) is measured and used to compensate the TE and SE signals.

RF AVRG: The RF DC offset (RF AVRG) is measured and used to compensate the RFDC signal.

<Compensation>

RFLC: (RF signal – RF AVRG) is input to the RF In register.
"00" is input when the RF signal is lower than RF AVRG.

TCL0: (TE signal – VC AVRG) is input to the TRK In register.

TCL1: (TE signal – TE AVRG) is input to the TRK In register.

VCLC: (FE signal – VC AVRG) is input to the FCS In register.

FLC1: (FE signal – FE AVRG) is input to the FCS In register.

FLC0: (FE signal – FE AVRG) is input to the FZC register.

Two methods of canceling the DC offset are assumed for the CXD3027R. These methods are shown in Figs. 5-3a and 5-3b.

An example of AVRG measurement and compensation commands is shown below.

\$38 08 00 (RF AVRG measurement)

\$38 20 00 (FE AVRG measurement)

\$38 00 10 (TE AVRG measurement)

\$38 14 0A (Compensation on [RFLC, FLC0, FLC1, TLC1]; corresponds to Fig. 5-3a.)

See the description of \$38 for these commands.

§5-4. E:F Balance Adjustment Function (See Fig. 5-3.)

When the disc is rotated with the laser on, and with the FCS (focus) servo on via FCS search, the traverse waveform appears in the TE signal due to disc eccentricity.

In this condition, the low-frequency component can be extracted from the TE signal using the built-in TRK hold filter by setting D5 (TBLM) of \$38 to 1.

The extracted low-frequency component is loaded into the TRVSC register as a digital value, and the TRVSC register value is established when TBLM returns to 0.

Next, setting D2 (TLC2) of \$38 to 1 compensates the values obtained from the TE and SE input pins with the TRVSC register value (subtraction), allowing the E:F balance offset to be adjusted. (See Fig. 5-3.)

§5-5. FCS Bias (Focus Bias) Adjustment Function

The FBIAS register value can be added to the FCS servo filter input by setting D14 (FBON) of \$3A to 1. (See Fig. 5-3.)

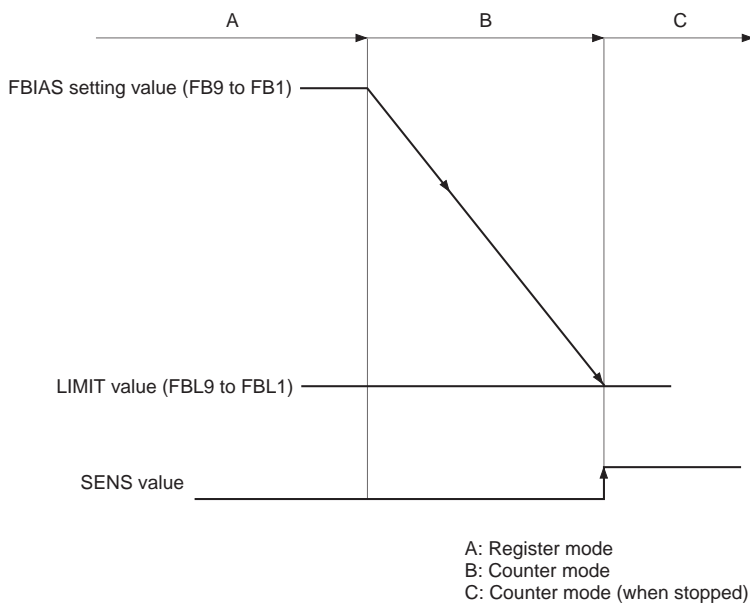
When D11 = 0 and D10 = 1 is set by \$34F, the FBIAS register value can be written using the 9-bit value of D9 to D1 (D9: MSB).

In addition, the RF jitter can be monitored by setting the \$8 command SOCT to 1. (See "DSP Block Timing Chart".)

The FBIAS register can be used as a counter by setting D13 (FBSS) of \$3A to 1. The FBIAS register functions as an up counter when D12 (FBUP) of \$3A = 1, and as a down counter when D12 (FBUP) of \$3A = 0.

The number of up and down steps can be changed by setting D11 and D10 (FBV1 and FBV0) of \$3A.

When using the FBIAS register as a counter, the counter stops when the value set beforehand in FBL9 to FBL1 of \$34 matches the FCSBIAS value. Also, if the upper 8 bits of the command register are \$3A at this time, SENS goes high and the counter stop can be monitored.



Here, assume the FBIAS setting value FB9 to FB1 and the FBIAS LIMIT value FBL9 to FBL1 are set in status A. For example, if command registers FBUP = 0, FBV1 = 0, FBV0 = 0 and FBSS = 1 are set from this status, down count starts from status A and approaches the set LIMIT value. When the LIMIT value is reached and the FBIAS value matches FBL9 to FBL1, the counter stops and the SENS pin goes high. Note that the up/down counter counts at each sampling cycle of the focus servo filter. The number of steps by which the count value changes can be selected from 1, 2, 4 or 8 steps by FBV1 and FBV0. When converted to FE input, 1 step corresponds to $1/512 \times V_{DD}/2$.

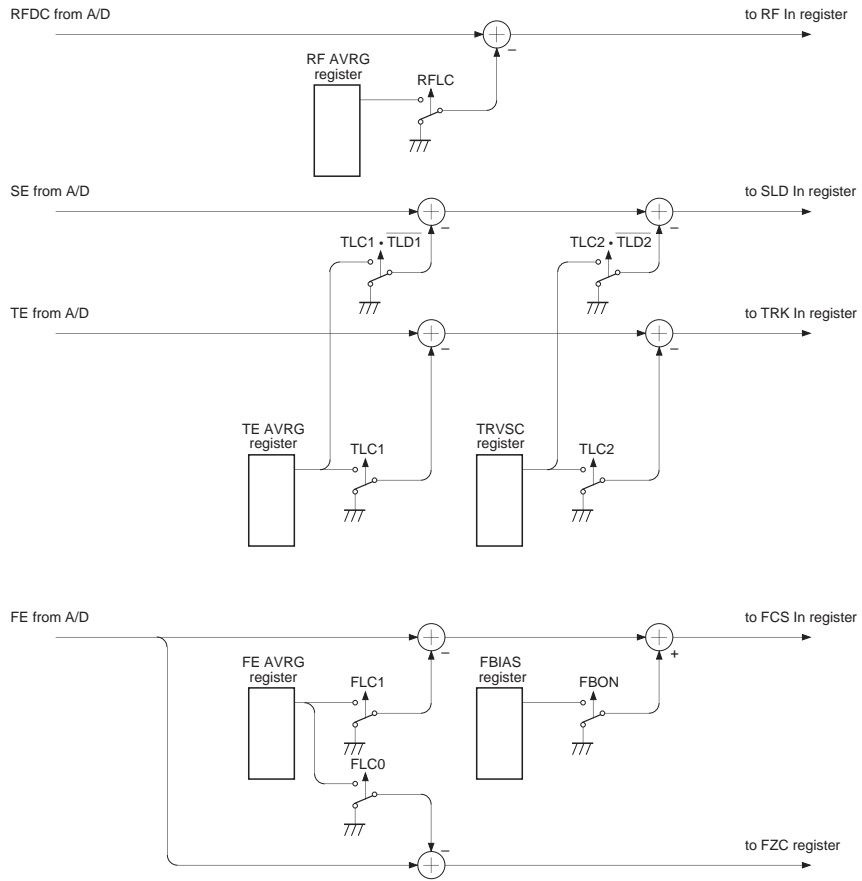


Fig. 5-3a.

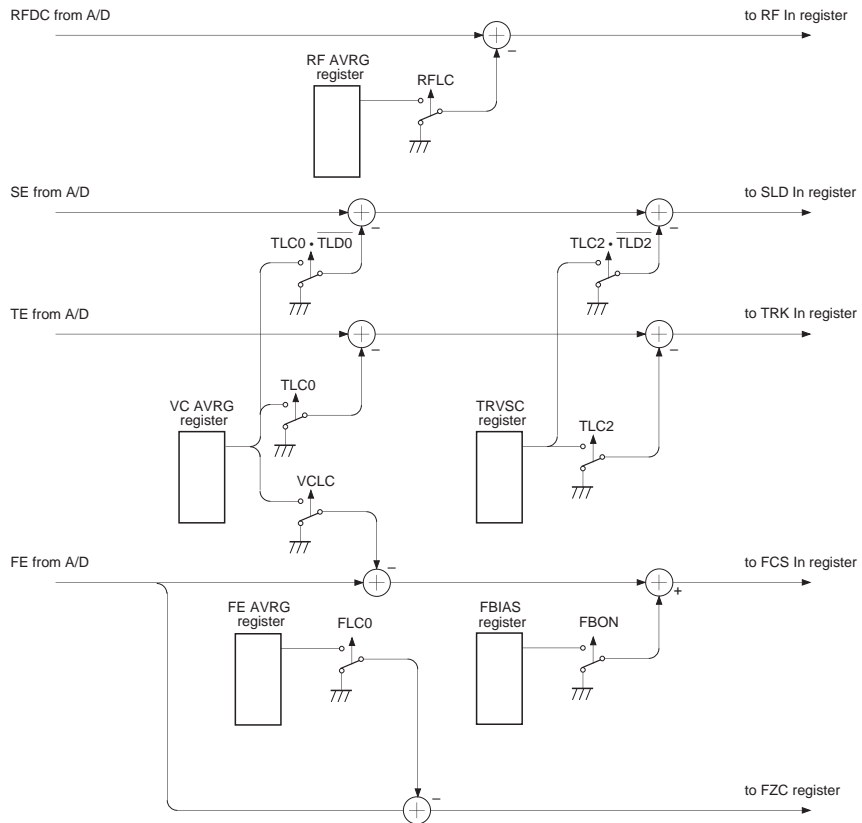


Fig. 5-3b.

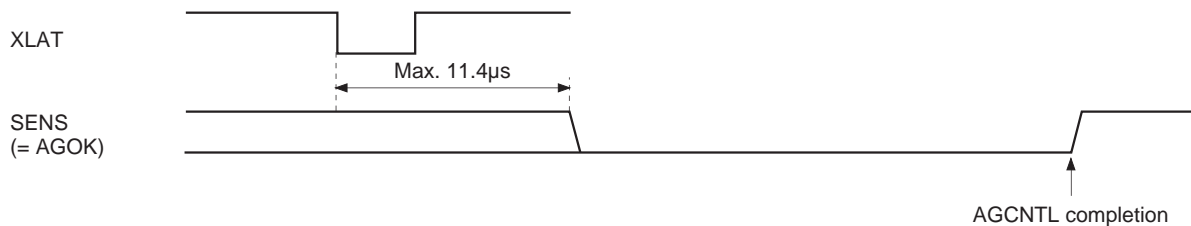
§5-6. AGCNTL (Automatic Gain Control) Function

The AGCNTL function automatically adjusts the filter internal gain in order to obtain the appropriate servo loop gain. AGCNTL not only copes with the sensitivity variation of the actuator and photo diode, etc., but also obtains the optimal gain for each disc.

The AGCNTL command is sent when each servo is turned on. During AGCNTL operation, if the upper 8 bits of the command register are 38 (h), the completion of AGCNTL operation can be confirmed by monitoring the SENS pin. (See Timing Chart 5-4 and "Description of SENS Signals".)

Setting D9 and D8 of \$38 to 1 sets FCS (focus) and TRK (tracking) respectively to AGCNTL operation.

Note) During AGCNTL operation, each servo filter gain must be normal, and the anti-shock circuit (described hereafter) must be disabled.



Timing Chart 5-4

Coefficient K13 changes for AGF (focus AGCNTL) and coefficients K23 and K07 change for AGT (tracking AGCNTL) due to AGCNTL.

These coefficients change from 01 to 7F (h), and they must also be set within this range when written externally.

After AGCNTL operation has completed, these coefficient values can be confirmed by reading them out from the SENS pin with the serial readout function (described hereafter).

AGCNTL related settings

The following settings can be changed with \$35, \$36 and \$37.

FG6 to FG0; AGF convergence gain setting, effective setting range: 00 to 57 (h)

TG6 to TG0; AGT convergence gain setting, effective setting range: 00 to 57 (h)

AGS; Self-stop on/off

AGJ; Convergence completion judgment time

AGGF; Internally generated sine wave amplitude (AGF)

AGGT; Internally generated sine wave amplitude (AGT)

AGV1; AGCNTL sensitivity 1 (during rough adjustment)

AGV2; AGCNTL sensitivity 2 (during fine adjustment)

AGHS; Rough adjustment on/off

AGHT; Fine adjustment time

Note) Converging servo loop gain values can be changed with the FG6 to FG0 and TG6 to TG0 setting values.

In addition, these setting values must be within the effective setting range. The default settings aim for 0 dB at 1kHz. However, since convergence values vary according to the characteristics of each constituent element of the servo loop, FG and TG values should be set as necessary.

AGCNTL default operation has two stages.

In the first stage, rough adjustment is performed with high sensitivity for a certain period of time (select 256/128ms with AGHT, when MCK = 128Fs), and the AGCNTL coefficient approaches the appropriate value. The sensitivity at this time can be selected from two types with AGV1.

In the second stage, the AGCNTL coefficient is finely adjusted with relatively low sensitivity to further approach the appropriate value. The sensitivity for the second stage can be selected from two types with AGV2. In the second stage of default operation, when the AGCNTL coefficient reaches the appropriate value and stops changing, the CXD3027R confirms that the AGCNTL coefficient has not changed for a certain period of time (select 63/31ms with AGHJ, when MCK = 128Fs), and then completes AGCNTL operation. (Self-stop mode) This self-stop mode can be canceled by setting AGS to 0.

In addition, the first stage is omitted for AGCNTL operation when AGHS is set to 0.

An example of AGCNTL coefficient transitions during AGCNTL operation with various settings is shown in Fig. 5-5.

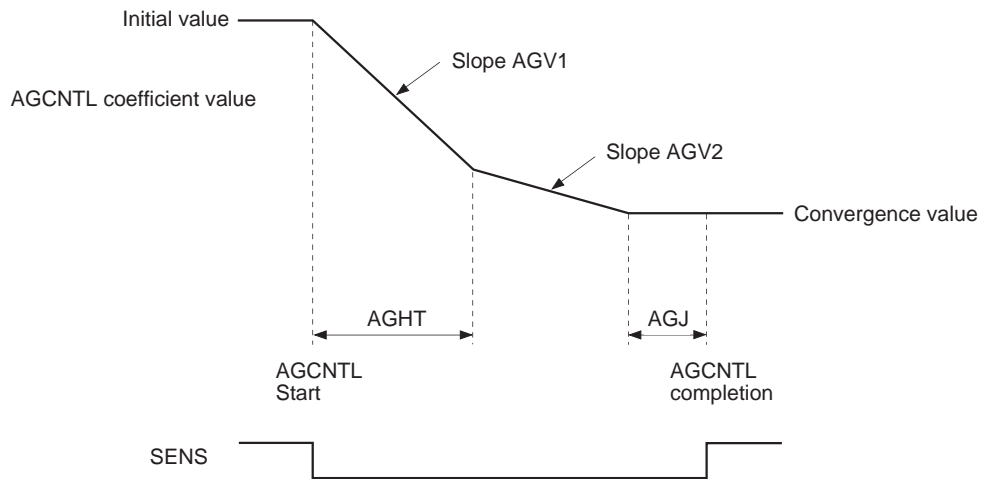


Fig. 5-5.

Note) Fig. 5-5 shows the case where the AGCCNTL coefficient converges from the initial value to a smaller value.

§5-7. FCS Servo and FCS Search (Focus Search)

The FCS servo is controlled by the 8-bit serial command \$0X. (See Table 5-6.)

Register name	Command	D23 to D20	D19 to D16	
0	FOCUS CONTROL	0 0 0 0	1 0 * *	FOCUS SERVO ON (FOCUS GAIN NORMAL)
			1 1 * *	FOCUS SERVO ON (FOCUS GAIN DOWN)
			0 * 0 *	FOCUS SERVO OFF, 0V OUT
			0 * 1 *	FOCUS SERVO OFF, FOCUS SEARCH VOLTAGE OUT
			0 * 1 0	FOCUS SEARCH VOLTAGE DOWN
			0 * 1 1	FOCUS SEARCH VOLTAGE UP

*: don't care

Table 5-6.

FCS Search

FCS search is required in the course of turning on the FCS servo.

Fig. 5-7 shows the signals for sending commands \$00 → \$02 → \$03 and performing only FCS search operation. Fig. 5-8 shows the signals for sending \$08 (FCS on) after that.

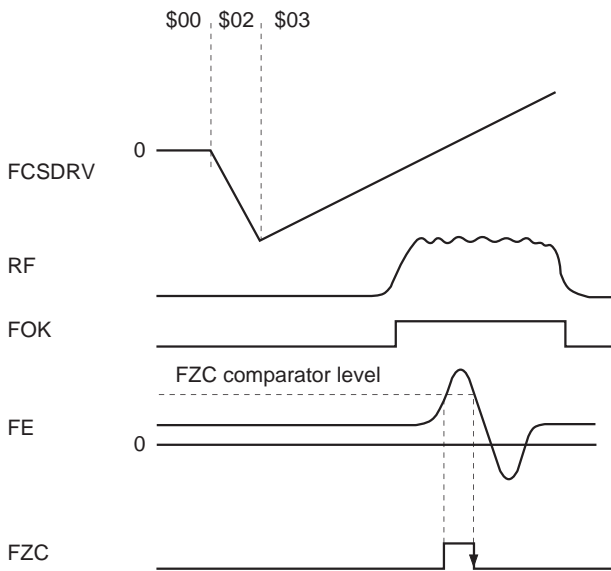


Fig. 5-7.

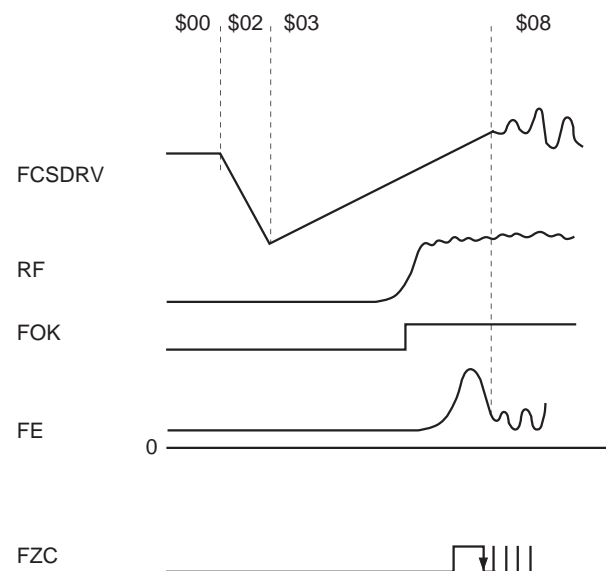


Fig. 5-8.

§5-8. TRK (Tracking) and SLD (Sled) Servo Control

The TRK and SLD servos are controlled by the 8-bit command \$2X. (See Table 5-9.)

When the upper 4 bits of the serial data are 2 (h), TZC is output to the SENS pin.

Register name	Command	D23 to D20	D19 to D16	
2	TRACKING MODE	0 0 1 0	0 0 * *	TRACKING SERVO OFF
			0 1 * *	TRACKING SERVO ON
			1 0 * *	FORWARD TRACK JUMP
			1 1 * *	REVERSE TRACK JUMP
			* * 0 0	SLED SERVO OFF
			* * 0 1	SLED SERVO ON
			* * 1 0	FORWARD SLED MOVE
			* * 1 1	REVERSE SLED MOVE

*: don't care

Table 5-9.

TRK Servo

The TRK JUMP (track jump) level can be set with 6 bits (D13 to D8) of \$36.

In addition, when the TRK servo is on and D17 of \$1 is set to 1, the TRK servo filter switches to gain-up mode. The filter also switches to gain-up mode when the LOCK signal goes low or when vibration is detected with the anti-shock circuit (described hereafter) enabled.

The CXD3027R has 2 types of gain-up filter structures in TRK gain-up mode which can be selected by setting D16 of \$1. (See Table 5-17.)

SLD Servo

The SLD MOV (sled move) output, composed of a basic value from 6 bits (D13 to D8) of \$37, is determined by multiplying this value by 1×, 2×, 3×, or 4× set using D17 and D16 when D18 = D19 = 0 is set with \$3. (See Table 5-10.)

SLD MOV must be performed continuously for 50µs or more. In addition, if the LOCK input signal goes low when the SLD servo is on, the SLD servo turns off.

Note) When the LOCK signal is low, the TRK servo switches to gain-up mode and the SLD servo is turned off.

These operations are disabled by setting D6 (LKSW) of \$38 to 1.

Register name	Command	D23 to D20	D19 to D16	
3	SELECT	0 0 1 1	0 0 0 0	SLED KICK LEVEL (basic value × ±1)
			0 0 0 1	SLED KICK LEVEL (basic value × ±2)
			0 0 1 0	SLED KICK LEVEL (basic value × ±3)
			0 0 1 1	SLED KICK LEVEL (basic value × ±4)

Table 5-10.

§5-9. MIRR and DFCT Signal Generation

The RF signal obtained from the RFDC pin is sampled at approximately 1.4MHz (when MCK = 128Fs) and loaded. The MIRR and DFCT signals are generated from this RF signal.

MIRR Signal Generation

The loaded RF signal is applied to peak hold and bottom hold circuits.

An envelope is generated from the waveforms generated in these circuits, and the MIRR comparator level is generated from the average of this envelope waveform.

The MIRR signal is generated by comparing the waveform generated by subtracting the bottom hold value from the peak hold value with this MIRR comparator level. (See Fig. 5-11.)

The bottom hold speed and mirror sensitivity can be selected from four values using D7 and D6, and D5 and D4, respectively, of §3C.

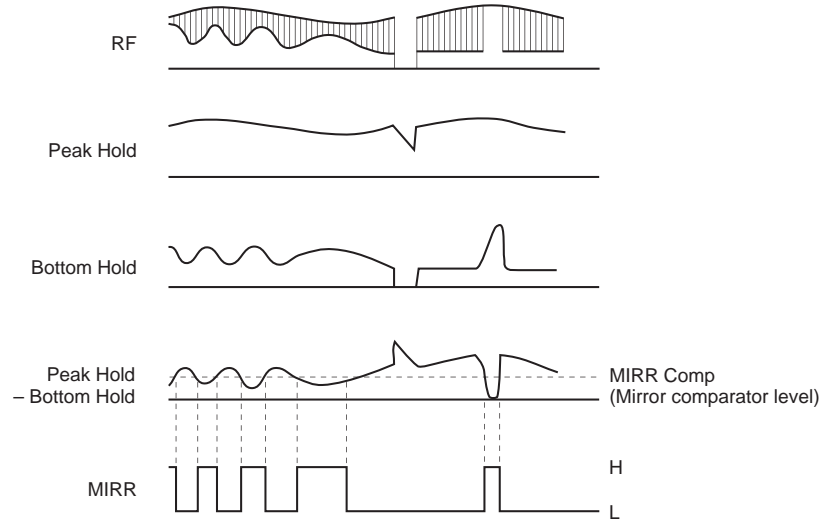


Fig. 5-11.

DFCT Signal Generation

The loaded RF signal is input to two peak hold circuits with different time constants, and the DFCT signal is generated by comparing the difference between these two peak hold waveforms with the DFCT comparator level. (See Fig. 5-12.)

The DFCT comparator level can be selected from four values using D13 and D12 of §3B.

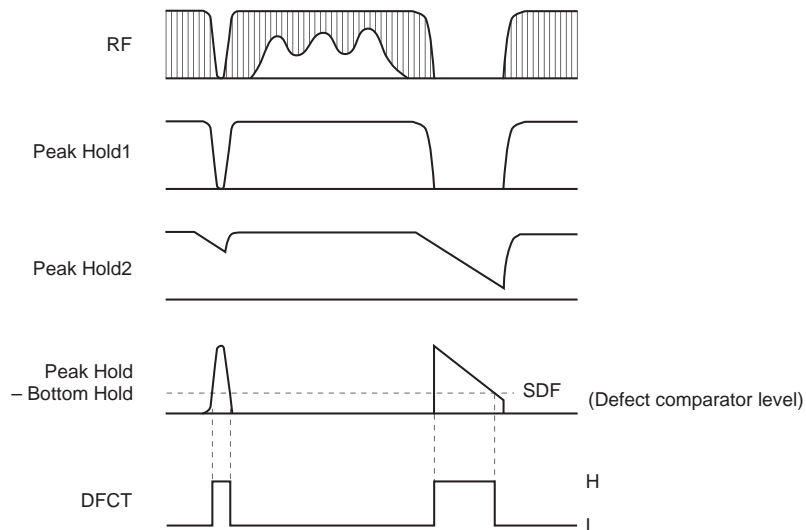


Fig. 5-12.

§5-10. DFCT Countermeasure Circuit

The DFCT countermeasure circuit maintains the directionality of the servo so that the servo does not become easily dislocated due to scratches or defects on discs.

Specifically, this operation is achieved by detecting scratches and defects with the DFCT signal generation circuit, and when DFCT goes high, applying the low-frequency component of the error signal before DFCT went high to the FCS and TRK servo filter inputs. (See Fig. 5-13.)

In addition, these operations are activated by the default. They can be disabled by setting D7 (DFSW) of \$38 to 1.

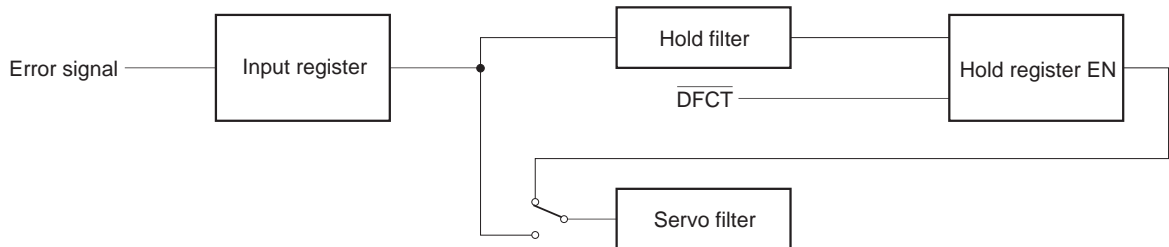


Fig. 5-13.

§5-11. Anti-Shock Circuit

When vibrations occur in the CD player, this circuit forces the TRK filter to switch to gain-up mode so that the servo does not become easily dislocated. This circuit is for systems which require vibration countermeasures. Concretely, vibrations are detected using an internal anti-shock filter and comparator circuit, and the gain is increased. (See Fig. 5-14.)

The comparator level is fixed to 1/16 of the maximum comparator input amplitude. However, the comparator level is practically variable by adjusting the value of the anti-shock filter output coefficient K35.

This function can be turned on and off by D19 of \$1 when the brake circuit (described hereafter) is off. (See Table 5-17.)

This circuit can also support an external vibration detection circuit, and can set the TRK servo filter to gain-up mode by inputting high level to the ATSK pin.

When the upper 4 bits of the command register are 1 (h), vibration detection can be monitored from the SENS pin. It can also be monitored from the ATSK pin by setting \$3F command ASOT to 1.

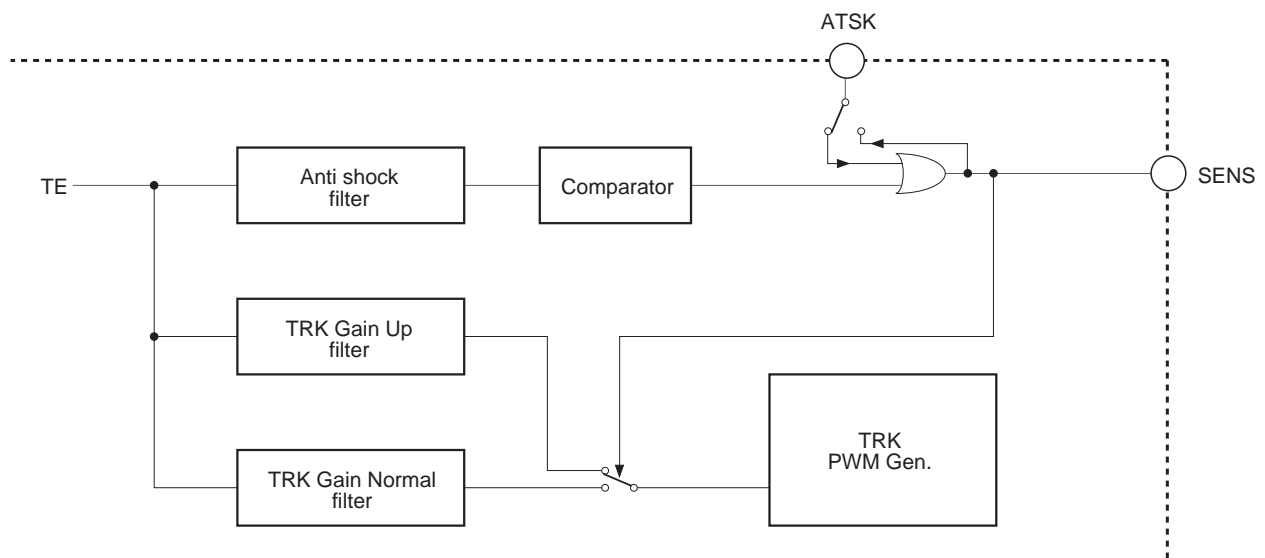


Fig. 5-14.

§5-12. Brake Circuit

Immediately after a long distance track jump it tends to be hard for the actuator to settle and for the servo to turn on.

The brake circuit prevents these phenomenon.

In principle, the brake circuit uses the tracking drive as a brake by cutting the unnecessary portions utilizing the 180° offset in the RF envelope and tracking error phase relationship which occurs when the actuator traverses the track in the radial direction from the inner track to the outer track and vice versa. (See Figs. 5-15 and 5-16.) Concretely, this operation is achieved by masking the tracking drive using the TRKCNCL signal generated by loading the MIRR signal at the edge of the TZC (Tracking Zero Cross) signal.

The brake circuit can be turned on and off by D18 of \$1. (See Table 5-17.)

In addition, the low frequency for the tracking drive after masking can be boosted. (SFBK1, 2 of \$34B)

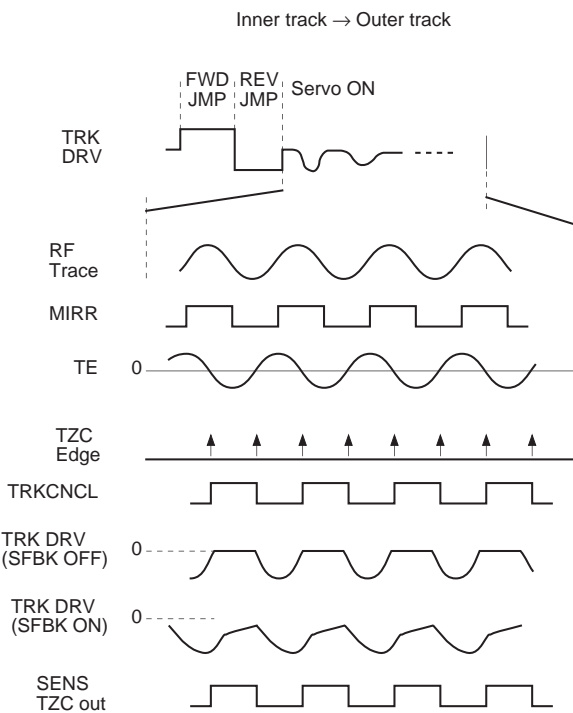


Fig. 5-15.

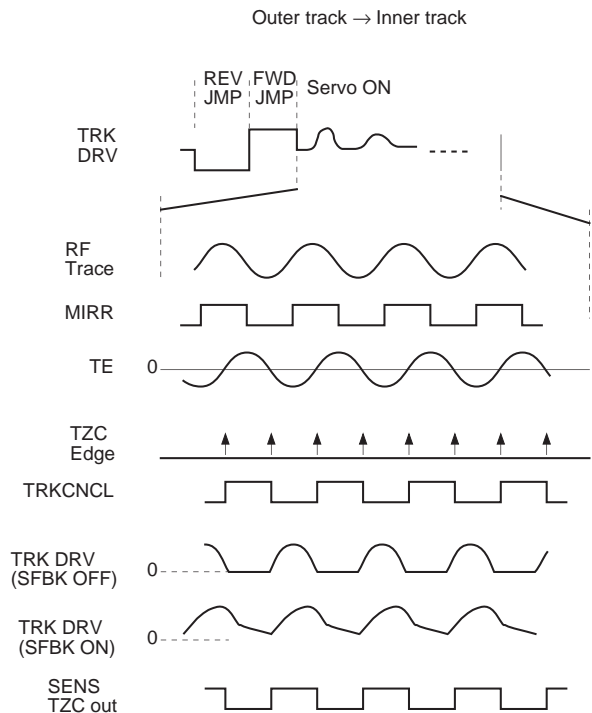


Fig. 5-16.

Register name	Command	D23 to D20	D19 to D16	
1	TRACKING CONTROL	0 0 0 1	1 0 * *	ANTI SHOCK ON
			0 * * *	ANTI SHOCK OFF
			* 1 * *	BRAKE ON
			* 0 * *	BRAKE OFF
			* * 0 *	TRACKING GAIN NORMAL
			* * 1 *	TRACKING GAIN UP
			* * * 1	TRACKING GAIN UP FILTER SELECT 1
			* * * 0	TRACKING GAIN UP FILTER SELECT 2

Table 5-17.

*: don't care

§5-13. COUT Signal

The COUT signal is output to count the number of tracks during traverse, etc. It is basically generated by loading the MIRR signal at both edges of the TZC signal. The used TZC signal can be selected from among three different phases according to the COUT signal application.

- HPTZC: For 1-track jumps
Fast phase COUT signal generation with a fast phase TZC signal. (The TZC phase is advanced by a cut-off 1kHz digital HPF; when MCK = 128Fs.)
- STZC: For COUT generation when MIRR is externally input and for applications other than COUT generation. This is generated by sampling the TE signal at 700kHz. (when MCK = 128Fs)
- DTZC: For high-speed traverse
Reliable COUT signal generation with a delayed phase STZC signal.

Since it takes some time to generate the MIRR signal, it is necessary to delay the TZC signal in accordance with the MIRR signal delay during high-speed traverse.

The COUT signal output method is switched with D15 and D14 of \$3C.

- When D15 = 1: STZC
- When D15 = 0 and D14 = 0: HPTZC
- When D15 = 0 and D14 = 1: DTZC

When DTZC is selected, the delay can be selected from two values with D14 of \$36.

§5-14. Serial Readout Circuit

The following measurement and adjustment results specified beforehand by serial command \$39 can be read out from the SENS pin by inputting the readout clock to the SCLK pin. (See Fig. 5-18, Table 5-19 and "Description of SENS Signals".)

Specified commands

- \$390C: VC AVRГ measurement result
- \$3908: FE AVRГ measurement result
- \$3904: TE AVRГ measurement result
- \$391F: RF AVRГ measurement result
- \$3953: FCS AGCNTL coefficient result
- \$3963: TRK AGCNTL coefficient result
- \$391C: TRVSC adjustment result
- \$391D: FBIAS register value

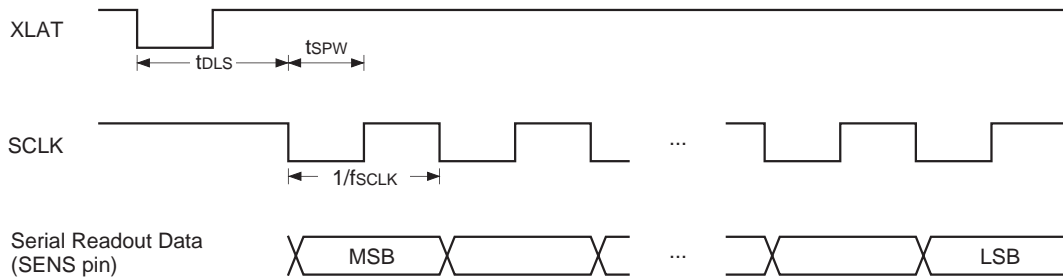


Fig. 5-18.

Item	Symbol	Min.	Typ.	Max.	Unit
SCLK frequency	fsCLK			16	MHz
SCLK pulse width	tSPW	31.3			ns
Delay time	tDLS	15			μs

Table 5-19.

During readout, the upper 8 bits of the command register must be 39 (h).

§5-17. Servo Status Changes Produced by LOCK Signal

When the LOCK signal becomes low, the TRK servo switches to the gain-up mode and the SLD servo turns off in order to prevent SLD free-running.

Setting D6 (LKSW) of \$38 to 1 deactivates this function.

In other words, neither the TRK servo nor the SLD servo change even when the LOCK signal becomes low. This enables microcomputer control.

§5-18. Description of Commands and Data Sets

\$34

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
0	KA6	KA5	KA4	KA3	KA2	KA1	KA0	KD7	KD6	KD5	KD4	KD3	KD2	KD1	KD0

When D15 = 0.

KA6 to KA0: Coefficient address

KD7 to KD0: Coefficient data

\$348 (preset: \$348 000)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
1	0	0	0	PGFS1	PGFS0	PFOK1	PFOK0	0	0	0	MRS	MRT1	MRT0	0	0

These commands set the GFS signal hold time. The hold time is inversely proportional to the playback speed.

PGFS1	PGFS0	Processing
0	0	High when the frame sync is at the correct timing, low when not the correct timing.
0	1	High when the frame sync is at the correct timing, low when continuously not the correct timing for 2ms or longer.
1	0	High when the frame sync is at the correct timing, low when continuously not the correct timing for 4ms or longer.
1	1	High when the frame sync is at the correct timing, low when continuously not the correct timing for 8ms or longer.

These commands set the FOK signal hold time. See \$3B for the FOK slice level.

These are the values when MCK = 128Fs, and the hold time is inversely proportional to the MCK setting.

PFOK1	PFOK0	Processing
0	0	High when the RFDC value is higher than the FOK slice level, low when lower than the FOK slice level.
0	1	High when the RFDC value is higher than the FOK slice level, low when continuously lower than the FOK slice level for 4.35ms or more.
1	0	High when the RFDC value is higher than the FOK slice level, low when continuously lower than the FOK slice level for 10.16ms or more.
1	1	High when the RFDC value is higher than the FOK slice level, low when continuously lower than the FOK slice level for 21.77ms or more.

MRS: This command switches the time constant for generating the MIRR comparator level of the MIRR generation circuit.

When 0, the time constant is normal. (default)

When 1, the time constant is longer than normal.

The time during which MIRR = high due to the effects of RFDC signal pulse noise, etc., can be suppressed by setting MRS = 1.

MRT1, 0: These commands limit the time while MIRR = high.

	MRT2	MRT1	MIRR maximum time [ms]
*	0	0	No time limit
	0	1	1.10
	1	0	2.20
	1	1	4.00

*: preset

\$34A (preset: \$34A 150)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
1	0	1	0	A/D SEL	COPY EN	EMPH D	CAT b8	DOU EN1	DOU DMUT	DOU WOD	WIN EN	DOU EN2	0	0	0

Command bit	Processing
A/DSEL = 0	Bit 1 of the channel status data is output as audio data.
A/DSEL = 1	Bit 1 of the channel status data is output as other than audio data.

Command bit	Processing
COPY EN1 = 0	Bit 2 of the channel status data is output as digital copy prohibited.
COPY EN1 = 1	Bit 2 of the channel status data is output as digital copy enabled.

Command bit	Processing
EMPH D = 0	Bit 3 of the channel status data is output as without pre-emphasis.
EMPH D = 1	Bit 3 of the channel status data is output as with pre-emphasis.

Command bit	Processing
CAT b8 = 0	Bit 8 of the channel status data is output as 0.
CAT b8 = 1	Bit 8 of the channel status data is output as 1.

Command bit	Processing
DOU EN = 0	The DOU signal, generated from the PCM data read out from the disc, is output.
DOU EN = 1	The DOU signal, generated from the DA interface input, is output.

\$34A commands cont.

Command bit	Processing
DOUT DMUT = 0	Digital Out output is normally output.
DOUT DMUT = 1	All the audio data portions are output in zero, with Digital Out output as it is.

Command bit	Processing
DOUT WOD = 0	The DOUT sync window is not open.
DOUT WOD = 1	The DOUT sync window is open.

Command bit	Processing
WIN EN = 0	Automatic synchronization to the input LRCK to match the phase with the internal processing is disabled.
WIN EN = 1	Automatic synchronization to the input LRCK to match the phase with the internal processing is enabled.

Command bit	Processing
DOUT EN2 = 0	Set to 0 when not generating Digital Out from the DA interface input.
DOUT EN2 = 1	Set to 1 when generating Digital Out from the DA interface input.

DOUT EN1	DOUT DMUT	MD2 pin	Other mute conditions	DOUT Mute	DOUT Mute F	DOUT output
0	—	0	—	—	—	OFF
0	—	1	0	0	0	0dB The output from the PCM data read out from a disc.
0	—	1	0	0	1	
0	—	1	0	1	0	-∞dB The output from the PCM data read out from a disc.
0	—	1	0	1	1	
0	—	1	1	0	0	
0	—	1	1	0	1	
0	—	1	1	1	0	
0	—	1	1	1	1	
1	0	—	—	—	—	0dB The output from the DA interface input.
1	1	—	—	—	—	-∞dB The output from the DA interface input.

—: don't care

* See "Mute conditions" (1) and (3) to (5) of \$AX commands for the other mute conditions.

* See \$8 commands for DOUT Mute and DOUT Mute F.

\$34B (preset: \$34B 000)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
1	0	1	1	SFBK1	SFBK2	0	0	0	0	0	0	0	0	0	0

The low frequency can be boosted for brake operation.
See §5-12 for brake operation.

SFBK1: When 1, brake operation is performed by setting the LowBooster-1 input to 0.
This is valid only when TLB1ON = 1. Preset is 0.

SFBK2: When 1, brake operation is performed by setting the LowBooster-2 input to 0.
This is valid only when TLB2ON = 1. Preset is 0.

\$34C (preset: \$34C 000)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
1	1	0	0	THBON	FHBON	TLB1ON	FLB1ON	TLB2ON	0	HBST1	HBST0	LB1S1	LB1S0	LB2S1	LB2S0

These bits turn on the boost function. (See §5-20. Filter Composition.)
There are five boosters (three for the TRK filter and two for the FCS filter) which can be turned on and off independently.

THBON: When 1, the high frequency is boosted for the TRK filter. Preset is 0.

FHBON: When 1, the high frequency is boosted for the FCS filter. Preset is 0.

TLB1ON: When 1, the low frequency is boosted for the TRK filter. Preset is 0.

FLB1ON: When 1, the low frequency is boosted for the FCS filter. Preset is 0.

TLB2ON: When 1, the low frequency is boosted for the TRK filter. Preset is 0.

The difference between TLB1ON and TLB2ON is the position where the low frequency is boosted.
For TLB1ON, the low frequency is boosted before the TRK jump, and for TLB2ON, after the TRK jump.

The following commands set the boosters. (See §5-20. Filter Composition.)

HBST1, HBST0: TRK and FCS HighBooster setting.

HighBooster has the configuration shown in Fig. 5-22a, and can select three different combinations of coefficients BK1, BK2 and BK3. (See Table 5-23a.)

An example of characteristics is shown in Fig. 5-24a.

These characteristics are the same for both the TRK and FCS filters.

The sampling frequency is 88.2kHz (when MCK = 128Fs).

LB1S1, LB1S0: TRK and FCS LowBooster-1 setting.

LowBooster-1 has the configuration shown in Fig. 5-22b, and can select three different combinations of coefficients BK4, BK5 and BK6. (See Table 5-23b.)

An example of characteristics is shown in Fig. 5-24b.

These characteristics are the same for both the TRK and FCS filters.

The sampling frequency is 88.2kHz (when MCK = 128Fs).

LB2S1, LB2S0: TRK LowBooster-2 setting.

LowBooster-2 has the configuration shown in Fig. 5-22c, and can select three different combinations of coefficients BK7, BK8 and BK9. (See Table 5-23c.)

An example of characteristics is shown in Fig. 5-24c.

This booster is used exclusively for the TRK filter.

The sampling frequency is 88.2kHz (when MCK = 128Fs).

Note) Fs = 44.1kHz

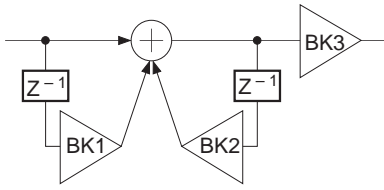


Fig. 5-22a

HBST1	HBST0	HighBooster setting		
		BK1	BK2	BK3
0	—	-120/128	96/128	2
1	0	-124/128	112/128	2
1	1	-126/128	120/128	2

Table 5-23a

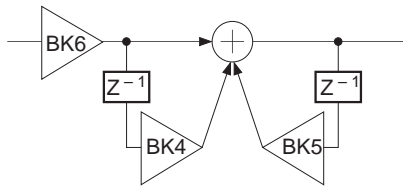


Fig. 5-22b

LB1S1	LB1S0	LowBooster-1 setting		
		BK4	BK5	BK6
0	—	-255/256	1023/1024	1/4
1	0	-511/512	2047/2048	1/4
1	1	-1023/1024	4095/4096	1/4

Table 5-23b

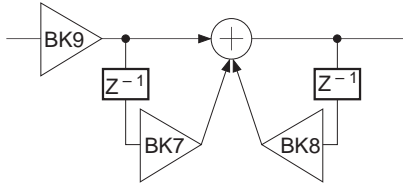


Fig. 5-22c

LB2S1	LB2S0	LowBooster-12 setting		
		BK7	BK8	BK9
0	—	-255/256	1023/1024	1/4
1	0	-511/512	2047/2048	1/4
1	1	-1023/1024	4095/4096	1/4

Table 5-23c

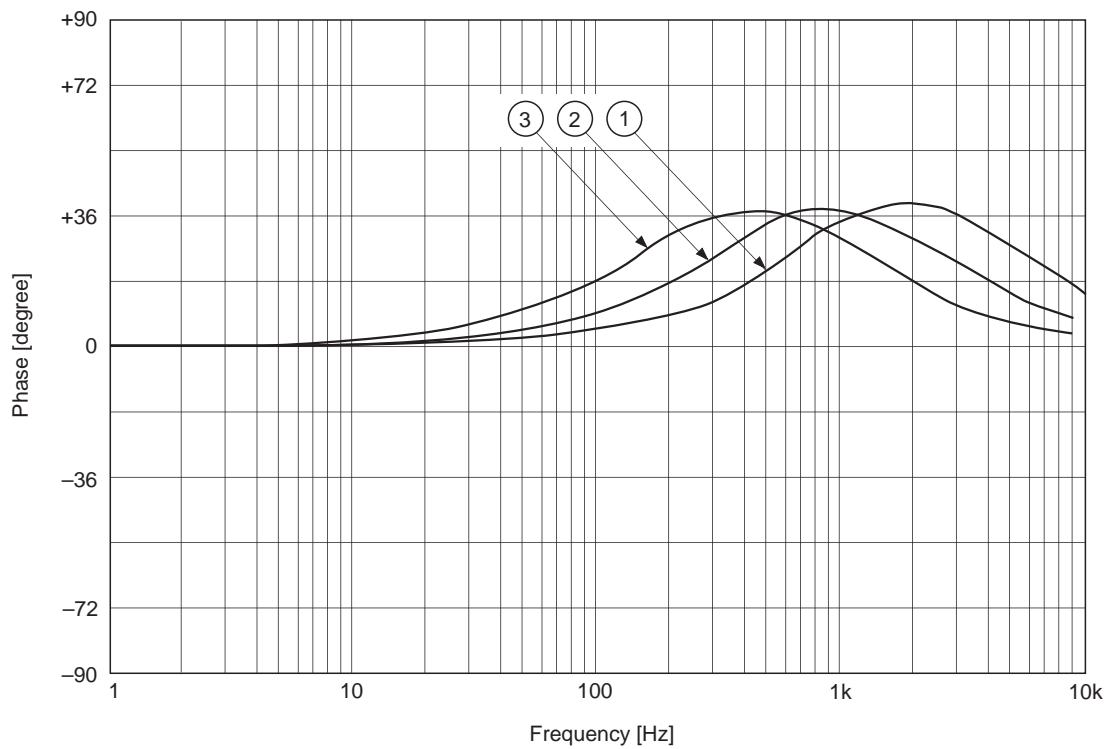
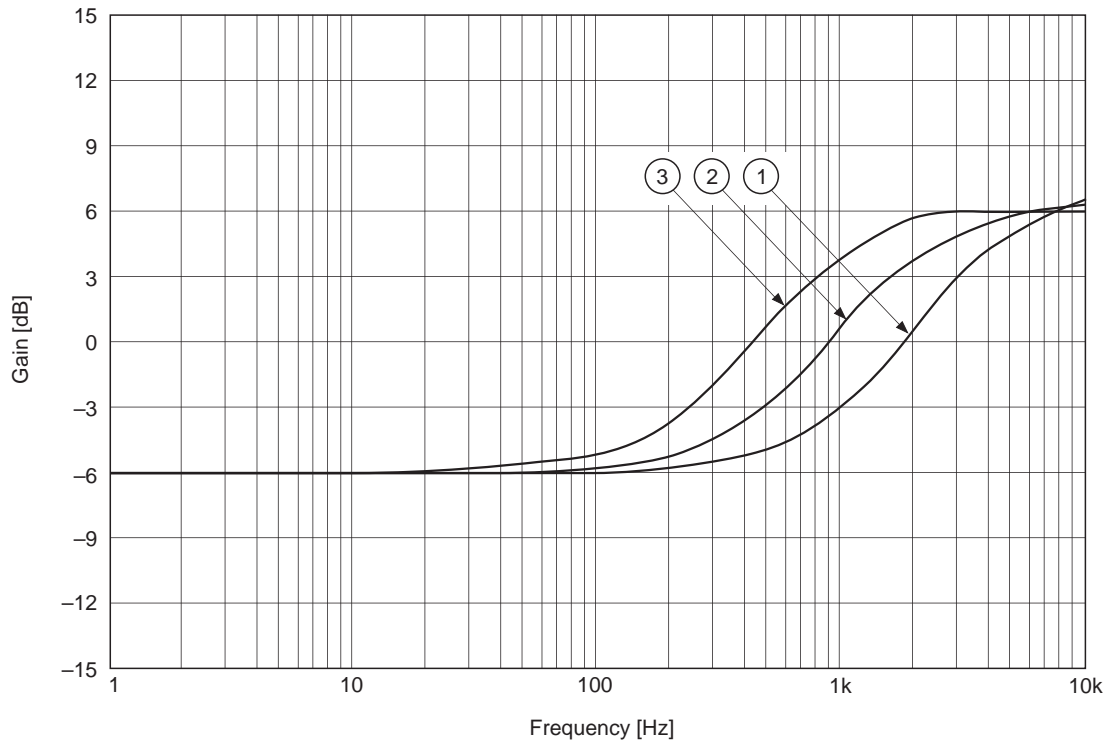


Fig. 5-24a. Servo HighBooster characteristics [FCS, TRK] (MCK = 128Fs)

- ① HBST1 = 0
- ② HBST1 = 1, HBST0 = 0
- ③ HBST1 = 1, HBST0 = 1

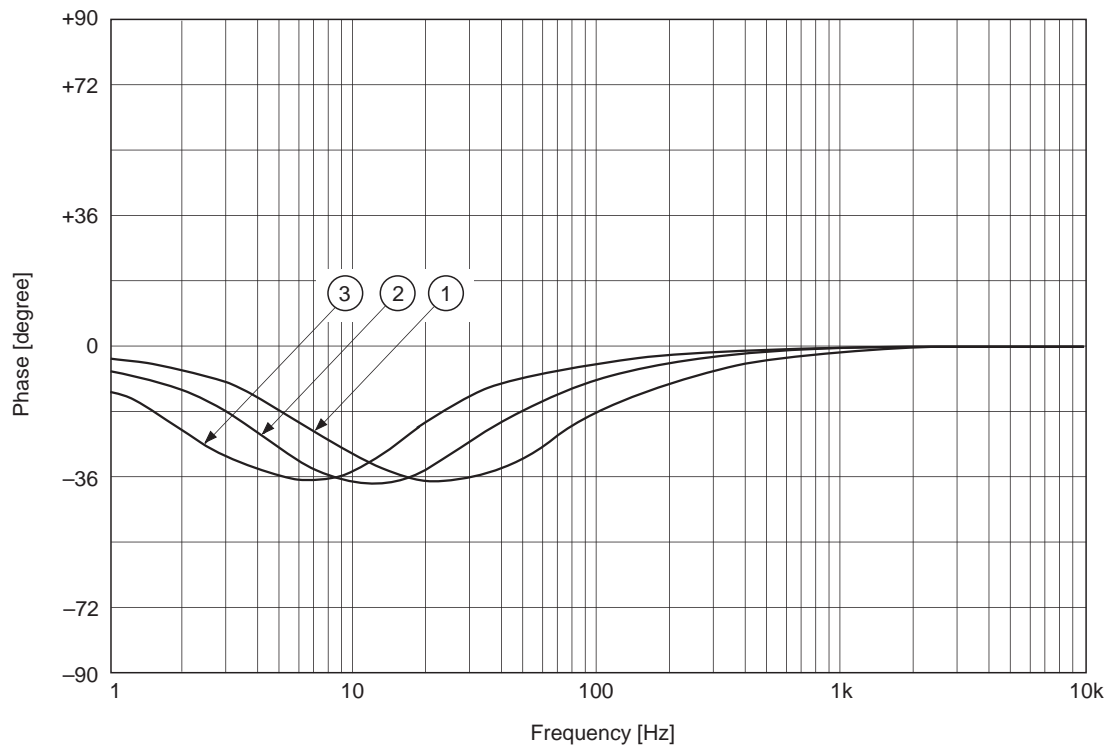
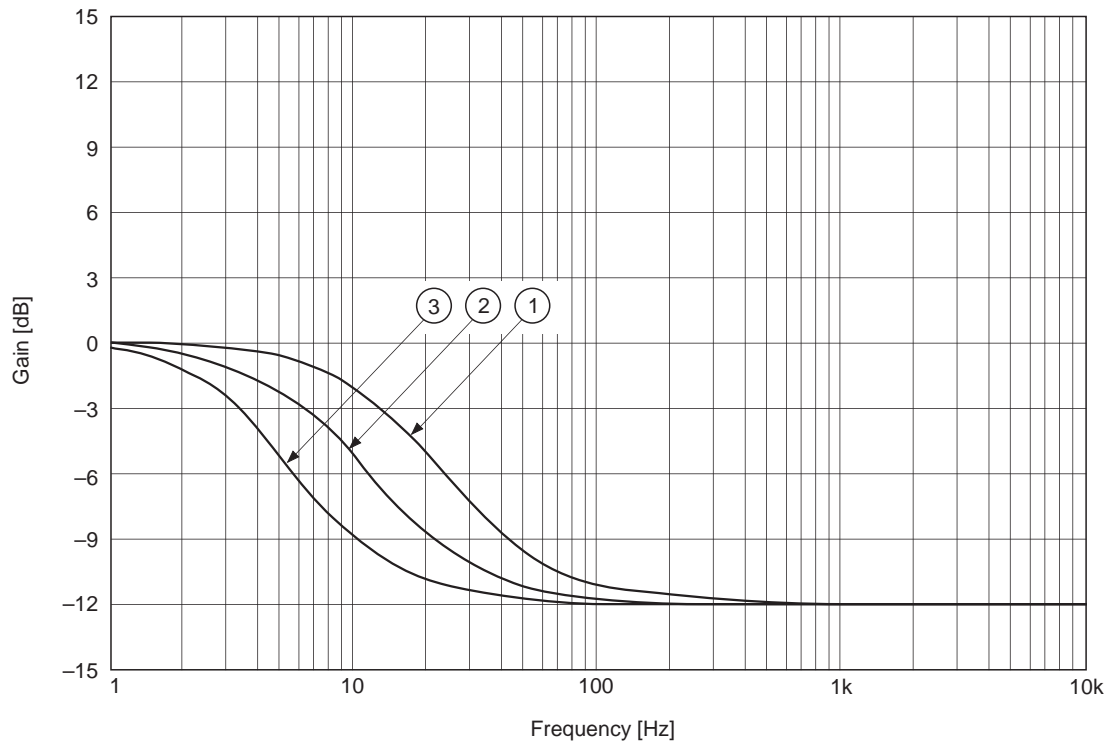


Fig. 5-24b. Servo LowBooster-1 characteristics [FCS, TRK] (MCK = 128Fs)

- ① LB1S1 = 0
- ② LB1S1 = 1, LB1S0 = 0
- ③ LB1S1 = 1, LB1S0 = 1

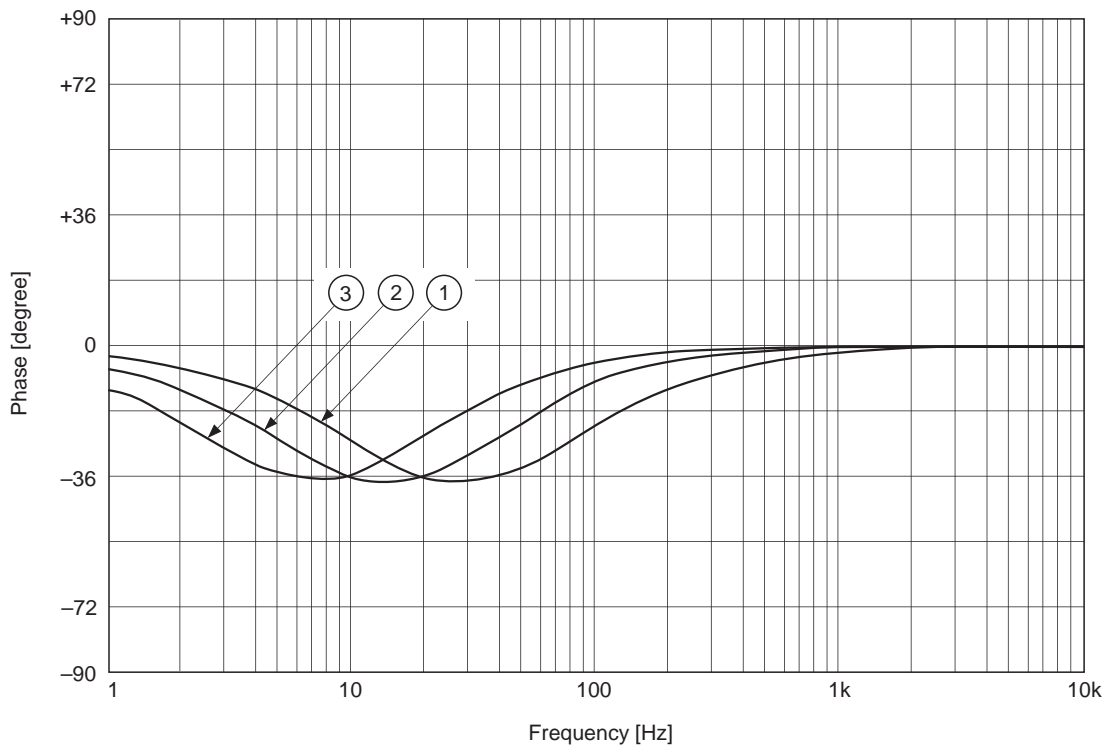
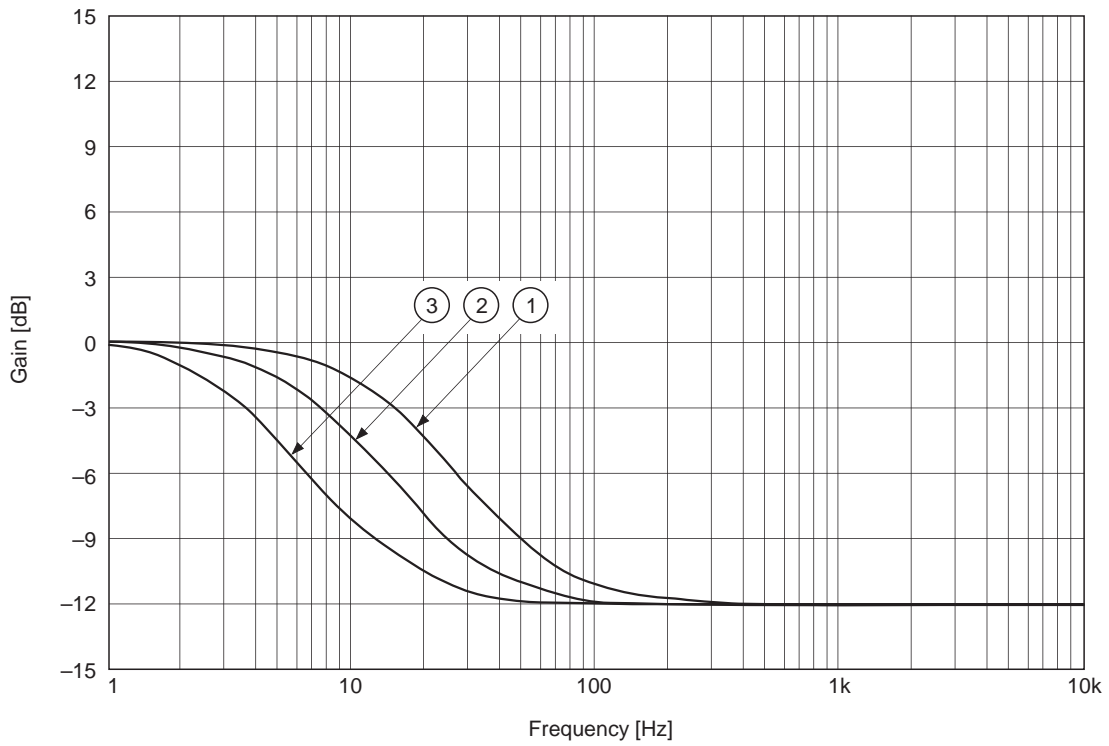


Fig. 5-24c. Servo LowBooster-2 characteristics [TRK] (MCK = 128Fs)

① LB2S1 = 0

② LB2S1 = 1, LB2S0 = 0

③ LB2S1 = 1, LB2S0 = 1

\$34E (preset: \$34E000)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
1	1	1	0	IDFSL3	IDFSL2	IDFSL1	IDFSL0	0	0	IDFT1	IDFT0	0	0	0	INVRFDC

IDFSL3: New DFCT detection output setting.
 When 0, only the DFCT signal described in §5-9 is detected and output from the DFCT pin. (default)
 When 1, the DFCT signal described in §5-9 and the new DFCT signal are switched and output from the DFCT pin.
 The switching timing is as follows.
 When the §5-9 DFCT signal is low, the new DFCT signal is output from the DFCT pin.
 When the §5-9 DFCT signal is high, this DFCT signal is output from the DFCT pin.
 In addition, the time at which the new DFCT signal can be output after the §5-9 DFCT signal switches to low can also be set. (See IDFT1, 0 of \$34E.)

IDFSL3	§5-9 DFCT	DFCT pin
0	L	§5-9 DFCT
0	H	§5-9 DFCT
1	L	New DFCT
1	H	§5-9 DFCT

IDFSL2: New DFCT detection time setting.
 DFCT = high is held for a certain time after new DFCT detection. This command sets that time.
 When 0, a long hold time. (default)
 When 1, a short hold time.

IDFSL1: New DFCT detection sensitivity setting.
 When 0, a high detection sensitivity. (default)
 When 1, a low detection sensitivity.

IDFSL0: New DFCT release sensitivity setting.
 When 0, a high release sensitivity. (default)
 When 1, a low release sensitivity.

IDFT1, 0: These commands set the time at which the new DFCT signal can be output (output prohibited time) after the §5-9 DFCT signal switches to low.

	IDFT1	IDFT0	New DFCT signal output prohibited time
*	0	0	204.08µs
	0	1	294.78µs
	1	0	408.16µs
	1	1	612.24µs

*: preset

INVRFDC: RFDC signal polarity inverted input setting.
 When 0, the RFDC signal polarity is set to non-inverted. (default)
 When 1, the RFDC signal polarity is set to inverted.

\$34F

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
1	1	1	1	1	0	FBL9	FBL8	FBL7	FBL6	FBL5	FBL4	FBL3	FBL2	FBL1	—

When D15 = D14 = D13 = D12 = D11 = 1 (\$34F)

D10 = 0

FBIAS LIMIT register write

FBL9 to FBL1: Data; data compared with FB9 to FB1, FBL9 = MSB.

When using the FBIAS register in counter mode, counter operation stops when the value of FB9 to FB1 matches with FBL9 to FBL1.

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
1	1	1	1	0	1	FB9	FB8	FB7	FB6	FB5	FB4	FB3	FB2	FB1	—

When D15 = D14 = D13 = D12 = 1 (\$34F)

D11 = 0, D10 = 1

FBIAS register write

FB9 to FB1: Data; two's complement data, FB9 = MSB.

For FE input conversion, FB9 to FB1 = 01111111 corresponds to $255/256 \times V_{DD}/4$ and FB9 to FB1 = 10000000 to $-256/256 \times V_{DD}/4$ respectively. (V_{DD} : supply voltage)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
1	1	1	1	0	0	TV9	TV8	TV7	TV6	TV5	TV4	TV3	TV2	TV1	TV0

When D15 = D14 = D13 = D12 = 1 (\$34F)

D11 = 0, D10 = 0

TRVSC register write

TV9 to TV0: Data; two's complement data, TV9 = MSB.

For TE input conversion, TV9 to TV0 = 0011111111 corresponds to $255/256 \times V_{DD}/4$ and TV9 to TV0 = 1100000000 to $-256/256 \times V_{DD}/4$ respectively. (V_{DD} : supply voltage)

- Notes)**
- When the TRVSC register is read out, the data length is 9 bits. At this time, data corresponding to each bit TV8 to TV0 during external write are read out.
 - When reading out internally measured values and then writing these values externally, set TV9 the same as TV8.

§35 (preset: §35 58 2D)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
FT1	FT0	FS5	FS4	FS3	FS2	FS1	FS0	FTZ	FG6	FG5	FG4	FG3	FG2	FG1	FG0

FT1, FT0, FTZ: Focus search-up speed
 Default value: 010 ($0.673 \times V_{DD}$ /s)
 Focus drive output conversion

FT1	FT0	FTZ	Focus search speed [V/s]
0	0	0	$1.35 \times V_{DD}$
* 0	1	0	$0.673 \times V_{DD}$
1	0	0	$0.449 \times V_{DD}$
1	1	0	$0.336 \times V_{DD}$
0	0	1	$1.79 \times V_{DD}$
0	1	1	$1.08 \times V_{DD}$
1	0	1	$0.897 \times V_{DD}$
1	1	1	$0.769 \times V_{DD}$

*: preset, V_{DD} : PWM driver supply voltage

FS5 to FS0: Focus search limit voltage
 Default value: 011000 ($(1 \pm 24/64) \times V_{DD}/2$, V_{DD} : PWM driver supply voltage)
 Focus drive output conversion

FG6 to FG0: AGF convergence gain setting value
 Default value: 0101101

§36 (preset: §36 0E 2E)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
TDZC	DTZC	TJ5	TJ4	TJ3	TJ2	TJ1	TJ0	SFJP	TG6	TG5	TG4	TG3	TG2	TG1	TG0

TDZC: Selects the TZC signal for generating the TRKCNCL signal during brake circuit operation.
 When 0, the edge of the HPTZC or STZC signal, whichever has the faster phase, is used.
 When 1, the edge of the HPTZC, STZC signal or the tracking drive signal zero-cross, whichever has the faster phase, is used. (See §5-12.)

DTZC: DTZC delay ($8.5/4.25\mu\text{s}$, when $MCK = 128Fs$)
 Default value: 0 ($4.25\mu\text{s}$)

TJ5 to TJ0: Track jump voltage
 Default value: 001110 ($(1 \pm 14/64) \times V_{DD}/2$, V_{DD} : PWM driver supply voltage)
 Tracking drive output conversion

SFJP: Surf jump mode on/off
 The tracking PWM output is generated by adding the tracking filter output and TJReg (TJ5 to TJ0), by setting D7 to 1 (on)

TG6 to TG0: AGT convergence gain setting value
 Default value: 0101110

\$37 (preset: \$37 50 BA)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
FZSH	FZSL	SM5	SM4	SM3	SM2	SM1	SM0	AGS	AGJ	AGGF	AGGT	AGV1	AGV2	AGHS	AGHT

FZSH, FZSL: FZC (Focus Zero Cross) slice level

Default value: 01 ($1/8 \times V_{DD}/2$, V_{DD} : supply voltage); FE input conversion

FZSH	FZSL	Slice level
0	0	$1/4 \times V_{DD}/2$
0	1	$1/8 \times V_{DD}/2$
1	0	$1/16 \times V_{DD}/2$
1	1	$1/32 \times V_{DD}/2$

*: preset

SM5 to SM0: Sled move voltage

Default value: 010000 ($(1 \pm 16/64) \times V_{DD}/2$, V_{DD} : PWM driver supply voltage)

Sled drive output conversion

AGS: AGCNTL self-stop on/off

Default value: 1 (on)

AGJ: AGCNTL convergence completion judgment time during low sensitivity adjustment (31/63ms, when MCK = 128Fs)

Default value: 0 (63ms)

AGGF: Focus AGCNTL internally generated sine wave amplitude (small/large)

Default value: 1 (large)

AGGT: Tracking AGCNTL internally generated sine wave amplitude (small/large)

Default value: 1 (large)

	FE/TE input conversion
AGGF 0 (small)	$1/32 \times V_{DD}/2$
1 (large)*	$1/16 \times V_{DD}/2$
AGGT 0 (small)	$1/16 \times V_{DD}/2$
1 (large)*	$1/8 \times V_{DD}/2$

*: preset

AGV1: AGCNTL convergence sensitivity during high sensitivity adjustment; high/low

Default value: 1 (high)

AGV2: AGCNTL convergence sensitivity during low sensitivity adjustment; high/low

Default value: 0 (low)

AGHS: AGCNTL high sensitivity adjustment on/off

Default value: 1 (on)

AGHT: AGCNTL high sensitivity adjustment time (128/256ms, when MCK = 128Fs)

Default value: 0 (256ms)

\$38 (preset: \$38 00 00)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
VCLM	VCLC	FLM	FLC0	RFLM	RFLC	AGF	AGT	DFSW	LKSW	TBLM	TCLM	FLC1	TLC2	TLC1	TLC0

DC offset cancel. See §5-3.

- * VCLM: VC level measurement (on/off)
- VCLC: VC level compensation for FCS In register (on/off)
- * FLM: Focus zero level measurement (on/off)
- FLC0: Focus zero level compensation for FZC register (on/off)
- * RFLM: RF zero level measurement (on/off)
- RFLC: RF zero level compensation (on/off)

Automatic gain control. See §5-6.

- AGF: Focus auto gain adjustment (on/off)
- AGT: Tracking auto gain adjustment (on/off)

Misoperation prevention circuit

- DFSW: Defect disable switch (on/off)
Setting this switch to 1 (on) disables the defect countermeasure circuit.
- LKSW: Lock switch (on/off)
Setting this switch to 1 (on) disables the sled free-running prevention circuit.

DC offset cancel. See §5-3.

- TBLM: Traverse center measurement (on/off)
- * TCLM: Tracking zero level measurement (on/off)
- FLC1: Focus zero level compensation for FCS In register (on/off)
- TLC2: Traverse center compensation (on/off)
- TLC1: Tracking zero level compensation (on/off)
- TLC0: VC level compensation for TRK/SLD In register (on/off)

Note) Commands marked with * are accepted every 2.9ms. (when MCK = 128Fs)

All commands are on when 1.

\$39 (preset: \$390000)

D15	D14	D13	D12	D11	D10	D9	D8
DAC	SD6	SD5	SD4	SD3	SD2	SD1	SD0

When \$3A command SVDA = 0

DAC: Serial data readout DAC mode setting.
 When 0, serial data cannot be read out. (default)
 When 1, serial data can be read out.

SD6 to SD0: These bits select the serial readout data.

D14	D13	D12	D11	D10	D9	D8	Readout data	Readout data length
SD6	SD5	SD4	SD3	SD2	SD1	SD0		
1	Coefficient RAM address						Coefficient RAM data	8 bits
0	1	Data RAM address					Data RAM data	16 bits
0	0	1	1	1	1	1	RF AVRG register	8 bits
0	0	1	1	1	1	0	RFDC input signal	8 bits
0	0	1	1	1	0	1	FCS Bias register	9 bits
0	0	1	1	1	0	0	TRVSC register	9 bits
0	0	1	0	1	0	0	DFCT count	8 bits
0	0	1	0	0	1	1	VC AVRG register	8 bits
0	0	1	0	0	1	0	FE AVRG register	8 bits
0	0	1	0	0	0	1	TE AVRG register	8 bits
0	0	0	1	1	*	*	RFDC (Bottom)	9 bits
0	0	0	1	0	*	*	RFDC (Peak)	9 bits
0	0	0	0	1	*	*	RFDC (Peak – Bottom)	9 bits
0	0	0	0	0	1	1	FE input signal	8 bits
0	0	0	0	0	1	0	TE input signal	8 bits
0	0	0	0	0	0	1	SE input signal	8 bits
0	0	0	0	0	0	0	VC input signal	8 bits

*: don't care

Note) When \$3A SVDA is changed, select the readout data again.

When \$3A command SVDA = 1

DAC: This command selects whether to set readout data for the left or right channel.
 When 0, right channel readout data is selected. (default)
 When 1, left channel readout data is selected.

SD6 to SD0: These bits select the data to be output from the left or right channel.

D14	D13	D12	D11	D10	D9	D8	Readout data	Readout data length
SD6	SD5	SD4	SD3	SD2	SD1	SD0		
0	1	Data RAM address					Data RAM data	16 bits
0	0	1	1	1	1	1	RF AVRG register	8 bits
0	0	1	1	1	1	0	RFDC input signal	8 bits
0	0	1	1	1	0	1	FCS Bias register	9 bits
0	0	1	1	1	0	0	TRVSC register	9 bits
0	0	0	1	1	*	*	VC AVRG register	9 bits
*1	0	0	1	0	*	*	FE AVRG register	9 bits
*2	0	0	0	1	*	*	TE AVRG register	9 bits
0	0	0	0	0	1	1	FE input signal	8 bits
0	0	0	0	0	1	0	TE input signal	8 bits
0	0	0	0	0	0	1	SE input signal	8 bits
0	0	0	0	0	0	0	VC input signal	8 bits

*: don't care

*1 Right channel preset

*2 Left channel preset

Note) Coefficient RAM data cannot be output from the audio DAC side.

Do not output RFDC (peak, bottom, peak-bottom) or the DFCT count from the audio DAC side.

When \$3A SVDA is changed, select the readout data again.

The DFCT count counts the number of times the DFCT signal rises while \$3994 is set.

Readout outputs the DFCT count at that time.

\$3A (preset: \$3A0000)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
0	FBON	FBSS	FBUP	FBV1	FBV0	FIFZC	TJDO	FPS1	FPS0	TPS1	TPS0	SVDA	SJHD	INBK	MTI0

FBON: FBIAS (focus bias) register operation setting.

FBSS
FBUP

FBON	FBSS	FBUP	Processing
0	0	—	FBIAS (focus bias) register addition off.
1	0	—	FBIAS (focus bias) register addition on.
1	1	0	FBIAS register acts as a down counter.
1	1	1	FBIAS register acts as an up counter.

FBV1, FBV0: FBIAS (focus bias) counter voltage switching.

The number of FCS BIAS count-up/-down steps per cycle is decided by these bits.

FBV1	FBV0	Number of steps per cycle
0	0	1
0	1	2
1	0	4
1	1	8

The counter changes once for each sampling cycle of the focus servo filter. When MCK is 128Fs, the sampling frequency is 88.2kHz. When converted to FE input, 1 step is approximately $1/2^9 \times V_{DD}/2$, V_{DD} = supply voltage.

*: preset

FIFZC: This selects the FZC slice level setting command.

When 0, the FZC slice level is determined by the \$37 FZSH and FZSL setting values. (default)
When 1, the FZC slice level is determined by the \$3F8 FIFZB3 to FIFZB0 and FIFZA3 to FIFZA0 setting values.

This allows more detailed setting and the addition of hysteresis compared to the \$37 FZSH and FZSL setting.

TJDO: This sets the tracking servo filter data RAM to 0 when switched from track jump to servo on only when SFJP = 1 (during surf jump operation).

FPS1, FPS0: Gain setting when transferring data from the focus filter to the PWM block.

TPS1, TPS0: Gain setting when transferring data from the tracking filter to the PWM block.

These are effective for increasing the overall gain in order to widen the servo band, etc.

Operation when FPS1, FPS0 (TPS1, TPS0) = 00 is the same as usual (7-bit shift). However, 6dB, 12dB and 18dB can be selected independently for focus and tracking by setting the relative gain to 0dB when FPS1, FPS0 (TPS1, TPS0) = 00.

FPS1	FPS0	Relative gain
0	0	0dB
0	1	+6dB
1	0	+12dB
1	1	+18dB

TPS1	TPS0	Relative gain
0	0	0dB
0	1	+6dB
1	0	+12dB
1	1	+18dB

*: preset

- SVDA: This allows the data set by the \$39 command to be output through the audio DAC.
 When 0, audio is output. (default)
 When 1, the data set by the \$39 command is output.
- SJHD: This holds the tracking filter output at the value when surf jump starts during surf jump.
- INBK: When INBK = 0 (off), the brake circuit masks the tracking drive signal with the TRKCNCL signal which is generated by taking the MIRR signal at the TZC edge. When INBK = 1 (on), the tracking filter input is masked instead of the drive output.
- MTI0: The tracking filter input is masked when the MIRR signal is high by setting MTI0 = 1 (on).

\$3B (preset: \$3B E0 50)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
SFO2	SFO1	SDF2	SDF1	MAX2	MAX1	SFOX	BTF	D2V2	D2V1	D1V2	D1V1	RINT	0	0	0

SFOX, SFO2, SFO1:

FOK slice level

Default value: 011 ($28/256 \times V_{DD}/2$, V_{DD} = supply voltage)

RFDC input conversion

SFOX	SFO2	SFO1	Slice level
0	0	0	$16/256 \times V_{DD}/2$
0	0	1	$20/256 \times V_{DD}/2$
0	1	0	$24/256 \times V_{DD}/2$
* 0	1	1	$28/256 \times V_{DD}/2$
1	0	0	$32/256 \times V_{DD}/2$
1	0	1	$40/256 \times V_{DD}/2$
1	1	0	$48/256 \times V_{DD}/2$
1	1	1	$56/256 \times V_{DD}/2$

*: preset

SDF2, SDF1: DFCT slice level

Default value: 10 ($0.0313 \times V_{DD}$)

RFDC input conversion

SDF2	SDF1	Slice level
0	0	$0.0156 \times V_{DD}$
0	1	$0.0234 \times V_{DD}$
* 1	0	$0.0313 \times V_{DD}$
1	1	$0.0391 \times V_{DD}$

*: preset, V_{DD} : supply voltage

MAX2, MAX1: DFCT maximum time (MCK = 128Fs)

Default value: 00 (no timer limit)

MAX2	MAX1	DFCT maximum time
* 0	0	No timer limit
0	1	2.00ms
1	0	2.36
1	1	2.72

*: preset

BTF: Bottom hold double-speed count-up mode for MIRR signal generation

On/off (default: off)

On when 1.

D2V2, D2V1: Peak hold 2 for DFCT signal generation

Count-down speed setting

Default value: 01 ($0.086 \times V_{DD}/\text{ms}$, 44.1kHz)

[V/ms] unit items indicate RFDC input conversion; [kHz] unit items indicate the operating frequency of the internal counter.

D2V2	D2V1	Count-down speed	
		[V/ms]	[kHz]
0	0	$0.0431 \times V_{DD}$	22.05
* 0	1	$0.0861 \times V_{DD}$	44.1
1	0	$0.172 \times V_{DD}$	88.2
1	1	$0.344 \times V_{DD}$	176.4

*: preset, V_{DD} : supply voltage

D1V2, D1V1: Peak hold 1 for DFCT signal generation

Count-down speed setting

Default value: 01 ($0.688 \times V_{DD}/\text{ms}$, 352.8kHz)

[V/ms] unit items indicate RFDC input conversion; [kHz] unit items indicate the operating frequency of the internal counter.

D1V2	D1V1	Count-down speed	
		[V/ms]	[kHz]
0	0	$0.344 \times V_{DD}$	176.4
* 0	1	$0.688 \times V_{DD}$	352.8
1	0	$1.38 \times V_{DD}$	705.6
1	1	$2.75 \times V_{DD}$	1411.2

*: preset, V_{DD} : supply voltage

RINT: This initializes the initial-stage registers of the circuits which generate MIRR, DFCT and FOK.

\$3C (preset: \$3C 00 80)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
COSS	COTS	CETZ	CETF	COT2	COT1	MOT2	0	BTS1	BTS0	MRC1	MRC0	0	0	0	0

COSS, COTS: These select the TZC signal used when generating the COUT signal.

COSS	COTS	TZC
1	—	STZC
0	0	HPTZC
0	1	DTZC

*: preset, —: don't care

STZC is the TZC generated by sampling the TE signal at 700kHz. (when MCK = 128Fs)
 DTZC is the delayed phase STZC. (The delay time can be selected by D14 of \$36.)
 HPTZC is the fast phase TZC passed through a HPF with a cut-off frequency of 1kHz.
 See §5-13.

CETZ: Normally, the input from the TE pin enters the TRK filter and is used to generate the TZC signal. However, the input from the CE pin can also be used. This function is for the center error servo.

When 0, the TZC signal is generated by using the signal input to the TE pin.

When 1, the TZC signal is generated by using the signal input to the CE pin.

CETF: When 0, the signal input to the TE pin is input to the TRK servo filter.

When 1, the signal input to the CE pin is input to the TRK servo filter.

These commands output the TZC signal.

COT2, COT1: The COUT signal is replaced by the TZC signal. Concretely, the TZC signal is output from the COUT pin and the TZC signal is used for auto sequence instead of the COUT signal.

COT2	COT1	COUT pin output
1	—	STZC
0	1	HPTZC
0	0	COUT

*: preset, —: don't care

MOT2: The MIRR signal is replaced by the STZC signal. Concretely, the STZC signal is output from the MIRR pin and the STZC signal is used for generating the COUT signal instead of the MIRR signal.

These commands set the MIRR signal generation circuit.

BTS1, BTS0: These set the count-up speed for the bottom hold value of the MIRR generation circuit. The time per step is approximately 708ns (when MCK = 128Fs). The preset value is BTS1 = 1, BTS0 = 0 like the CXD2586R. These bits are valid only when BTF of \$3B is 0.

MRC1, MRC0: These set the minimum pulse width for masking the MIRR signal of the MIRR generation circuit. As noted in §5-9, the MIRR signal is generated by comparing the waveform obtained by subtracting the bottom hold value from the peak hold value with the MIRR comparator level. Strictly speaking, however, for MIRR to become high, these levels must be compared continuously for a certain time. These bits set that time. The preset value is MRC1 = 0, MRC0 = 0 like the CXD2586R.

BTS1	BTS0	Number of count-up steps per cycle
0	0	1
0	1	2
1	0	4
1	1	8

MRC1	MRC0	Setting time [μs]
0	0	5.669 *
0	1	11.338
1	0	22.675
1	1	45.351

*: preset (when MCK = 128Fs)

\$3D (preset: \$3D 00 00)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
SFID	SFSK	THID	THSK	ABEF	TLD2	TLD1	TLD0	0	0	0	0	0	0	0	0

- SFID:** SLED servo filter input can be obtained not from SLD in Reg, but from M0D, which is the TRK filter second-stage output.
When the low frequency component of the tracking error signal obtained from the RF amplifier is attenuated, the low frequency can be amplified and input to the SLD servo filter.
- SFSK:** Only during TRK servo gain up2 operation, coefficient K30 is used instead of K00. Normally, the DC gain between the TE input pin and M0D changes for TRK filter gain normal and gain up2, and error occurs in the DC level at M0D. In this case, the DC level of the signal transmitted to M00 can be kept uniform by adjusting the K30 value even during the above switching.
- THID:** TRK hold filter input can be obtained not from SLD in Reg, but from M0D, which is the TRK filter second-stage output.
When signals other than the tracking error signal from the RF amplifier are input to the SE input pin, the signal transmitted from the TE pin can be obtained as TRK hold filter input.
- THSK:** Only during TRK servo gain up2 operation, coefficient K46 is used instead of K40. Normally, the DC gain between the TE input pin and M0D changes for TRK filter gain normal and gain up2, and error occurs in the DC level at M0D. In this case, the DC level of the signal transmitted to M18 can be kept uniform by adjusting the K46 value even during the above switching.
* See "§5-20. Filter Composition" regarding the SFID, SFSK, THID and THSK commands.
- ABEF:** The focus error (FE) and tracking error (TE) can be generated internally.
When 0, the FE and TE signal input mode results. Input each error signal through the FE and TE pins. (default)
When 1, the FE and TE signal generation mode results and the FE and TE signals are generated internally.
- TLD0 to 2:** These turn on and off SLD filter correction independently of the TRK filter.
See \$38 (TLC0 to TLC2) and Fig. 5-3.

TLC2	TLD2	Traverse center correction	
		TRK filter	SLD filter
* 0	—	OFF	OFF
1	0	ON	ON
	1	ON	OFF

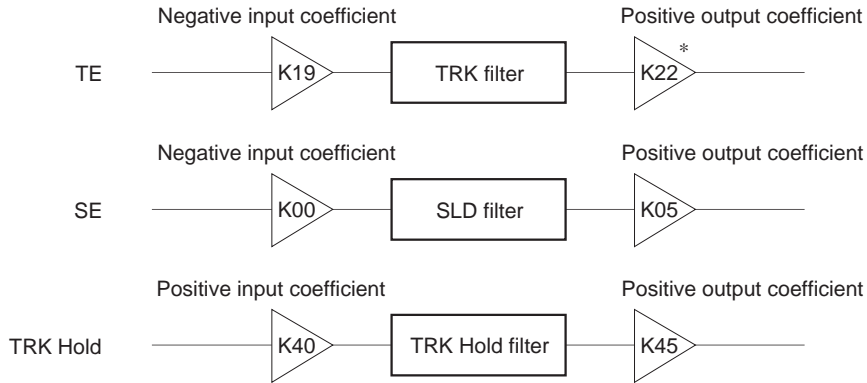
TLC1	TLD1	Tracking zero level correction	
		TRK filter	SLD filter
* 0	—	OFF	OFF
1	0	ON	ON
	1	ON	OFF

TLC0	TLD0	VC level correction	
		TRK filter	SLD filter
* 0	—	OFF	OFF
1	0	ON	ON
	1	ON	OFF

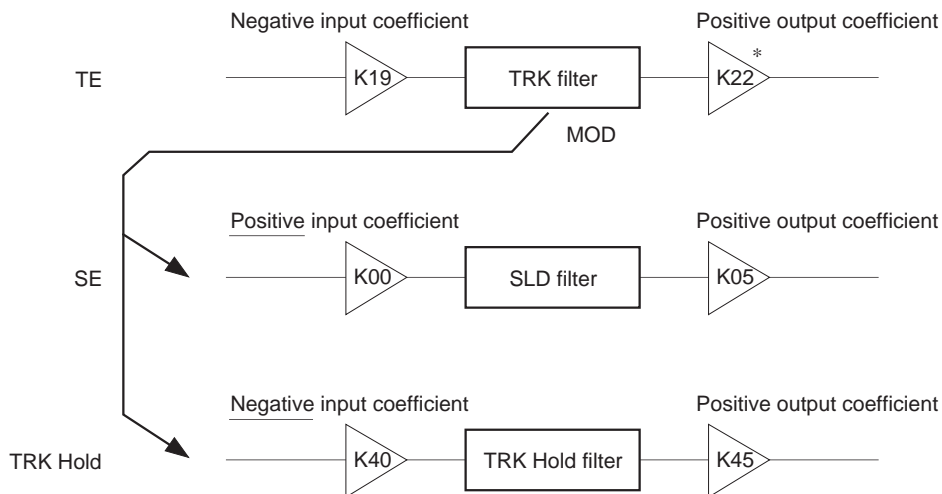
*: preset, —: don't care

- Input coefficient sign inversion when SFID = 1 and THID = 1

The preset coefficients for the TRK filter are negative for input and positive for output. With this, the CXD3027R outputs servo drives which have the reversed phase of input errors.



When SFID = 1, the TRK filter negative input coefficient is applied to the SLD filter, so the SLD input coefficient (K00) sign must be inverted. (For example, inverting the sign for coefficient K00: E0h results in 20h.) For the same reason, when THID = 1, the TRK hold input coefficient (K40) sign must be inverted.



* For TRK servo gain normal
See §5-20. Filter Composition".

\$3E (preset: \$3E 00 00)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
F1NM	F1DM	F3NM	F3DM	T1NM	T1UM	T3NM	T3UM	DFIS	TLCD	0	LKIN	COIN	MDFI	MIRI	XT1D

- F1NM, F1DM: Quasi double accuracy setting for FCS servo filter first-stage
 On when 1; default is 0.
 F1NM: Gain normal
 F1DM: Gain down
- T1NM, T1UM: Quasi double accuracy setting for TRK servo filter first-stage
 On when 1; default is 0.
 T1NM: Gain normal
 T1UM: Gain up
- F3NM, F3DM: Quasi double accuracy setting for FCS servo filter third-stage
 On when 1; default is 0.
 Generally, the advance amount of the phase increases by partially setting the FCS servo third-stage filter which is used as the phase compensation filter to double accuracy.
 F3NM: Gain normal
 F3DM: Gain down
- T3NM, T3UM: Quasi double accuracy setting for TRK servo filter third-stage
 On when 1; default is 0.
 Generally, the advance amount of the phase increases by partially setting the TRK servo third-stage filter which is used as the phase compensation filter to double accuracy.
 T3NM: Gain normal
 T3UM: Gain up

Note) Filter first- and third-stage quasi double accuracy settings can be set individually.
 See "\$5-20 Filter Composition" at the end of this specification concerning quasi double accuracy.

- DFIS: FCS hold filter input extraction node selection
 0: M05 (Data RAM address 05); default
 1: M04 (Data RAM address 04)
- TLCD: This command masks the TLC2 command set by D2 of \$38 only when FOK is low.
 On when 1; default is 0
- LKIN: When 0, the internally generated LOCK signal is output to the LOCK pin. (default)
 When 1, the LOCK signal can be input from an external source to the LOCK pin.
- COIN: When 0, the internally generated COUT signal is output to the COUT pin. (default)
 When 1, the COUT signal can be input from an external source to the COUT pin.

The MIRR, DFCT and FOK signals can also be input from an external source.

- MDFI: When 0, the MIRR, DFCT and FOK signals are generated internally. (default)
 When 1, the MIRR, DFCT and FOK signals can be input from an external source through the MIRR, DFCT and FOK pins.
- MIRI: When 0, the MIRR signal is generated internally. (default)
 When 1, the MIRR signal can be input from an external source through the MIRR pin.

	MDFI	MIRI	
*	0	0	MIRR, DFCT and FOK are all generated internally.
	0	1	MIRR only is input from an external source.
	1	—	MIRR, DFCT and FOK are all input from an external source.

*: preset, —: don't care

- XT1D: The input to the servo master clock is used without being frequency-divided by setting XT1D to 1.
 This command takes precedence over the XTSL pin, XT2D and XT4D. See the description of \$3F for XT2D and XT4D.

\$3F (preset: \$3F 00 00)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
0	AGG4	XT4D	XT2D	0	DRR2	DRR1	DRR0	0	ASFG	FTQ	LPAS	SRO1	0	AGHF	ASOT

AGG4: This varies the amplitude of the internally generated sine wave using the AGGF and AGGT commands during AGC.
 When AGG4 = 0, the default is used. When AGG4 = 1, the setting is as shown in the table below.

AGG4	AGGF	AGGT	Sine wave amplitude	
			FE input conversion	TE input conversion
0	0	—	$1/32 \times V_{DD}/2$	—
	1	—	$1/16 \times V_{DD}/2^*$	—
	—	0	—	$1/16 \times V_{DD}/2$
	—	1	—	$1/8 \times V_{DD}/2^*$
1	0	0	$1/64 \times V_{DD}/2$	
	0	1	$1/32 \times V_{DD}/2$	
	1	0	$1/16 \times V_{DD}/2$	
	1	1	$1/8 \times V_{DD}/2$	

See \$37 for AGGF and AGGT.
 The presets are AGG4 = 0, AGGF = 1 and AGGT = 1.

*: preset, —: don't care

XT4D, XT2D: MCK (digital servo master clock) frequency division ratio setting
 This command forcibly sets the frequency division ratio to 1/4, 1/2 or 1/1 when MCK is generated.
 See the description of \$3E for XT1D. Also, see "\$5-2. Digital Servo Block Master Clock (MCK)".

	XT1D	XT2D	XT4D	Frequency division ratio
*	0	0	0	According to XTSL
	1	—	—	1/1
	0	1	—	1/2
	0	0	1	1/4

*: preset, —: don't care

DRR2 to DRR0: Partially clears the Data RAM values (0 write).

The following values are cleared when 1 (on) respectively; default is 0

DRR2: M08, M09, M0A

DRR1: M00, M01, M02

DRR0: M00, M01, M02 only when LOCK = low

Note) Set DRR1 and DRR0 on for 50µs or more.

ASFG: When vibration detection is performed during anti-shock circuit operation, the FCS servo filter is forcibly set to gain normal status.

On when 1; default is 0

FTQ: The slope of the output during focus search is 1/4 the conventional output slope. On when 1; default is 0

LPAS: Built-in analog buffer low-current consumption mode
 This mode reduces the total analog buffer current consumption for the VC, TE, SE and FE input analog buffers by using a single operational amplifier.
 On when 1; default is 0
Note) When using this mode, first check whether each error signal is properly A/D converted using data readout, etc.

SRO1: This command is used to continuously externally output various data inside the digital servo block which have been specified with the \$39 command. (However, D15 (DAC) of \$39 must be set to 1.)
 Digital output (SOCK, XOLT and SOUT) can be obtained from three specified pins by setting this command to 1.

	SRO1 = 1
SOLK	Output from XPCK pin.
XOLT	Output from GFS pin.
SOUT	Output from XUGF pin.

AGHF: This halves the frequency of the internally generated sine wave during AGC.
ASOT: The anti-shock signal, which is internally detected, is output from the ATSK pin. Output when 1; default is 0.
 Vibration detection when a high signal is output for the anti-shock signal output.

\$3F8 (preset: \$3F8800)

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
1	0	0	0	SYG3	SYG2	SYG1	SYG0	FIFZB3	FIFZB2	FIFZB1	FIFZB0	FIFZA3	FIFZA2	FIFZA1	FIFZA0

SYG3 to SYG0: These simultaneously set the focus drive, tracking drive and sled drive output gains. See the \$AF and \$CX commands for the spindle drive output gain setting.

SYG3	SYG2	SYG1	SYG0	GAIN
0	0	0	0	0 ($-\infty$ dB)
0	0	0	1	0.125 (-18.1dB)
0	0	1	0	0.250 (-12.0dB)
0	0	1	1	0.375 (-8.5dB)
0	1	0	0	0.500 (-6.0dB)
0	1	0	1	0.625 (-4.1dB)
0	1	1	0	0.750 (-2.5dB)
0	1	1	1	0.875 (-1.2dB)
*	1	0	0	1.000 (0.0dB)
	1	0	1	1.125 (+1.0dB)
	1	0	1	1.250 (+1.9dB)
	1	0	1	1.375 (+2.8dB)
	1	1	0	1.500 (+3.5dB)
	1	1	0	1.625 (+4.2dB)
	1	1	1	1.750 (+4.9dB)
	1	1	1	1.875 (+5.5dB)

*: preset

FIFZB3 to FIFZB0:

This sets the slice level at which FZC changes from high to low.

FIFZA3 to FIFZA0:

This sets the slice level at which FZC changes from low to high.

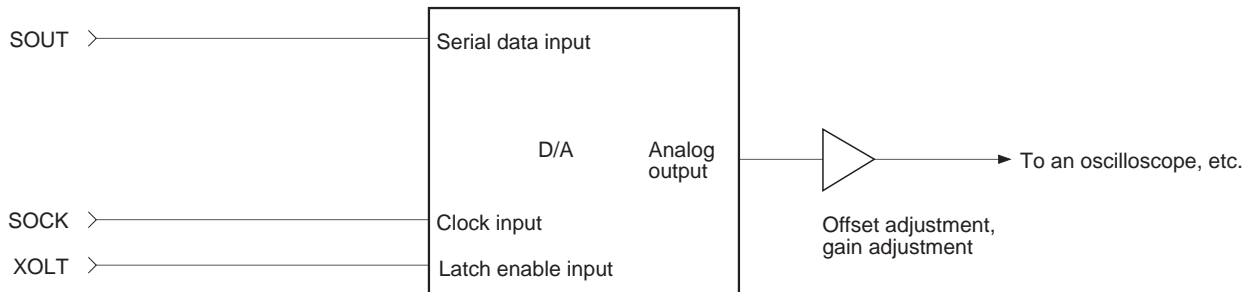
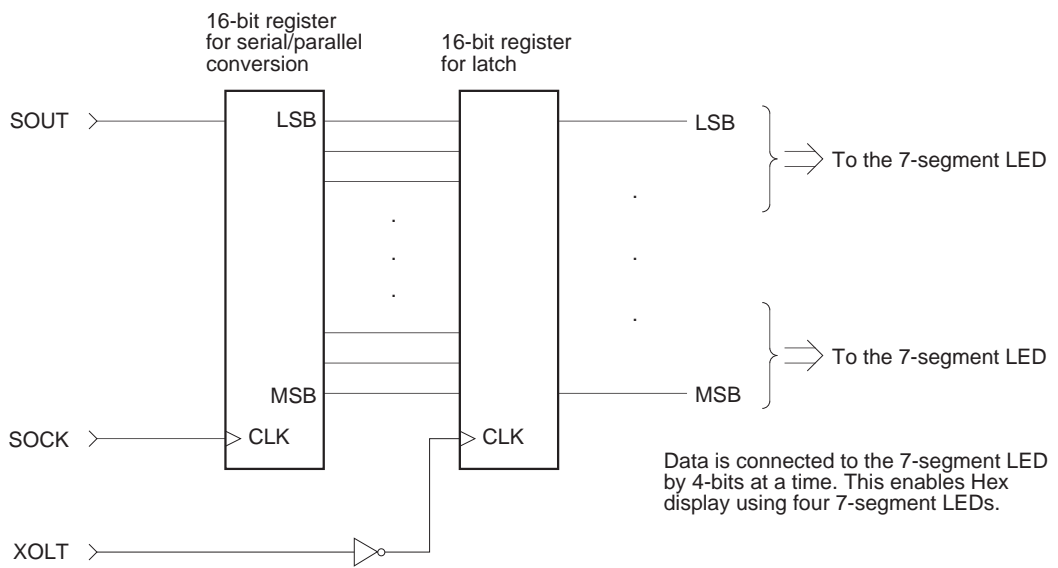
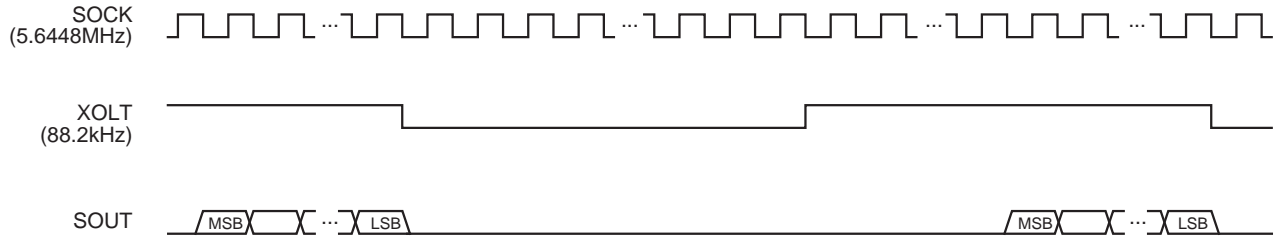
The FIFZB3 to FIFZB0 and FIFZA3 to FIFZA0 setting values are valid only when \$3A FIFZC is 1.

Set so that the FIFZB3 to FIFZB0 \leq FIFZA3 to FIFZA0.

Hysteresis can be added to the slice level by setting FIFZB3 to FIFZB0 < FIFZA3 to FIFZA0.

$$\text{FZC slice level} = \frac{\text{FIFZB3 to FIFZB0 or FIFZA3 to FIFZA0 setting value}}{32} \times 0.5 \times V_{DD} \text{ [V]}$$

Description of Data Readout



Waveforms can be monitored with an oscilloscope using a serial input-type D/A converter as shown above.

§5-19. List of Servo Filter Coefficients

<Coefficient Preset Value Table (1)>

ADDRESS	DATA	CONTENTS
K00	E0	SLED INPUT GAIN
K01	81	SLED LOW BOOST FILTER A-H
K02	23	SLED LOW BOOST FILTER A-L
K03	7F	SLED LOW BOOST FILTER B-H
K04	6A	SLED LOW BOOST FILTER B-L
K05	10	SLED OUTPUT GAIN
K06	14	FOCUS INPUT GAIN
K07	30	SLED AUTO GAIN
K08	7F	FOCUS HIGH CUT FILTER A
K09	46	FOCUS HIGH CUT FILTER B
K0A	81	FOCUS LOW BOOST FILTER A-H
K0B	1C	FOCUS LOW BOOST FILTER A-L
K0C	7F	FOCUS LOW BOOST FILTER B-H
K0D	58	FOCUS LOW BOOST FILTER B-L
K0E	82	FOCUS PHASE COMPENSATE FILTER A
K0F	7F	FOCUS DEFECT HOLD GAIN
K10	4E	FOCUS PHASE COMPENSATE FILTER B
K11	32	FOCUS OUTPUT GAIN
K12	20	ANTI SHOCK INPUT GAIN
K13	30	FOCUS AUTO GAIN
K14	80	HPTZC / Auto Gain HIGH PASS FILTER A
K15	77	HPTZC / Auto Gain HIGH PASS FILTER B
K16	80	ANTI SHOCK HIGH PASS FILTER A
K17	77	HPTZC / Auto Gain LOW PASS FILTER B
K18	00	Fix*
K19	F1	TRACKING INPUT GAIN
K1A	7F	TRACKING HIGH CUT FILTER A
K1B	3B	TRACKING HIGH CUT FILTER B
K1C	81	TRACKING LOW BOOST FILTER A-H
K1D	44	TRACKING LOW BOOST FILTER A-L
K1E	7F	TRACKING LOW BOOST FILTER B-H
K1F	5E	TRACKING LOW BOOST FILTER B-L
K20	82	TRACKING PHASE COMPENSATE FILTER A
K21	44	TRACKING PHASE COMPENSATE FILTER B
K22	18	TRACKING OUTPUT GAIN
K23	30	TRACKING AUTO GAIN
K24	7F	FOCUS GAIN DOWN HIGH CUT FILTER A
K25	46	FOCUS GAIN DOWN HIGH CUT FILTER B
K26	81	FOCUS GAIN DOWN LOW BOOST FILTER A-H
K27	3A	FOCUS GAIN DOWN LOW BOOST FILTER A-L
K28	7F	FOCUS GAIN DOWN LOW BOOST FILTER B-H
K29	66	FOCUS GAIN DOWN LOW BOOST FILTER B-L
K2A	82	FOCUS GAIN DOWN PHASE COMPENSATE FILTER A
K2B	44	FOCUS GAIN DOWN DEFECT HOLD GAIN
K2C	4E	FOCUS GAIN DOWN PHASE COMPENSATE FILTER B
K2D	1B	FOCUS GAIN DOWN OUTPUT GAIN
K2E	00	NOT USED
K2F	00	NOT USED

* Fix indicates that normal preset values should be used.

<Coefficient Preset Value Table (2)>

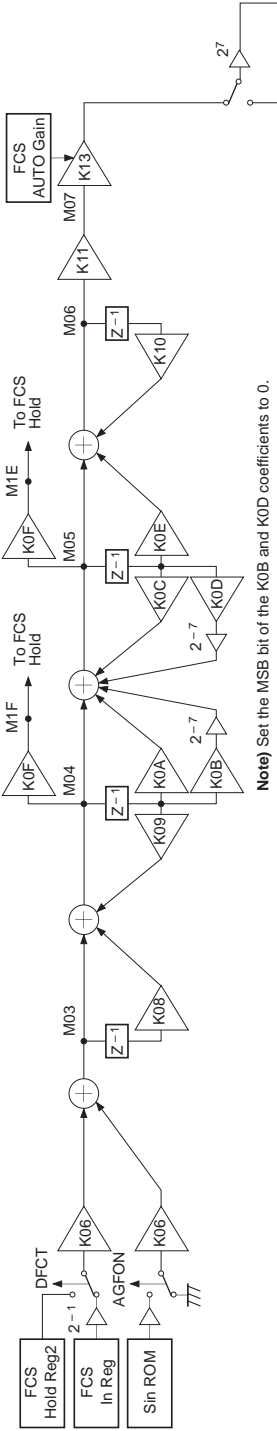
ADDRESS	DATA	CONTENTS
K30	80	SLED INPUT GAIN (Only when TRK gain up2 is accessed with SFSK = 1.)
K31	66	ANTI SHOCK LOW PASS FILTER B
K32	00	NOT USED
K33	7F	ANTI SHOCK HIGH PASS FILTER B-H
K34	6E	ANTI SHOCK HIGH PASS FILTER B-L
K35	20	ANTI SHOCK FILTER COMPARATE GAIN
K36	7F	TRACKING GAIN UP2 HIGH CUT FILTER A
K37	3B	TRACKING GAIN UP2 HIGH CUT FILTER B
K38	80	TRACKING GAIN UP2 LOW BOOST FILTER A-H
K39	44	TRACKING GAIN UP2 LOW BOOST FILTER A-L
K3A	7F	TRACKING GAIN UP2 LOW BOOST FILTER B-H
K3B	77	TRACKING GAIN UP2 LOW BOOST FILTER B-L
K3C	86	TRACKING GAIN UP PHASE COMPENSATE FILTER A
K3D	0D	TRACKING GAIN UP PHASE COMPENSATE FILTER B
K3E	57	TRACKING GAIN UP OUTPUT GAIN
K3F	00	NOT USED
K40	04	TRACKING HOLD FILTER INPUT GAIN
K41	7F	TRACKING HOLD FILTER A-H
K42	7F	TRACKING HOLD FILTER A-L
K43	79	TRACKING HOLD FILTER B-H
K44	17	TRACKING HOLD FILTER B-L
K45	6D	TRACKING HOLD FILTER OUTPUT GAIN
K46	00	TRACKING HOLD FILTER INPUT GAIN (Only when TRK gain up2 is accessed with THSK = 1.)
K47	00	NOT USED
K48	02	FOCUS HOLD FILTER INPUT GAIN
K49	7F	FOCUS HOLD FILTER A-H
K4A	7F	FOCUS HOLD FILTER A-L
K4B	79	FOCUS HOLD FILTER B-H
K4C	17	FOCUS HOLD FILTER B-L
K4D	54	FOCUS HOLD FILTER OUTPUT GAIN
K4E	00	NOT USED
K4F	00	NOT USED

§5-20. Filter Composition

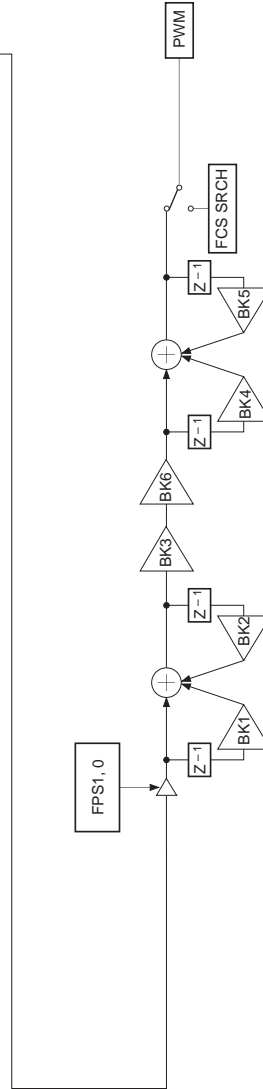
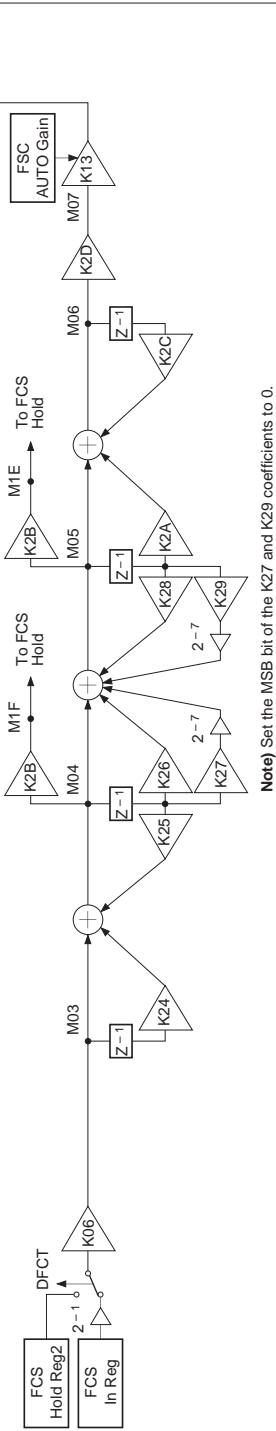
The internal filter composition is shown below.

K** : Coefficient RAM address, M** : Data RAM address

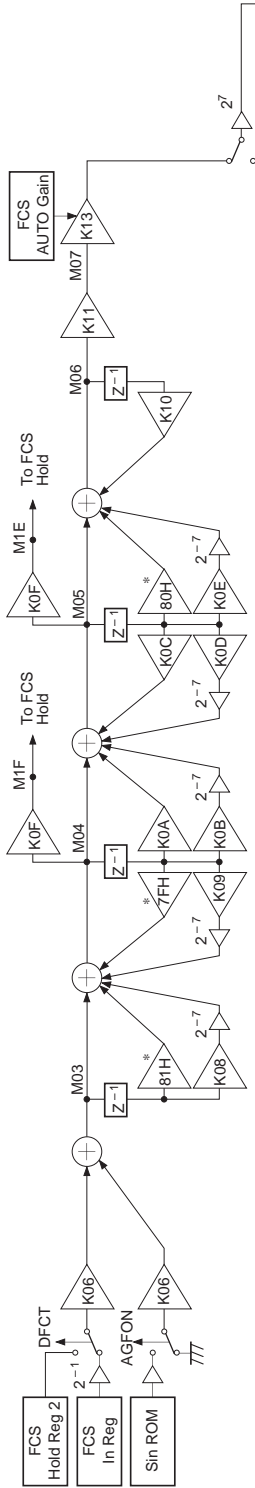
FCS Servo Gain Normal fs = 88.2kHz



FCS Servo Gain Down fs = 88.2kHz

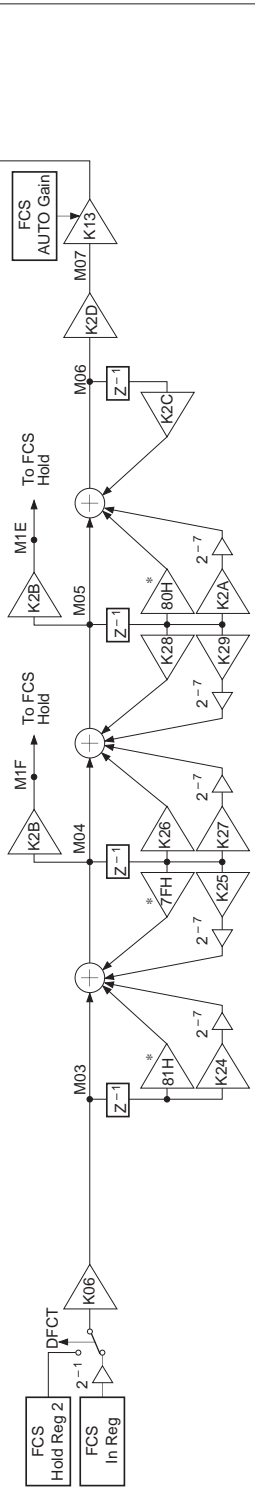


FCS Servo Gain Normal; fs = 88.2kHz, during quasi double accuracy (Ex.: \$3EAXX0)



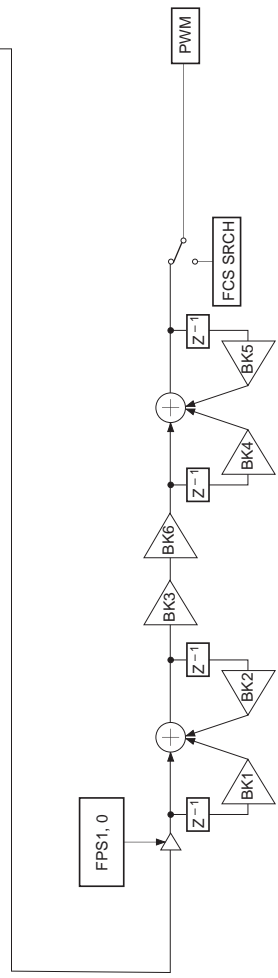
Note) Set the MSB bit of the K0B and K0D coefficients during normal operation, and of the K08, K09 and K0E coefficients during quasi double accuracy to 0.

FCS Servo Gain Normal; fs = 88.2kHz, during quasi double accuracy (Ex.: \$3E5XX0)

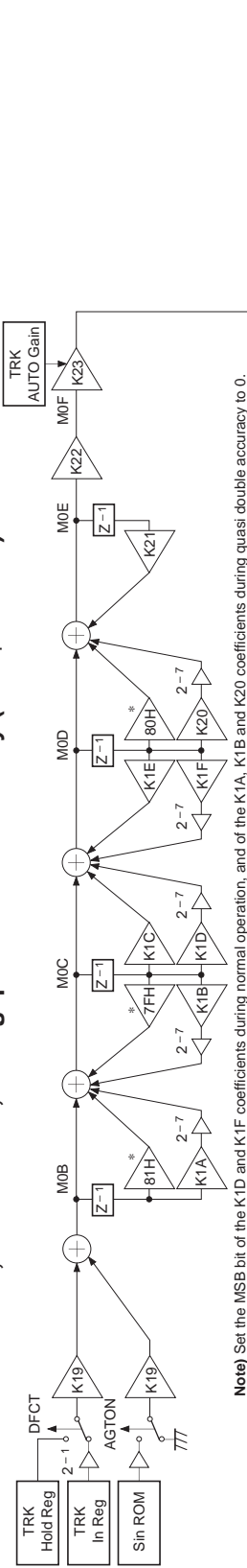


Note) Set the MSB bit of the K27 and K29 coefficients during normal operation, and of the K24, K25 and K2A coefficients during quasi double accuracy to 0.

* 81h, 7Fh and 80h are each Hex display 8-bit fixed values when set to quasi double accuracy.

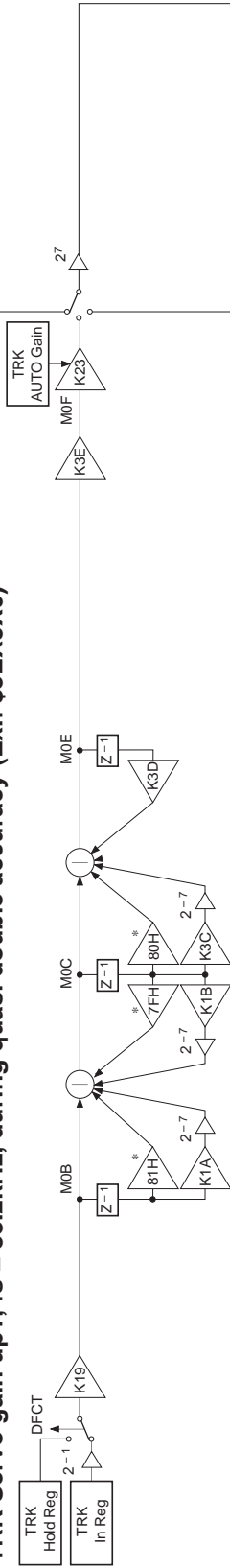


TRK Servo Gain Normal; fs = 88.2kHz, during quasi double accuracy (Ex.: \$3EXAX0)



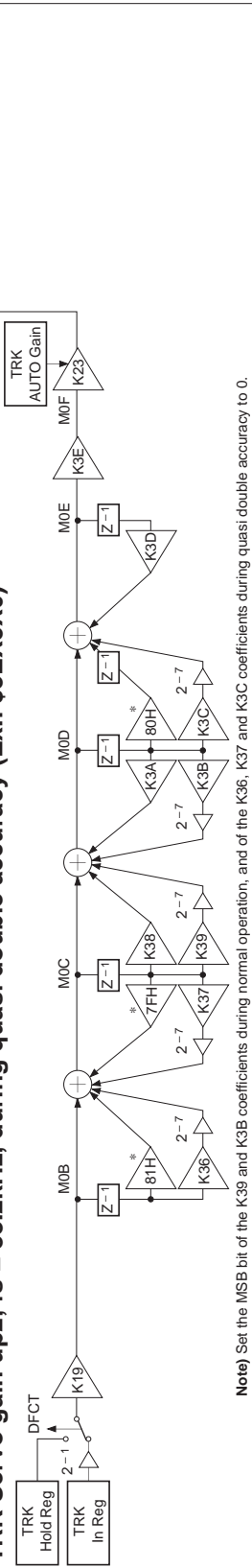
Note) Set the MSB bit of the K1D and K1F coefficients during normal operation, and of the K1A, K1B and K20 coefficients during quasi double accuracy to 0.

TRK Servo gain up1; fs = 88.2kHz, during quasi double accuracy (Ex.: \$3EX5X0)



Note) Set the MSB bit of the K1A, K1B and K3C coefficients during quasi double accuracy to 0.

TRK Servo gain up2; fs = 88.2kHz, during quasi double accuracy (Ex.: \$3EX5X0)

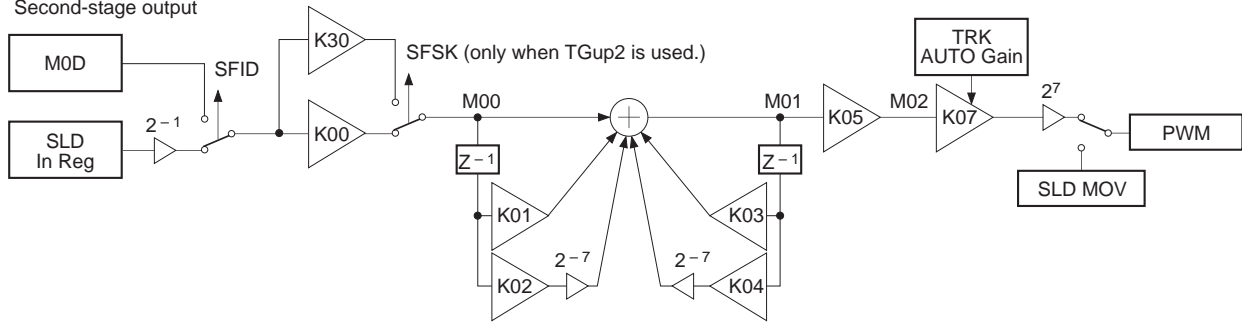


Note) Set the MSB bit of the K39 and K3B coefficients during normal operation, and of the K36, K37 and K3C coefficients during quasi double accuracy to 0.

* 81h, 7Fh and 80h are each Hex display 8-bit fixed values when set to quasi double accuracy.

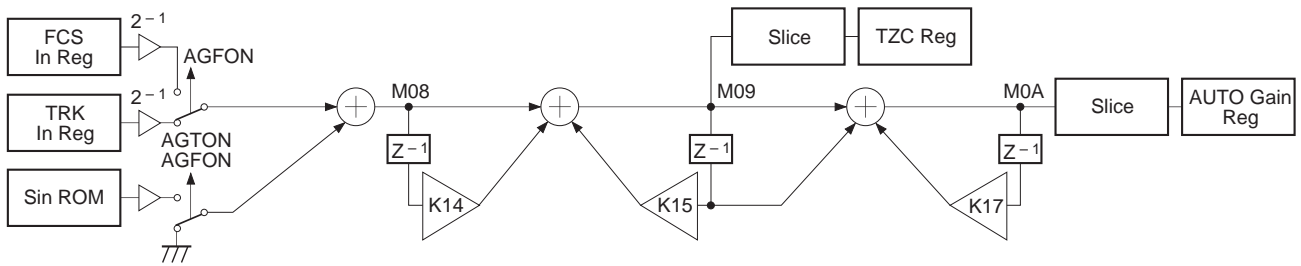
SLD Servo fs = 345Hz

TRK SERVO FILTER
Second-stage output

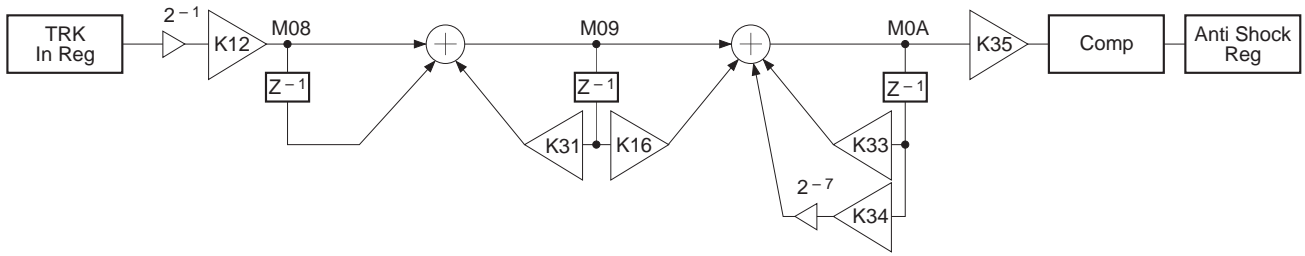


Note) Set the MSB bit of the K02 and K04 coefficients to 0.

HPTZC/Auto Gain fs = 88.2kHz

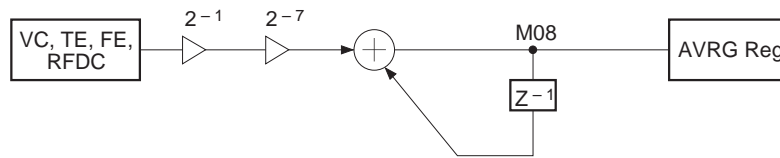


Anti Shock fs = 88.2kHz

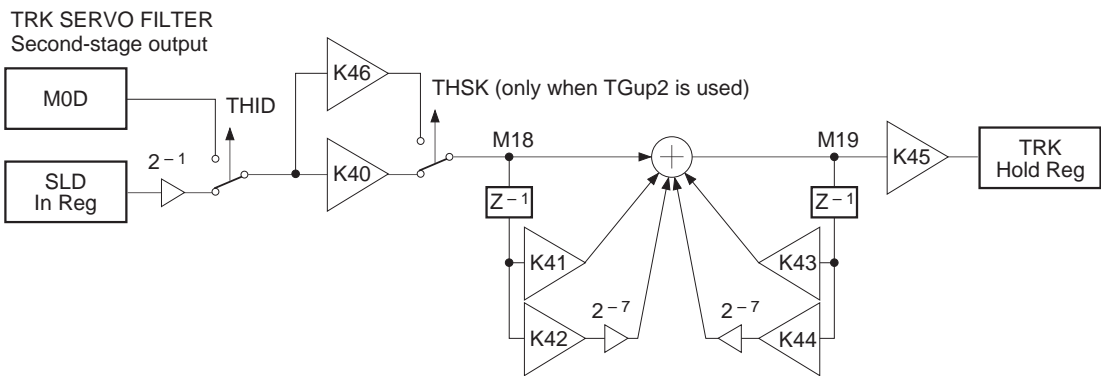


Note) Set the MSB bit of the K34 coefficient to 0.
The comparator level is 1/16 the maximum amplitude of the comparator input.

AVRG fs = 88.2kHz

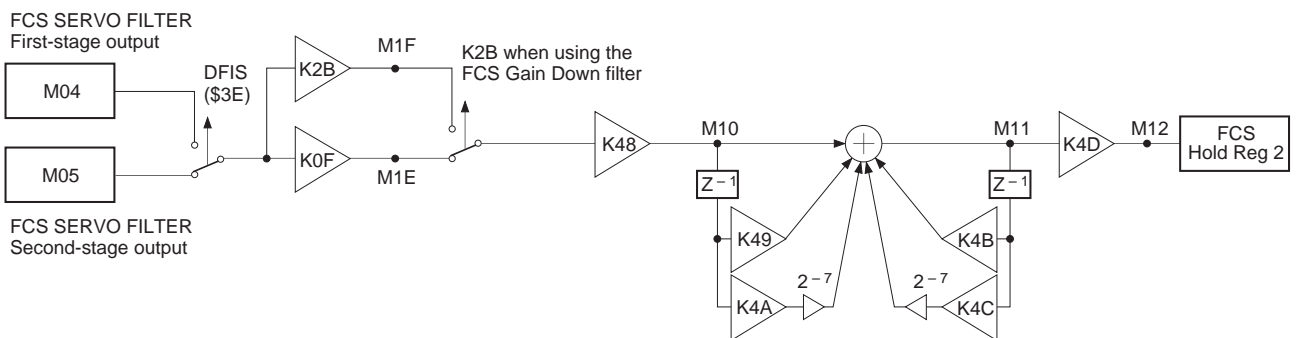


TRK Hold fs = 345Hz



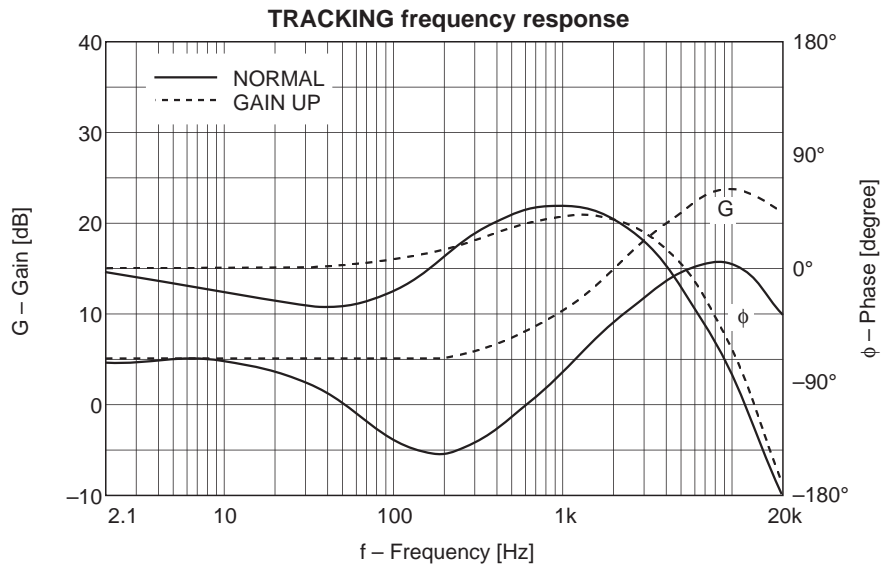
Note) Set the MSB bit of the K42 and K44 coefficients to 0.

FCS Hold fs = 345Hz

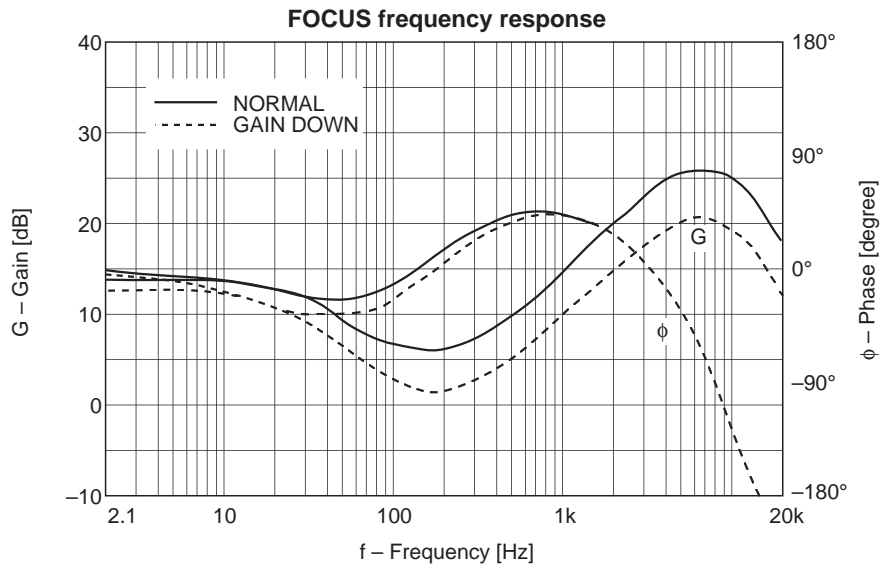


Note) Set the MSB bit of the K4A and K4C coefficients to 0.

§5-21. TRACKING and FOCUS Frequency Response

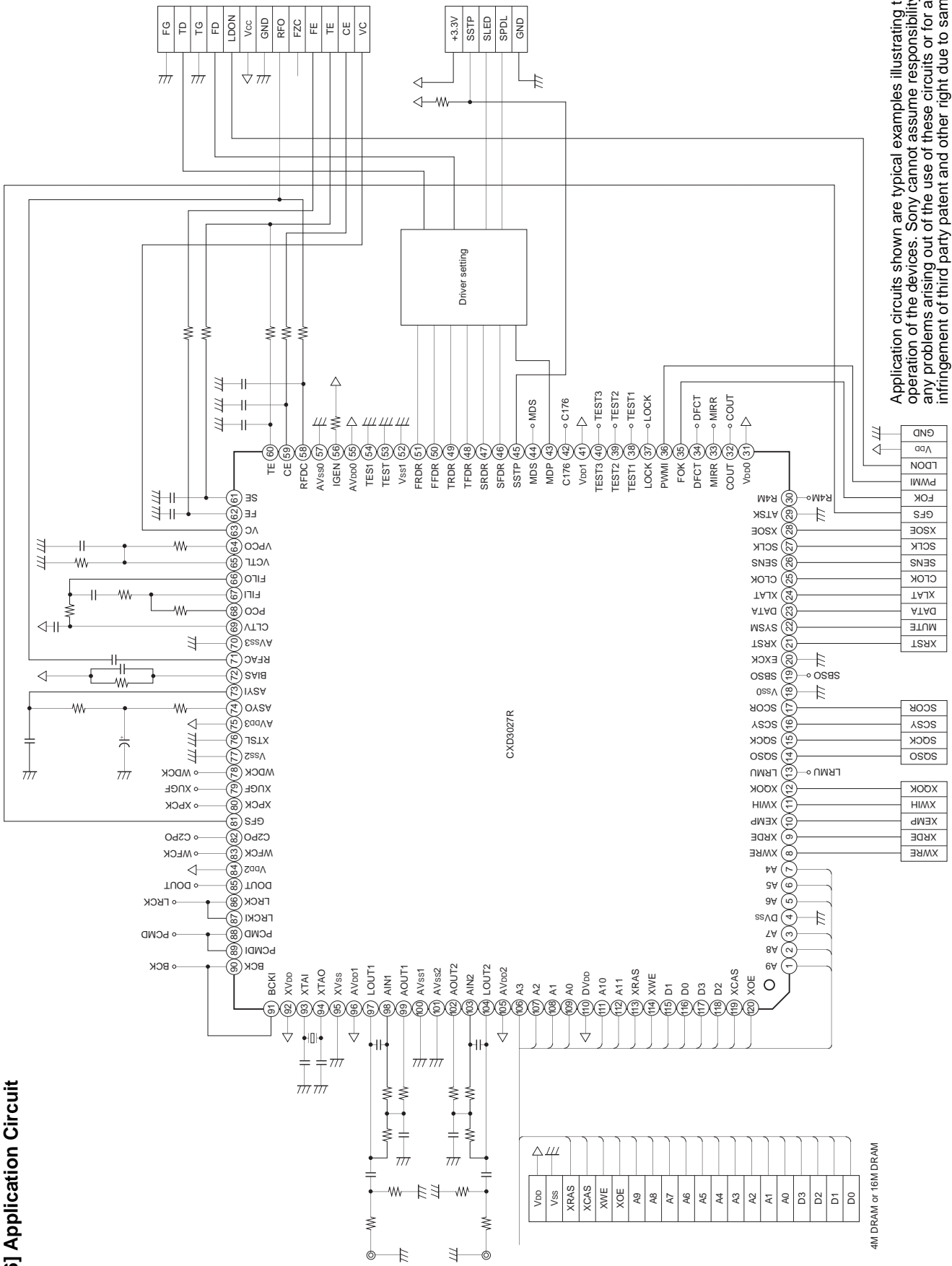


When using the preset coefficients with the boost function off.



When using the preset coefficients with the boost function off.

[6] Application Circuit

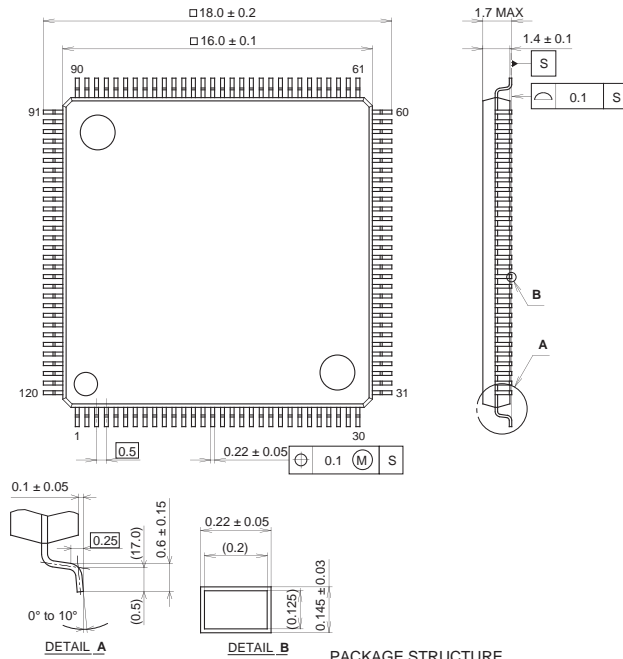


Application circuits shown are typical examples illustrating the operation of the devices. Sony cannot assume responsibility for any problems arising out of the use of these circuits or for any infringement of third party patent and other right due to same.

Package Outline

Unit: mm

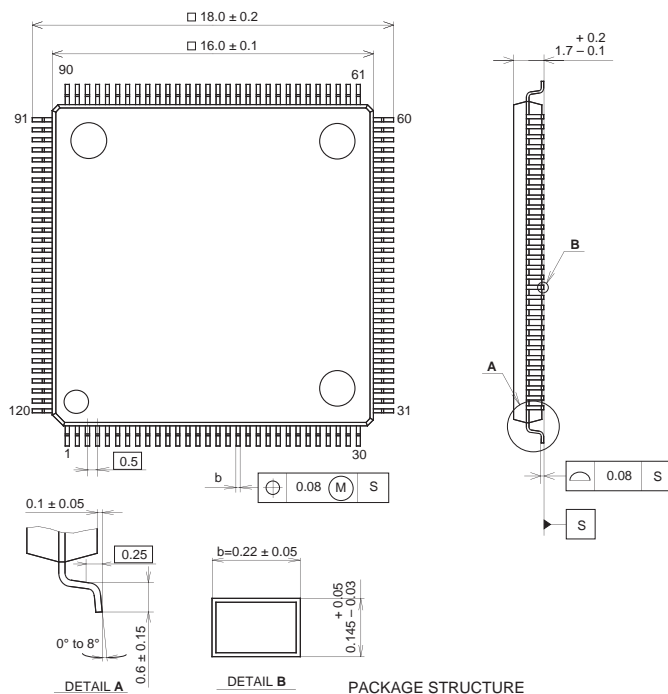
120PIN LQFP (PLASTIC)



SONY CODE	LQFP-120P-L01
EIAJ CODE	LQFP120-P-1616
JEDEC CODE	—

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER PLATING
LEAD MATERIAL	COPPER ALLOY
PACKAGE MASS	0.8g

120PIN LQFP(PLASTIC)



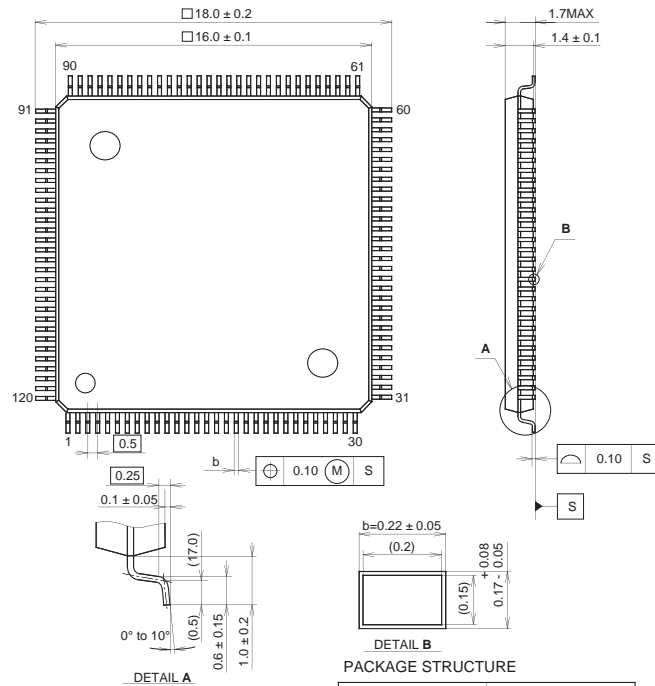
SONY CODE	LQFP-120P-L021
EIAJ CODE	P-LQFP120-16x16-0.5
JEDEC CODE	—

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER
LEAD MATERIAL	COPPER ALLOY
PACKAGE WEIGHT	0.8g

Package Outline

Unit: mm

120PIN LQFP(PLASTIC)



SONY CODE	LQFP-120P-L051
EIAJ CODE	P-LQFP120-16x16-0.5
JEDEC CODE	

PACKAGE STRUCTURE

PACKAGE MATERIAL	EPOXY RESIN
LEAD TREATMENT	SOLDER
LEAD MATERIAL	COPPER ALLOY
PACKAGE WEIGHT	0.8g